

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### General Description

The SLG46824 provides a small, low power component for commonly used Mixed-Signal functions. The user creates the circuit design by programming the multiple time Non-Volatile Memory (NVM) to configure the interconnect logic, the IOs, and the macrocells of the SLG46824. Dual power supply allows to flexibly interface two independent voltage domains. This highly versatile device allows a wide variety of Mixed-Signal functions to be designed within a very small, low power single integrated circuit.

### Key Features

- Two Low Power General Purpose Rail-to-Rail Analog Comparators (ACMPxL)
- One Voltage Reference
  - One Vref Output
- Eleven Combination Function Macrocells
  - Three Selectable DFF/LATCH or 2-bit LUTs
  - One Selectable Programmable Pattern Generator or 2-bit LUT
  - Six Selectable DFF/LATCH or 3-bit LUTs
  - One Selectable Pipe Delay or Ripple Counter, or 3-bit LUT
- Eight Multi-Function Macrocells
  - Seven Selectable DFF/LATCH or 3-bit LUTs + 8-bit Delay/Counters
  - One Selectable DFF/LATCH or 4-bit LUT + 16-bit Delay/Counter
- Serial Communications
  - I<sup>2</sup>C Protocol Interface
- Programmable Delay with Edge Detector Output
- Deglitch Filter or Edge Detector
- Three Oscillators
  - 2.048 kHz Oscillator
  - 2.048 MHz Oscillator
  - 25 MHz Oscillator
- Power-On Reset
- In System Programmability
- Multiple Time Programmable Memory
- Wide Range Power Supply
- 2.5 V ( $\pm 8\%$ ) to 5 V ( $\pm 10\%$ )  $V_{DD}$
- 1.8 V ( $\pm 5\%$ ) to 5 V ( $\pm 10\%$ )  $V_{DD2}$  ( $V_{DD2} \leq V_{DD}$ )
- Operating Temperature Range: -40 °C to 85 °C
- RoHS Compliant/Halogen-Free
- Two Packages Available
  - 20-pin STQFN: 2 mm x 3 mm x 0.55 mm, 0.4 mm pitch
  - 20-pin TSSOP: 6.5 mm x 6.4 mm x 1.2 mm, 0.65 mm pitch

### Applications

- Personal Computers and Servers
- PC Peripherals
- Consumer Electronics
- Data Communications Equipment
- Handheld and Portable Electronics
- Smartphones and Fitness Bands
- Notebook and Tablet PCs

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### Contents

<b>General Description</b>	1
<b>Key Features</b>	1
<b>Applications</b>	1
<b>1 Block Diagram</b>	7
<b>2 Pinout</b>	8
2.1 Pin Configuration - STQFN- 20L	8
2.2 Pin Configuration - TSSOP-20L	9
<b>3 Characteristics</b>	13
3.1 Absolute Maximum Ratings	13
3.2 Electrostatic Discharge Ratings	13
3.3 Recommended Operating Conditions	13
3.4 Electrical Characteristics	14
3.5 Timing Characteristics	21
3.6 OSC Characteristics	25
3.7 ACMP Specifications	25
<b>4 User Programmability</b>	27
<b>5 IO Pins</b>	28
5.1 IO Pins	28
5.2 GPIO Pins	28
5.3 GPO Pins	28
5.4 GPI Pins	28
5.5 Pull-Up/Down Resistors	28
5.6 Fast Pull-up/down during Power-up	28
5.7 I <sup>2</sup> C Mode IO Structure (VDD or VDD2)	29
5.8 Matrix OE IO Structure (VDD or VDD2)	30
5.9 Register OE IO Structure (VDD or VDD2)	31
5.10 Register OE IO Structure (VDD or VDD2)	32
5.11 IO Typical Performance	33
<b>6 Connection Matrix</b>	36
6.1 Matrix Input Table	37
6.2 Matrix Output Table	38
6.3 Connection Matrix Virtual Inputs	41
6.4 Connection Matrix Virtual Outputs	42
<b>7 Combination Function Macrocells</b>	43
7.1 2-Bit LUT or D Flip-Flop Macrocells	43
7.2 2-bit LUT or Programmable Pattern Generator	46
7.3 3-Bit LUT or D Flip-Flop with Set/Reset Macrocells	48
7.4 3-Bit LUT or Pipe Delay/Ripple Counter Macrocell	55
<b>8 Multi-Function Macrocells</b>	60
8.1 3-Bit LUT or DFF/LATCH with 8-Bit Counter/Delay Macrocells	60
8.2 CNT/DLY/FSM Timing Diagrams	69
8.3 4-Bit LUT or DFF/LATCH with 16-Bit Counter/Delay Macrocell	78
<b>9 Analog Comparators</b>	81
9.1 ACMP0L Block Diagram	82
9.2 ACMP1L Block Diagram	83
9.3 ACMP Typical Performance	84
<b>10 Programmable Delay/Edge Detector</b>	86
10.1 Programmable Delay Timing Diagram - Edge Detector Output	86
<b>11 Additional Logic Function. Deglitch Filter</b>	87
<b>12 Voltage Reference</b>	88
12.1 Voltage Reference Overview	88
12.2 Vref Selection Table	88
12.3 Vref Block Diagram	89
12.4 VREF Load Regulation	89
<b>13 Clocking</b>	92
13.1 Oscillator general description	92

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

13.2 Oscillator0 (2.048 kHz) .....	93
13.3 Oscillator1 (2.048 MHz) .....	94
13.4 Oscillator2 (25 MHz) .....	95
13.5 CNT/DLY Clock Scheme .....	96
13.6 External Clocking .....	96
13.7 Oscillators Power-On Delay .....	97
13.8 Oscillators Accuracy .....	99
<b>14 Power-On Reset .....</b>	<b>102</b>
14.1 General Operation .....	102
14.2 POR Sequence .....	103
14.3 Macrocells Output States During POR Sequence .....	103
<b>15 I<sup>2</sup>C Serial Communications Macrocell .....</b>	<b>106</b>
15.1 I <sup>2</sup> C Serial Communications Macrocell Overview .....	106
15.2 I <sup>2</sup> C Serial Communications Device Addressing .....	106
15.3 I <sup>2</sup> C Serial General Timing .....	107
15.4 I <sup>2</sup> C Serial Communications Commands .....	107
15.5 Chip Configuration Data Protection .....	110
15.6 I <sup>2</sup> C Serial Command Register Map .....	111
15.7 I <sup>2</sup> C Additional Options .....	112
<b>16 Non-Volatile Memory .....</b>	<b>115</b>
16.1 Serial NVM Write Operations .....	115
16.2 Serial NVM Read Operations .....	117
16.3 Serial NVM Erase Operations .....	117
<b>17 Register Definitions .....</b>	<b>118</b>
17.1 Register Map .....	118
<b>18 Package Top Marking System Definition .....</b>	<b>156</b>
18.1 STQFN 20L 2 mm x 3 mm 0.4P FCD Package .....	156
18.2 TSSOP-20 .....	156
<b>19 Package Information .....</b>	<b>157</b>
19.1 Package outlines for STQFN 20L 2 mm x 3 mm 0.4P FCD .....	157
19.2 Package outlines for TSSOP 20L 173 MIL Green .....	158
19.3 STQFN and TSSOP Handling .....	159
19.4 Soldering Information .....	159
<b>20 Ordering Information .....</b>	<b>160</b>
20.1 Tape and Reel Specifications .....	160
20.2 Carrier Tape Drawing and Dimensions .....	160
20.3 STQFN-20L .....	161
20.4 TSSOP-20L .....	161
<b>21 Layout Guidelines .....</b>	<b>162</b>
21.1 STQFN 20L 2 mm x 3 mm 0.4P FCD Package .....	162
21.2 TSSOP-20 .....	163
<b>Glossary.....</b>	<b>164</b>
<b>Revision History .....</b>	<b>167</b>

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### Figures

Figure 1: Block Diagram.....	7
Figure 2: Steps to Create a Custom GreenPAK Device .....	27
Figure 3: IO with I <sup>2</sup> C Mode IO Structure Diagram.....	29
Figure 4: Matrix OE IO Structure Diagram .....	30
Figure 5: GPIO Register OE IO Structure Diagram.....	31
Figure 6: GPIO Register OE IO Structure Diagram.....	32
Figure 7: Typical High Level Output Current vs. High Level Output Voltage at T = 25 °C .....	33
Figure 8: Typical Low Level Output Current vs. Low Level Output Voltage, 1x Drive at T = 25 °C, Full Range .....	33
Figure 9: Typical Low Level Output Current vs. Low Level Output Voltage, 1x Drive at T = 25 °C .....	34
Figure 10: Typical Low Level Output Current vs. Low Level Output Voltage, 2x Drive at T = 25 °C, Full Range .....	34
Figure 11: Typical Low Level Output Current vs. Low Level Output Voltage, 2x Drive at T = 25 °C .....	35
Figure 12: Connection Matrix .....	36
Figure 13: Connection Matrix Example .....	36
Figure 14: 2-bit LUT0 or DFF0 .....	43
Figure 15: 2-bit LUT1 or DFF1 .....	44
Figure 16: 2-bit LUT2 or DFF2 .....	44
Figure 17: DFF Polarity Operations.....	46
Figure 18: 2-bit LUT3 or PGen .....	47
Figure 19: PGen Timing Diagram.....	47
Figure 20: 3-bit LUT0 or DFF3 .....	49
Figure 21: 3-bit LUT1 or DFF4 .....	49
Figure 22: 3-bit LUT2 or DFF5 .....	50
Figure 23: 3-bit LUT3 or DFF6 .....	50
Figure 24: 3-bit LUT4 or DFF7 .....	51
Figure 25: 3-bit LUT5 or DFF8 .....	51
Figure 26: DFF Polarity Operations with nReset.....	54
Figure 27: DFF Polarity Operations with nSet.....	55
Figure 28: 3-bit LUT6/Pipe Delay/Ripple Counter .....	57
Figure 29: Example: Ripple Counter Functionality.....	58
Figure 30: Possible Connections Inside Multi-Function Macrocell .....	60
Figure 31: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT7/DFF10, CNT/DLY1) .....	61
Figure 32: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT8/DFF11, CNT/DLY2) .....	62
Figure 33: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT9/DFF12, CNT/DLY3) .....	63
Figure 34: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT10/DFF13, CNT/DLY4) .....	64
Figure 35: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT11/DFF14, CNT/DLY5) .....	65
Figure 36: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT12/DFF15, CNT/DLY6) .....	66
Figure 37: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT13/DFF16, CNT/DLY7) .....	67
Figure 38: Delay Mode Timing Diagram, Edge Select: Both, Counter Data: 3 .....	69
Figure 39: Delay Mode Timing Diagram for Different Edge Select Modes.....	70
Figure 40: Counter Mode Timing Diagram without Two DFFs Synced Up .....	70
Figure 41: Counter Mode Timing Diagram with Two DFFs Synced Up .....	71
Figure 42: One-Shot Function Timing Diagram.....	72
Figure 43: Frequency Detection Mode Timing Diagram.....	73
Figure 44: Edge Detection Mode Timing Diagram .....	74
Figure 45: Delayed Edge Detection Mode Timing Diagram .....	75
Figure 46: CNT/FSM Timing Diagram (Reset Rising Edge Mode, Oscillator is Forced On, UP = 0) for Counter Data = 3 .....	76
Figure 47: CNT/FSM Timing Diagram (Set Rising Edge Mode, Oscillator is Forced On, UP = 0) for Counter Data = 3 .....	76
Figure 48: CNT/FSM Timing Diagram (Reset Rising Edge Mode, Oscillator is Forced On, UP = 1) for Counter Data = 3 .....	77
Figure 49: CNT/FSM Timing Diagram (Set Rising Edge Mode, Oscillator is Forced On, UP = 1) for Counter Data = 3 .....	77
Figure 50: Counter Value, Counter Data = 3.....	78
Figure 51: 4-bit LUT0 or CNT/DLY0.....	79
Figure 52: ACMP0L Block Diagram .....	82
Figure 53: ACMP0L Block Diagram .....	83
Figure 54: Typical Propagation Delay vs. Vref for ACMPxL at T = 25 °C, Gain = 1, Buffer - Disabled, Hysteresis = 0 .....	84
Figure 55: ACMPxL Power-On Delay vs. V <sub>DD</sub> .....	84
Figure 56: ACMPxL Input Offset Voltage vs. Vref at T = -40 °C to 85 °C .....	85

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Figure 57: Programmable Delay .....	86
Figure 58: Edge Detector Output .....	86
Figure 59: Deglitch Filter or Edge Detector .....	87
Figure 60: Voltage Reference Block Diagram .....	89
Figure 61: Typical Load Regulation, Vref = 320 mV, T = -40 °C to +85 °C, Buffer - Enable .....	89
Figure 62: Typical Load Regulation, Vref = 640 mV, T = -40 °C to +85 °C, Buffer - Enable .....	90
Figure 63: Typical Load Regulation, Vref = 1280 mV, T = -40 °C to +85 °C, Buffer - Enable .....	90
Figure 64: Typical Load Regulation, Vref = 2016 mV, T = -40 °C to +85 °C, Buffer - Enable .....	91
Figure 65: Oscillator0 Block Diagram .....	93
Figure 66: Oscillator1 Block Diagram .....	94
Figure 67: Oscillator2 Block Diagram .....	95
Figure 68: Clock Scheme .....	96
Figure 69: Oscillator Startup Diagram .....	97
Figure 70: Oscillator0 Maximum Power-On Delay vs. V <sub>DD</sub> at T = 25 °C, OSC0 = 2.048 kHz .....	97
Figure 71: Oscillator1 Maximum Power-On Delay vs. V <sub>DD</sub> at T = 25 °C, OSC1 = 2.048 MHz .....	98
Figure 72: Oscillator2 Maximum Power-On Delay vs. V <sub>DD</sub> at T = 25 °C, OSC2 = 25 MHz .....	98
Figure 73: Oscillator0 Frequency vs. Temperature, OSC0 = 2.048 kHz .....	99
Figure 74: Oscillator1 Frequency vs. Temperature, OSC1 = 2.048 MHz .....	99
Figure 75: Oscillator2 Frequency vs. Temperature, OSC2 = 25 MHz .....	100
Figure 76: Oscillators Total Error vs. Temperature .....	100
Figure 77: POR Sequence .....	103
Figure 78: Internal Macrocell States during POR Sequence .....	104
Figure 79: Power-Down .....	105
Figure 80: Basic Command Structure .....	106
Figure 81: I <sup>2</sup> C General Timing Characteristics .....	107
Figure 82: Byte Write Command, R/W = 0 .....	107
Figure 83: Sequential Write Command .....	108
Figure 84: Current Address Read Command, R/W = 1 .....	108
Figure 85: Random Read Command .....	109
Figure 86: Sequential Read Command .....	109
Figure 87: Reset Command Timing .....	110
Figure 88: Example of I <sup>2</sup> C Byte Write Bit Masking .....	114
Figure 89: Page Write Command .....	115
Figure 90: I <sup>2</sup> C Block Addressing .....	116

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### Tables

Table 1: Functional Pin Description.....	9
Table 2: Pin Type Definitions .....	12
Table 3: Absolute Maximum Ratings.....	13
Table 4: Electrostatic Discharge Ratings .....	13
Table 5: Recommended Operating Conditions .....	13
Table 6: EC at T = -40 °C to +85 °C, V <sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted .....	14
Table 7: EC of the I <sup>2</sup> C Pins at T = -40 °C to +85 °C, V <sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted .....	19
Table 8: I <sup>2</sup> C Pins Timing Characteristics at T = -40 °C to +85 °C, V <sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted.....	20
Table 9: Typical Current Estimated for Each Macrocell at T = -40 °C to +85 °C .....	21
Table 10: Typical Delay Estimated for Each Macrocell at T = 25 °C.....	21
Table 11: Programmable Delay Expected Delays and Widths (Typical) at T = 25 °C .....	24
Table 12: Typical Filter Rejection Pulse Width at T = 25 °C .....	24
Table 13: Typical Counter/Delay Offset Measurements at T = 25 °C .....	24
Table 14: Oscillators Frequency Limits, V <sub>DD</sub> = 2.3 V to 5.5 V .....	25
Table 15: Oscillators Power-On Delay at T = 25 °C, OSC Power Mode: "Auto Power-On" .....	25
Table 16: ACMP Specifications at T = -40 °C to +85 °C, V <sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted.....	25
Table 17: Matrix Input Table.....	37
Table 18: Matrix Output Table.....	38
Table 19: Connection Matrix Virtual Inputs .....	42
Table 20: 2-bit LUT0 Truth Table .....	45
Table 21: 2-bit LUT1 Truth Table .....	45
Table 22: 2-bit LUT2 Truth Table .....	45
Table 23: 2-bit LUT Standard Digital Functions .....	45
Table 24: 2-bit LUT1 Truth Table .....	48
Table 25: 2-bit LUT Standard Digital Functions .....	48
Table 26: 3-bit LUT0 Truth Table .....	52
Table 27: 3-bit LUT1 Truth Table .....	52
Table 28: 3-bit LUT2 Truth Table .....	52
Table 29: 3-bit LUT3 Truth Table .....	52
Table 30: 3-bit LUT4 Truth Table .....	52
Table 31: 3-bit LUT5 Truth Table .....	52
Table 32: 3-bit LUT Standard Digital Functions .....	53
Table 33: 3-bit LUT6 Truth Table .....	58
Table 34: 3-bit LUT7 Truth Table .....	68
Table 35: 3-bit LUT8 Truth Table .....	68
Table 36: 3-bit LUT9 Truth Table .....	68
Table 37: 3-bit LUT10 Truth Table .....	68
Table 38: 3-bit LUT11 Truth Table .....	68
Table 39: 3-bit LUT12 Truth Table .....	68
Table 40: 3-bit LUT13 Truth Table .....	68
Table 41: 4-bit LUT0 Truth Table .....	80
Table 42: 4-bit LUT Standard Digital Functions .....	80
Table 43: Vref Selection Table .....	88
Table 44: Oscillator Operation Mode Configuration Settings .....	92
Table 45: Oscillator Output Duty Cycle .....	101
Table 46: RPR Format .....	110
Table 47: RPR Bit Function Description.....	110
Table 48: NPR Format .....	111
Table 49: NPR Bit Function Description.....	111
Table 50: Read/Write Register Protection Options .....	111
Table 51: Erase Register Bit format .....	117
Table 52: Erase Register Bit Function Description.....	117
Table 53: Register Map .....	118

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 1 Block Diagram

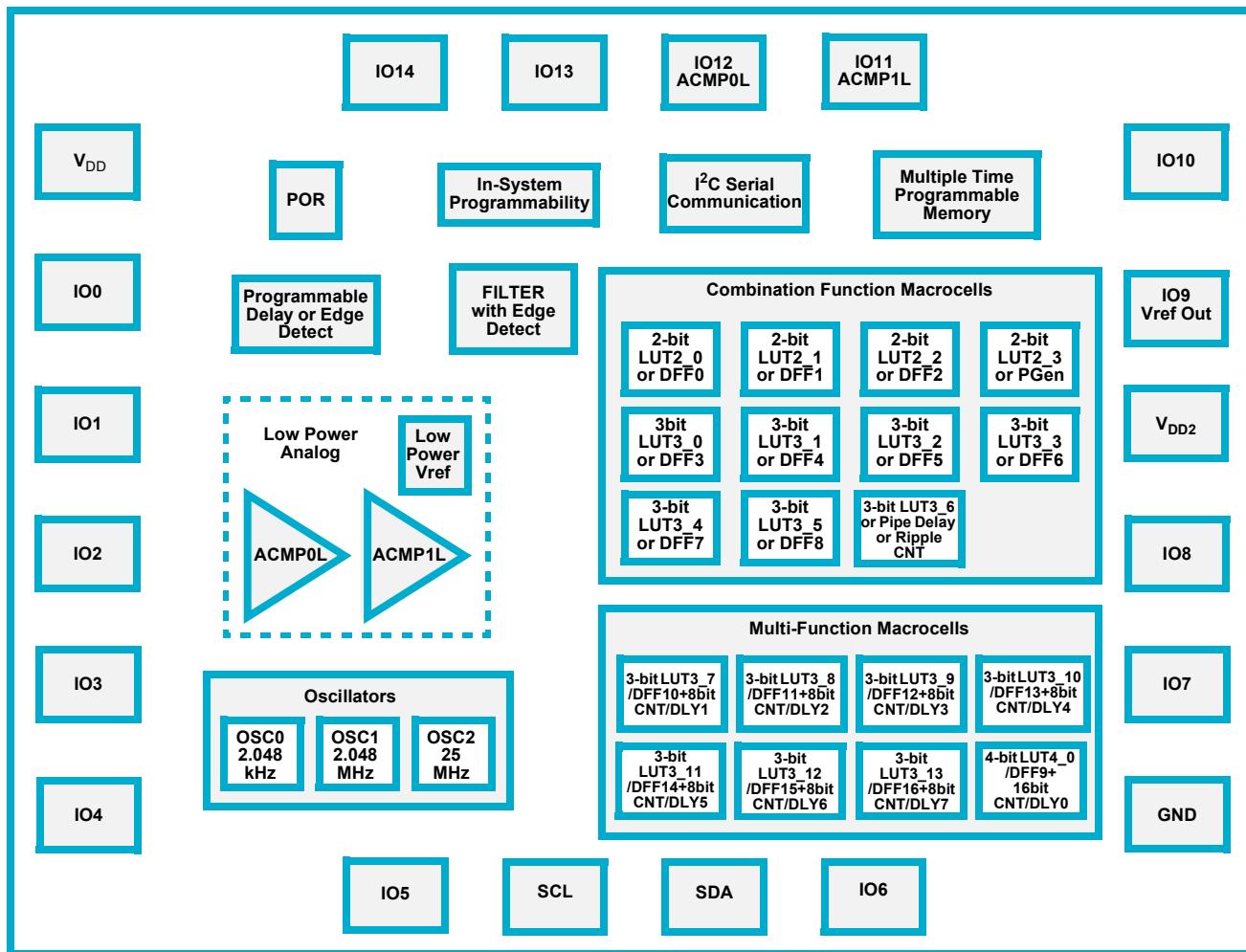
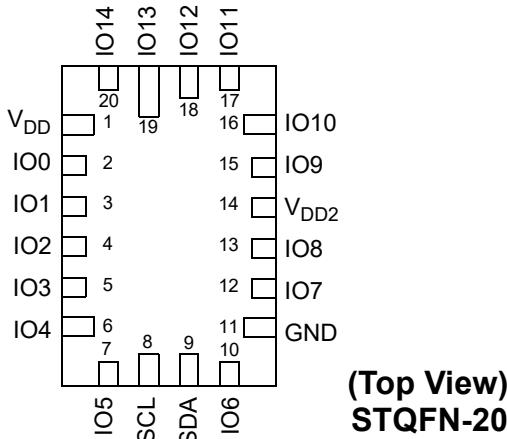


Figure 1: Block Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 2 Pinout

#### 2.1 PIN CONFIGURATION - STQFN- 20L



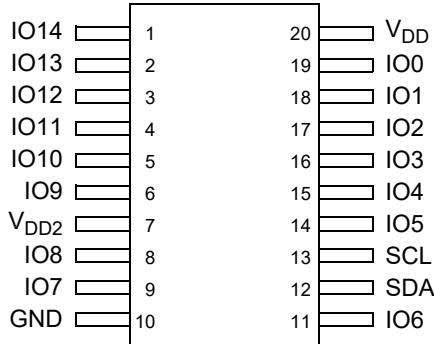
Pin #	Pin Name	Pin Functions
1	V <sub>DD</sub>	Power Supply
2	IO0	GPIO
3	IO1	GPIO or Vref IN
4	IO2	GPIO, SLA_0
5	IO3	GPIO, SLA_1
6	IO4	GPIO, SLA_2
7	IO5	GPIO, SLA_3
8	SCL	I <sup>2</sup> C_SCL
9	SDA	I <sup>2</sup> C_SDA
10	IO6	GPO
11	GND	Ground
12	IO7	GPO
13	IO8	GPIO
14	V <sub>DD2</sub>	Power Supply
15	IO9	GPIO or Vref_OUT1
16	IO10	GPIO
17	IO11	GPIO or ACMP1L_IN
18	IO12	GPIO or ACMP0L_IN
19	IO13	GPIO
20	IO14	GPIO

Legend:

**ACMPx+:** ACMPx Positive Input  
**ACMPx-:** ACMPx Negative Input  
**SCL:** I<sup>2</sup>C Clock Input  
**SDA:** I<sup>2</sup>C Data Input/Output  
**Vref:** Voltage Reference Output  
**SLA:** Slave Address

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 2.2 PIN CONFIGURATION - TSSOP-20L



**TSSOP-20  
(Top View)**

Pin #	Pin Name	Pin Functions
1	IO14	GPIO
2	IO13	GPIO
3	IO12	GPIO or ACMP0L_IN
4	IO11	GPIO or ACMP1L_IN
5	IO10	GPIO
6	IO9	GPIO or Vref_OUT1
7	V <sub>DD2</sub>	Power Supply
8	IO8	GPIO
9	IO7	GPO
10	GND	Ground
11	IO6	GPO
12	SDA	I <sup>2</sup> C_SDA
13	SCL	I <sup>2</sup> C_SCL
14	IO5	GPIO, SLA_3
15	IO4	GPIO, SLA_2
16	IO3	GPIO, SLA_1
17	IO2	GPIO, SLA_0]
18	IO1	GPIO or Vref IN
19	IO0	GPIO
20	V <sub>DD</sub>	Power Supply

*Legend:*

ACMPx+: ACMPx Positive Input

ACMPx-: ACMPx Negative Input

SCL: I<sup>2</sup>C Clock Input

SDA: I<sup>2</sup>C Data Input/Output

Vref: Voltage Reference Output

SLA: Slave Address

**Table 1: Functional Pin Description**

Pin No.		Pin Name	Signal Name	Function	Input Options	Output Options
STQFN 20L	TSSOP 20L					
1	20	V <sub>DD</sub>	VDD	Power Supply	--	--
			ACMP0L+	Analog Comparator 0 Positive Input	Analog	--
			ACMP1L+	Analog Comparator 1 Positive Input	Analog	--
2	19	IO0	IO0	General Purpose IO	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
			I <sup>2</sup> C_EXPAND_0	--	--	--
			EXT_OSC0_IN	External Clock Connection	--	--

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 1: Functional Pin Description(Continued)

Pin No.		Pin Name	Signal Name	Function	Input Options	Output Options
STQFN 20L	TSSOP 20L					
3	18	IO1	IO1	General Purpose IO with OE (Note 1)	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
			EXT_Vref	Analog Comparator Negative Input	Analog	--
4	17	IO2	IO2	General Purpose IO	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
			EXT_SLA_0		Low Voltage Digital Input	--
5	16	IO3	IO3	General Purpose IO	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
			EXT_SLA_1		Low Voltage Digital Input	--
6	15	IO4	IO4	General Purpose IO with OE (Note 1)	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
			EXT_SLA_2		Low Voltage Digital Input	--
7	14	IO5	IO5	General Purpose IO with OE (Note 1)	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
			EXT_SLA_3		Low Voltage Digital Input	--
			I <sup>2</sup> C_EXPAND_1	--	--	--
8	13	SCL	SCL	I <sup>2</sup> C Serial Clock	Digital Input without Schmitt Trigger	--
					Digital Input with Schmitt Trigger	--
					Low Voltage Digital Input	--
9	12	SDA	SDA	I <sup>2</sup> C Serial Data	Digital Input without Schmitt Trigger	--
					Digital Input with Schmitt Trigger	--
					Low Voltage Digital Input	--
10	11	IO6	IO6	General Purpose Output	--	Push-Pull (1x) (2x)
					--	Open-Drain NMOS (1x) (2x)
					--	--
			I <sup>2</sup> C_EXPAND_2	--	--	--
11	10	GND	GND	Ground	--	--

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 1: Functional Pin Description(Continued)**

Pin No.		Pin Name	Signal Name	Function	Input Options	Output Options
STQFN 20L	TSSOP 20L					
12	9	IO7	IO7	General Purpose Output	--	Push-Pull (1x) (2x)
					--	Open-Drain NMOS (1x) (2x)
					--	--
13	8	IO8	IO8	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
		EXT_OSC2_IN	--	--	--	--
14	7	V <sub>DD2</sub>	V <sub>DD2</sub>	Power Supply	--	--
15	6	IO9	IO9	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
		V <sub>ref_OUT</sub>	Voltage Reference 1 Output	--	--	Analog
		I <sup>2</sup> C_EXPAND_3	--	--	--	--
16	5	IO10	IO10	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
		EXT_OSC1_IN	--	--	--	--
17	4	IO11	IO11	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
		ACMP1L+	Analog Comparator 3 Positive Input	--	Analog	--
18	3	IO12	IO12	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
		ACMP0L+	Analog Comparator 2 Positive Input	--	Analog	--
19	2	IO13	IO13	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
					Low Voltage Digital Input	--
		Slave Address 2	--	--	--	--

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 1: Functional Pin Description(Continued)

Pin No.		Pin Name	Signal Name	Function	Input Options	Output Options
STQFN 20L	TSSOP 20L					
20	1	IO14	IO14	General Purpose IO with OE <b>(Note 1)</b>	Digital Input without Schmitt Trigger	Push-Pull (1x) (2x)
					Digital Input with Schmitt Trigger	Open-Drain NMOS (1x) (2x)
	1				Low Voltage Digital Input	--
			Slave Address 3	--	--	--

**Note 1** General Purpose IO's with OE can be used to implement bidirectional signals under user control via Connection Matrix to OE signal in IO structure.

Table 2: Pin Type Definitions

Pin Type	Description
V <sub>DD</sub>	Power Supply
IO	Input/Output
SCL	I <sup>2</sup> C Serial Clock
SDA	I <sup>2</sup> C Serial Data
GND	Ground
V <sub>DD2</sub>	Power Supply 2

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 3 Characteristics

#### 3.1 ABSOLUTE MAXIMUM RATINGS

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, so functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification are not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

**Table 3: Absolute Maximum Ratings**

Parameter	Min	Max	Unit
Supply Voltage on $V_{DD}$ relative to GND	-0.3	7	V
DC Input Voltage	GND - 0.5 V	$V_{DD} + 0.5$ V	V
Maximum Average or DC Current Through $V_{DD}$ Pin	--	90	mA
Maximum Average or DC Current Through $V_{DD2}$ Pin	--	90	mA
Maximum Average or DC Current Through GND Pin (Per chip side, (Note 1))	--	100	mA
Maximum Average or DC Current (Through pin)	Push-Pull 1x	--	15.3
	Push-Pull 2x	--	22.1
	OD 1x	--	15.5
	OD 2x	--	23
Current at Input Pin	-1.0	1.0	mA
Input leakage (Absolute Value)	--	1000	nA
Storage Temperature Range	-65	150	°C
Junction Temperature	--	150	°C
Moisture Sensitivity Level	1		
<b>Note 1</b> The GreenPAK's GND rail is divided in two sides. IOs 0 to 6, SCL, SDA are connected to one side and IOs 7 to 14 are connected to another side.			

#### 3.2 ELECTROSTATIC DISCHARGE RATINGS

**Table 4: Electrostatic Discharge Ratings**

Parameter	Min	Max	Unit
ESD Protection (Human Body Model)	2000	--	V
ESD Protection (Charged Device Model)	1300	--	V

#### 3.3 RECOMMENDED OPERATING CONDITIONS

**Table 5: Recommended Operating Conditions**

Parameter	Condition	Min	Max	Unit
Supply Voltage ( $V_{DD}$ )		2.3	5.5	V
	During NVM Write and Erase commands	2.5	5.5	V
Supply Voltage 2 ( $V_{DD2}$ )	$V_{DD2} \leq V_{DD}$	1.71	5.5	V
Operating Temperature		-40	85	°C
Maximal Voltage Applied to any PIN in High Impedance State		--	$V_{DD} + 0.3$ (Note 1)	V
Capacitor Value at $V_{DD}$		0.1	--	μF
Analog Input Common Mode Range	Allowable Input Voltage at Analog Pins	0	$V_{DD}$ or $V_{DD2}$ (Note 2)	V

**Note 1** IOs 0 to 6, SCL, SDA are powered from  $V_{DD}$  and IOs 7 to 12 are powered from  $V_{DD2}$ .

**Note 2**  $V_{DD}$  for IO1 and  $V_{DD2}$  for IO11, IO12

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 3.4 ELECTRICAL CHARACTERISTICS

Table 6: EC at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted

Parameter	Description	Condition	Min	Typ	Max	Unit
V <sub>IH</sub>	HIGH-Level Input Voltage	Logic Input (Note 2)	0.7x V <sub>DD</sub> (Note 1)	--	V <sub>DD</sub> <sup>+</sup> 0.3 (Note 1)	V
		Logic Input with Schmitt Trigger	0.8x V <sub>DD</sub> (Note 1)	--	V <sub>DD</sub> <sup>+</sup> 0.3 (Note 1)	V
		Low-Level Logic Input (Note 2)	1.25	--	V <sub>DD</sub> <sup>+</sup> 0.3 (Note 1)	V
V <sub>IL</sub>	LOW-Level Input Voltage	Logic Input (Note 2)	GND- 0.3	--	0.3x V <sub>DD</sub> (Note 1)	V
		Logic Input with Schmitt Trigger	GND- 0.3	--	0.2x V <sub>DD</sub> (Note 1)	V
		Low-Level Logic Input (Note 2)	GND- 0.3	--	0.5	V
V <sub>HYS</sub>	Schmitt Trigger Hysteresis Voltage	V <sub>DD2</sub> = 1.8 V ± 5 %	0.1	0.4	0.7	V
		V <sub>DD</sub> = 2.5 V ± 8 % (Note 1)	0.29	0.41	0.56	V
		V <sub>DD</sub> = 3.3 V ± 10 % (Note 1)	0.33	0.45	0.57	V
		V <sub>DD</sub> = 5 V ± 10 % (Note 1)	0.42	0.57	0.74	V
V <sub>O</sub>	Maximal Voltage Applied to any PIN in High Impedance State		--	--	V <sub>DD</sub> <sup>+</sup> 0.3 (Note 1)	V
V <sub>OH</sub>	HIGH-Level Output Voltage	Push-Pull, 1x Drive, I <sub>OH</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V (Note 1)	2.178	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V (Note 1)	2.389	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V (Note 1)	2.598	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V (Note 1)	2.712	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V (Note 1)	3.039	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V (Note 1)	3.36	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V (Note 1)	4.157	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V (Note 1)	4.678	--	--	V
		Push-Pull, 1x Drive, I <sub>OH</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V (Note 1)	5.201	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V (Note 1)	2.239	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V (Note 1)	2.443	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V (Note 1)	2.648	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V (Note 1)	2.854	--	--	V

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 6: EC at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Condition	Min	Typ	Max	Unit
V <sub>OH</sub>	HIGH-Level Output Voltage	Push-Pull, 2x Drive, I <sub>OH</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V ( <b>Note 1</b> )	3.165	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V ( <b>Note 1</b> )	3.474	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V ( <b>Note 1</b> )	4.314	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V ( <b>Note 1</b> )	4.821	--	--	V
		Push-Pull, 2x Drive, I <sub>OH</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V ( <b>Note 1</b> )	5.329	--	--	V
V <sub>OL</sub>	LOW-Level Output Voltage	Push-Pull, 1x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V ( <b>Note 1</b> )	--	--	0.085	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V ( <b>Note 1</b> )	--	--	0.079	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V ( <b>Note 1</b> )	--	--	0.074	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V ( <b>Note 1</b> )	--	--	0.210	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V ( <b>Note 1</b> )	--	--	0.195	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V ( <b>Note 1</b> )	--	--	0.183	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V ( <b>Note 1</b> )	--	--	0.271	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V ( <b>Note 1</b> )	--	--	0.256	V
		Push-Pull, 1x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V ( <b>Note 1</b> )	--	--	0.246	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V ( <b>Note 1</b> )	--	--	0.046	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V ( <b>Note 1</b> )	--	--	0.043	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V ( <b>Note 1</b> )	--	--	0.040	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V ( <b>Note 1</b> )	--	--	0.114	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V ( <b>Note 1</b> )	--	--	0.107	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V ( <b>Note 1</b> )	--	--	0.102	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V ( <b>Note 1</b> )	--	--	0.152	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V ( <b>Note 1</b> )	--	--	0.145	V
		Push-Pull, 2x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V ( <b>Note 1</b> )	--	--	0.140	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V ( <b>Note 1</b> )	--	--	0.038	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V ( <b>Note 1</b> )	--	--	0.035	V

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 6: EC at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Condition	Min	Typ	Max	Unit
V <sub>OL</sub>	LOW-Level Output Voltage	NMOS OD, 1x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V <b>(Note 1)</b>	--	--	0.033	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V <b>(Note 1)</b>	--	--	0.094	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V <b>(Note 1)</b>	--	--	0.088	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V <b>(Note 1)</b>	--	--	0.084	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V <b>(Note 1)</b>	--	--	0.127	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V <b>(Note 1)</b>	--	--	0.121	V
		NMOS OD, 1x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V <b>(Note 1)</b>	--	--	0.117	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V <b>(Note 1)</b>	--	--	0.032	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V <b>(Note 1)</b>	--	--	0.03	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 1 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V <b>(Note 1)</b>	--	--	0.029	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V <b>(Note 1)</b>	--	--	0.064	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V <b>(Note 1)</b>	--	--	0.062	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 3 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V <b>(Note 1)</b>	--	--	0.059	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V <b>(Note 1)</b>	--	--	0.085	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V <b>(Note 1)</b>	--	--	0.081	V
		NMOS OD, 2x Drive, I <sub>OL</sub> = 5 mA, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V <b>(Note 1)</b>	--	--	0.08	V
I <sub>OH</sub>	HIGH-Level Output Current <b>(Note 3)</b>	Push-Pull, 1x Drive, V <sub>OH</sub> = V <sub>DD</sub> - 0.2 = V <sub>DD2</sub> - 0.2 V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V <b>(Note 1)</b>	1.60	--	--	mA
		Push-Pull, 1x Drive, V <sub>OH</sub> = V <sub>DD</sub> - 0.2 = V <sub>DD2</sub> - 0.2 V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V <b>(Note 1)</b>	1.76	--	--	mA
		Push-Pull, 1x Drive, V <sub>OH</sub> = V <sub>DD</sub> - 0.2 = V <sub>DD2</sub> - 0.2 V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V <b>(Note 1)</b>	1.92	--	--	mA
		Push-Pull, 1x Drive, V <sub>OH</sub> = 2.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V <b>(Note 1)</b>	5.64	--	--	mA

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 6: EC at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Condition	Min	Typ	Max	Unit
$I_{OH}$	HIGH-Level Output Current <b>(Note 3)</b>	Push-Pull, 1x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.3 \text{ V}$ <b>(Note 1)</b>	8.56	--	--	mA
		Push-Pull, 1x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.6 \text{ V}$ <b>(Note 1)</b>	11.51	--	--	mA
		Push-Pull, 1x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 4.5 \text{ V}$ <b>(Note 1)</b>	20.46	--	--	mA
		Push-Pull, 1x Drive, $V_{OH} = 2.5 \text{ V}$ , $V_{DD} = V_{DD2} = 5.0 \text{ V}$ <b>(Note 1)</b>	25.12	--	--	mA
		Push-Pull, 1x Drive, $V_{OH} = 2.75 \text{ V}$ , $V_{DD} = V_{DD2} = 5.5 \text{ V}$ <b>(Note 1)</b>	29.34	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = V_{DD} - 0.2 = V_{DD2} - 0.2$ $V_{DD} = V_{DD2} = 2.3 \text{ V}$ <b>(Note 1)</b>	3.10	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = V_{DD} - 0.2 = V_{DD2} - 0.2$ $V_{DD} = V_{DD2} = 2.5 \text{ V}$ <b>(Note 1)</b>	3.40	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = V_{DD} - 0.2 = V_{DD2} - 0.2$ $V_{DD} = V_{DD2} = 2.7 \text{ V}$ <b>(Note 1)</b>	3.69	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.0 \text{ V}$ <b>(Note 1)</b>	10.89	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.3 \text{ V}$ <b>(Note 1)</b>	16.54	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.6 \text{ V}$ <b>(Note 1)</b>	22.28	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = 2.4 \text{ V}$ , $V_{DD} = V_{DD2} = 4.5 \text{ V}$ <b>(Note 1)</b>	39.61	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = 2.5 \text{ V}$ , $V_{DD} = V_{DD2} = 5.0 \text{ V}$ <b>(Note 1)</b>	48.49	--	--	mA
		Push-Pull, 2x Drive, $V_{OH} = 2.75 \text{ V}$ , $V_{DD} = V_{DD2} = 5.5 \text{ V}$ <b>(Note 1)</b>	56.39	--	--	mA
$I_{OL}$	LOW-Level Output Current <b>(Note 3)</b>	Push-Pull, 1x Drive, $V_{OL} = 0.15 \text{ V}$ , $V_{DD} = V_{DD2} = 2.3 \text{ V}$ <b>(Note 1)</b>	1.73	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.15 \text{ V}$ , $V_{DD} = V_{DD2} = 2.5 \text{ V}$ <b>(Note 1)</b>	1.87	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.15 \text{ V}$ , $V_{DD} = V_{DD2} = 2.7 \text{ V}$ <b>(Note 1)</b>	2.00	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.0 \text{ V}$ <b>(Note 1)</b>	5.45	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.3 \text{ V}$ <b>(Note 1)</b>	5.90	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.4 \text{ V}$ , $V_{DD} = V_{DD2} = 3.6 \text{ V}$ <b>(Note 1)</b>	6.29	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.4 \text{ V}$ , $V_{DD} = V_{DD2} = 4.5 \text{ V}$ <b>(Note 1)</b>	7.25	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.4 \text{ V}$ , $V_{DD} = V_{DD2} = 5.0 \text{ V}$ <b>(Note 1)</b>	7.67	--	--	mA
		Push-Pull, 1x Drive, $V_{OL} = 0.4 \text{ V}$ , $V_{DD} = V_{DD2} = 5.5 \text{ V}$ <b>(Note 1)</b>	8.01	--	--	mA

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 6: EC at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Condition	Min	Typ	Max	Unit
I <sub>OL</sub>	LOW-Level Output Current <b>(Note 3)</b>	Push-Pull, 2x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V <b>(Note 1)</b>	3.20	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V <b>(Note 1)</b>	3.44	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V <b>(Note 1)</b>	3.65	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V <b>(Note 1)</b>	10.01	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V <b>(Note 1)</b>	10.73	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V <b>(Note 1)</b>	11.36	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V <b>(Note 1)</b>	12.85	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V <b>(Note 1)</b>	13.52	--	--	mA
		Push-Pull, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V <b>(Note 1)</b>	14.05	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V <b>(Note 1)</b>	3.91	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V <b>(Note 1)</b>	4.19	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V <b>(Note 1)</b>	4.44	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V <b>(Note 1)</b>	12.18	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V <b>(Note 1)</b>	13.02	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V <b>(Note 1)</b>	13.75	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V <b>(Note 1)</b>	15.47	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V <b>(Note 1)</b>	16.19	--	--	mA
		NMOS OD, 1x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V <b>(Note 1)</b>	16.80	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.3 V <b>(Note 1)</b>	6.28	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.5 V <b>(Note 1)</b>	6.68	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.15 V, V <sub>DD</sub> = V <sub>DD2</sub> = 2.7 V <b>(Note 1)</b>	7.02	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V <b>(Note 1)</b>	20.14	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.3 V <b>(Note 1)</b>	21.23	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 3.6 V <b>(Note 1)</b>	22.12	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 4.5 V <b>(Note 1)</b>	24.84	--	--	mA

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 6: EC at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Condition	Min	Typ	Max	Unit
I <sub>OL</sub>	LOW-Level Output Current <b>(Note 3)</b>	NMOS OD, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 5.0 V <b>(Note 1)</b>	26.08	--	--	mA
		NMOS OD, 2x Drive, V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = V <sub>DD2</sub> = 5.5 V <b>(Note 1)</b>	26.72	--	--	mA
T <sub>SU</sub>	Startup Time	From V <sub>DD</sub> rising past PON <sub>THR</sub>	--	1.66	2.59	ms
T <sub>WR</sub>	NVM Page Write Time	V <sub>DD</sub> = 2.5 V to 5.5 V	--	--	20	ms
T <sub>ER</sub>	NVM Page Erase Time	V <sub>DD</sub> = 2.5 V to 5.5 V	--	--	20	ms
PON <sub>THR</sub>	Power-On Threshold	V <sub>DD</sub> Level Required to Start Up the Chip	1.60	1.85	2.07	V
POFF <sub>THR</sub>	Power-Off Threshold	V <sub>DD</sub> Level Required to Switch Off the Chip	0.97	1.23	1.46	V
R <sub>PULL</sub>	Pull-up or Pull-down Resistance	1 M for Pull-up: V <sub>IN</sub> = GND; for Pull-down: V <sub>IN</sub> = V <sub>DD</sub> <b>(Note 1)</b>	--	1	--	MΩ
		100 k for Pull-up: V <sub>IN</sub> = GND; for Pull-down: V <sub>IN</sub> = V <sub>DD</sub> <b>(Note 1)</b>	--	100	--	kΩ
		10 k For Pull-up: V <sub>IN</sub> = GND; for Pull-down: V <sub>IN</sub> = V <sub>DD</sub> <b>(Note 1)</b>	--	10	--	kΩ
C <sub>IN</sub>	Input Capacitance				4	pF
<b>Note 1</b> The GreenPAK's power rails are divided in two sides. IOs 0 to 6, SCL, SDA are powered from V <sub>DD</sub> (one side) and IOs 7 to 14 are powered from V <sub>DD2</sub> (another side).						
<b>Note 2</b> No hysteresis.						
<b>Note 3</b> DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.						

**Table 7: EC of the I<sup>2</sup>C Pins at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted**

Parameter	Description	Condition	Fast-Mode		Fast-Mode Plus		Unit
			Min	Max	Min	Max	
V <sub>IL</sub>	LOW-level Input Voltage		-0.5	0.3xV <sub>DD</sub>	-0.5	0.3xV <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level Input Voltage		0.7xV <sub>DD</sub>	5.5	0.7xV <sub>DD</sub>	5.5	V
V <sub>HYS</sub>	Hysteresis of Schmitt Trigger Inputs		0.05xV <sub>DD</sub>	--	0.05xV <sub>DD</sub>	--	V
V <sub>OL1</sub>	LOW-Level Output Voltage 1	(Open-Drain) at 3mA sink current V <sub>DD</sub> > 2 V	0	0.4	0	0.4	V
V <sub>OL2</sub>	LOW-Level Output Voltage 2	(Open-Drain) at 2 mA sink current V <sub>DD</sub> ≤ 2 V	0	0.2xV <sub>DD</sub>	0	0.2xV <sub>DD</sub>	V
I <sub>OL</sub>	LOW-Level Output Current <b>(Note 1)</b>	V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = 2.3 V	3	--	16.75	--	mA
		V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = 3.0 V	3	--	20	--	mA
		V <sub>OL</sub> = 0.4 V, V <sub>DD</sub> = 4.5 V	3	--	20	--	mA
		V <sub>OL</sub> = 0.6 V	6	--	--	--	mA
t <sub>of</sub>	Output Fall Time from V <sub>IHmin</sub> to V <sub>ILmax</sub> <b>(Note 1)</b>		14x (V <sub>DD</sub> /5.5V)	250	10x (V <sub>DD</sub> /5.5V)	120	ns

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 7: EC of the I<sup>2</sup>C Pins at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Condition	Fast-Mode		Fast-Mode Plus		Unit
			Min	Max	Min	Max	
t <sub>SP</sub>	Pulse Width of Spikes that must be suppressed by the Input Filter		0	50	0	50	ns
I <sub>i</sub>	Input Current each IO Pin	0.1V <sub>DD</sub> < V <sub>i</sub> < 0.9V <sub>DDmax</sub>	-10	+10	-10	+10	µA
C <sub>i</sub>	Capacitance for each IO Pin		--	10	--	10	pF

**Note 1** Does not meet standard I<sup>2</sup>C specifications: t<sub>of</sub> = 20x(V<sub>DD</sub>/5.5 V) (min); For Fast-mode Plus I<sub>OL</sub> = 20 mA (min) at V<sub>OL</sub> = 0.4 V.

**Note 2** For Fast-mode Plus SDA pin must be configured as NMOS 2x Open-Drain, see register [769] in section 17.

**Table 8: I<sup>2</sup>C Pins Timing Characteristics at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted**

Parameter	Description	Condition	Fast-Mode		Fast-Mode Plus		Unit
			Min	Max	Min	Max	
F <sub>SCL</sub>	Clock Frequency, SCL		--	400	--	1000	kHz
t <sub>LOW</sub>	Clock Pulse Width Low		1300	--	500	--	ns
t <sub>HIGH</sub>	Clock Pulse Width High		600	--	260	--	ns
t <sub>I</sub>	Input Filter Spike Suppression (SCL, SDA) <b>(Note 2)</b>	V <sub>DD</sub> = 2.5 V ± 8 %	--	95	--	168	ns
		V <sub>DD</sub> = 3.3 V ± 10 %	--	95	--	157	
		V <sub>DD</sub> = 5.0 V ± 10 %	--	111	--	156	
t <sub>AA</sub>	Clock Low to Data Out Valid		--	900	--	450	ns
t <sub>BUF</sub>	Bus Free Time between Stop and Start		1300	--	500	--	ns
t <sub>HD_STA</sub>	Start Hold Time		600	--	260	--	ns
t <sub>SU_STA</sub>	Start Set-up Time		600	--	260	--	ns
t <sub>HD_DAT</sub>	Data Hold Time		0	--	0	--	ns
t <sub>SU_DAT</sub>	Data Set-up Time		100	--	50	--	ns
t <sub>R</sub>	Inputs Rise Time		--	300	--	120	ns
t <sub>F</sub>	Inputs Fall Time		--	300	--	120	ns
t <sub>SU_STO</sub>	Stop Set-up Time		600	--	260	--	ns
t <sub>DH</sub>	Data Out Hold Time		50	--	50	--	ns

**Note 1** Timing diagram can be found in the [Figure 81](#).

**Note 2** Does not meet standard I<sup>2</sup>C specifications: 50 ns.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 9: Typical Current Estimated for Each Macrocell at T = -40 °C to +85 °C**

Parameter	Description	Note	V <sub>DD</sub> = 2.5 V	V <sub>DD</sub> = 3.3 V	V <sub>DD</sub> = 5.0 V	Unit
		Chip Quiescent	0.39	0.43	0.53	µA
		Vref OUT (Source none, Buffer On)	6.53	6.61	7.02	µA
		Vref OUT (Source none, Buffer Off)	1.40	1.44	1.54	µA
		Vref (ACMPxL, 0.32 mV, Buffer On)	6.93	7.01	7.43	µA
I	Current	ACMP0L, 1L, hysteresis disabled, gain = 1, +IN - IO11, 12 Pull-up 1M, Vref = 32 mV	2.54	2.59	2.74	µA
		ACMP0L, 1L, hysteresis disabled, gain = 1, +IN - IO11, 12 Pull-down 1M, Vref = 32 mV	1.92	1.96	2.09	µA
		ACMP0L, hysteresis disabled, gain = 1, +IN - IO12 Pull-up 1M, Vref = 32 mV	1.98	2.02	2.15	µA
		ACMP0L, hysteresis disabled, gain = 0.25, +IN - IO12 Pull-up 1M, Vref = 32 mV	2.53	2.82	3.60	µA
		ACMP0L, hysteresis disabled, gain = 1 or gain = 0.25, +IN - IO12 Pull-down 1M, Vref = 32 mV	1.66	1.70	1.82	µA
		OSC2 25 MHz, pre-divider = 1	48.79	60.45	87.16	µA
		OSC2 25 MHz, pre-divider = 4	33.19	39.57	54.85	µA
		OSC2 25 MHz, pre-divider = 8	30.30	35.70	48.87	µA
		OSC1 2.048 MHz, pre-divider = 1	23.37	25.98	32.00	µA
		OSC1 2.048 MHz, pre-divider = 4	19.13	20.11	22.32	µA
		OSC1 2.048 MHz, pre-divider = 8	18.40	19.10	20.64	µA
		OSC0 2.048 kHz, Force	0.65	0.70	0.83	µA

### 3.5 TIMING CHARACTERISTICS

**Table 10: Typical Delay Estimated for Each Macrocell at T = 25 °C**

Parameter	Description	Note	V <sub>DD</sub> = 2.5 V		V <sub>DD</sub> = 3.3 V		V <sub>DD</sub> = 5 V		Unit
			Rising	Falling	Rising	Falling	Rising	Falling	
tpd	Delay	Multi-Function DFF Q	23	21	16	15	11	11	ns
tpd	Delay	Multi-Function DFF nQ	23	21	17	15	12	11	ns
tpd	Delay	Multi-Function DFF nRESET Q	--	29	--	21	--	15	ns
tpd	Delay	Multi-Function DFF nRESET nQ	31	--	22	--	16	--	ns
tpd	Delay	Multi-Function DFF nSET Q	31	--	22	--	16	--	ns
tpd	Delay	Multi-Function DFF nSET nQ	--	29	--	21	--	15	ns
tpd	Delay	DFF Q	17	17	12	12	8	8	ns
tpd	Delay	DFF nQ	18	16	13	11	9	8	ns
tpd	Delay	DFF nRESET Q	--	21	--	15	--	11	ns
tpd	Delay	DFF nRESET nQ	23	--	16	--	11	--	ns
tpd	Delay	DFF nSET Q	22	--	16	--	11	--	ns

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 10: Typical Delay Estimated for Each Macrocell at T = 25 °C(Continued)**

Parameter	Description	Note	$V_{DD} = 2.5\text{ V}$		$V_{DD} = 3.3\text{ V}$		$V_{DD} = 5\text{ V}$		Unit
			Rising	Falling	Rising	Falling	Rising	Falling	
tpd	Delay	DFF nSET nQ	--	22	--	15	--	11	ns
tpd	Delay	DFF3 First Q	18	17	12	12	9	9	ns
tpd	Delay	DFF3 First nQ	19	17	13	12	9	8	ns
tpd	Delay	DFF3 First nRESET Q	--	22	--	16	--	11	ns
tpd	Delay	DFF3 First nRESET nQ	23	--	17	--	12	--	ns
tpd	Delay	DFF3 First nSET Q	23	--	16	--	12	--	ns
tpd	Delay	DFF3 First nSET nQ	--	22	--	16	--	11	ns
tpd	Delay	DFF3 Second Q	21	20	15	15	10	10	ns
tpd	Delay	DFF3 Second nQ	22	20	15	14	11	10	ns
tpd	Delay	DFF3 Second nRESET Q	--	22	--	16	--	11	ns
tpd	Delay	DFF3 Second nRESET nQ	23	--	16	--	12	--	ns
tpd	Delay	DFF3 Second nSET Q	23	--	16	--	11	--	ns
tpd	Delay	DFF3 Second nSET nQ	--	22	--	16	--	11	ns
tpd	Delay	Multi-Function LATCH Q	22	24	15	18	11	13	ns
tpd	Delay	Multi-Function LATCH nQ	27	20	19	14	14	10	ns
tpd	Delay	Multi-Function LATCH nRESET Q	27	30	19	22	14	16	ns
tpd	Delay	Multi-Function LATCH nRESET nQ	32	26	23	18	16	13	ns
tpd	Delay	Multi-Function LATCH nSET Q	30	23	21	17	15	12	ns
tpd	Delay	Multi-Function LATCH nSET nQ	25	28	18	20	13	15	ns
tpd	Delay	LATCH Q	16	19	11	13	8	9	ns
tpd	Delay	LATCH nQ	20	15	14	11	10	8	ns
tpd	Delay	LATCH nRESET Q	20	22	14	16	10	11	ns
tpd	Delay	LATCH nRESET nQ	24	20	17	14	12	10	ns
tpd	Delay	LATCH nSET Q	21	17	15	12	11	8	ns
tpd	Delay	LATCH nSET nQ	18	20	13	15	9	10	ns
tpd	Delay	LATCH3 First Q	17	19	12	14	8	10	ns
tpd	Delay	LATCH3 First nQ	21	16	15	11	10	8	ns
tpd	Delay	LATCH3 First nRESET Q	21	23	15	17	11	12	ns
tpd	Delay	LATCH3 First nRESET nQ	24	21	17	15	12	10	ns
tpd	Delay	LATCH3 First nSET Q	22	18	15	13	11	9	ns
tpd	Delay	LATCH3 First nSET nQ	19	21	14	15	10	11	ns
tpd	Delay	LATCH3 Second Q	18	18	13	13	9	9	ns
tpd	Delay	LATCH3 Second nQ	19	17	14	12	9	9	ns
tpd	Delay	LATCH3 Second nRESET Q	--	23	--	16	--	12	ns
tpd	Delay	LATCH3 Second nRESET nQ	24	--	17	--	12	--	ns
tpd	Delay	LATCH3 Second nSET Q	22	--	15	--	11	--	ns
tpd	Delay	LATCH3 Second nSET nQ	--	21	--	15	--	11	ns
tpd	Delay	Multi-Function 3-bit LUT	22	24	16	18	11	13	ns

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 10: Typical Delay Estimated for Each Macrocell at T = 25 °C(Continued)

Parameter	Description	Note	$V_{DD} = 2.5\text{ V}$		$V_{DD} = 3.3\text{ V}$		$V_{DD} = 5\text{ V}$		Unit
			Rising	Falling	Rising	Falling	Rising	Falling	
tpd	Delay	Multi-Function 3-bit LUT, CNT Delay	50	52	36	38	25	27	ns
tpd	Delay	Multi-Function 4-bit LUT	22	25	16	18	11	13	ns
tpd	Delay	Multi-Function 4-bit LUT, CNT Delay	52	50	37	36	25	26	ns
tpd	Delay	2-bit LUT	17	16	12	12	8	8	ns
tpd	Delay	3-bit LUT	17	17	12	12	8	9	ns
tpd	Delay	Digital input to Low Voltage to PP 1x	35	222	24	150	16	96	ns
tpd	Delay	Digital input to with Schmitt Trigger to PP 1x	26	30	19	22	13	16	ns
tpd	Delay	Digital input to PP 1x	27	31	19	22	13	16	ns
tpd	Delay	Digital input to PP 2x	24	29	18	21	12	15	ns
tpd	Delay	Digital input to NMOS 1x	--	27	--	20	--	14	ns
tpd	Delay	Digital input to NMOS 2x	--	26	--	19	--	14	ns
tpd	Delay	Digital input to 1x3-State (Z to 0)	--	24	--	17	--	12	ns
tpd	Delay	Digital input to 2x3-State (Z to 0)	--	23	--	17	--	12	ns
tpd	Delay	Digital input to 1x3-State (Z to 1)	27	--	19	--	14	--	ns
tpd	Delay	Digital input to 2x3-State (Z to 1)	26	--	19	--	13	--	ns
tpd	Delay	Digital input to 1xOE (Z to 0)	--	24	--	17	--	12	ns
tpd	Delay	Digital input to 1xOE (Z to 1)	27	--	19	--	14	--	ns
tpd	Delay	Ripple CNT CLK UP Q0	18	15	13	11	9	8	ns
tpd	Delay	Ripple CNT CLK UP Q0	23	22	17	16	12	12	ns
tpd	Delay	Ripple CNT CLK UP Q1	28	21	20	16	14	12	ns
tpd	Delay	Ripple CNT CLK DOWN Q0	18	15	13	11	9	8	ns
tpd	Delay	Ripple CNT CLK DOWN Q0	27	21	19	15	14	11	ns
tpd	Delay	Ripple CNT CLK DOWN Q1	26	27	19	20	13	14	ns
tpd	Delay	Ripple CNT nSET UP Q0	26	35	19	25	14	18	ns
tpd	Delay	Ripple CNT nSET UP Q0	25	39	18	28	13	20	ns
tpd	Delay	Ripple CNT nSET UP Q1	24	44	17	32	12	23	ns
tpd	Delay	Ripple CNT nSET DOWN Q0	26	34	19	25	14	18	ns
tpd	Delay	Ripple CNT nSET DOWN Q0	25	41	18	30	13	22	ns
tpd	Delay	Ripple CNT nSET DOWN Q1	24	40	17	29	12	21	ns
tpd	Delay	Edge detect	21	20	15	14	11	10	ns
tw	Width	Edge detect	205	206	153	153	113	113	ns
tpd	Delay	Edge detect Delayed	227	229	168	169	123	124	ns
tpd	Delay	Filter nQ	141	154	99	106	67	67	ns
tpd	Delay	Filter Q	158	137	108	97	68	65	ns
tpd	Delay	PGen CLK	16	15	11	11	8	8	ns
tpd	Delay	PGen nRESET (Z to 0)	--	20	--	14	--	10	ns

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 10: Typical Delay Estimated for Each Macrocell at T = 25 °C(Continued)**

Parameter	Description	Note	V <sub>DD</sub> = 2.5 V		V <sub>DD</sub> = 3.3 V		V <sub>DD</sub> = 5 V		Unit
			Rising	Falling	Rising	Falling	Rising	Falling	
tpd	Delay	PGen nRESET (Z to 1)	18	--	12	--	8	--	ns
tpd	Delay	Pipe Delay nRESET Out	30	26	22	19	16	14	ns
tpd	Delay	Pipe Delay Out	22	19	16	13	11	10	ns

**Table 11: Programmable Delay Expected Delays and Widths (Typical) at T = 25 °C**

Parameter	Description	Note	V <sub>DD</sub> = 2.5 V	V <sub>DD</sub> = 3.3 V	V <sub>DD</sub> = 5.0 V	Unit
tw	Pulse Width, 1 cell	mode: (any) edge detect, edge detect output	205	153	113	ns
tw	Pulse Width, 2 cell	mode: (any) edge detect, edge detect output	407	303	223	ns
tw	Pulse Width, 3 cell	mode: (any) edge detect, edge detect output	610	453	334	ns
tw	Pulse Width, 4 cell	mode: (any) edge detect, edge detect output	812	603	444	ns
time1	Delay, 1 cell	mode: (any) edge detect, edge detect output	20	14	10	ns
time1	Delay, 2 cell	mode: (any) edge detect, edge detect output	20	14	10	ns
time1	Delay, 3 cell	mode: (any) edge detect, edge detect output	20	14	10	ns
time1	Delay, 4 cell	mode: (any) edge detect, edge detect output	20	14	10	ns
time2	Delay, 1 cell	mode: both edge delay, edge detect output	226	168	123	ns
time2	Delay, 2 cell	mode: both edge delay, edge detect output	429	318	234	ns
time2	Delay, 3 cell	mode: both edge delay, edge detect output	632	468	344	ns
time2	Delay, 4 cell	mode: both edge delay, edge detect output	834	618	455	ns

**Table 12: Typical Filter Rejection Pulse Width at T = 25 °C**

Parameter	V <sub>DD</sub> = 2.5 V	V <sub>DD</sub> = 3.3 V	V <sub>DD</sub> = 5.0 V	Unit
Filtered Pulse Width	< 123	< 84	< 52	ns

**Table 13: Typical Counter/Delay Offset Measurements at T = 25 °C**

Parameter	OSC Freq	OSC Power	V <sub>DD</sub> = 2.5 V	V <sub>DD</sub> = 3.3 V	V <sub>DD</sub> = 5.0 V	Unit
Power-On time	25 MHz	auto	0.14	0.14	0.14	μs
Power-On time	2.048 MHz	auto	0.51	0.46	0.41	μs
Power-On time	2.048 kHz	auto	705	604	486	μs
frequency settling time	25 MHz	auto	4	4	8	μs
frequency settling time	2.048 MHz	auto	0.3	0.4	0.4	μs
frequency settling time	2.048 kHz	auto	660	570	480	μs
variable (CLK period)	25 MHz	forced	0-40	0-40	0-40	ns
variable (CLK period)	2.048 MHz	forced	0-0.5	0-0.5	0-0.5	μs
variable (CLK period)	2.048 kHz	forced	0-488	0-488	0-488	μs
tpd (non-delayed edge)	25 MHz/ 2.048 kHz	either	35	14	10	ns

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 3.6 OSC CHARACTERISTICS

#### 3.6.1 OSC Specifications

Table 14: Oscillators Frequency Limits,  $V_{DD} = 2.3\text{ V}$  to  $5.5\text{ V}$

OSC	Temperature Range					
	+25 °C			-40 °C to +85 °C		
	Minimum Value, kHz	Maximum Value, kHz	Error, %	Minimum Value, kHz	Maximum Value, kHz	Error, %
2.048 kHz OSC0	2.025	2.071	+1.13	1.900	2.093	+2.19
			-1.11			-7.21
2.048 MHz OSC1	2020.83	2073.33	+1.19	1991.05	2083.90	+1.75
			-1.33			-2.78
25 MHz OSC2	24585.51	25354.98	+1.42	23562.69	25606.32	+2.43
			-1.66			-5.75

#### 3.6.2 OSC Power-On Delay

Table 15: Oscillators Power-On Delay at  $T = 25\text{ °C}$ , OSC Power Mode: "Auto Power-On"

Power Supply Range ( $V_{DD}$ ), V	Oscillator2 25 MHz		Oscillator2 25 MHz Start with delay		Oscillator1 2.048 MHz		Oscillator0 2.048 kHz	
	Typical Value, ns	Maximum Value, ns	Typical Value, ns	Maximum Value, ns	Typical Value, ns	Maximum Value, ns	Typical Value, $\mu\text{s}$	Maximum Value, $\mu\text{s}$
2.30	43.41	48.00	142.46	153.00	530.99	549.00	746.66	1011.73
2.50	38.55	42.00	140.90	150.00	508.76	521.00	704.97	939.85
2.70	34.89	38.00	140.22	149.00	491.43	512.00	671.91	884.63
3.00	30.82	34.00	139.81	149.00	473.49	497.00	633.51	819.23
3.30	27.79	30.00	139.66	148.00	460.75	481.00	604.09	768.79
3.60	25.53	27.00	139.70	149.00	450.80	472.00	580.73	730.10
4.00	23.21	26.00	139.84	149.00	439.61	462.00	556.22	690.04
4.20	22.32	25.00	140.03	148.00	435.00	456.00	545.94	673.29
4.50	21.12	25.00	140.16	150.00	428.88	449.00	532.09	649.85
5.00	19.61	20.00	140.34	149.00	419.91	439.00	510.48	616.17
5.50	18.57	19.00	140.51	149.00	412.39	432.00	485.59	579.80

### 3.7 ACMP SPECIFICATIONS

Table 16: ACMP Specifications at  $T = -40\text{ °C}$  to  $+85\text{ °C}$ ,  $V_{DD} = 2.3\text{ V}$  to  $5.5\text{ V}$  Unless Otherwise Noted

Parameter	Description	Note	Condition	Min	Typ	Max	Unit
$V_{ACMP}$	ACMP0L, ACMP1L Input Voltage Range	Positive Input		0	--	$V_{DD}$	V
		Negative Input		0	--	$V_{DD}$	V
$V_{offset}$	ACMP0L, ACMP1L Input Offset Voltage	$V_{phys} = 0\text{ mV}$ , Gain = 1, $V_{ref} = 32\text{ mV}$ to $2016\text{ mV}$	$T = 25\text{ °C}$	-6.4	--	6.7	mV
				-7.3	--	7.2	mV
$t_{start}$	ACMP0L, ACMP1L Start Time	ACMP Power-On delay	$T = 25\text{ °C}$ BG Forced On	--	139.3	233.3	$\mu\text{s}$
				--	144.6	326.6	$\mu\text{s}$

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 16: ACMP Specifications at T = -40 °C to +85 °C, V<sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted(Continued)**

Parameter	Description	Note	Condition	Min	Typ	Max	Unit
V <sub>HYS</sub>	ACMP0L, ACMP1L Built-in Hysteresis	V <sub>HYS</sub> = 32 mV	T = 25 °C	27.23	--	43.27	mV
		V <sub>HYS</sub> = 64 mV	T = 25 °C	59.43	--	75.81	mV
		V <sub>HYS</sub> = 192 mV	T = 25 °C	187.14	--	206.30	mV
		V <sub>HYS</sub> = 32 mV		25.29	--	44.19	mV
		V <sub>HYS</sub> = 64 mV		56.49	--	77.18	mV
		V <sub>HYS</sub> = 192 mV		186.73	--	206.30	mV
R <sub>sin</sub>	Input Resistance	Gain = 1x		--	100.0	--	MΩ
		Gain = 0.25x, 0.33x, 0.5x		--	2.0	--	MΩ
PROP	Propagation Delay, Response Time for ACMP0L, ACMP1L	Gain = 1, Vref = 32 mV to 2016 mV, Overdrive = 10 mV	Low to High	--	42.93	114.55	μs
			High to Low	--	38.99	83.66	μs
		Gain = 1, Vref = 32 mV to 2016 mV, Overdrive = 100 mV	Low to High	--	21.13	51.24	μs
			High to Low	--	20.34	51.08	μs
G	Gain error (including threshold and internal Vref error)	G = 1		--	1	--	
		G = 0.5		0.496	--	0.504	
		G = 0.33		0.330	--	0.338	
		G = 0.25		0.246	--	0.255	
Vref	Vref Output error, Vref = 224 mV to 2016 mV, Buffer Enabled		T = 25 °C, Loading = 1 μA	-6.04	--	5.59	%
			Loading = 1 μA	-6.11	--	5.72	%
	Vref Output Capacitance Loading		Load Resistance = 1 MΩ	--	--	15	pF
			Load Resistance = 560 kΩ	--	--	27	pF
			Load Resistance = 100 kΩ	--	--	64	pF
			Load Resistance = 10 kΩ	--	--	120	pF
			Load Resistance = 2 kΩ	--	--	180	pF
			Load Resistance = 1 kΩ, Vref = 32 mV to 1024 mV	--	--	210	pF

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 4 User Programmability

The SLG46824 is a user programmable device with Multiple-Time-Programmable (MTP) memory elements that are able to configure the connection matrix and macrocells. A programming development kit allows the user the ability to create initial devices. Once the design is finalized, the programming code (.gpx file) is forwarded to Renesas Electronics Corporation to integrate into a production process.

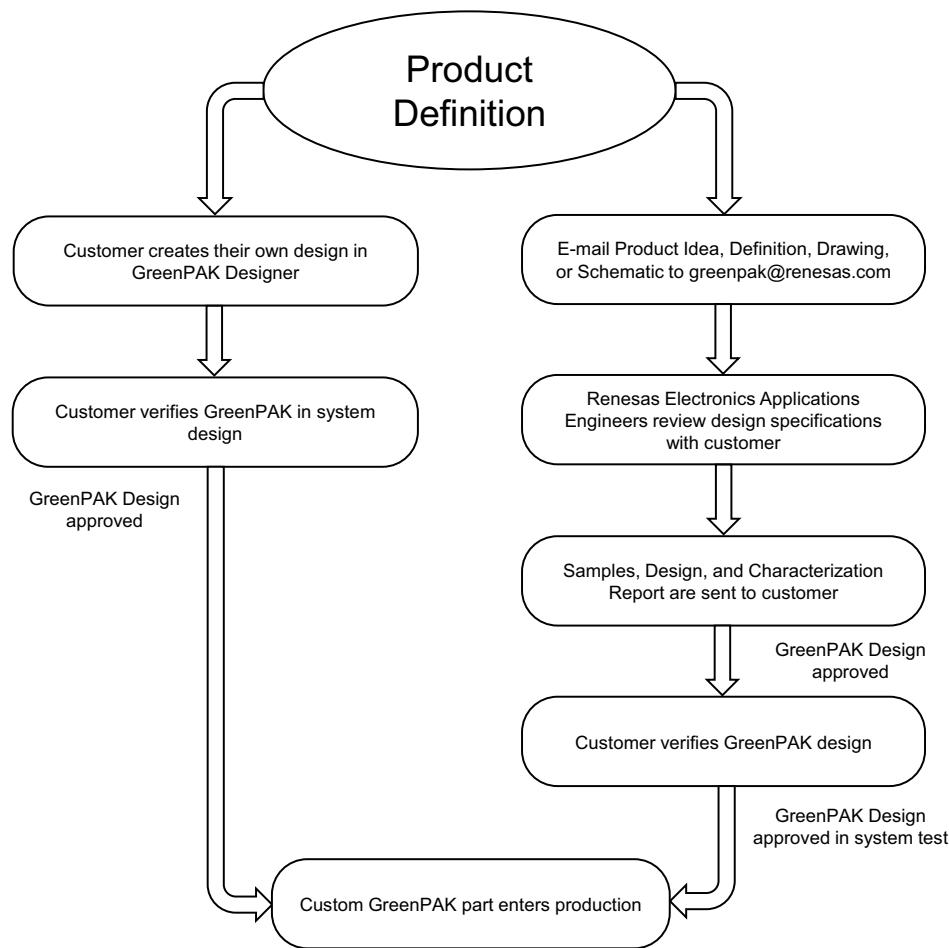


Figure 2: Steps to Create a Custom GreenPAK Device

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 5 IO Pins

#### 5.1 IO PINS

The SLG46824 has a total of 13 GPIO, 2 GPO, and 2 GPI Pins which can function as either a user defined Input or Output, as well as serving as a special function (such as outputting the voltage reference).

IOs 0 to 6, SCL, SDA are powered from  $V_{DD}$  and IOs 7 to 14 are powered from  $V_{DD2}$ . All internal macrocells are powered from  $V_{DD}$ . Voltage on  $V_{DD2}$  Pin must be less or equal voltage on  $V_{DD}$  Pin.

In case  $V_{DD2}$  floating and any Pin powered from  $V_{DD2}$  is configured as input, ESD pin protection diodes must be considered when applying an input signal to the pin. This will cause a significant current leakage.

In case  $V_{DD2}$  floating and any Pin powered from  $V_{DD2}$  is configured as Output, the pin will behave as NMOS Open-Drain.

It is not recommended to connect  $V_{DD2}$  to the GND.

#### 5.2 GPIO PINS

IO0, IO1, IO2, IO3, IO4, IO5, IO8, IO9, IO10, IO11, IO12, IO13, IO14 serve as General Purpose IO Pins.

#### 5.3 GPO PINS

IO6 and IO7 serve as General Purpose Output Pins.

#### 5.4 GPI PINS

SCL and SDA serve as General Purpose Input Pins.

#### 5.5 PULL-UP/DOWN RESISTORS

All IO Pins have the option of user-selectable resistors that can be connected to the pin structure. The selectable values on these resistors are 10 k $\Omega$ , 100 k $\Omega$ , and 1 M $\Omega$ . The internal resistors can be configured as either Pull-up or Pull-downs.

#### 5.6 FAST PULL-UP/DOWN DURING POWER-UP

During power-up, IO Pull-up/down resistance will switch to 2.6 k $\Omega$  initially and then it will switch to normal setting value. This function is enabled by register [768].

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 5.7 I<sup>2</sup>C MODE IO STRUCTURE (V<sub>DD</sub> OR V<sub>DD2</sub>)

#### 5.7.1 I<sup>2</sup>C Mode Structure (for SCL and SDA)

**Input Mode [1:0]**  
 00: Digital In without Schmitt Trigger, wosmt\_en = 1  
 01: Digital In with Schmitt Trigger, smt\_en = 1  
 10: Low Voltage Digital In mode 1, lv\_en = 1  
 11: Reserved

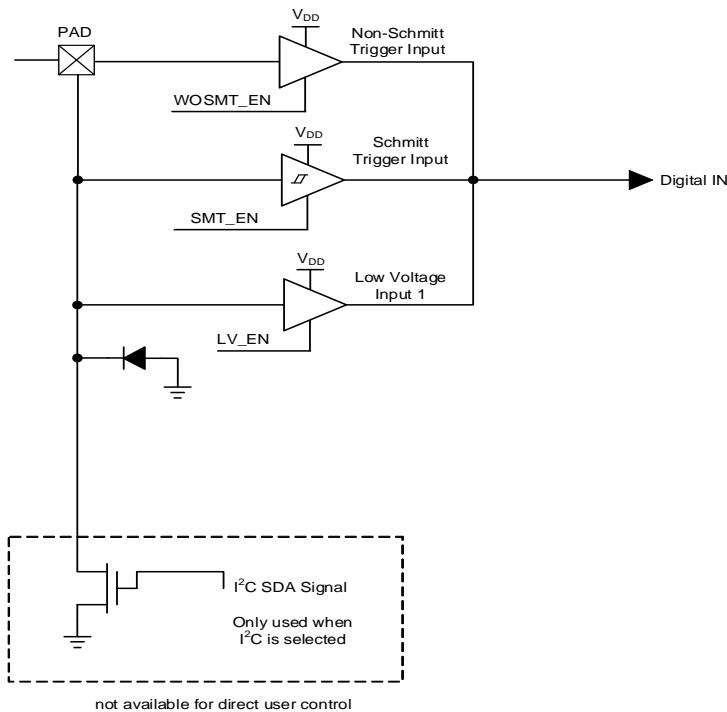


Figure 3: IO with I<sup>2</sup>C Mode IO Structure Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 5.8 MATRIX OE IO STRUCTURE ( $V_{DD}$ OR $V_{DD2}$ )

#### 5.8.1 Matrix OE IO Structure (for IOs 1, 4, 5 with $V_{DD}$ , and IOs 8, 9, 10, 11, 12, 13, 14 with $V_{DD2}$ )

**Input Mode [1:0]**  
 00: Digital In without Schmitt Trigger, wosmt\_en = 1  
 01: Digital In with Schmitt Trigger, smt\_en = 1  
 10: Low Voltage Digital In mode, lv\_en = 1  
 11: analog IO mode

**Output Mode [1:0]**  
 00: Push-Pull 1x mode, pp1x\_en = 1  
 01: Push-Pull 2x mode, pp2x\_en = 1, pp1x\_en = 1  
 10: NMOS 1x Open-Drain mode, od1x\_en = 1  
 11: NMOS 2x Open-Drain mode, od2x\_en = 1, od1x\_en = 1

Note 1: Digital Out and OE are Matrix Output, Digital In is Matrix Input  
 Note 2: Can be varied over PVT, for reference only.

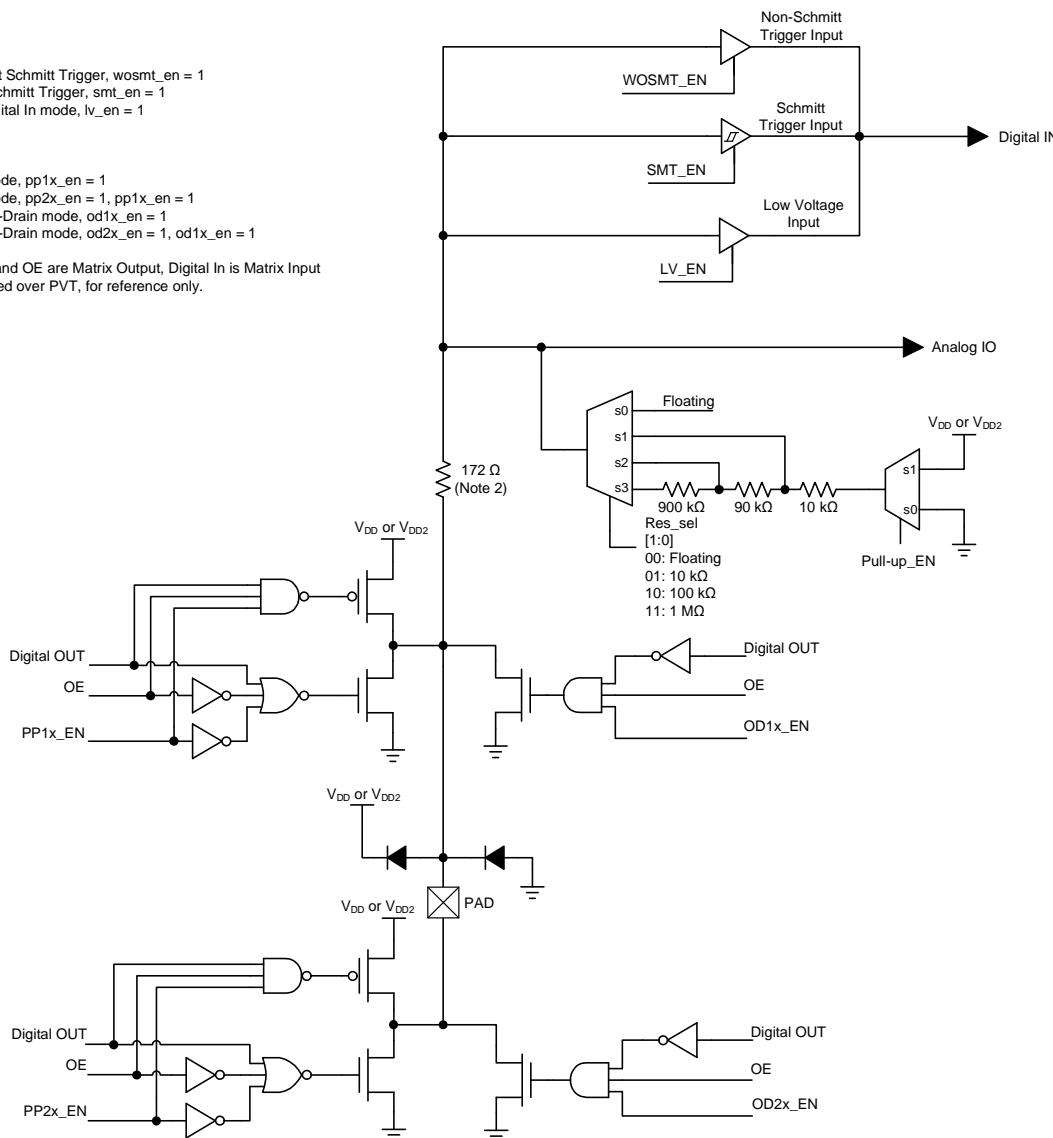


Figure 4: Matrix OE IO Structure Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 5.9 REGISTER OE IO STRUCTURE ( $V_{DD}$ OR $V_{DD2}$ )

#### 5.9.1 Register OE IO Structure (for IOs 0, 2, 3 with $V_{DD}$ )

**Input Mode [1:0]**  
 00: Digital In without Schmitt Trigger, wosmt\_en = 1, OE = 0  
 01: Digital In with Schmitt Trigger, smt\_en = 1, OE = 0  
 10: Low Voltage Digital In mode, lv\_en = 1, OE = 0  
 11: Reserved

**Output Mode [1:0]**  
 00: Push-Pull 1x mode, pp1x\_en = 1, OE = 1  
 01: Push-Pull 2x mode, pp2x\_en = 1, OE = 1  
 10: 1x Open-Drain mode, od1x\_en = 1, OE = 1  
 11: 2x Open-Drain mode, od2x\_en = 1, OE = 1

Note 1: OE cannot be selected by user and is controlled by register  
 Note 2: Can be varied over PVT, for reference only

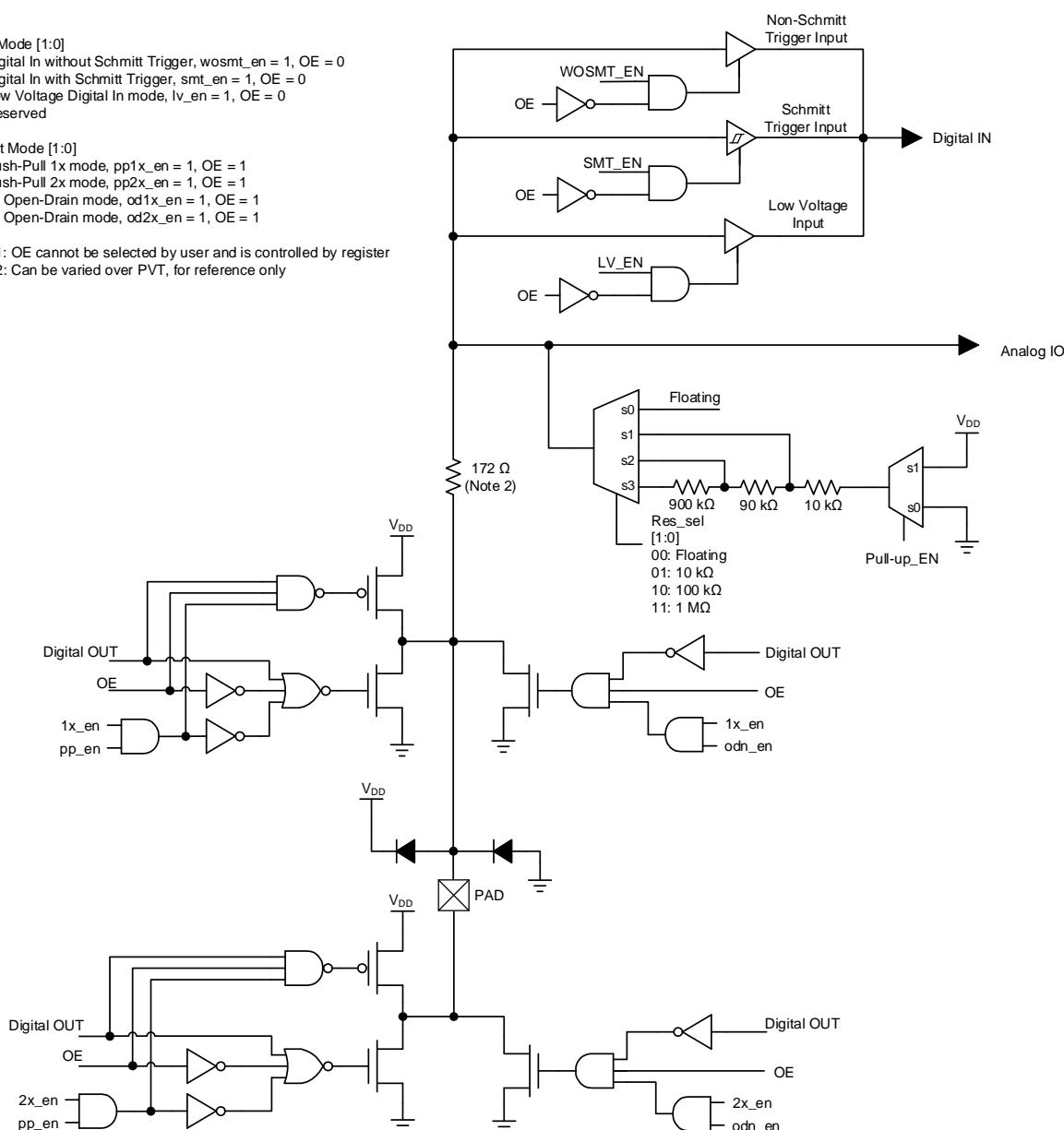


Figure 5: GPIO Register OE IO Structure Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 5.10 REGISTER OE IO STRUCTURE ( $V_{DD}$ OR $V_{DD2}$ )

#### 5.10.1 Register OE IO Structure (for IO 6 with $V_{DD}$ , and IO 7 with $V_{DD2}$ )

Mode [2:0]  
 000: Reserved  
 001: Reserved  
 010: Reserved  
 011: Reserved  
 100: Push-Pull mode, pp\_en = 1, OE = 1  
 101: NMOS Open-Drain mode, odr\_en = 1, OE = 1  
 110: PMOS Open-Drain mode, odp\_en = 1, OE = 1  
 111: analog IO and NMOS Open-Drain mode, odr\_en = 1 and aio\_en=1

Note: OE cannot be selected by user and is controlled by register

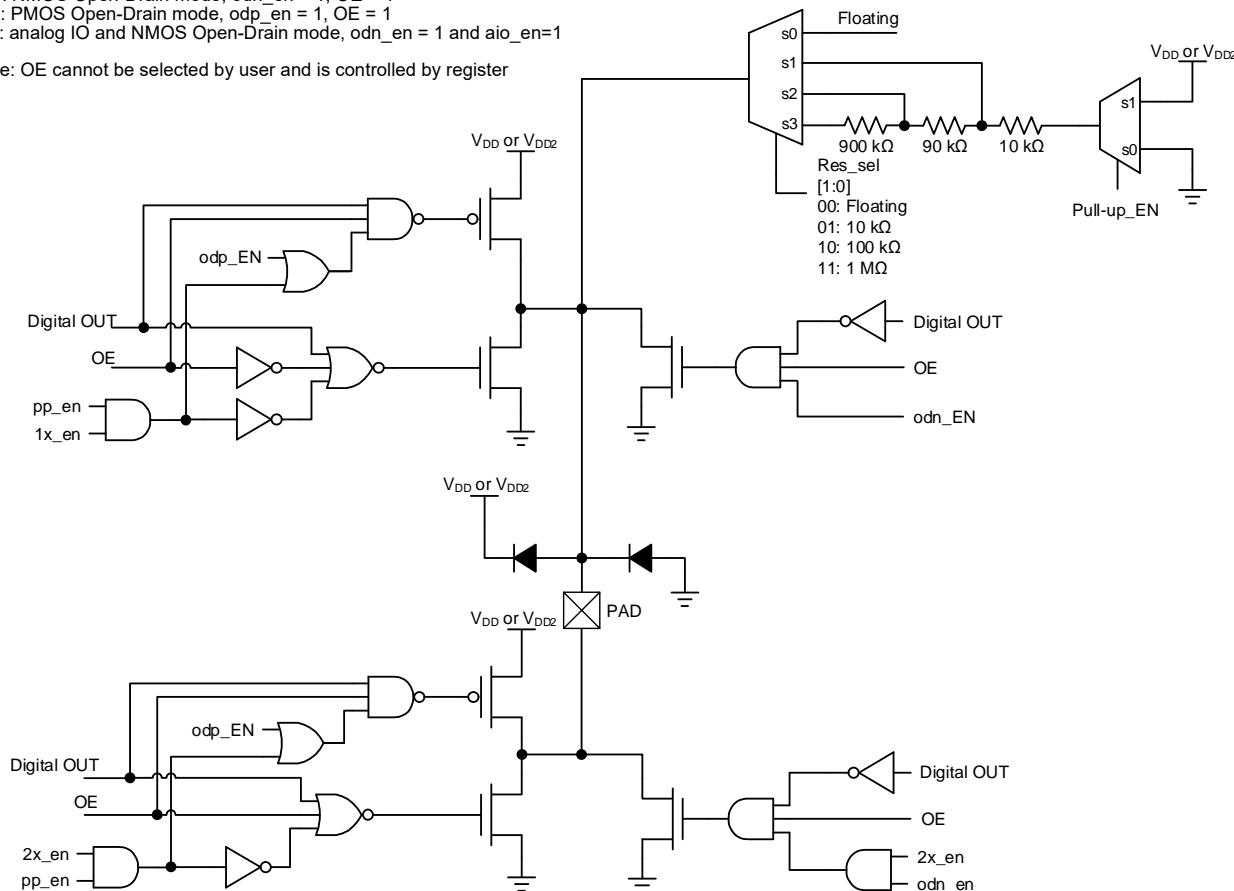


Figure 6: GPIO Register OE IO Structure Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 5.11 IO TYPICAL PERFORMANCE

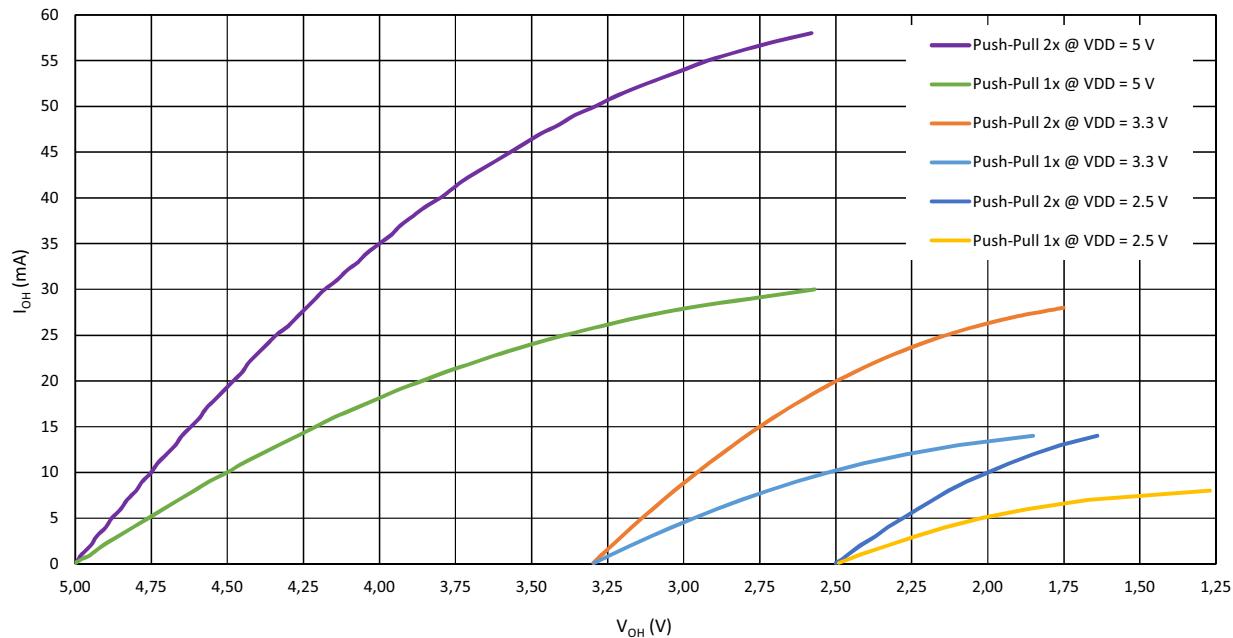


Figure 7: Typical High Level Output Current vs. High Level Output Voltage at  $T = 25^\circ\text{C}$

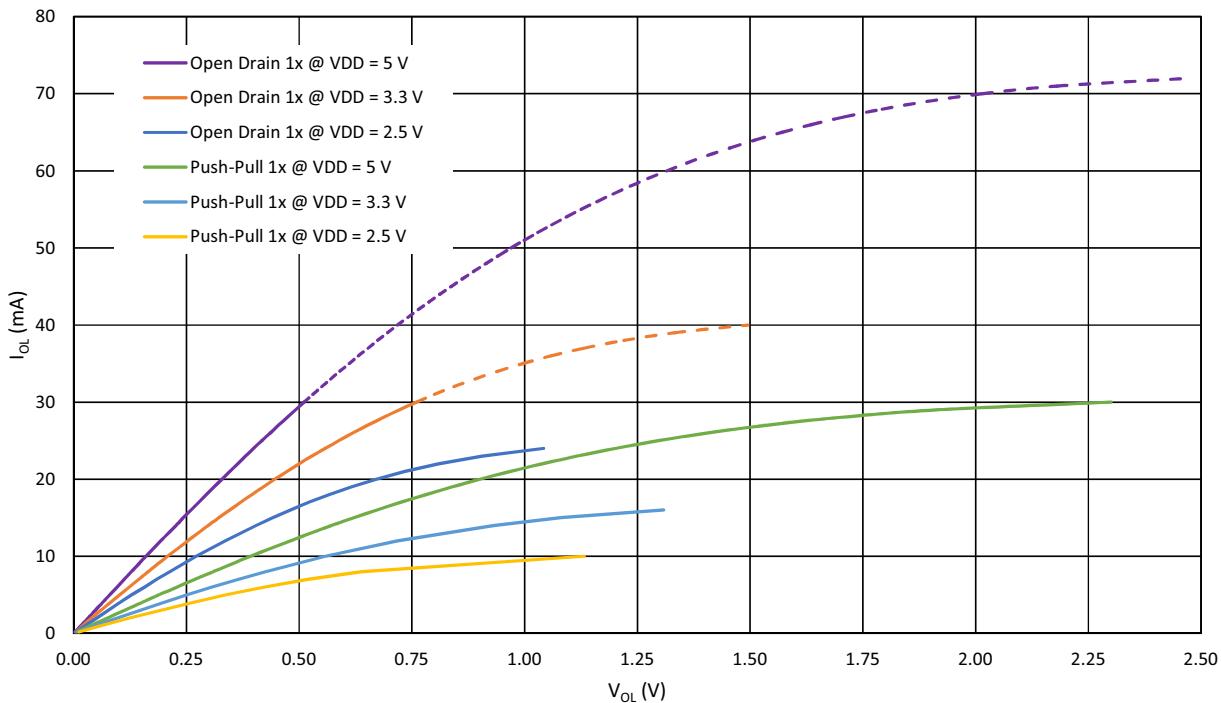


Figure 8: Typical Low Level Output Current vs. Low Level Output Voltage, 1x Drive at  $T = 25^\circ\text{C}$ , Full Range

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

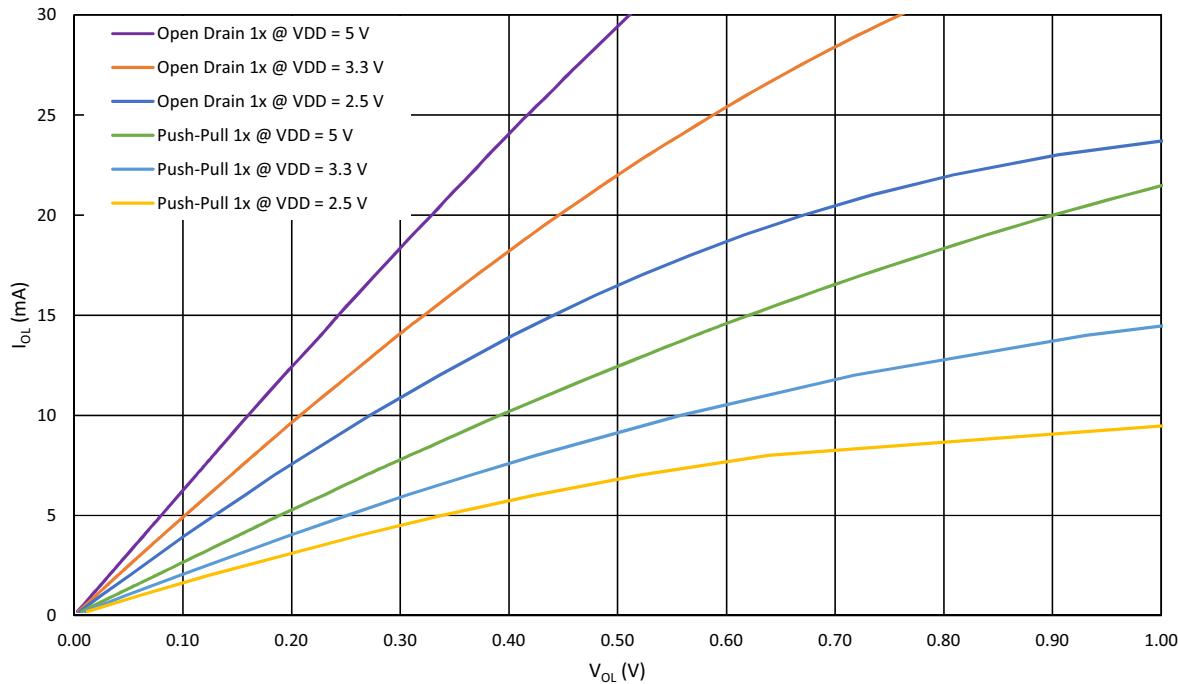


Figure 9: Typical Low Level Output Current vs. Low Level Output Voltage, 1x Drive at  $T = 25^\circ\text{C}$

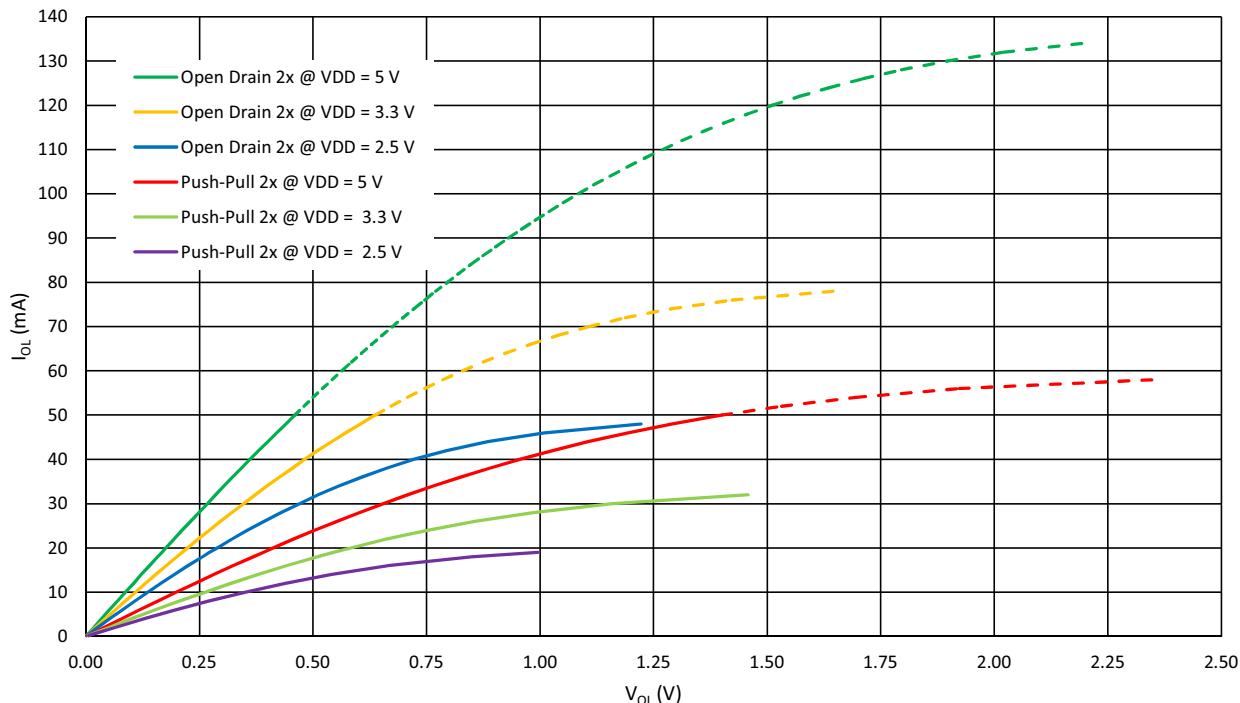


Figure 10: Typical Low Level Output Current vs. Low Level Output Voltage, 2x Drive at  $T = 25^\circ\text{C}$ , Full Range

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

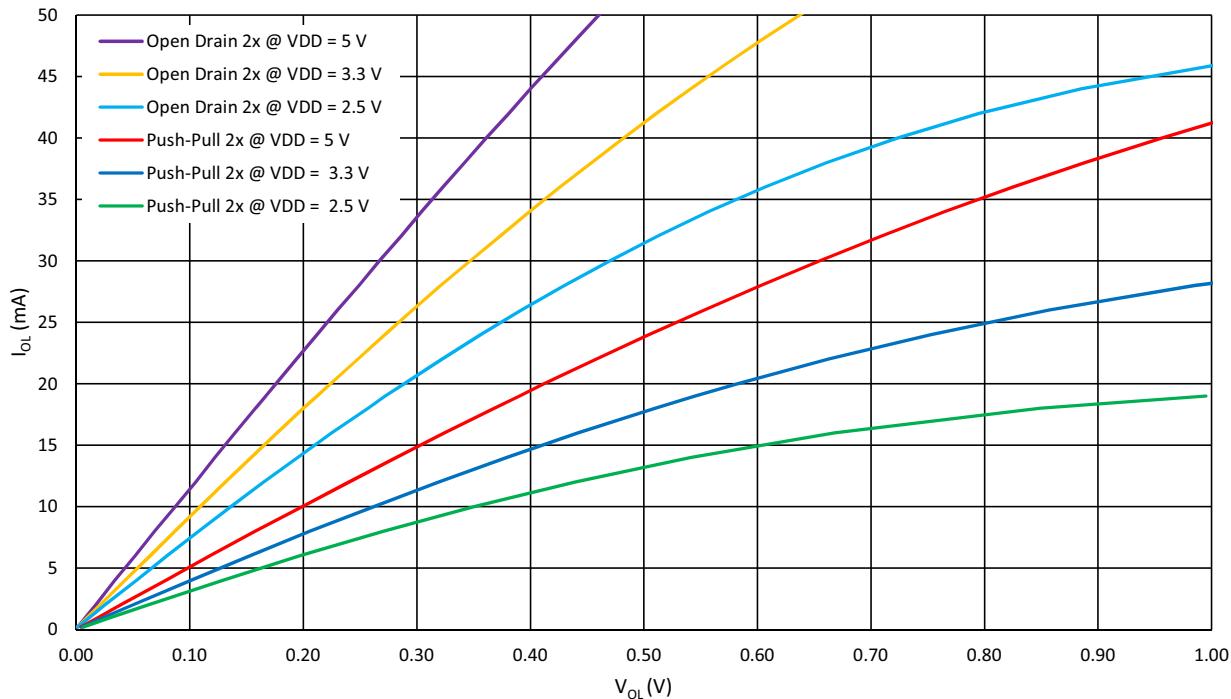


Figure 11: Typical Low Level Output Current vs. Low Level Output Voltage, 2x Drive at  $T = 25^\circ\text{C}$

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 6 Connection Matrix

The Connection Matrix in the SLG46824 is used to create the internal routing for internal functional macrocells of the device once it is programmed. The registers are programmed from the multiple-time NVM cell during Test Mode Operation. The output of each functional macrocell within the SLG46824 has a specific digital bit code assigned to it that is either set to active “High” or inactive “Low”, based on the design that is created. Once the 2048 register bits within the SLG46824 are programmed a fully custom circuit will be created.

The Connection Matrix has 64 inputs and 96 outputs. Each of the 64 inputs to the Connection Matrix is hard-wired to the digital output of a particular source macrocell, including IOs, LUTs, analog comparators, other digital resources, such as  $V_{DD}$  and GND. The input to a digital macrocell uses a 6-bit register to select one of these 64 input lines.

For a complete list of the SLG46824’s register table, see Section [17](#).

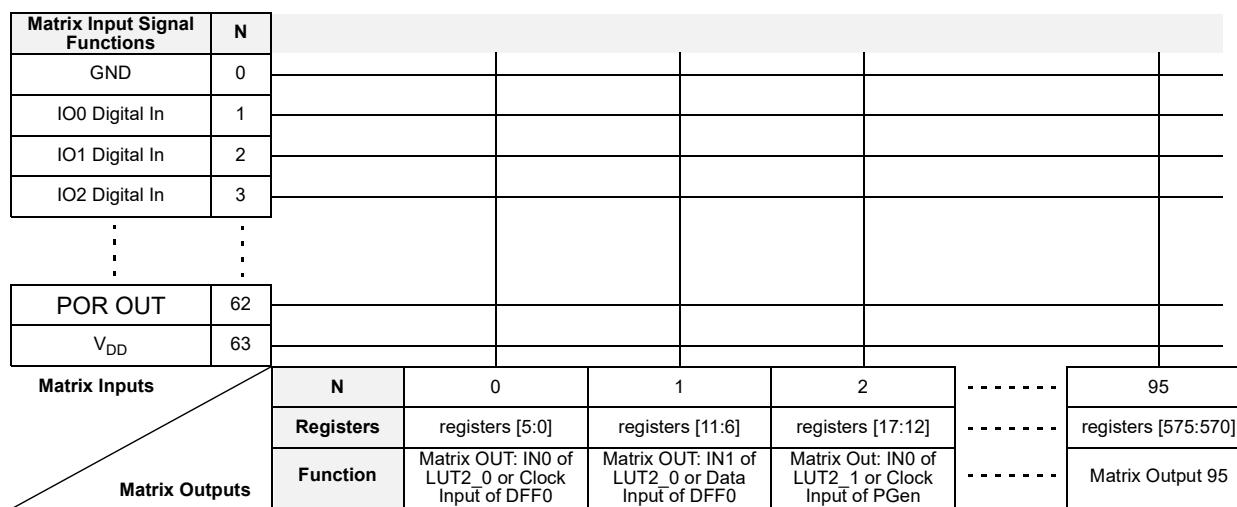


Figure 12: Connection Matrix

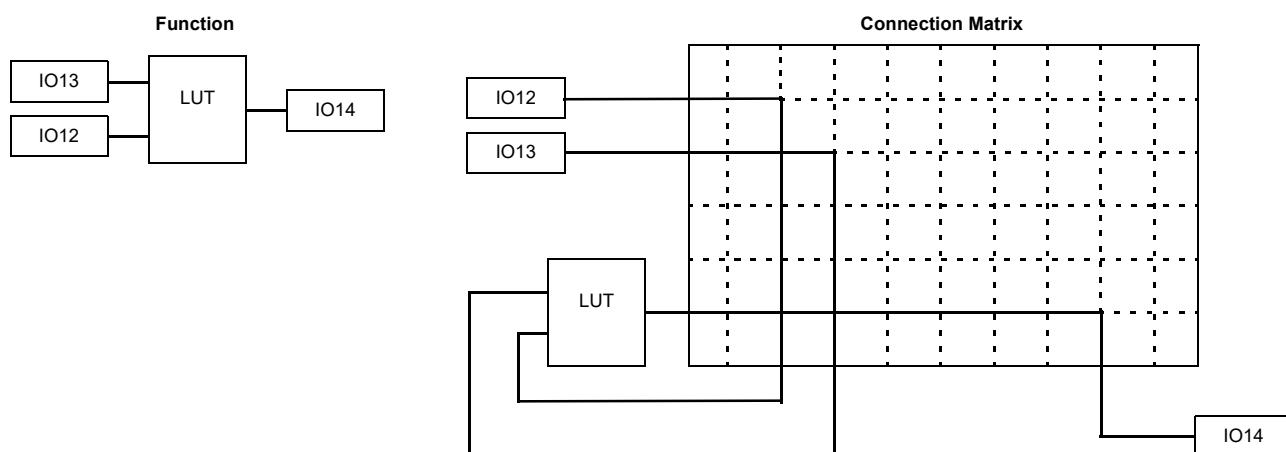


Figure 13: Connection Matrix Example

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 6.1 MATRIX INPUT TABLE

Table 17: Matrix Input Table

Matrix Input Number	Matrix Input Signal Function	Matrix Decode					
		5	4	3	2	1	0
0	GND	0	0	0	0	0	0
1	IO0 Digital Input	0	0	0	0	0	1
2	IO1 Digital Input	0	0	0	0	1	0
3	IO2 Digital Input	0	0	0	0	1	1
4	IO3 Digital Input	0	0	0	1	0	0
5	IO4 Digital Input	0	0	0	1	0	1
6	IO5 Digital Input	0	0	0	1	1	0
7	IO8 Digital Input	0	0	0	1	1	1
8	IO9 Digital Input	0	0	1	0	0	0
9	IO10 Digital Input	0	0	1	0	0	1
10	IO11 Digital Input	0	0	1	0	1	0
11	IO12 Digital Input	0	0	1	0	1	1
12	IO13 Digital Input	0	0	1	1	0	0
13	IO14 Digital Input	0	0	1	1	0	1
14	LUT2_0_DFF0_OUT	0	0	1	1	1	0
15	LUT2_1_DFF1_OUT	0	0	1	1	1	1
16	LUT2_2_DFF2_OUT	0	1	0	0	0	0
17	LUT2_3_PGEN_OUT	0	1	0	0	0	1
18	LUT3_0_DFF3_OUT	0	1	0	0	1	0
19	LUT3_1_DFF4_OUT	0	1	0	0	1	1
20	LUT3_2_DFF5_OUT	0	1	0	1	0	0
21	LUT3_3_DFF6_OUT	0	1	0	1	0	1
22	LUT3_4_DFF7_OUT	0	1	0	1	1	0
23	LUT3_5_DFF8_OUT	0	1	0	1	1	1
24	LUT3_6_PIPEPLY_RIPP_CNT_OUT0	0	1	1	0	0	0
25	PIPEPLY_RIPP_CNT_OUT1	0	1	1	0	0	1
26	RIPP_CNT_OUT2	0	1	1	0	1	0
27	EDET_FILTER_OUT	0	1	1	0	1	1
28	PROG_DLY_EDET_OUT	0	1	1	1	0	0
29	MULTFUNC_8BIT_1: DLY_CNT_OUT	0	1	1	1	0	1
30	CKOSC1_MATRIX: OSC1 matrix input	0	1	1	1	1	0
31	CKOSC0_MATRIX: OSC0 matrix input	0	1	1	1	1	1
32	CKOSC2_MATRIX: OSC2 matrix input	1	0	0	0	0	0
33	MULTFUNC_8BIT_2: DLY_CNT_OUT	1	0	0	0	0	1
34	MULTFUNC_8BIT_3: DLY_CNT_OUT	1	0	0	0	1	0
35	MULTFUNC_8BIT_4: DLY_CNT_OUT	1	0	0	0	1	1
36	MULTFUNC_8BIT_5: DLY_CNT_OUT	1	0	0	1	0	0
37	MULTFUNC_8BIT_6: DLY_CNT_OUT	1	0	0	1	0	1

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 17: Matrix Input Table(Continued)

Matrix Input Number	Matrix Input Signal Function	Matrix Decode					
		5	4	3	2	1	0
38	MULTFUNC_8BIT_7: DLY_CNT_OUT	1	0	0	1	1	0
39	MULTFUNC_16BIT_0: LUT_DFF_OUT	1	0	0	1	1	1
40	MULTFUNC_8BIT_1: LUT_DFF_OUT	1	0	1	0	0	0
41	MULTFUNC_8BIT_2: LUT_DFF_OUT	1	0	1	0	0	1
42	MULTFUNC_8BIT_3: LUT_DFF_OUT	1	0	1	0	1	0
43	MULTFUNC_8BIT_4: LUT_DFF_OUT	1	0	1	0	1	1
44	MULTFUNC_8BIT_5: LUT_DFF_OUT	1	0	1	1	0	0
45	MULTFUNC_8BIT_6: LUT_DFF_OUT	1	0	1	1	0	1
46	MULTFUNC_8BIT_7: LUT_DFF_OUT	1	0	1	1	1	0
47	MULTFUNC_16BIT_0: DLY_CNT_OUT	1	0	1	1	1	1
48	I <sup>2</sup> C_virtual_7 Input: register [976]	1	1	0	0	0	0
49	I <sup>2</sup> C_virtual_6 Input: register [977]	1	1	0	0	0	1
50	I <sup>2</sup> C_virtual_5 Input: register [978]	1	1	0	0	1	0
51	I <sup>2</sup> C_virtual_4 Input: register [979]	1	1	0	0	1	1
52	I <sup>2</sup> C_virtual_3 Input: register [980]	1	1	0	1	0	0
53	I <sup>2</sup> C_virtual_2 Input: register [981]	1	1	0	1	0	1
54	I <sup>2</sup> C_virtual_1 Input: register [982]	1	1	0	1	1	0
55	I <sup>2</sup> C_virtual_0 Input: register [983]	1	1	0	1	1	1
56	Reserved	1	1	1	0	0	0
57	Reserved	1	1	1	0	0	1
58	ACMP0L_OUT	1	1	1	0	1	0
59	ACMP1L_OUT	1	1	1	0	1	1
60	2nd CKOSC1_MATRIX	1	1	1	1	0	0
61	2nd CKOSC0_MATRIX	1	1	1	1	0	1
62	POR OUT	1	1	1	1	1	0
63	V <sub>DD</sub>	1	1	1	1	1	1

## 6.2 MATRIX OUTPUT TABLE

Table 18: Matrix Output Table

Register Bit Address	Matrix Output Signal Function	Matrix Output Number
5:0	IN0 of LUT2_0 or Clock Input of DFF0	0
11:6	IN1 of LUT2_0 or Data Input of DFF0	1
17:12	IN0 of LUT2_3 or Clock Input of PGen	2
23:18	IN1 of LUT2_3 or nRST of PGen	3
29:24	IN0 of LUT2_1 or Clock Input of DFF1	4
35:30	IN1 of LUT2_1 or Data Input of DFF1	5
41:36	IN0 of LUT2_2 or Clock Input of DFF2	6
47:42	IN1 of LUT2_2 or Data Input of DFF2	7
53:48	IN0 of LUT3_0 or Clock Input of DFF3	8

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 18: Matrix Output Table(Continued)

Register Bit Address	Matrix Output Signal Function	Matrix Output Number
59:54	IN1 of LUT3_0 or Data Input of DFF3	9
65:60	IN2 of LUT3_0 or nRST(nSET) of DFF3	10
71:66	IN0 of LUT3_1 or Clock Input of DFF4	11
77:72	IN1 of LUT3_1 or Data Input of DFF4	12
83:78	IN2 of LUT3_1 or nRST(nSET) of DFF4	13
89:84	IN0 of LUT3_2 or Clock Input of DFF5	14
95:90	IN1 of LUT3_2 or Data Input of DFF5	15
101:96	IN2 of LUT3_2 or nRST(nSET) of DFF5	16
107:102	IN0 of LUT3_3 or Clock Input of DFF6	17
113:108	IN1 of LUT3_3 or Data Input of DFF6	18
119:114	IN2 of LUT3_3 or nRST(nSET) of DFF6	19
125:120	IN0 of LUT3_4 or Clock Input of DFF7	20
131:126	IN1 of LUT3_4 or Data Input of DFF7	21
137:132	IN2 of LUT3_4 or nRST(nSET) of DFF7	22
143:138	IN0 of LUT3_5 or Clock Input of DFF8	23
149:144	IN1 of LUT3_5 or Data Input of DFF8	24
155:150	IN2 of LUT3_5 or nRST(nSET) of DFF8	25
161:156	IN0 of LUT3_6 or Input of Pipe Delay or UP Signal of RIPP CNT	26
167:162	IN1 of LUT3_6 or nRST of Pipe Delay or STB of RIPP CNT	27
173:168	IN2 of LUT3_6 or Clock of Pipe Delay_RIPP_CNT	28
179:174	Reserved	29
185:180	MULTFUNC_16BIT_0: IN0 of LUT4_0 or Clock Input of DFF9; Delay0 Input (or Counter0 nRST/SET Input)	30
191:186	MULTFUNC_16BIT_0: IN1 of LUT4_0 or nRST of DFF9; Delay0 Input (or Counter0 nRST Input) or Delay/Counter0 External Clock Source	31
197:192	MULTFUNC_16BIT_0: IN2 of LUT4_0 or nSET of DFF9; Delay0 Input (or Counter0 nRST Input) or Delay/Counter0 External Clock Source or KEEP Input of FSM0	32
203:198	MULTFUNC_16BIT_0: IN3 of LUT4_0 or Data Input of DFF9; Delay0 Input (or Counter0 nRST Input) or UP Input of FSM0	33
209:204	MULTFUNC_8BIT_1: IN0 of LUT3_7 or Clock Input of DFF10; Delay1 Input (or Counter1 nRST Input)	34
215:210	MULTFUNC_8BIT_1: IN1 of LUT3_7 or nRST (nSET) of DFF10; Delay1 Input (or Counter1 nRST Input) or Delay/Counter1 External Clock Source	35
221:216	MULTFUNC_8BIT_1: IN2 of LUT3_7 or Data Input of DFF10; Delay1 Input (or Counter1 nRST Input)	36
227:222	MULTFUNC_8BIT_2: IN0 of LUT3_8 or Clock Input of DFF11; Delay2 Input (or Counter2 nRST Input);	37
233:228	MULTFUNC_8BIT_2: IN1 of LUT3_8 or nRST (nSET) of DFF11; Delay2 Input (or Counter2 nRST Input) or Delay/Counter2 External Clock Source	38
239:234	MULTFUNC_8BIT_2: IN2 of LUT3_8 or Data Input of DFF11; Delay2 Input (or Counter2 nRST Input)	39

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 18: Matrix Output Table(Continued)

Register Bit Address	Matrix Output Signal Function	Matrix Output Number
245:240	MULTFUNC_8BIT_3: IN0 of LUT3_9 or Clock Input of DFF12; Delay3 Input (or Counter3 nRST Input)	40
251:246	MULTFUNC_8BIT_3: IN1 of LUT3_9 or nRST (nSET) of DFF12; Delay3 Input (or Counter3 nRST Input) or Delay/Counter3 External Clock Source	41
257:252	MULTFUNC_8BIT_3: IN2 of LUT3_9 or Data Input of DFF12; Delay3 Input (or Counter3 nRST Input)	42
263:258	MULTFUNC_8BIT_4: IN0 of LUT3_10 or Clock Input of DFF13; Delay4 Input (or Counter4 nRST Input)	43
269:264	MULTFUNC_8BIT_4: IN1 of LUT3_10 or nRST (nSET) of DFF13; Delay4 Input (or Counter4 nRST Input) or Delay/Counter4 External Clock Source	44
275:270	MULTFUNC_8BIT_4: IN2 of LUT3_10 or Data Input of DFF13; Delay4 Input (or Counter4 nRST Input)	45
281:276	MULTFUNC_8BIT_5: IN0 of LUT3_11 or Clock Input of DFF14; Delay5 Input (or Counter5 nRST Input)	46
287:282	MULTFUNC_8BIT_5: IN1 of LUT3_11 or nRST (nSET) of DFF14; Delay5 Input (or Counter5 nRST Input) or Delay/Counter5 External Clock Source	47
293:288	MULTFUNC_8BIT_5: IN2 of LUT3_11 or Data Input of DFF14; Delay5 Input (or Counter5 nRST Input)	48
299:294	MULTFUNC_8BIT_6: IN0 of LUT3_12 or Clock Input of DFF15; Delay6 Input (or Counter6 nRST Input)	49
305:300	MULTFUNC_8BIT_6: IN1 of LUT3_12 or nRST (nSET) of DFF15; Delay6 Input (or Counter6 nRST Input) or Delay/Counter6 External Clock Source	50
311:306	MULTFUNC_8BIT_6: IN2 of LUT3_12 or Data Input of DFF15; Delay6 Input (or Counter6 nRST Input)	51
317:312	MULTFUNC_8BIT_7: IN0 of LUT3_13 or Clock Input of DFF16; Delay7 Input (or Counter7 nRST Input)	52
323:318	MULTFUNC_8BIT_7: IN1 of LUT3_13 or nRST (nSET) of DFF16; Delay7 Input (or Counter7 nRST Input) or Delay/Counter7 External Clock Source	53
329:324	MULTFUNC_8BIT_7: IN2 of LUT3_13 or Data Input of DFF16; Delay7 Input (or Counter7 nRST Input)	54
335:330	Filter/Edge detect input	55
341:336	Programmable delay/edge detect input	56
347:342	OSC2 ENABLE from matrix	57
353:348	OSC0 ENABLE from matrix	58
359:354	OSC1 ENABLE matrix	59
365:360	Vref PD from matrix	60
371:366	BG power-down from matrix	61
377:372	Reserved	62
383:378	Reserved	63
389:384	PWR UP of ACMP0L from matrix	64
395:390	PWR UP of ACMP1L from matrix	65
401:396	Reserved	66
407:402	IO0 Digital Output	67
413:408	IO1 Digital Output	68

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 18: Matrix Output Table(Continued)**

<b>Register Bit Address</b>	<b>Matrix Output Signal Function</b>	<b>Matrix Output Number</b>
419:414	IO1 Digital Output OE	69
425:420	IO2 Digital Output	70
431:426	IO3 Digital Output	71
437:432	IO4 Digital Output	72
443:438	IO4 Digital Output OE	73
449:444	IO5 Digital Output	74
455:450	IO5 Digital Output OE	75
461:456	IO6 Digital Output	76
467:462	IO7 Digital Output	77
473:468	IO8 Digital Output	78
479:474	IO8 Digital Output OE	79
485:480	IO9 Digital Output	80
491:486	IO9 Digital Output OE	81
497:492	IO10 Digital Output	82
503:498	IO10 Digital Output OE	83
509:504	IO11 Digital Output	84
515:510	IO11 Digital Output OE	85
521:516	IO12 Digital Output	86
527:522	IO12 Digital Output OE	87
533:528	IO13 Digital Output	88
539:534	IO13 Digital Output OE	89
545:540	IO14 Digital Output	90
551:546	IO14 Digital Output OE	91
557:552	Reserved	92
563:558	Reserved	93
569:564	Matrix OUT 94	94
575:570	Matrix OUT 95	95

**Note 1** For each Address, the two most significant bits are unused.

### 6.3 CONNECTION MATRIX VIRTUAL INPUTS

As mentioned previously, the Connection Matrix inputs come from the outputs of various digital macrocells on the device. Eight of the Connection Matrix inputs have the special characteristic that the state of these signal lines comes from a corresponding data bit written as a register value via I<sup>2</sup>C. This gives the user the ability to write data via the serial channel, and have this information translated into signals that can be driven into the Connection Matrix and from the Connection Matrix to the digital inputs of other macrocells on the device. The I<sup>2</sup>C address for reading and writing these register values is at 0x7A (0122).

An I<sup>2</sup>C write command to these register bits will set the signal values going into the Connection Matrix to the desired state. A read command to these register bits will read either the original data values coming from the NVM memory bits (that were loaded during the initial device startup), or the values from a previous write command (if that has happened). See [Table 19](#).

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 19: Connection Matrix Virtual Inputs**

Matrix Input Number	Matrix Input Signal Function	Register Bit Addresses (d)
55	I <sup>2</sup> C_virtual_0 Input	[983]
54	I <sup>2</sup> C_virtual_1 Input	[982]
53	I <sup>2</sup> C_virtual_2 Input	[981]
52	I <sup>2</sup> C_virtual_3 Input	[980]
51	I <sup>2</sup> C_virtual_4 Input	[979]
50	I <sup>2</sup> C_virtual_5 Input	[978]
49	I <sup>2</sup> C_virtual_6 Input	[977]
48	I <sup>2</sup> C_virtual_7 Input	[976]

### 6.4 CONNECTION MATRIX VIRTUAL OUTPUTS

The digital outputs of the various macrocells are routed to the Connection Matrix to enable interconnections to the inputs of other macrocells in the device. At the same time, it is possible to read the state of each of the macrocell outputs as a register value via I<sup>2</sup>C. This option, called Connection Matrix Virtual Outputs, allows the user to remotely read the values of each macrocell output. The I<sup>2</sup>C addresses for reading these register values are 0x74 (0116) to 0x7B (0123). Write commands to these same register values will be ignored (with the exception of the Virtual Input register bits at 0x7A (0122)).

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 7 Combination Function Macrocells

The SLG46824 has 11 combination function macrocells that can serve more than one logic or timing function. In each case, they can serve as a Look Up Table (LUT), or as another logic or timing function. See the list below for the functions that can be implemented in these macrocells.

- Three macrocells that can serve as either 2-bit LUT or as D Flip-Flop
- Six macrocells that can serve as either 3-bit LUTs or as D Flip-Flops with Set/Reset Input
- One macrocell that can serve as either 3-bit LUT or as Pipe Delay/Ripple Counter
- One macrocell that can serve as either 2-bit LUT or as Programmable Pattern Generator (PGen)

Inputs/Outputs for the 11 combination function macrocells are configured from the connection matrix with specific logic functions being defined by the state of NVM bits.

When used as a LUT to implement combinatorial logic functions, the outputs of the LUTs can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR).

#### 7.1 2-BIT LUT OR D FLIP-FLOP MACROCELLS

There are three macrocells that can serve as either 2-bit LUT or as D Flip-Flop. When used to implement LUT functions, the 2-bit LUT takes in two input signals from the connection matrix and produce a single output, which goes back into the connection matrix. When used to implement D Flip-Flop function, the two input signals from the connection matrix go to the data (D) and clock (CLK) inputs for the Flip-Flop, with the output going back to the connection matrix.

The operation of the D Flip-Flop and LATCH will follow the functional descriptions below:

DFF: CLK is rising edge triggered, then Q = D; otherwise Q will not change

LATCH: when CLK is Low, then Q = D; otherwise Q remains its previous value (input D has no effect on the output, when CLK is High).

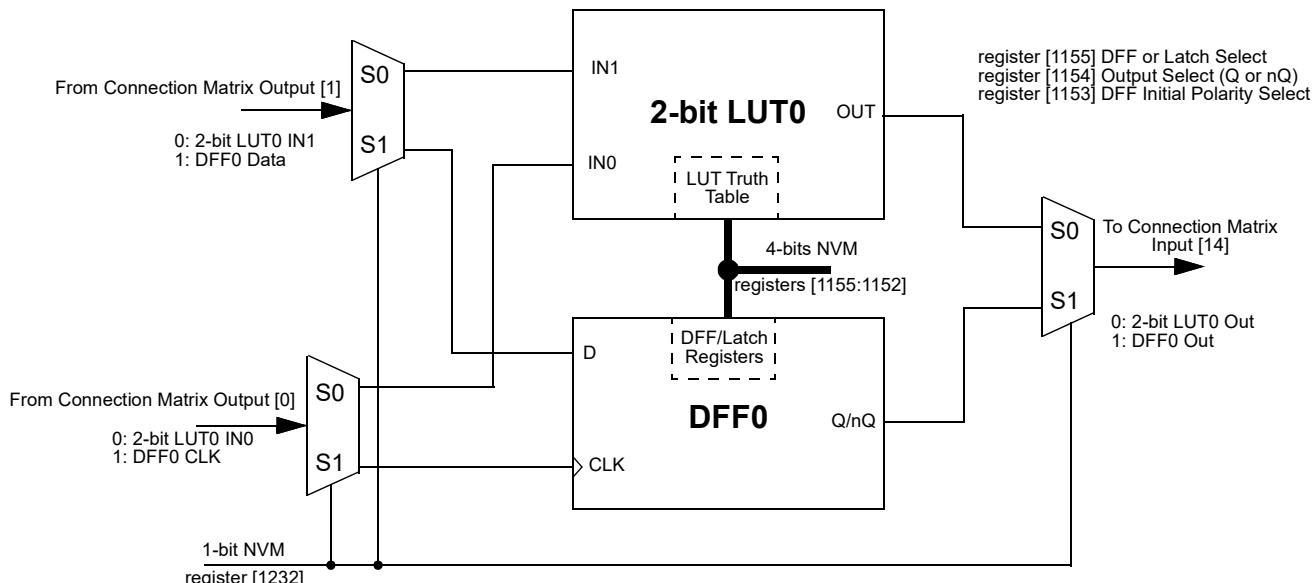


Figure 14: 2-bit LUT0 or DFF0

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

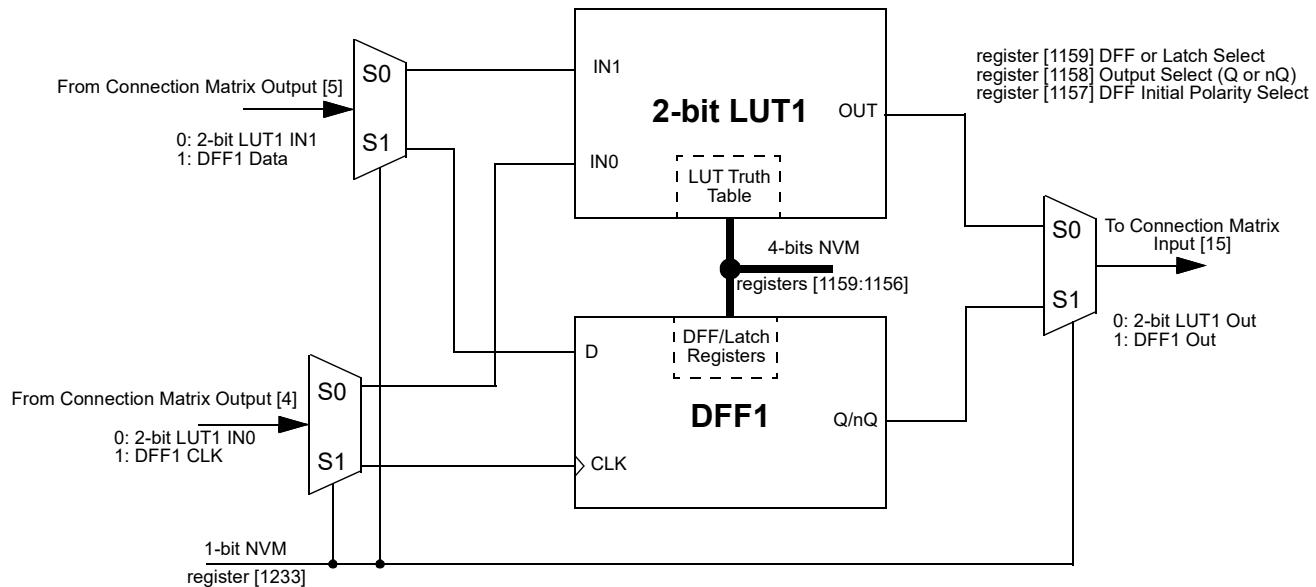


Figure 15: 2-bit LUT1 or DFF1

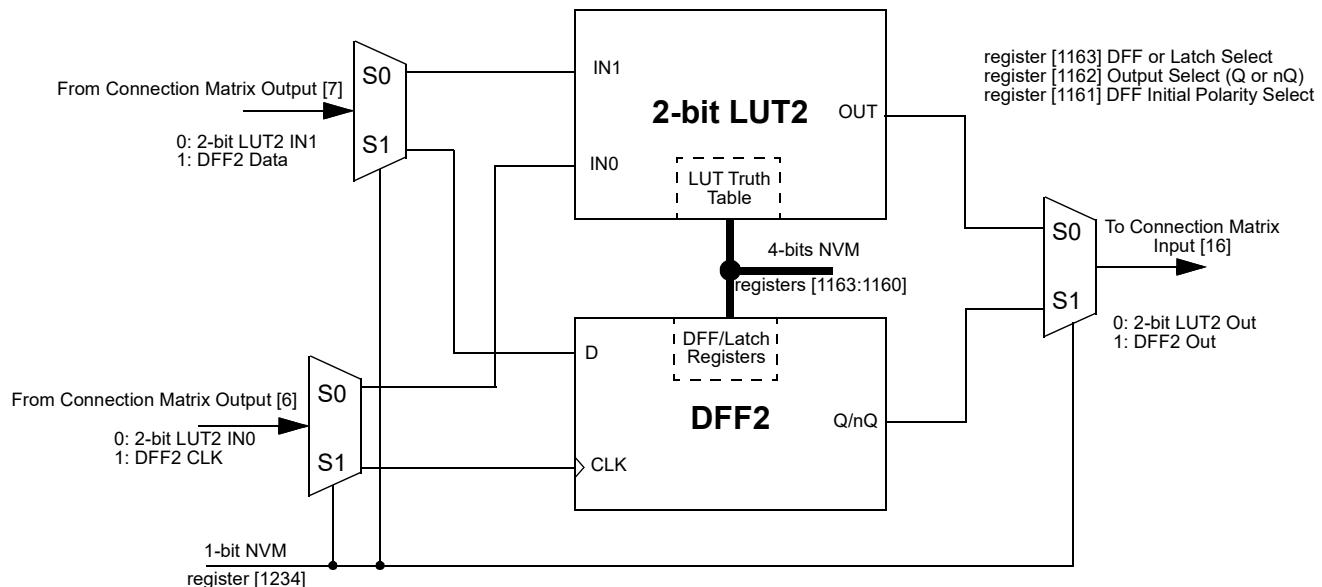


Figure 16: 2-bit LUT2 or DFF2

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 7.1.1 2-Bit LUT or D Flip-Flop Macrocell Used as 2-Bit LUTT

**Table 20: 2-bit LUT0 Truth Table**

IN1	IN0	OUT	
0	0	register [1152]	LSB
0	1	register [1153]	
1	0	register [1154]	
1	1	register [1155]	MSB

**Table 21: 2-bit LUT1 Truth Table**

IN1	IN0	OUT	
0	0	register [1156]	LSB
0	1	register [1157]	
1	0	register [1158]	
1	1	register [1159]	MSB

**Table 22: 2-bit LUT2 Truth Table**

IN1	IN0	OUT	
0	0	register [1160]	LSB
0	1	register [1161]	
1	0	register [1162]	
1	1	register [1163]	MSB

This macrocell, when programmed for a LUT function, uses a 4-bit register to define their output function:

*2-Bit LUT0 is defined by registers [1155:1152]*

*2-Bit LUT1 is defined by registers [1159:1156]*

*2-Bit LUT2 is defined by registers [1163:1160]*

**Table 23** shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the 2-bit LUT logic cells.

**Table 23: 2-bit LUT Standard Digital Functions**

Function	MSB			LSB
AND-2	1	0	0	0
NAND-2	0	1	1	1
OR-2	1	1	1	0
NOR-2	0	0	0	1
XOR-2	0	1	1	0
XNOR-2	1	0	0	1

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 7.1.2 Initial Polarity Operations

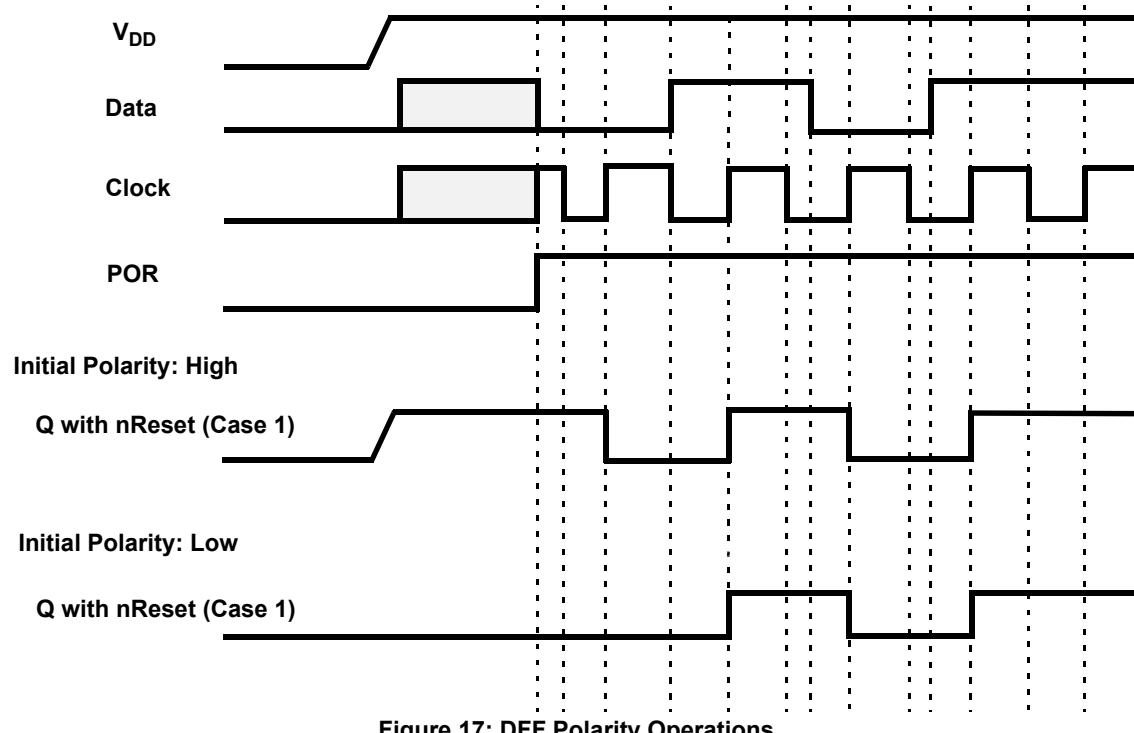


Figure 17: DFF Polarity Operations

### 7.2 2-BIT LUT OR PROGRAMMABLE PATTERN GENERATOR

The SLG46824 has one combination function macrocell that can serve as a logic or timing function. This macrocell can serve as a Look Up Table (LUT), or Programmable Pattern Generator (PGen).

When used to implement LUT functions, the 2-bit LUT takes in two input signals from the connection matrix and produces a single output, which goes back into the connection matrix. When used as a LUT to implement combinatorial logic functions, the outputs of the LUT can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR). The user can also define the combinatorial relationship between inputs and outputs to be any selectable function.

When operating as a Programmable Pattern Generator, the output of the macrocell with clock out a sequence of two to sixteen bits that are user selectable in their bit values, and user selectable in the number of bits (up to sixteen) that are output before the pattern repeats.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

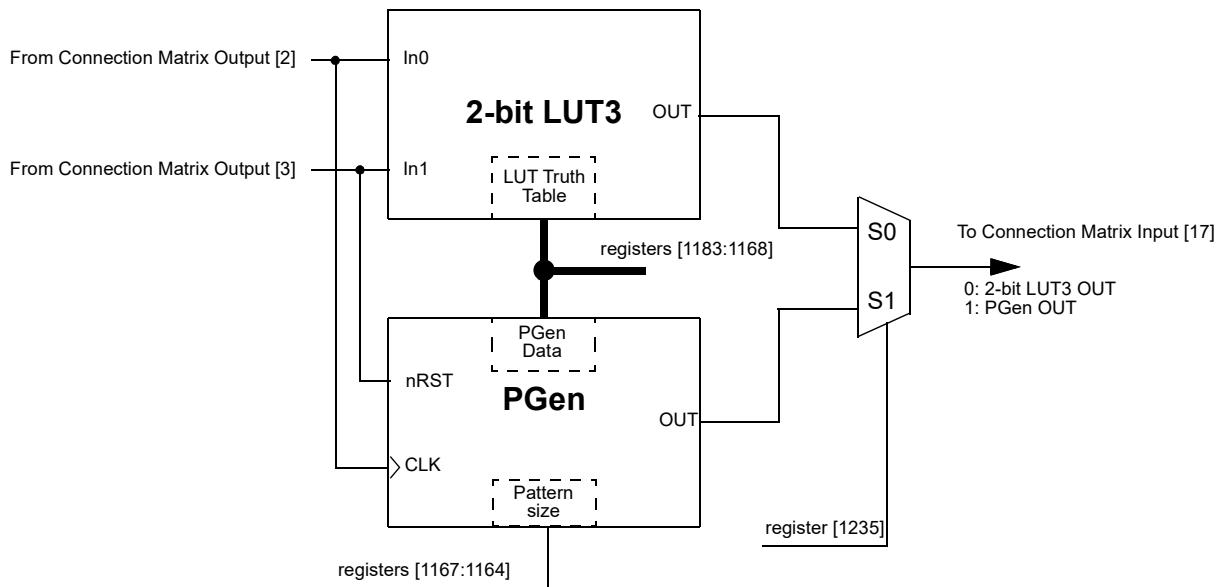


Figure 18: 2-bit LUT3 or PGen

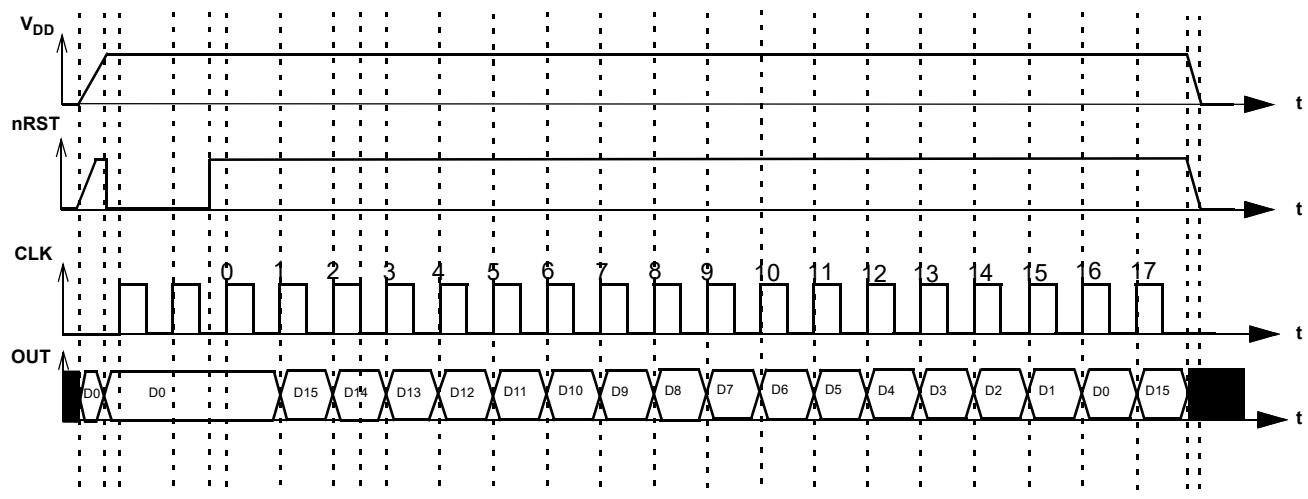


Figure 19: PGen Timing Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 7.2.1 2-Bit LUT or PGen Macrocell Used as 2-Bit LUT

**Table 24: 2-bit LUT1 Truth Table**

IN1	IN0	OUT	
0	0	register [1164]	LSB
0	1	register [1165]	
1	0	register [1166]	
1	1	register [1167]	MSB

This macrocell, when programmed for a LUT function, uses a 4-bit register to define their output function:

*2-Bit LUT3 is defined by registers [1167:1164]*

**Table 25** shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the 2-bit LUT logic cells.

**Table 25: 2-bit LUT Standard Digital Functions**

Function	MSB			LSB
AND-2	1	0	0	0
NAND-2	0	1	1	1
OR-2	1	1	1	0
NOR-2	0	0	0	1
XOR-2	0	1	1	0
XNOR-2	1	0	0	1

### 7.3 3-BIT LUT OR D FLIP-FLOP WITH SET/RESET MACROCELLS

There are six macrocells that can serve as either 3-bit LUTs or as D Flip-Flops with Set/Reset inputs. When used to implement LUT functions, the 3-bit LUTs each take in three input signals from the connection matrix and produce a single output, which goes back into the connection matrix. When used to implement D Flip-Flop function, the three input signals from the connection matrix go to the data (D) and clock (CLK), and Reset/Set (nRST/nSET) inputs for the Flip-Flop, with the output going back to the connection matrix.

DFF3 operation is described below:

- If register [1237] = 0, and the CLK is rising edge triggered, then Q = D, otherwise Q will not change
- If register [1237] = 1, then data from D is written into the DFF by the rising edge on CLK and output to Q by the falling edge on CLK.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

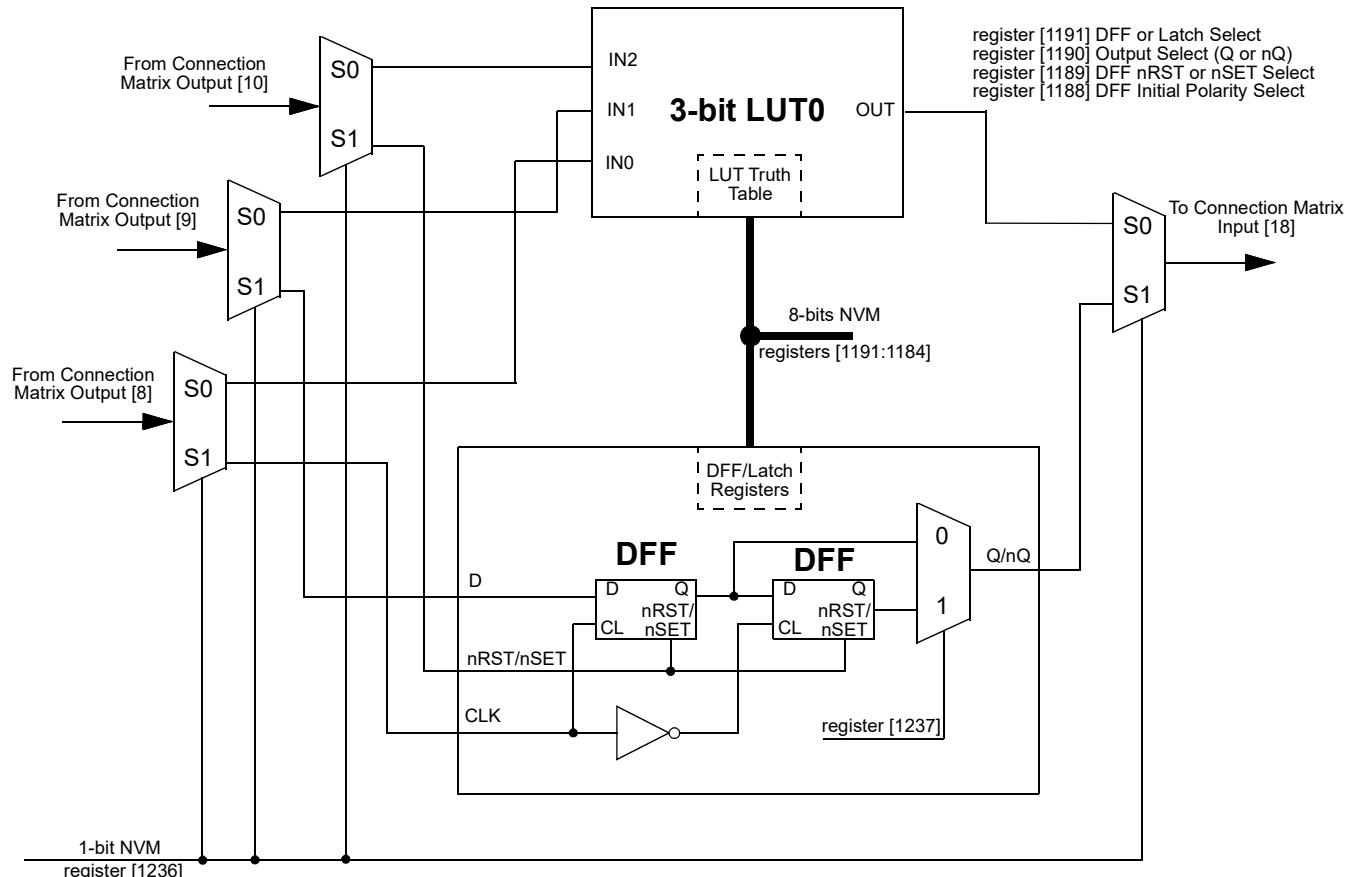


Figure 20: 3-bit LUT0 or DFF3

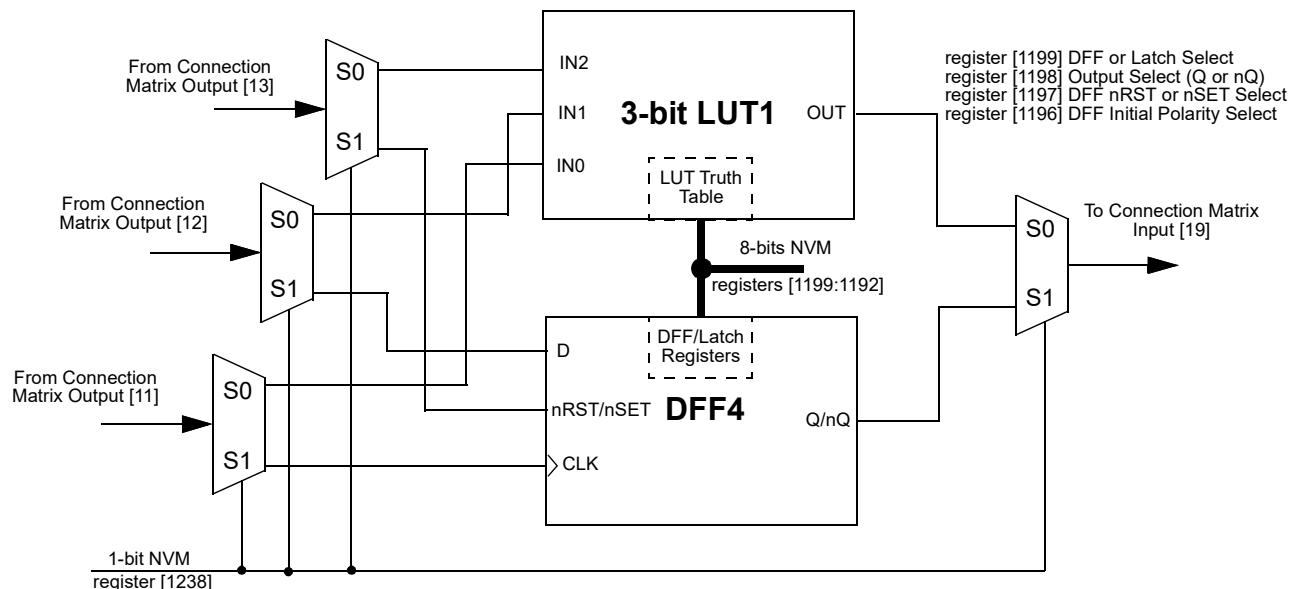


Figure 21: 3-bit LUT1 or DFF4

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

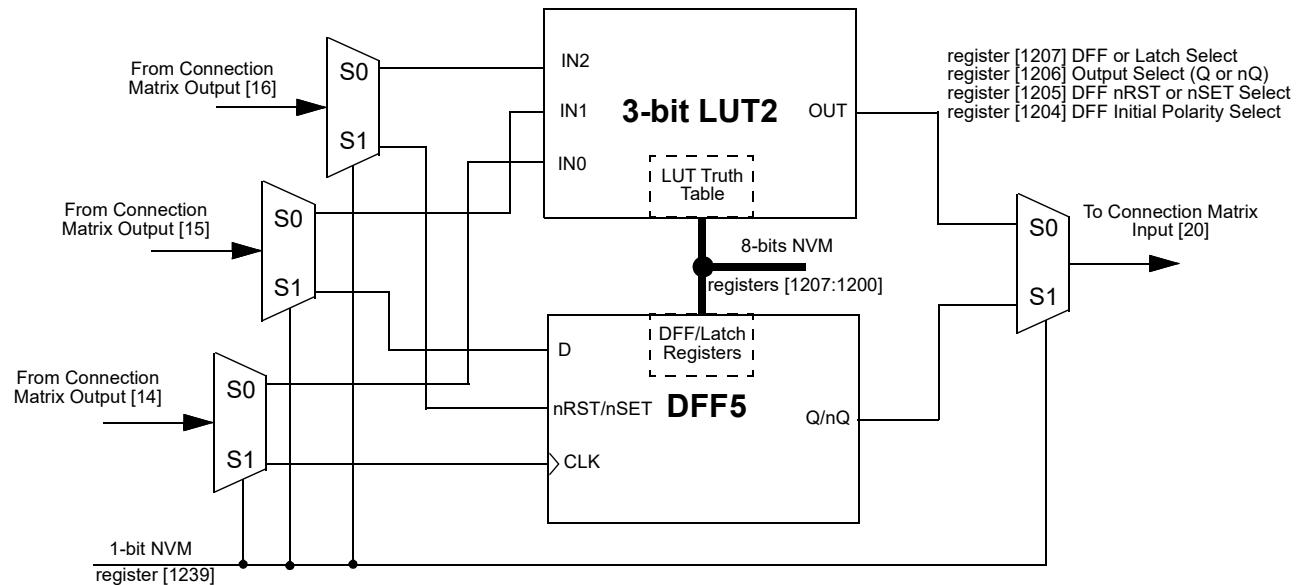


Figure 22: 3-bit LUT2 or DFF5

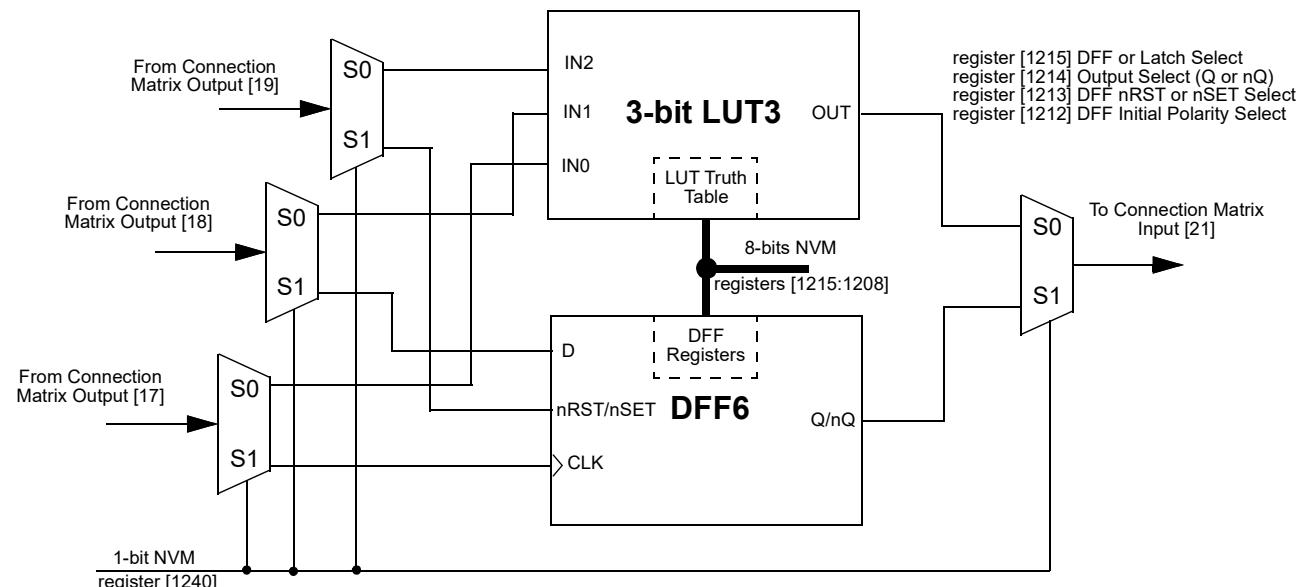


Figure 23: 3-bit LUT3 or DFF6

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

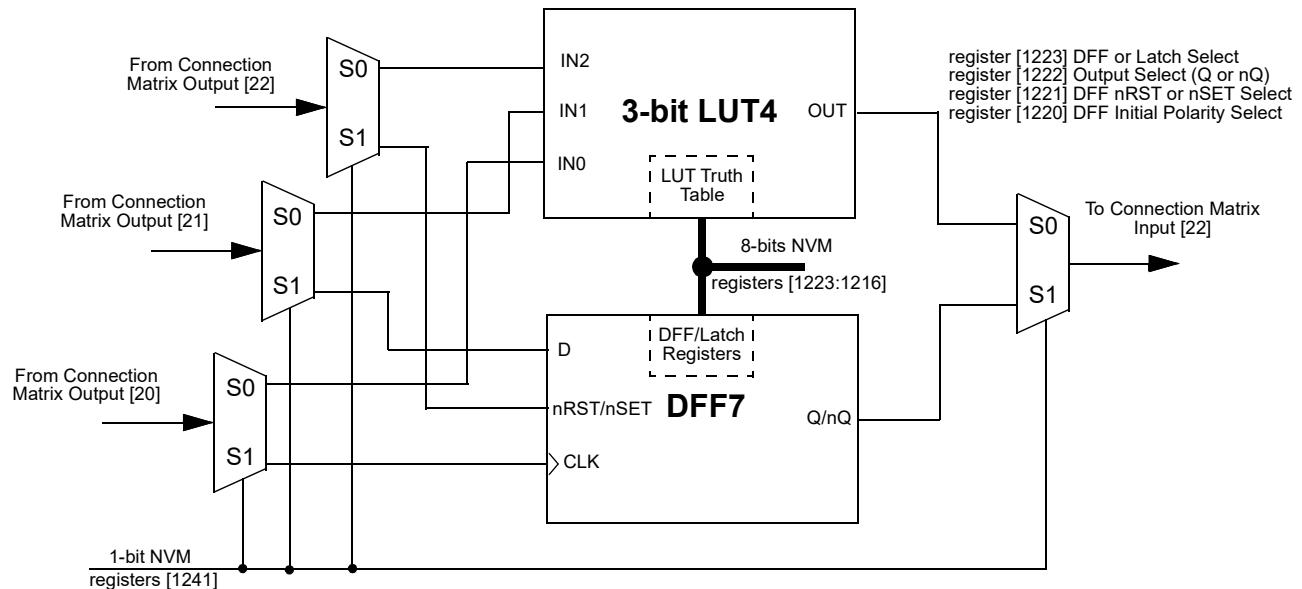


Figure 24: 3-bit LUT4 or DFF7

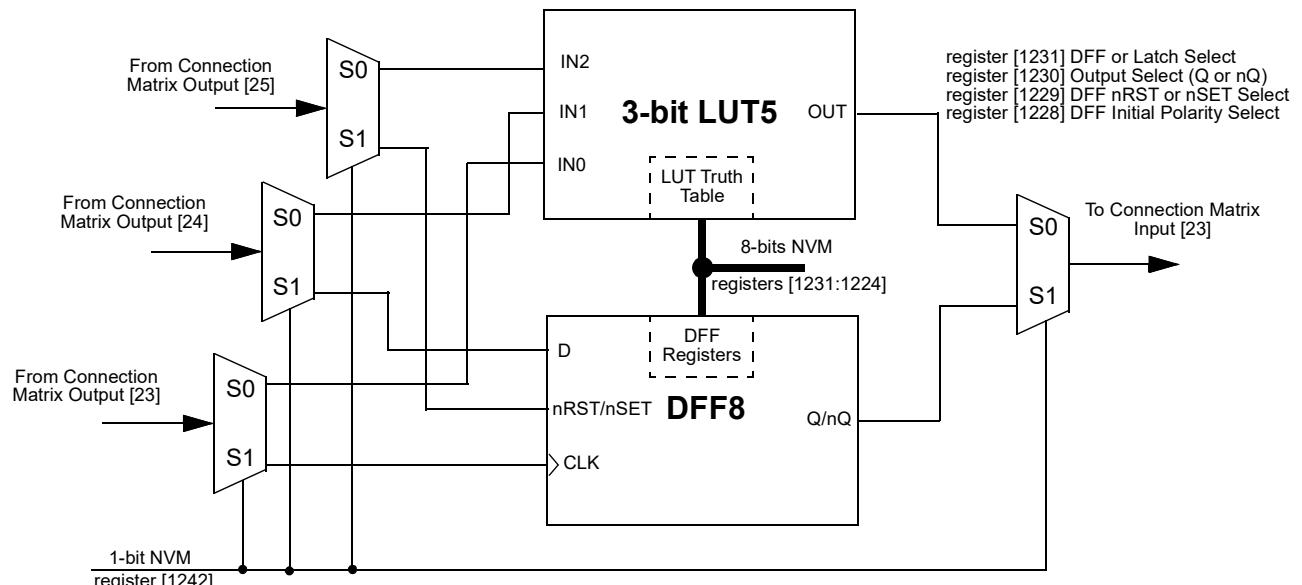


Figure 25: 3-bit LUT5 or DFF8

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 7.3.1 3-Bit LUT or D Flip-Flop Macrocells Used as 3-Bit LUTs

**Table 26: 3-bit LUT0 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1184]	LSB
0	0	1	register [1185]	
0	1	0	register [1186]	
0	1	1	register [1187]	
1	0	0	register [1188]	
1	0	1	register [1189]	
1	1	0	register [1190]	
1	1	1	register [1191]	MSB

**Table 27: 3-bit LUT1 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1192]	LSB
0	0	1	register [1193]	
0	1	0	register [1194]	
0	1	1	register [1195]	
1	0	0	register [1196]	
1	0	1	register [1197]	
1	1	0	register [1198]	
1	1	1	register [1199]	MSB

**Table 28: 3-bit LUT2 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1200]	LSB
0	0	1	register [1201]	
0	1	0	register [1202]	
0	1	1	register [1203]	
1	0	0	register [1204]	
1	0	1	register [1205]	
1	1	0	register [1206]	
1	1	1	register [1207]	MSB

Each macrocell, when programmed for a LUT function, uses a 8-bit register to define their output function:

*3-Bit LUT0 is defined by registers [1191:1184]*

*3-Bit LUT1 is defined by registers [1199:1192]*

*3-Bit LUT2 is defined by registers [1207:1200]*

*3-Bit LUT3 is defined by registers [1215:1208]*

*3-Bit LUT4 is defined by registers [1223:1216]*

*3-Bit LUT5 is defined by registers [1231:1224]*

**Table 29: 3-bit LUT3 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1208]	LSB
0	0	1	register [1209]	
0	1	0	register [1210]	
0	1	1	register [1211]	
1	0	0	register [1212]	
1	0	1	register [1213]	
1	1	0	register [1214]	
1	1	1	register [1215]	MSB

**Table 30: 3-bit LUT4 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1216]	LSB
0	0	1	register [1217]	
0	1	0	register [1218]	
0	1	1	register [1219]	
1	0	0	register [1220]	
1	0	1	register [1221]	
1	1	0	register [1222]	
1	1	1	register [1223]	MSB

**Table 31: 3-bit LUT5 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1224]	LSB
0	0	1	register [1225]	
0	1	0	register [1226]	
0	1	1	register [1227]	
1	0	0	register [1228]	
1	0	1	register [1229]	
1	1	0	register [1230]	
1	1	1	register [1231]	MSB

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 32 shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the four 3-bit LUT logic cells.

**Table 32: 3-bit LUT Standard Digital Functions**

Function	MSB							LSB
AND-3	1	0	0	0	0	0	0	0
NAND-3	0	1	1	1	1	1	1	1
OR-3	1	1	1	1	1	1	1	0
NOR-3	0	0	0	0	0	0	0	1
XOR-3	1	0	0	1	0	1	1	0
XNOR-3	0	1	1	0	1	0	0	1

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 7.3.2 Initial Polarity Operations

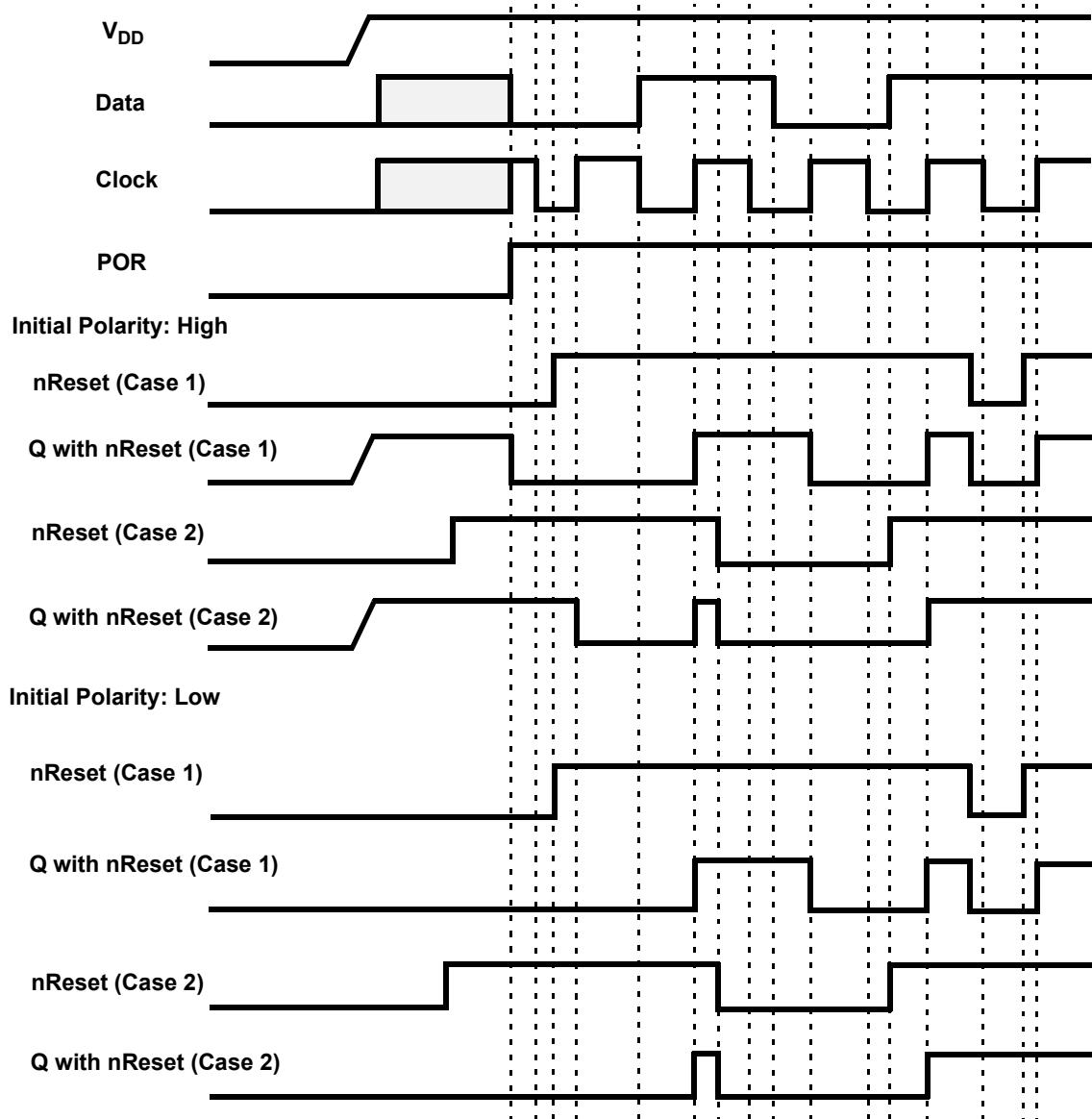


Figure 26: DFF Polarity Operations with nReset

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

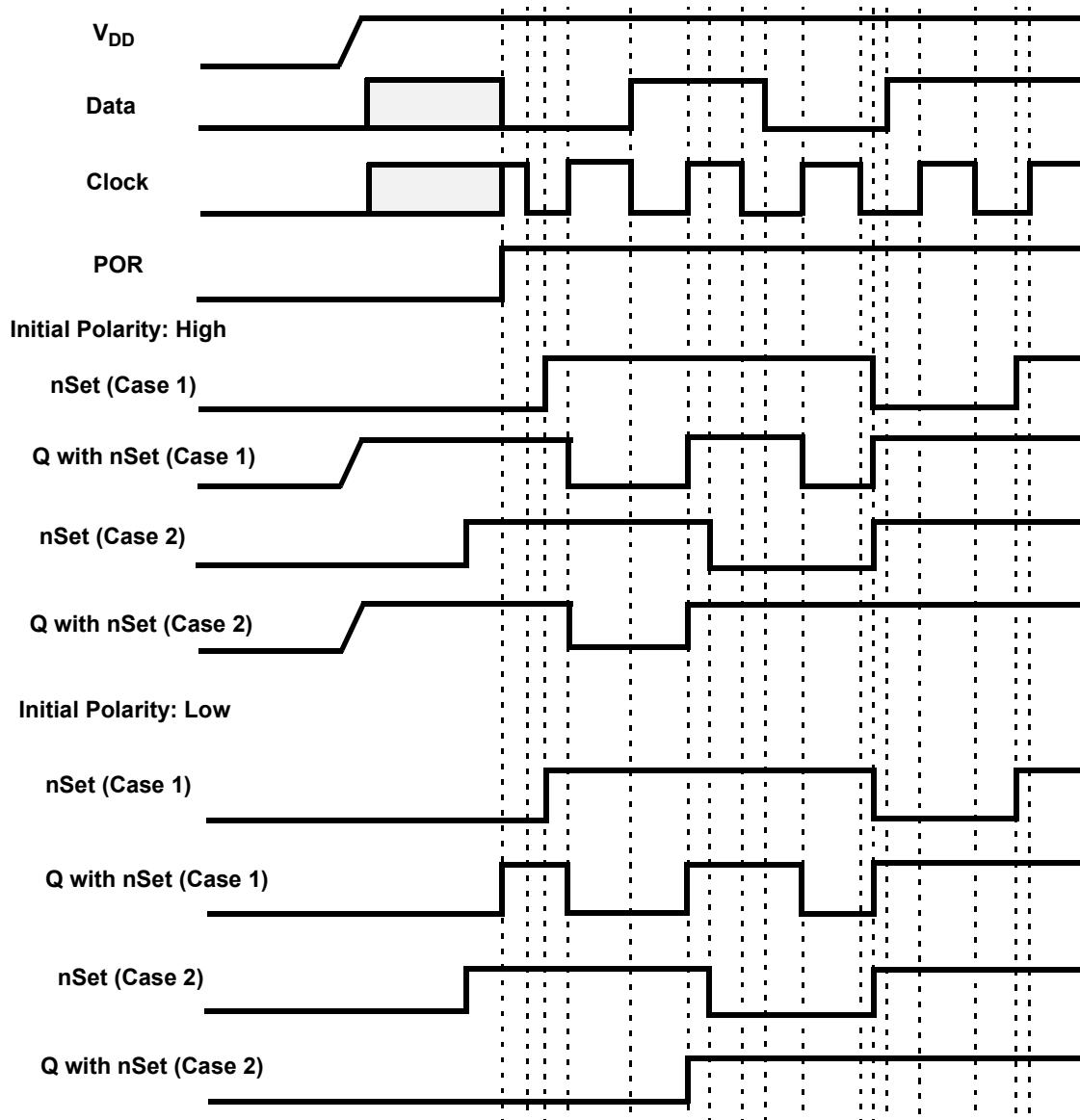


Figure 27: DFF Polarity Operations with nSet

### 7.4 3-BIT LUT OR PIPE DELAY/RIPPLE COUNTER MACROCELL

There is one macrocell that can serve as either a 3-bit LUT or as a Pipe Delay/Ripple Counter.

When used to implement LUT functions, the 3-bit LUT takes in three input signals from the connection matrix and produces a single output, which goes back into the connection matrix.

When used as a Pipe Delay, there are three inputs signals from the matrix, Input (IN), Clock (CLK), and Reset (nRST). The Pipe Delay cell is built from 16 D Flip-Flop logic cells that provide the three delay options, two of which are user selectable. The DFF cells are tied in series where the output (Q) of each delay cell goes to the next DFF cell input (IN). Both of the two outputs (OUT0 and OUT1) provide user selectable options for 1 to 16 stages of delay. There are delay output points for each set of the OUT0 and OUT1 outputs to a 4-input mux that is controlled by registers [1251:1248] for OUT0 and registers [1255:1252] for OUT1. The 4-input mux is used to control the selection of the amount of delay.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

The overall time of the delay is based on the clock used in the SLG46824 design. Each DFF cell has a time delay of the inverse of the clock time (either external clock or the internal Oscillator within the SLG46824). The sum of the number of DFF cells used will be the total time delay of the Pipe Delay logic cell. OUT1 Output can be inverted (as selected by register [1256]).

In the Ripple Counter mode, there are 3 options for setting, which use 7 bits. There are 3 bits to set **nSET value (SV)** in range from 0 to 7. It is a value, which will be set into the Ripple Counter outputs when nSET input goes LOW. **End value (EV)** will use 3 bits for setting outputs code, which will be last code in the cycle. After reaching the EV, the Ripple Counter goes to the first code by the rising edge on CLK input. The **Functionality mode** option uses 1 bit. This setting defines how exactly Ripple Counter will operate.

The user can select one of the functionality modes by register: RANGE or FULL. If the RANGE option is selected, the count starts from SV. If UP input is LOW the count goes down: SV→EV→EV-1 to SV+1→SV and others (if SV is smaller than EV), or SV→SV-1 to EV+1→EV→SV (if SV is bigger than EV). If UP input is HIGH, count starts from SV up to EV and others.

In the FULL range configuration the Ripple Counter functions as follows. If UP input is LOW, the count starts from SV and goes down to 0. Then current counter value jumps to EV and goes down to 0 etc.

If UP input is HIGH, count goes up starting from SV. Then current counter value jumps to 0 and counts up to EV and others. See Ripple Counter functionality example in [Figure 29](#).

Every step is executed by the rising edge on CLK input.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

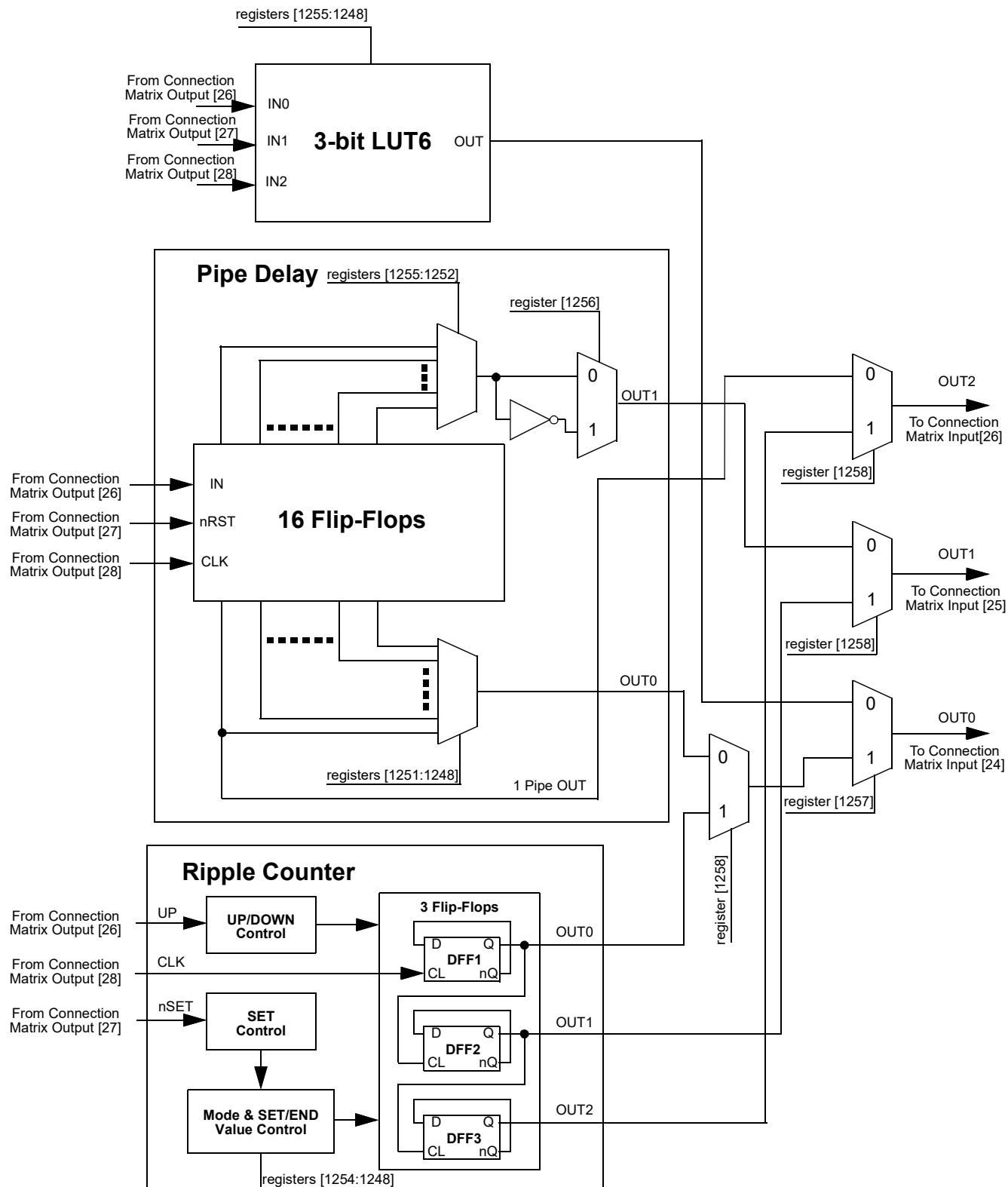


Figure 28: 3-bit LUT6/Pipe Delay/Ripple Counter

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

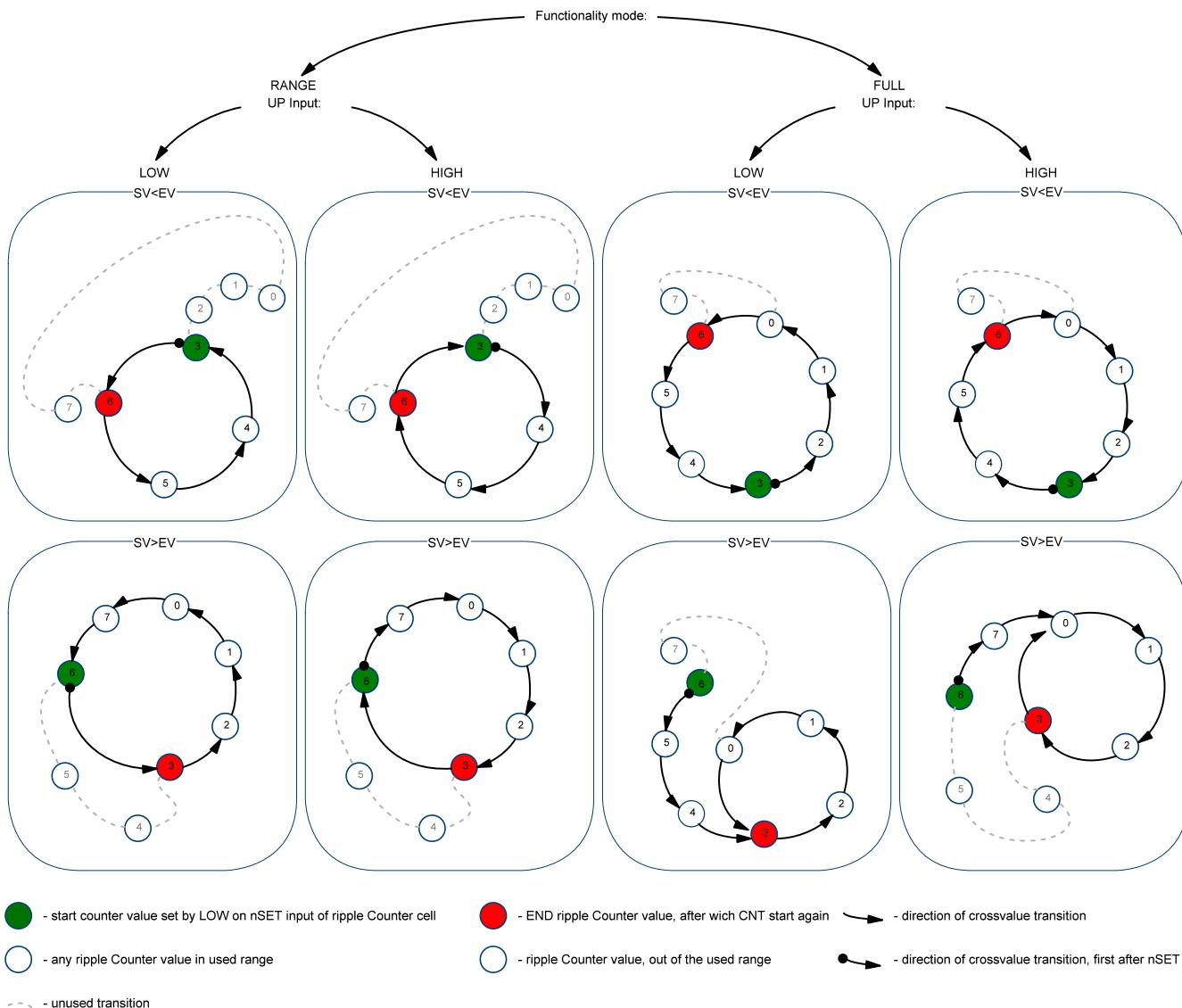


Figure 29: Example: Ripple Counter Functionality

### 7.4.1 3-Bit LUT or Pipe Delay Macrocells Used as 3-Bit LUT

Table 33: 3-bit LUT6 Truth Table

IN2	IN1	IN0	OUT
0	0	0	register [1248]
0	0	1	register [1249]
0	1	0	register [1250]
0	1	1	register [1251]
1	0	0	register [1252]
1	0	1	register [1253]
1	1	0	register [1254]
1	1	1	register [1255]

---

**GreenPAK Programmable Mixed-Signal Matrix with In System  
Programmability**

Each macrocell, when programmed for a LUT function, uses a 8-bit register to define their output function:

*3-Bit LUT6 is defined by registers [1255:1248]*

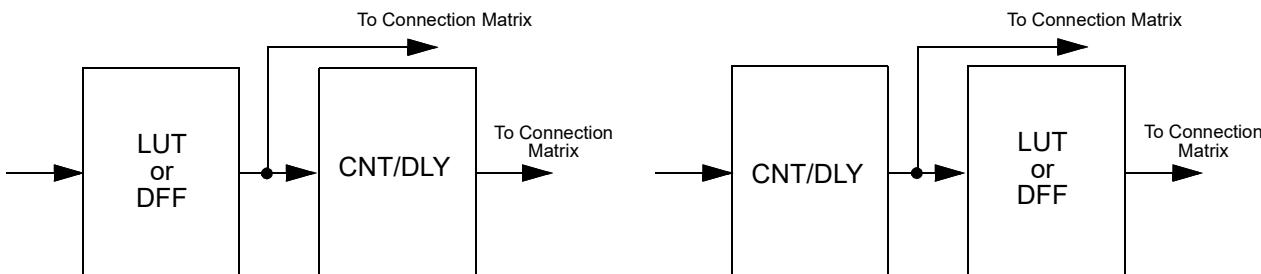
## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8 Multi-Function Macrocells

The SLG46824 has 8 Multi-Function macrocells that can serve more than one logic or timing function. In each case, they can serve as a LUT, DFF with flexible settings, or as CNT/DLY with multiple modes such as One Shot, Frequency Detect, Edge Detect, and others. Also, the macrocell is capable to combine those functions: LUT/DFF connected to CNT/DLY or CNT/DLY connected to LUT/DFF, see [Figure 30](#).

See the list below for the functions that can be implemented in these macrocells:

- Seven macrocells that can serve as 3-bit LUTs/D Flip-Flops and as 8-Bit Counter/Delays
- One macrocell that can serve as a 4-bit LUT/D Flip-Flop and as 16-Bit Counter/Delay/FSM



**Figure 30: Possible Connections Inside Multi-Function Macrocell**

Inputs/Outputs for the 8 Multi-Function macrocells are configured from the connection matrix with specific logic functions being defined by the state of NVM bits.

When used as a LUT to implement combinatorial logic functions, the outputs of the LUTs can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR).

#### 8.1 3-BIT LUT OR DFF/LATCH WITH 8-BIT COUNTER/DELAY MACROCELLS

There are seven macrocells that can serve as 3-bit LUTs/D Flip-Flops and as 8-Bit Counter/Delays.

When used to implement LUT functions, the 3-bit LUTs each take in three input signals from the connection matrix and produce a single output, which goes back into the connection matrix or can be connected to CNT/DLY's input.

When used to implement D Flip-Flop function, the three input signals from the connection matrix go to the data (D), clock (CLK), and Reset/Set (nRST/nSET) inputs of the Flip-Flop, with the output going back to the connection matrix or to the CNT/DLY's input.

When used to implement Counter/Delays, each macrocell has a dedicated matrix input connection. For flexibility, each of these macrocells has a large selection of internal and external clock sources, as well as the option to chain from the output of the previous (N-1) CNT/DLY macrocell, to implement longer count/delay circuits. These macrocells can also operate in a One-Shot mode, which will generate an output pulse of user-defined width. They can also operate in a Frequency Detection or Edge Detection mode.

Counter/Delay macrocell has an initial value, which define its initial value after GPAK is powered up. It is possible to select initial Low or initial High, as well as initial value defined by a Delay In signal.

For example, in case initial LOW option is used, the rising edge delay will start operation.

For timing diagrams refer to Section [8.2](#).

**Note:** After two DFF – counters initialize with counter data = 0 after POR.

Initial state = 1 – counters initialize with counter data = 0 after POR.

Initial state = 0 And After two DFF is bypass – counters initialize with counter data after POR.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Three of eight macrocells can have their current count value read via I<sup>2</sup>C (CNT0, CNT2, and CNT4). However, it is possible to change the counter data (value counter starts operating from) for any macrocell using I<sup>2</sup>C write commands. In this mode, it is possible to load count data immediately (after two DFF) or after counter ends counting. See Section 15.7.1 for further details.

### 8.1.1 3-Bit LUT or 8-Bit CNT/DLY Block Diagrams

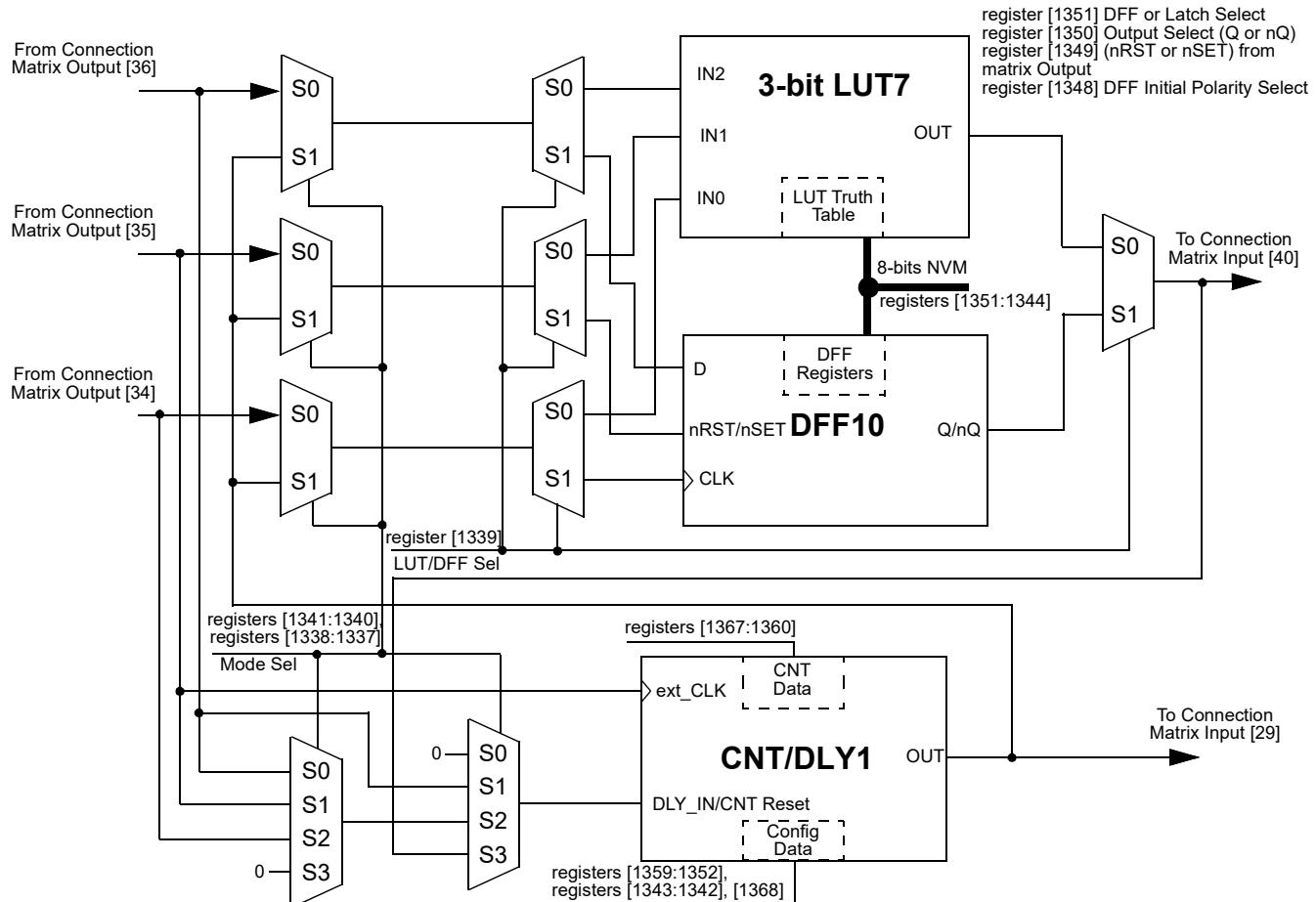


Figure 31: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT7/DFF10, CNT/DLY1)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

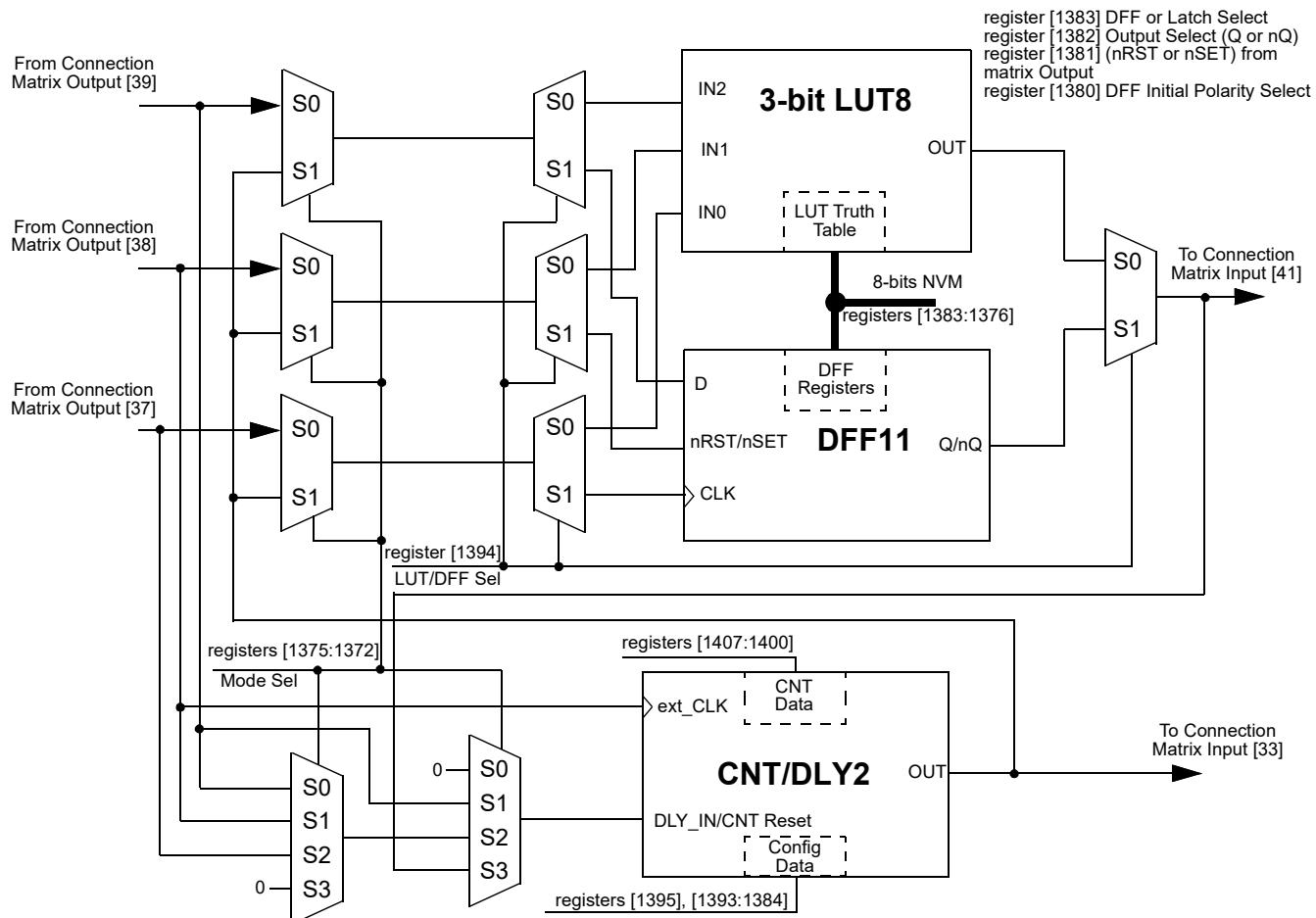


Figure 32: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT8/DFF11, CNT/DLY2)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

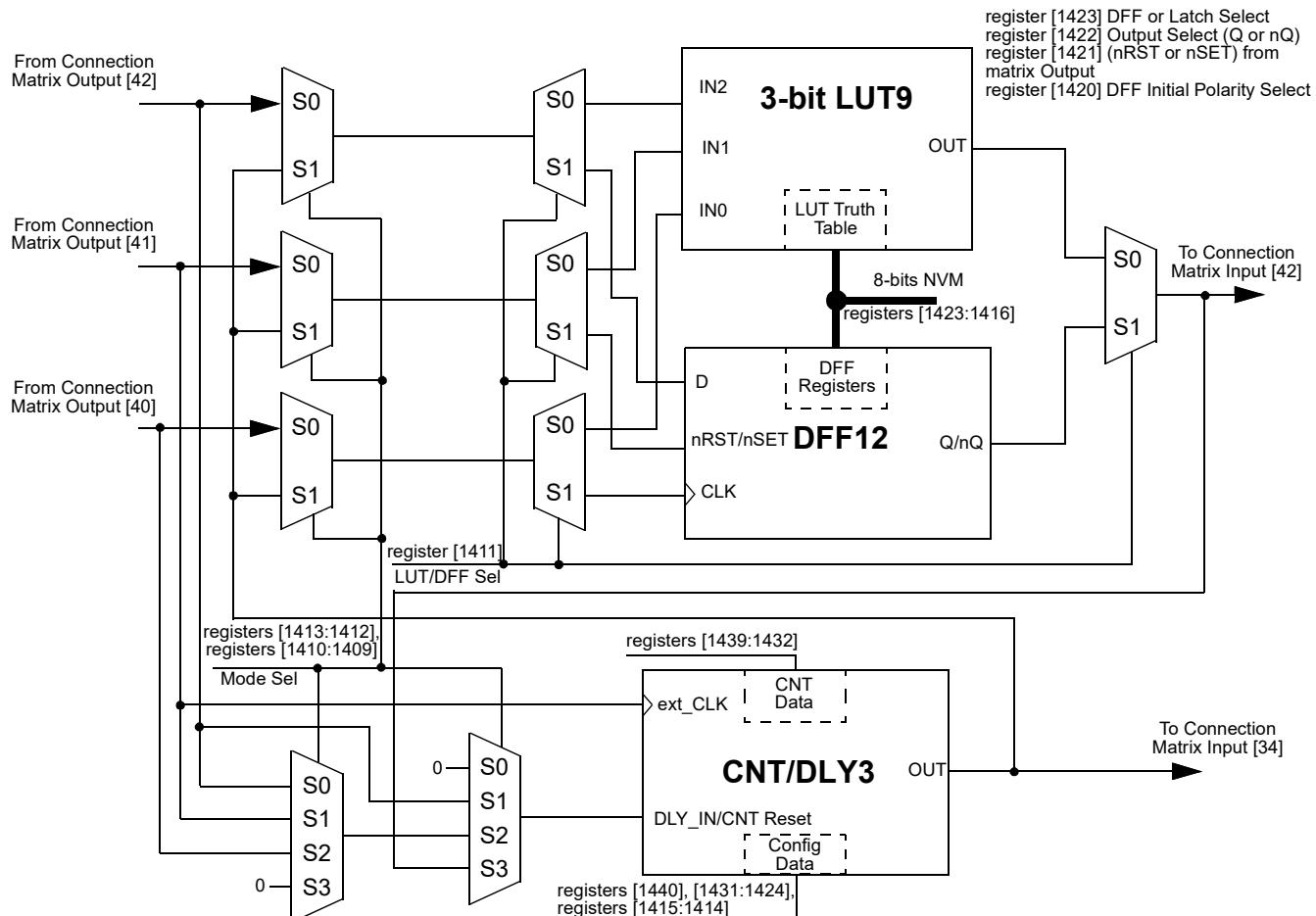
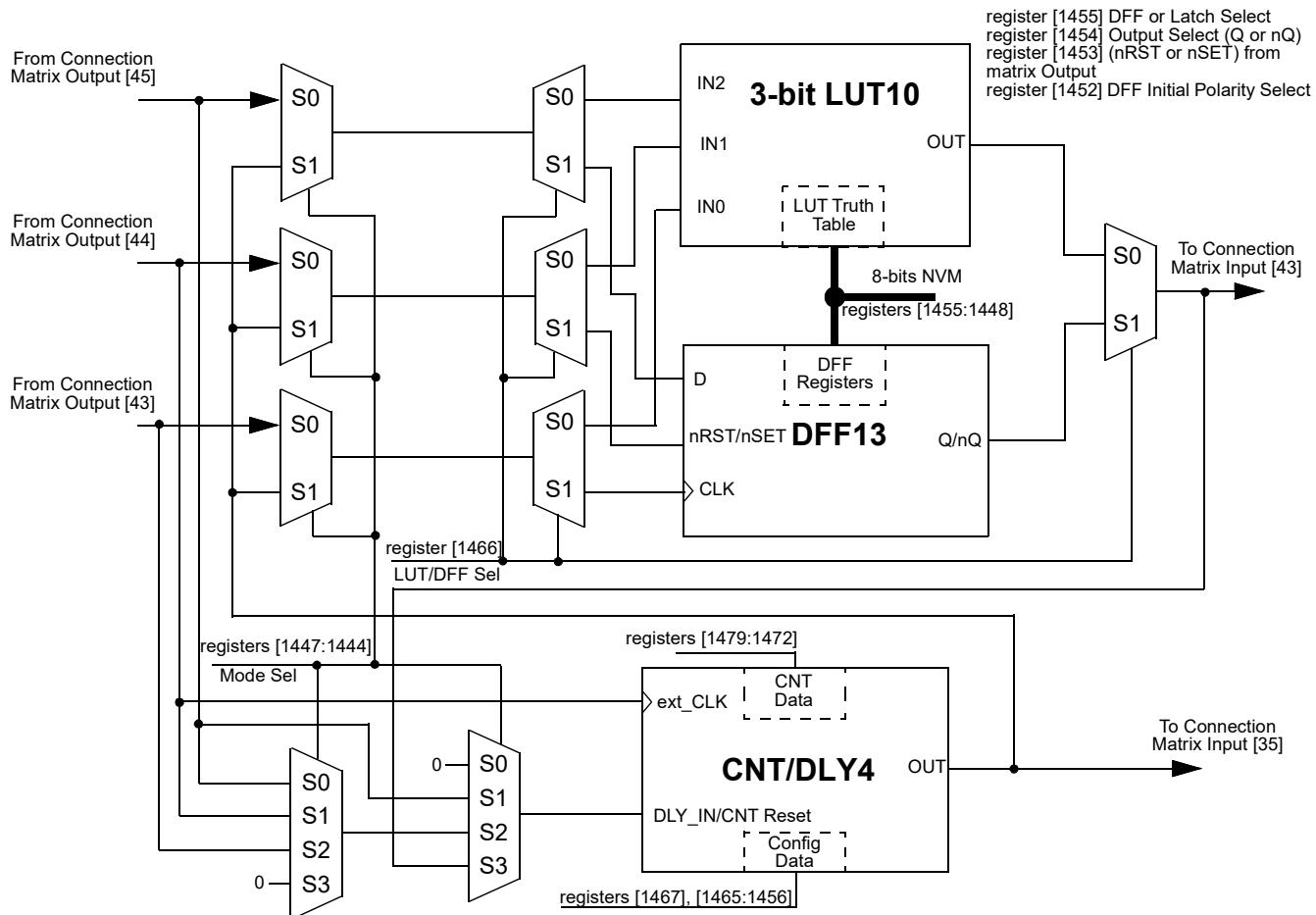


Figure 33: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT9/DFF12, CNT/DLY3)



**Figure 34: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT10/DFF13, CNT/DLY4)**

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

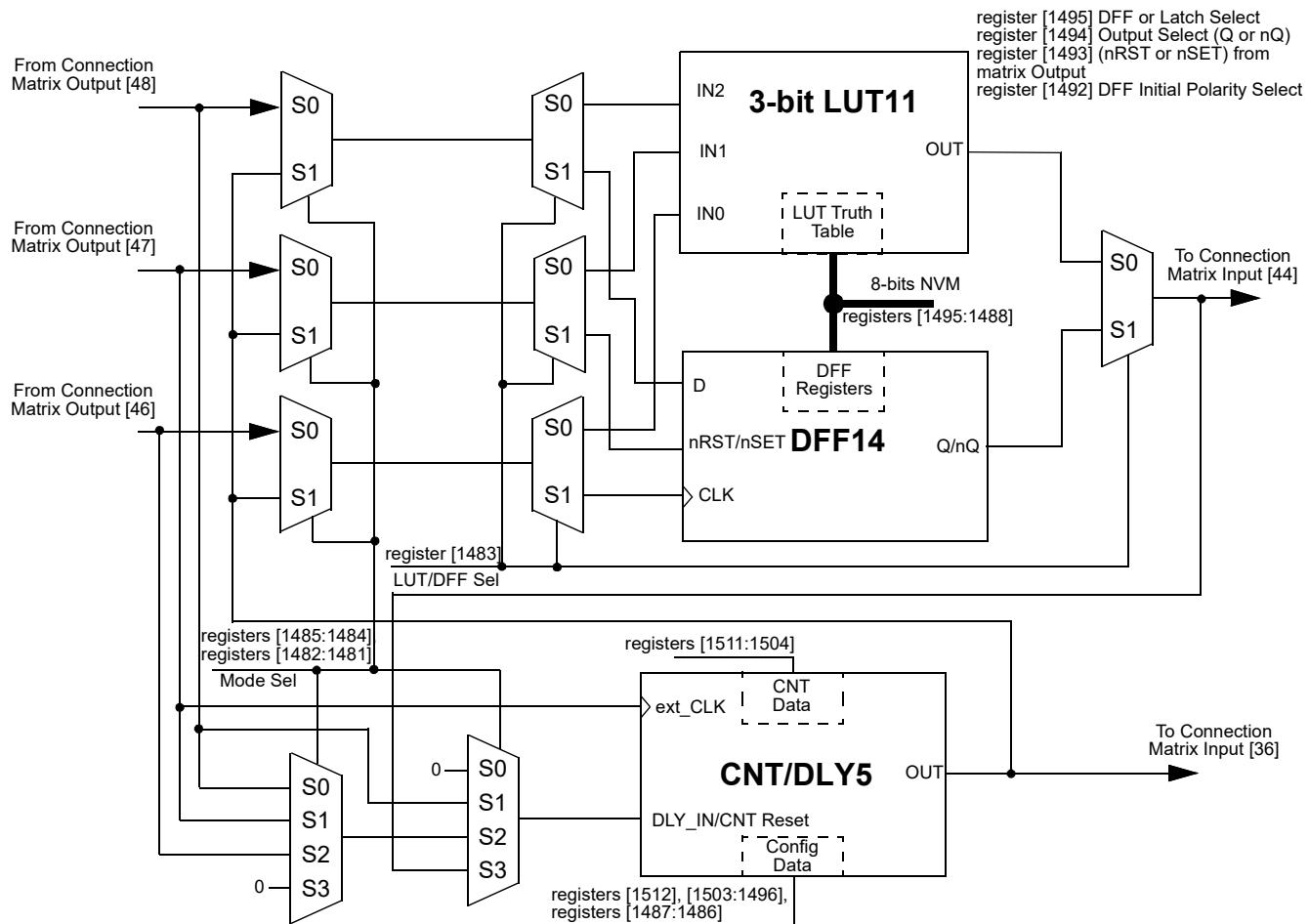


Figure 35: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT11/DFF14, CNT/DLY5)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

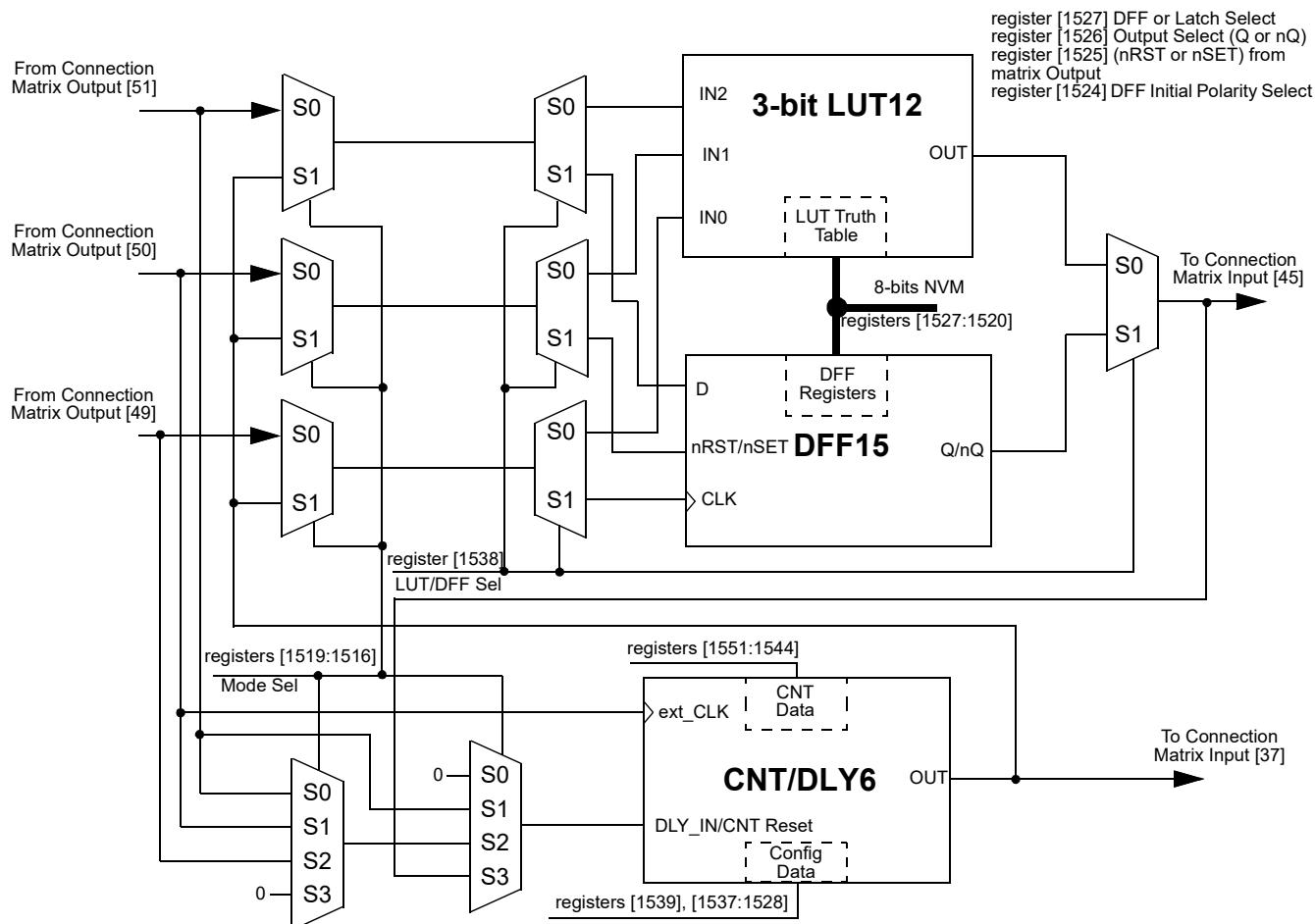


Figure 36: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT12/DFF15, CNT/DLY6)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

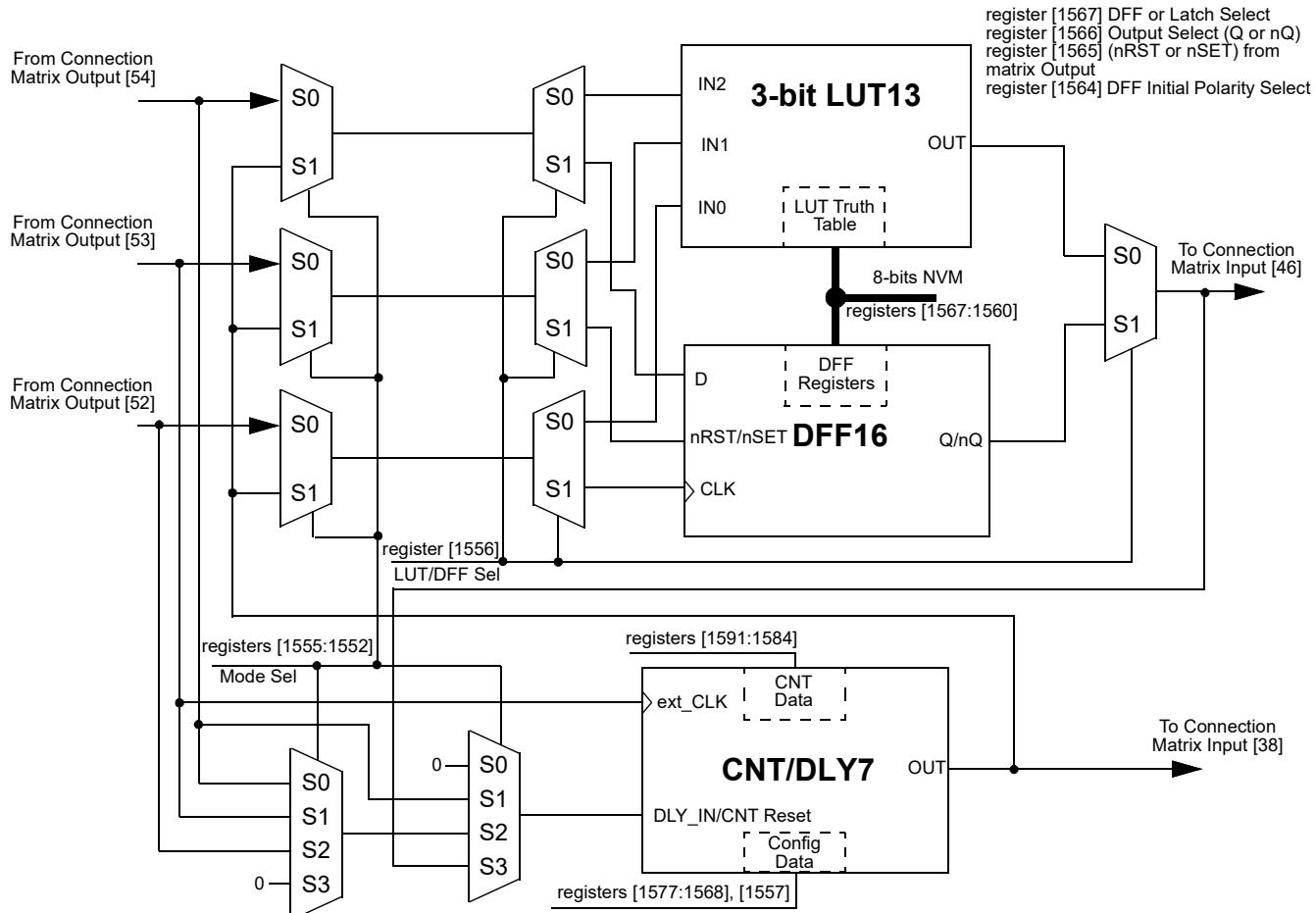


Figure 37: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT13/DFF16, CNT/DLY7)

As shown in Figures 24 to 30 there is a possibility to use LUT/DFF and CNT/DLY simultaneously.

**Note:** It is not possible to use LUT and DFF at once, one of these macrocells must be selected.

- Case 1. LUT/DFF in front of CNT/DLY. Three input signals from the connection matrix go to previously selected LUT or DFF's inputs and produce a single output which goes to a CND/DLY input. In its turn Counter/Delay's output goes back to the matrix.
- Case 2. CNT/DLY in front of LUT/DFF. Two input signals from the connection matrix go to CND/DLY's inputs (IN and CLK). Its output signal can be connected to any input of previously selected LUT or DFF, after which the signal goes back to the matrix.
- Case 3. Single LUT/DFF or CNT/DLY. Also, it is possible to use a standalone LUT/DFF or CNT/DLY. In this case, all inputs and output of the macrocell are connected to the matrix.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.1.2 3-Bit LUT or CNT/DLYs Used as 3-Bit LUTs

**Table 34: 3-bit LUT7 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1344]	LSB
0	0	1	register [1345]	
0	1	0	register [1346]	
0	1	1	register [1347]	
1	0	0	register [1348]	
1	0	1	register [1349]	
1	1	0	register [1350]	
1	1	1	register [1351]	MSB

**Table 35: 3-bit LUT8 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1376]	LSB
0	0	1	register [1377]	
0	1	0	register [1378]	
0	1	1	register [1379]	
1	0	0	register [1380]	
1	0	1	register [1381]	
1	1	0	register [1382]	
1	1	1	register [1383]	MSB

**Table 36: 3-bit LUT9 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1416]	LSB
0	0	1	register [1417]	
0	1	0	register [1418]	
0	1	1	register [1419]	
1	0	0	register [1420]	
1	0	1	register [1421]	
1	1	0	register [1422]	
1	1	1	register [1423]	MSB

**Table 37: 3-bit LUT10 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1448]	LSB
0	0	1	register [1449]	
0	1	0	register [1450]	
0	1	1	register [1451]	
1	0	0	register [1452]	
1	0	1	register [1453]	
1	1	0	register [1454]	
1	1	1	register [1455]	MSB

**Table 38: 3-bit LUT11 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1488]	LSB
0	0	1	register [1489]	
0	1	0	register [1490]	
0	1	1	register [1491]	
1	0	0	register [1492]	
1	0	1	register [1493]	
1	1	0	register [1494]	
1	1	1	register [1495]	MSB

**Table 39: 3-bit LUT12 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1520]	LSB
0	0	1	register [1521]	
0	1	0	register [1522]	
0	1	1	register [1523]	
1	0	0	register [1524]	
1	0	1	register [1525]	
1	1	0	register [1526]	
1	1	1	register [1527]	MSB

**Table 40: 3-bit LUT13 Truth Table**

IN2	IN1	IN0	OUT	
0	0	0	register [1560]	LSB
0	0	1	register [1561]	
0	1	0	register [1562]	
0	1	1	register [1563]	
1	0	0	register [1564]	
1	0	1	register [1565]	
1	1	0	register [1566]	
1	1	1	register [1567]	MSB

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Each macrocell, when programmed for a LUT function, uses a 8-bit register to define their output function:

*3-Bit LUT7 is defined by registers [1351:1344]*

*3-Bit LUT8 is defined by registers [1383:1376]*

*3-Bit LUT9 is defined by registers [1423:1416]*

*3-Bit LUT10 is defined by registers [1455:1448]*

*3-Bit LUT11 is defined by registers [1495:1488]*

*3-Bit LUT12 is defined by registers [1527:1520]*

*3-Bit LUT13 is defined by registers [1567:1560]*

### 8.2 CNT/DLY/FSM TIMING DIAGRAMS

Note: Counters initialize with counter data after POR

#### 8.2.1 Delay Mode CNT/DLY0 to CNT/DLY7

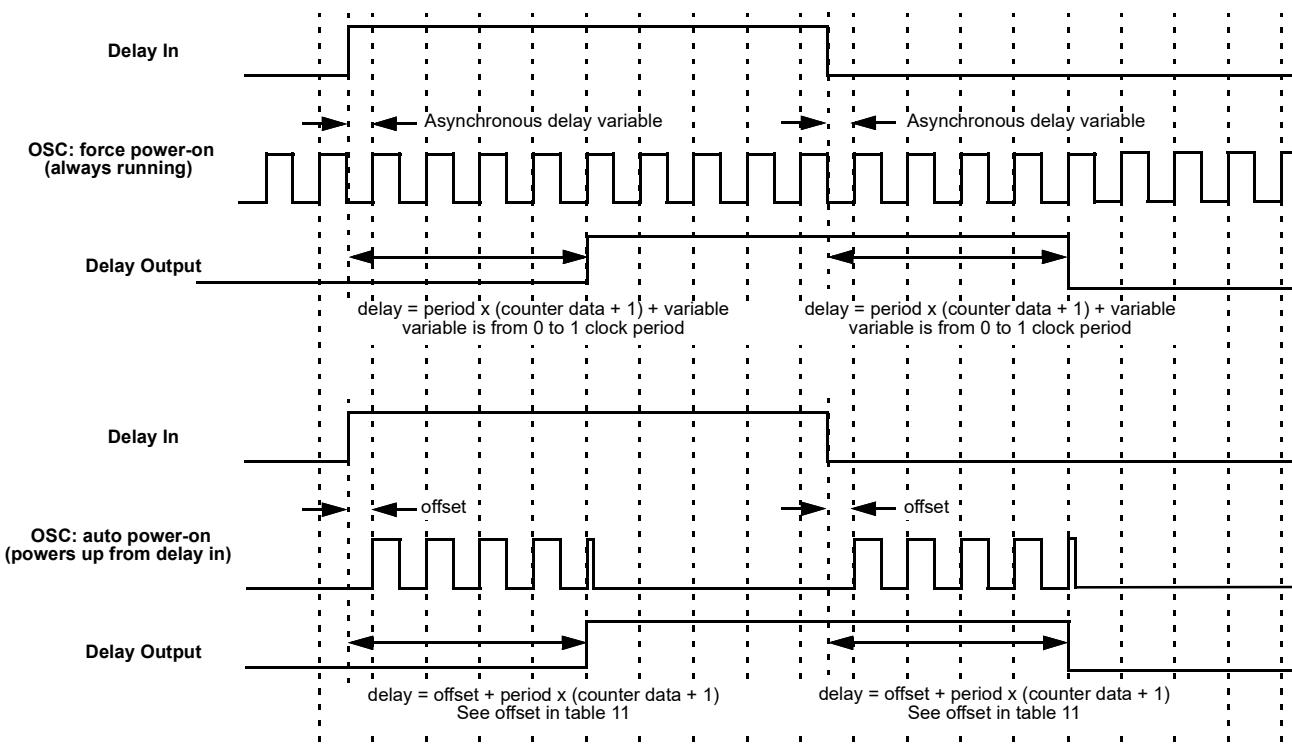


Figure 38: Delay Mode Timing Diagram, Edge Select: Both, Counter Data: 3

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

The macrocell shifts the respective edge to a set time and restarts by appropriate edge. It works as a filter if the input signal is shorter than the delay time.

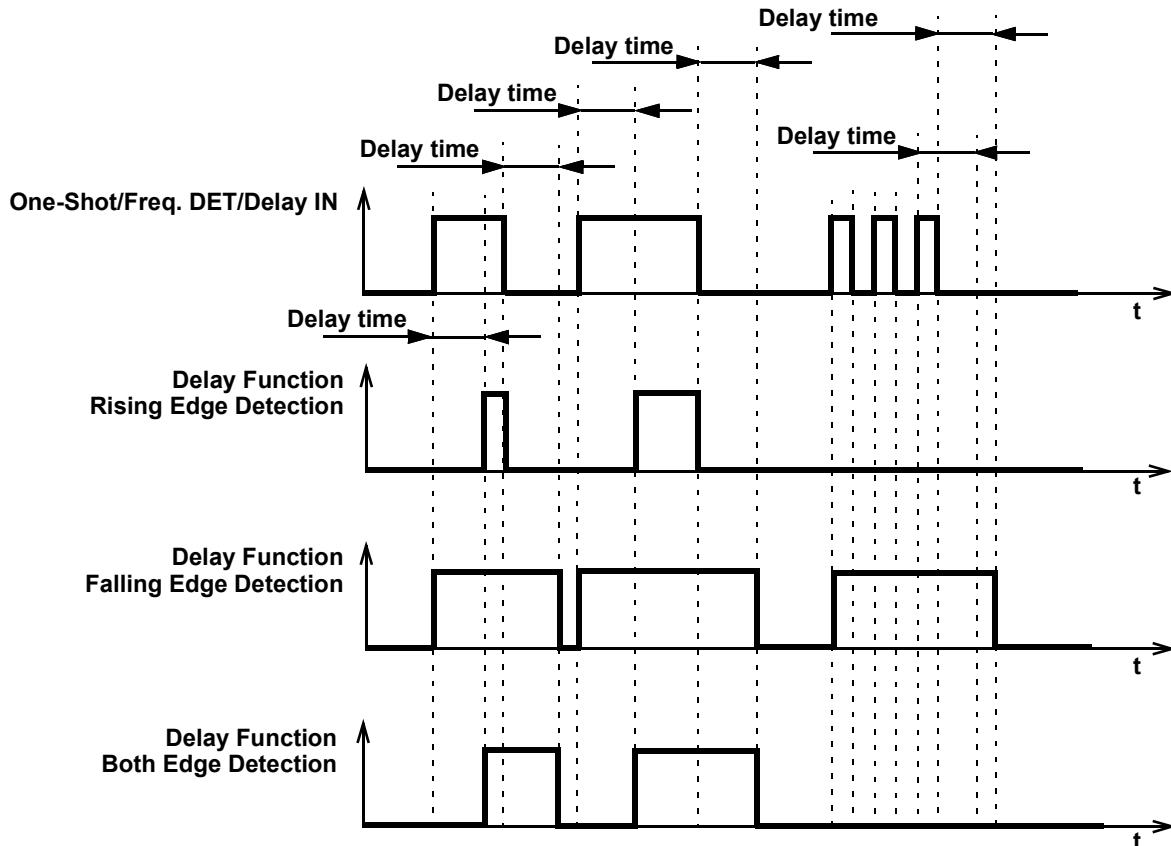


Figure 39: Delay Mode Timing Diagram for Different Edge Select Modes

### 8.2.2 Count Mode (Count Data: 3), Counter Reset (Rising Edge Detect) CNT/DLY0 to CNT/DLY7

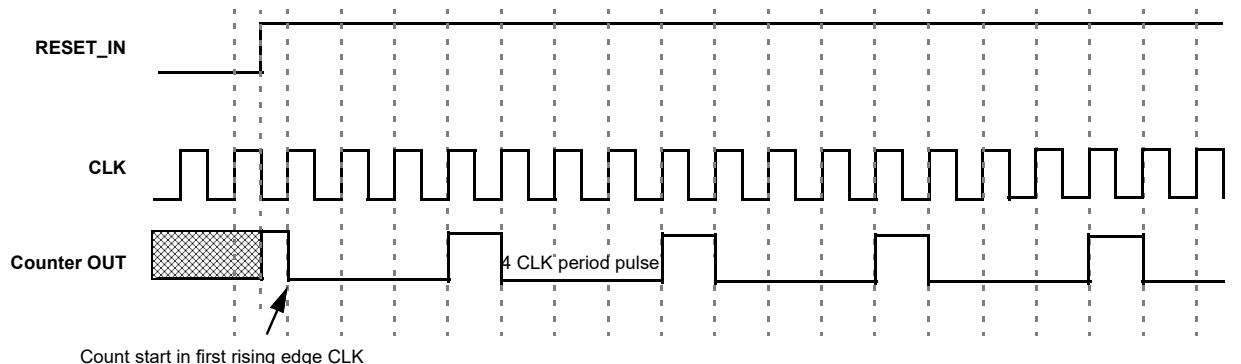


Figure 40: Counter Mode Timing Diagram without Two DFFs Synced Up

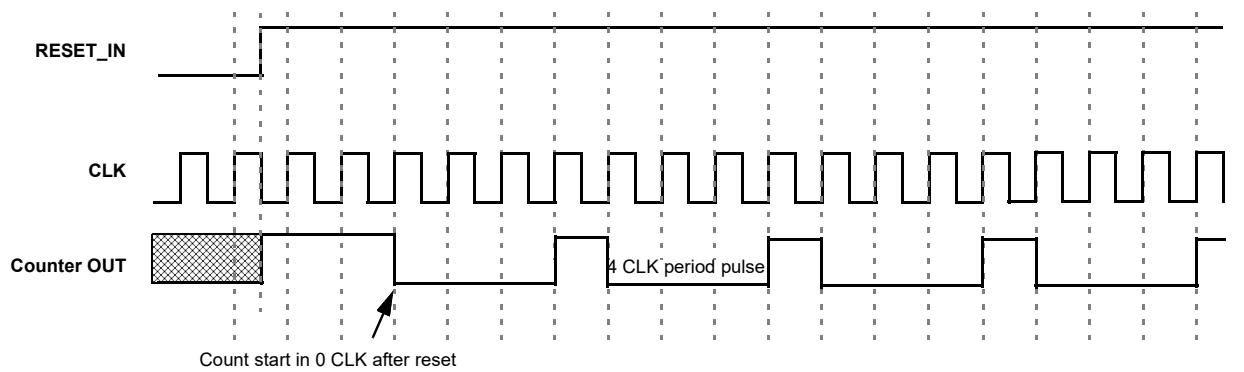


Figure 41: Counter Mode Timing Diagram with Two DFFs Synced Up

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.2.3 One-Shot Mode CNT/DLY0 to CNT/DLY7

This macrocell will generate a pulse whenever a selected edge is detected on its input. Register bits set the edge selection. The pulse width determines by counter data and clock selection properties.

The output pulse polarity (non-inverted or inverted) is selected by register bit. Any incoming edges will be ignored during the pulse width generation. The following diagram shows one-shot function for non-inverted output.

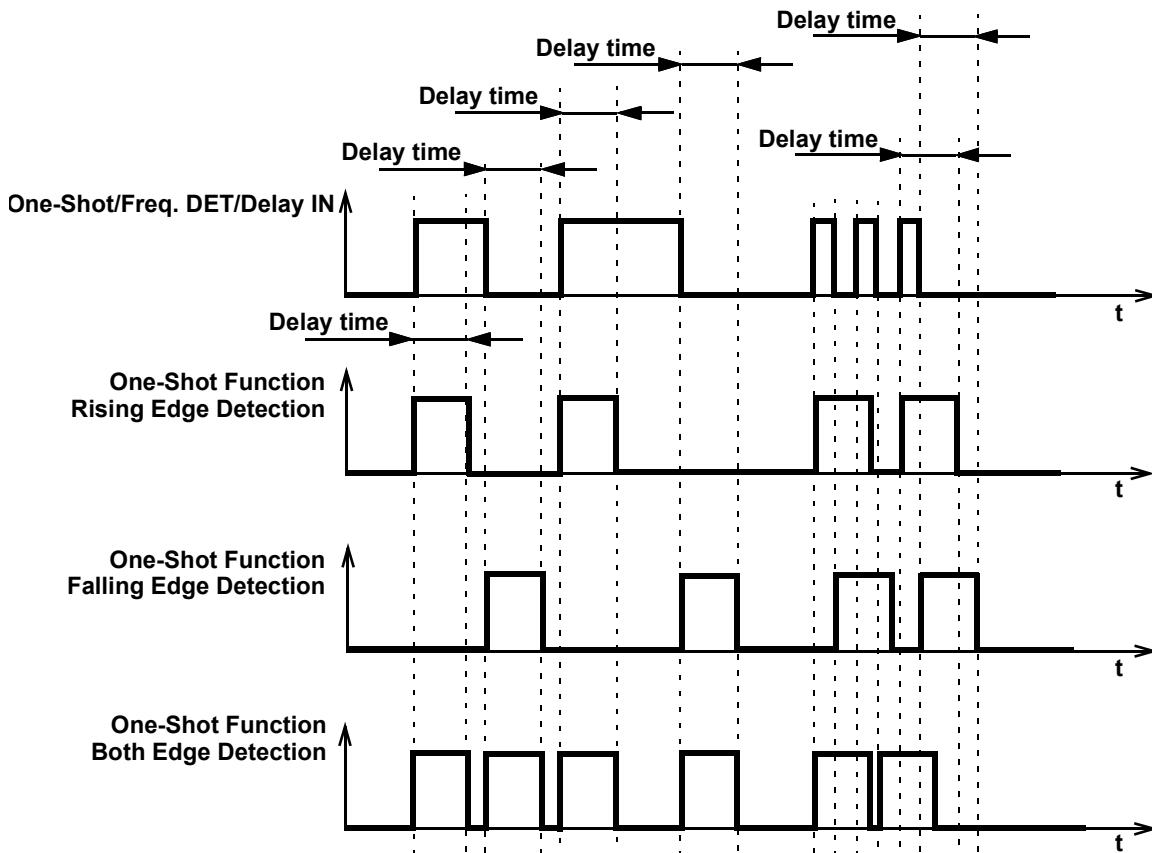


Figure 42: One-Shot Function Timing Diagram

This macrocell generates a high level pulse with a set width (defined by counter data) when detecting the respective edge. It does not restart while pulse is high.

### 8.2.4 Frequency Detection Mode CNT/DLY0 to CNT/DLY7

**Rising Edge:** The output goes high if the time between two successive edges is less than the delay. The output goes low if the second rising edge has not come after the last rising edge in specified time.

**Falling Edge:** The output goes high if the time between two falling edges is less than the set time. The output goes low if the second falling edge has not come after the last falling edge in specified time.

**Both Edge:** The output goes high if the time between the rising and falling edges is less than the set time, which is equivalent to the length of the pulse. The output goes low if after the last rising/falling edge and specified time, the second edge has not come.

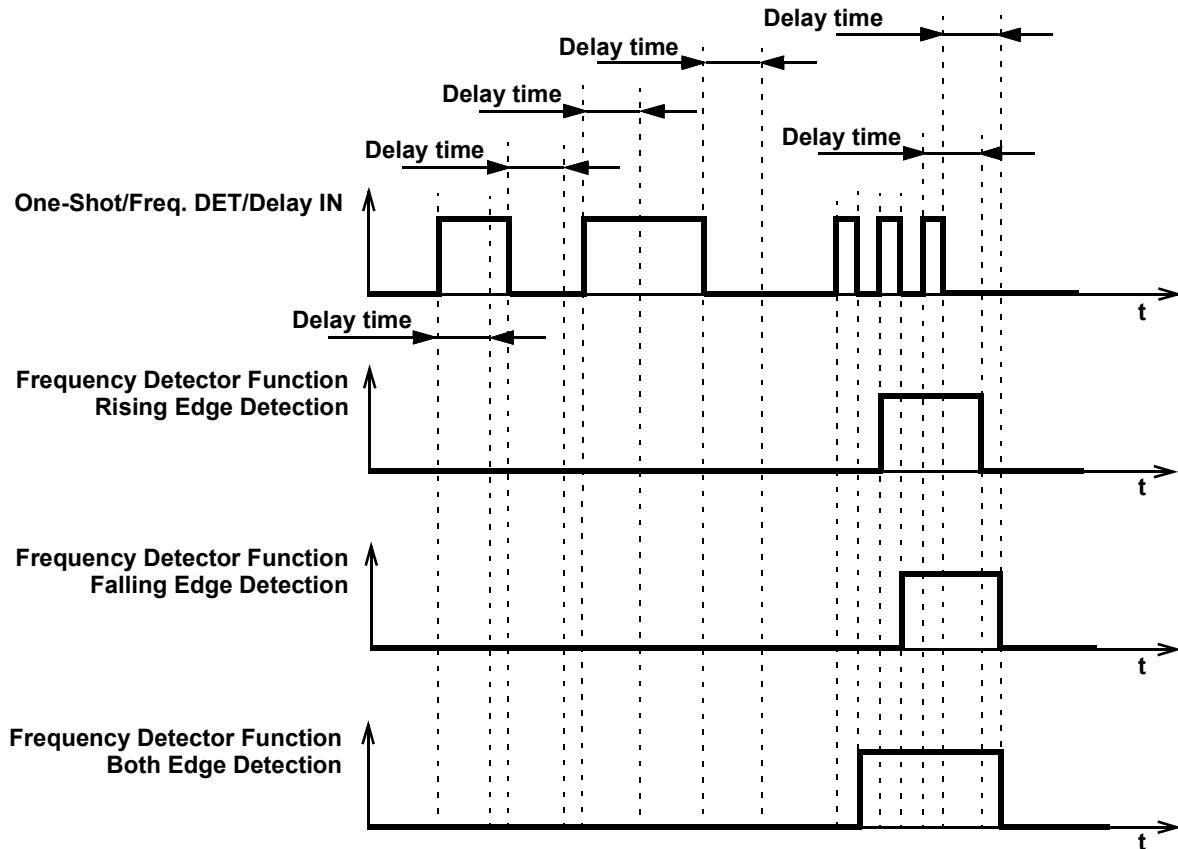


Figure 43: Frequency Detection Mode Timing Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.2.5 Edge Detection Mode CNT/DLY1 to CNT/DLY7

The macrocell generates high level short pulse when detecting the respective edge. See [Table 11](#).

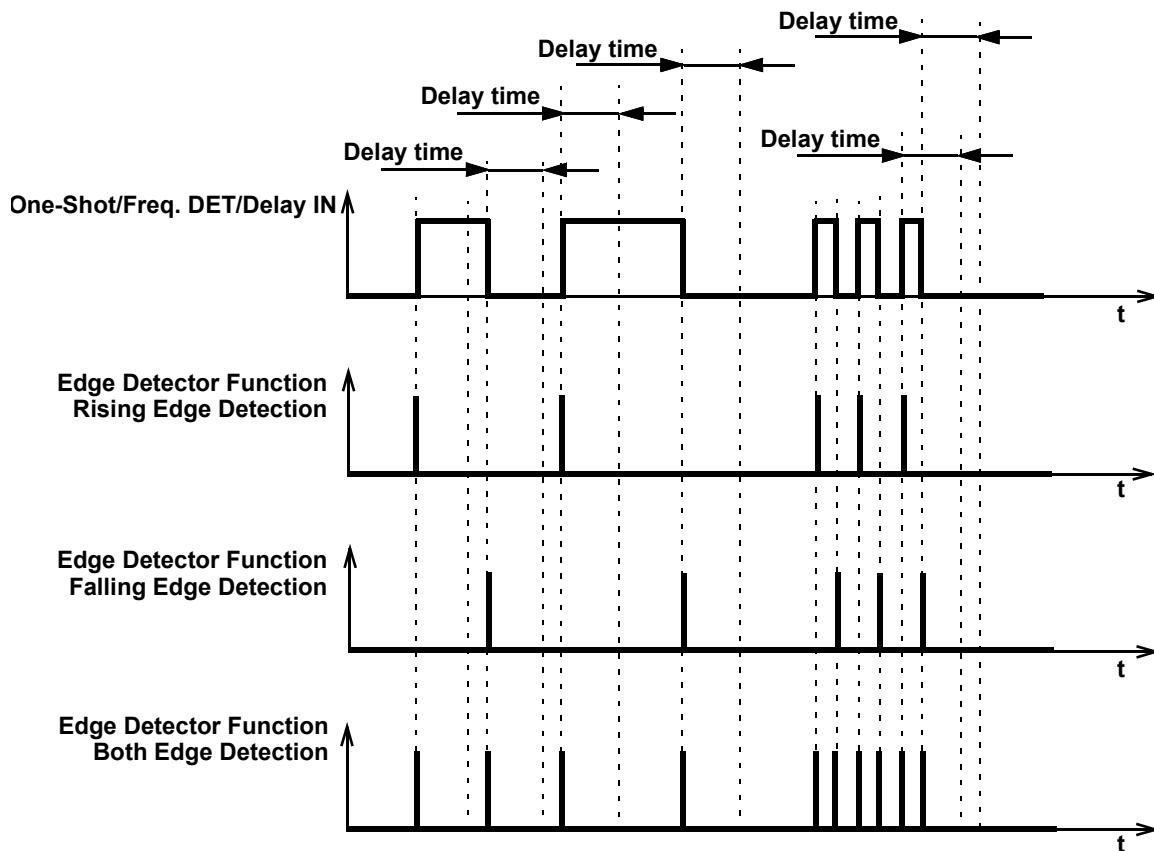


Figure 44: Edge Detection Mode Timing Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.2.6 Delayed Edge Detection Mode CNT/DLY0 to CNT/DLY7

In Delayed Edge Detection Mode, High level short pulses are generated on the macrocell output after the configured delay time, if the corresponding edge was detected on the input.

If the input signal is changed during the set delay time, the pulse will not be generated. See [Figure 45](#).

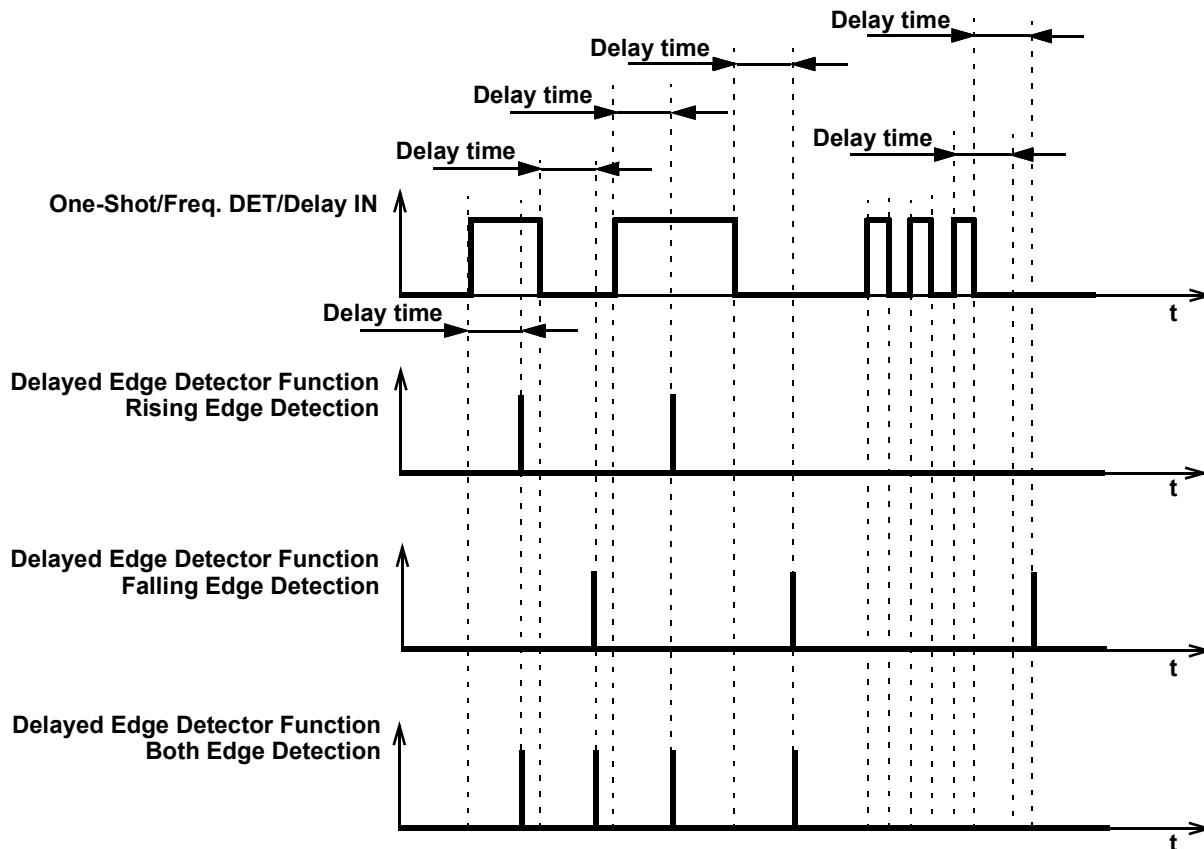


Figure 45: Delayed Edge Detection Mode Timing Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.2.7 CNT/FSM Mode CNT/DLY0

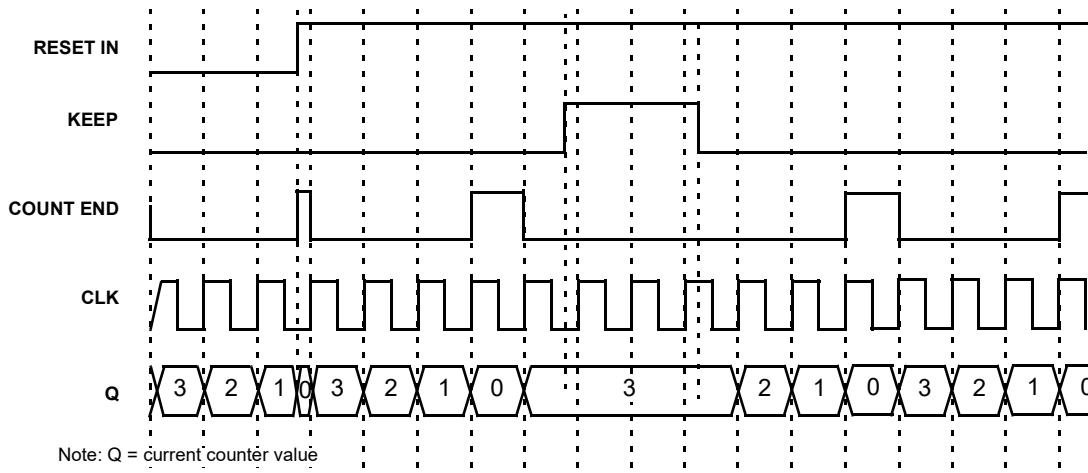


Figure 46: CNT/FSM Timing Diagram (Reset Rising Edge Mode, Oscillator is Forced On, UP = 0) for Counter Data = 3

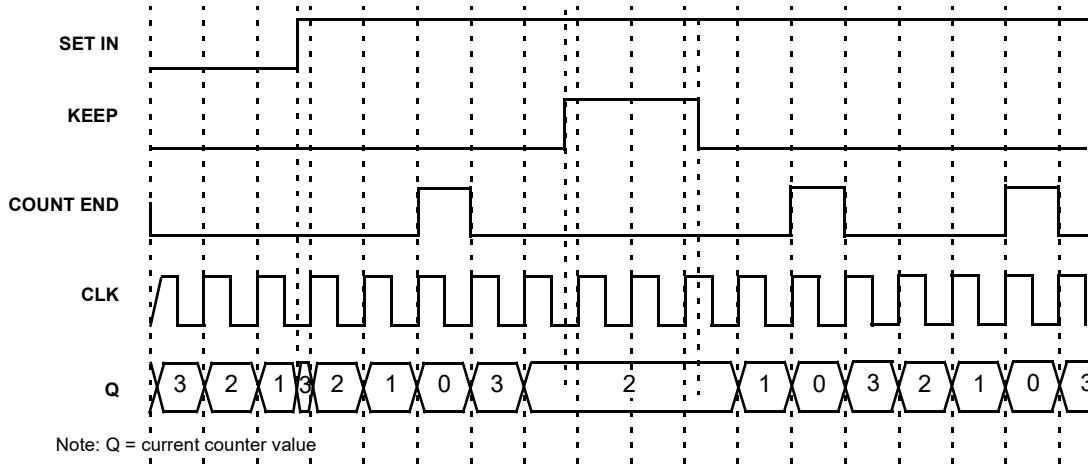


Figure 47: CNT/FSM Timing Diagram (Set Rising Edge Mode, Oscillator is Forced On, UP = 0) for Counter Data = 3

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

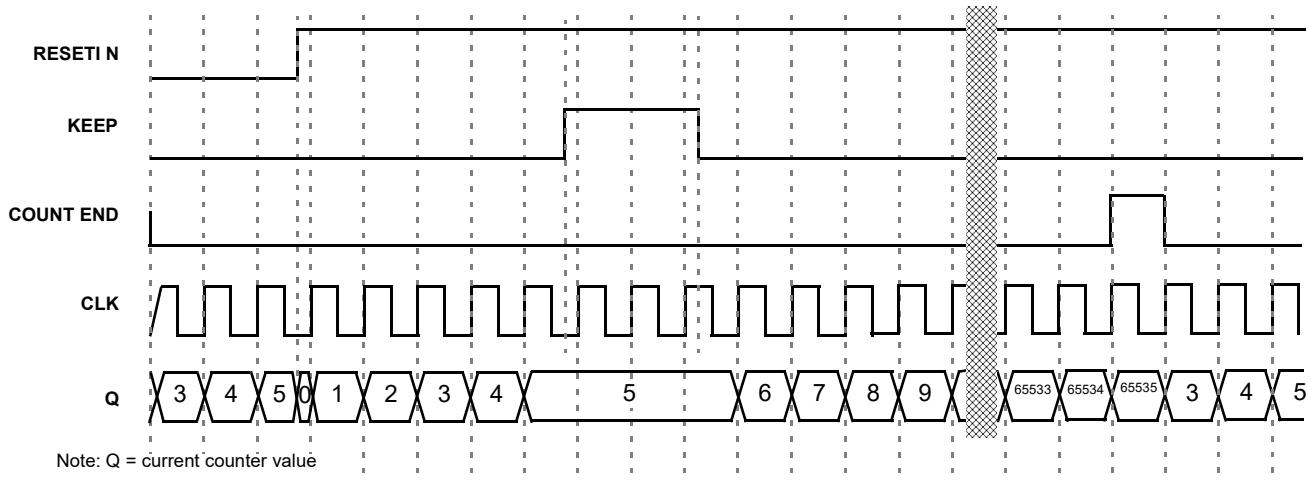


Figure 48: CNT/FSM Timing Diagram (Reset Rising Edge Mode, Oscillator is Forced On, UP = 1) for Counter Data = 3

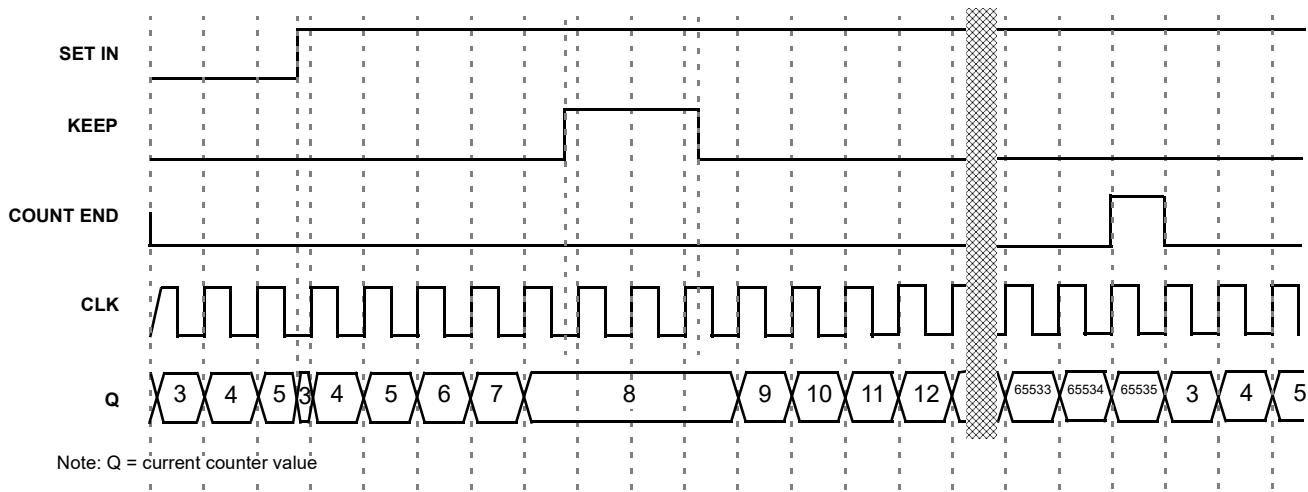


Figure 49: CNT/FSM Timing Diagram (Set Rising Edge Mode, Oscillator is Forced On, UP = 1) for Counter Data = 3

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.2.8 Difference in Counter Value for Counter, Delay, One-Shot, and Frequency Detect Modes

There is a difference in counter value for Counter and Delay/One-Shot/Frequency Detect modes. The counter value is shifted for two rising edges of the clock signal in Delay/One-Shot/Frequency Detect modes compared to Counter mode. See [Figure 50](#).

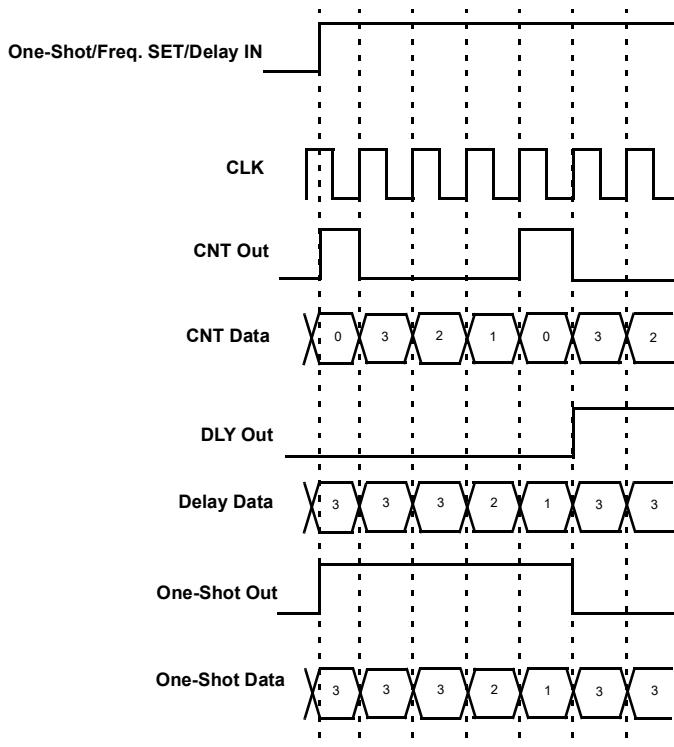


Figure 50: Counter Value, Counter Data = 3

### 8.3 4-BIT LUT OR DFF/LATCH WITH 16-BIT COUNTER/DELAY MACROCELL

There is one macrocell that can serve as either 4-bit LUT/D Flip-Flop or as 16-bit Counter/Delay.

When used to implement LUT function, the 4-bit LUT takes in four input signals from the Connection Matrix and produces a single output, which goes back into the Connection Matrix or can be connected to CNT/DLY's input or LUT/DFF's input.

When used to implement D Flip-Flop function, the two input signals from the connection matrix go to the data (D) and clock (CLK) inputs for the Flip-Flop, with the output going back to the connection matrix.

When used to implement 16-Bit Counter/Delay function, two of the four input signals from the connection matrix go to the external clock (EXT\_CLK) and reset (DLY\_IN/CNT Reset) for the counter/delay, with the output going back to the connection matrix.

This macrocell has an optional Finite State Machine (FSM) function. There are two additional matrix inputs for Up and Keep to support FSM functionality.

This macrocell can also operate in a one-shot mode, which will generate an output pulse of user-defined width. This macrocell can also operate in a frequency detection. This macrocell can have its active count value read via I<sup>2</sup>C. See Section [15.7.1](#) for further details.

**Note:** After two DFF – counters initialize with counter data = 0 after POR.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Initial state = 1 – counters initialize with counter data = 0 after POR.

Initial state = 0 And After two DFF is bypass – counters initialize with counter data after POR.

### 8.3.1 4-Bit LUT or 16-Bit CNT/DLY Block Diagram

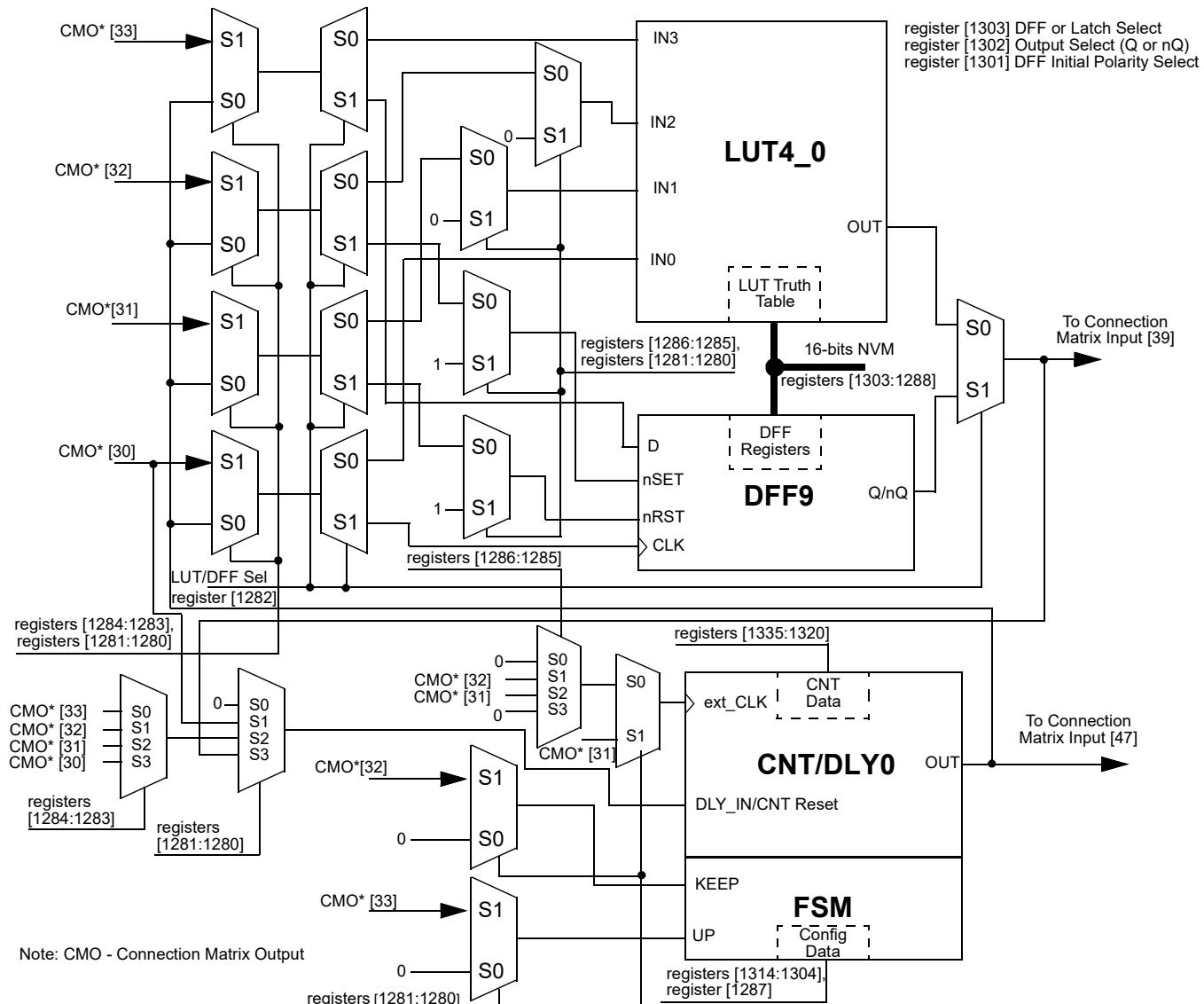


Figure 51: 4-bit LUT0 or CNT/DLY0

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 8.3.2 4-Bit LUT or 16-Bit Counter/Delay Macrocells Used as 4-Bit LUTs

**Table 41: 4-bit LUT0 Truth Table**

IN3	IN2	IN1	IN0	OUT	
0	0	0	0	register [1288]	LSB
0	0	0	1	register [1289]	
0	0	1	0	register [1290]	
0	0	1	1	register [1291]	
0	1	0	0	register [1292]	
0	1	0	1	register [1293]	
0	1	1	0	register [1294]	
0	1	1	1	register [1295]	
1	0	0	0	register [1296]	
1	0	0	1	register [1297]	
1	0	1	0	register [1298]	
1	0	1	1	register [1299]	
1	1	0	0	register [1300]	
1	1	0	1	register [1301]	
1	1	1	0	register [1302]	
1	1	1	1	register [1303]	MSB

This macrocell, when programmed for a LUT function, uses a 16-bit register to define their output function:

*4-Bit LUT0 is defined by registers [1303:1288]*

**Table 42: 4-bit LUT Standard Digital Functions**

Function	MSB																LSB
AND-4	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NAND-4	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
OR-4	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	
NOR-4	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	
XOR-4	0	1	1	0	1	0	0	1	1	0	0	1	0	1	1	0	
XNOR-4	1	0	0	1	0	1	1	0	0	1	1	0	1	0	0	1	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 9 Analog Comparators

There are two General Purpose Rail-to-Rail Analog Comparator (ACMP) macrocells in the SLG46824. In order for the ACMP cells to be used in a GreenPAK design, the power up signals (ACMP0L PWR UP, and ACMP1L PWR UP) need to be active. By connecting to signals coming from the Connection Matrix, it is possible to have each ACMP be on continuously, off continuously, or switched on periodically based on a digital signal coming from the Connection Matrix. When ACMP is powered down, output is low.

ACMPs are optimized for low power operation.

Each of the ACMP cells has a positive input signal that can be provided by a variety of external sources, and can also have a selectable gain stage before connection to the analog comparator. Each of the ACMP cells has a negative input signal that is either created from an internal Vref or provided by way of the external sources.

PWR UP = 1 → ACMP is powered up.

PWR UP = 0 → ACMP is powered down.

During power-up, the ACMP output will remain LOW, and then become valid 51.4 µs (max) after power up signal goes high for ACMP0L and ACMP1L. Input bias current < 1 nA (typ). The Gain divider is unbuffered and consists of 1 MΩ resistors.

Each cell also has a hysteresis selection, to offer hysteresis of (0, 32, 64, 192) mV. The hysteresis option is available when using an internal Vref only.

ACMP0L IN+ options are IO12

ACMP1L IN+ options are IO11

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 9.1 ACMP0L BLOCK DIAGRAM

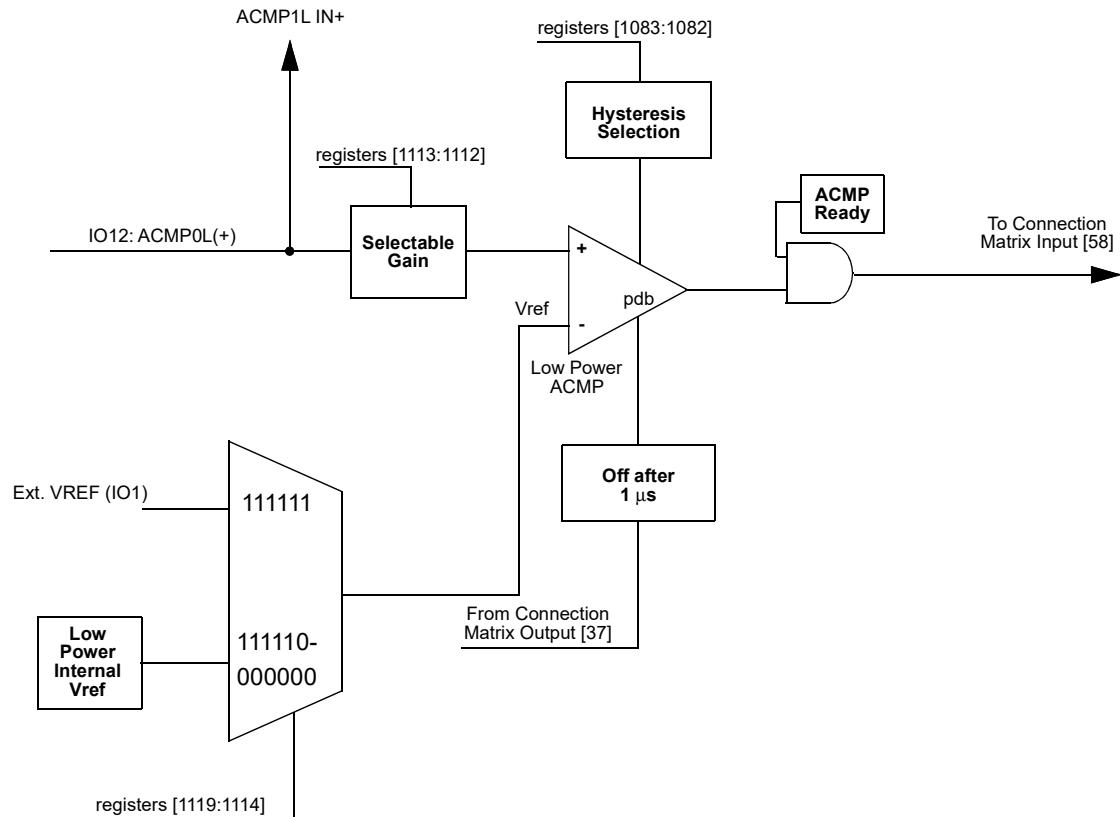


Figure 52: ACMP0L Block Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 9.2 ACMP1L BLOCK DIAGRAM

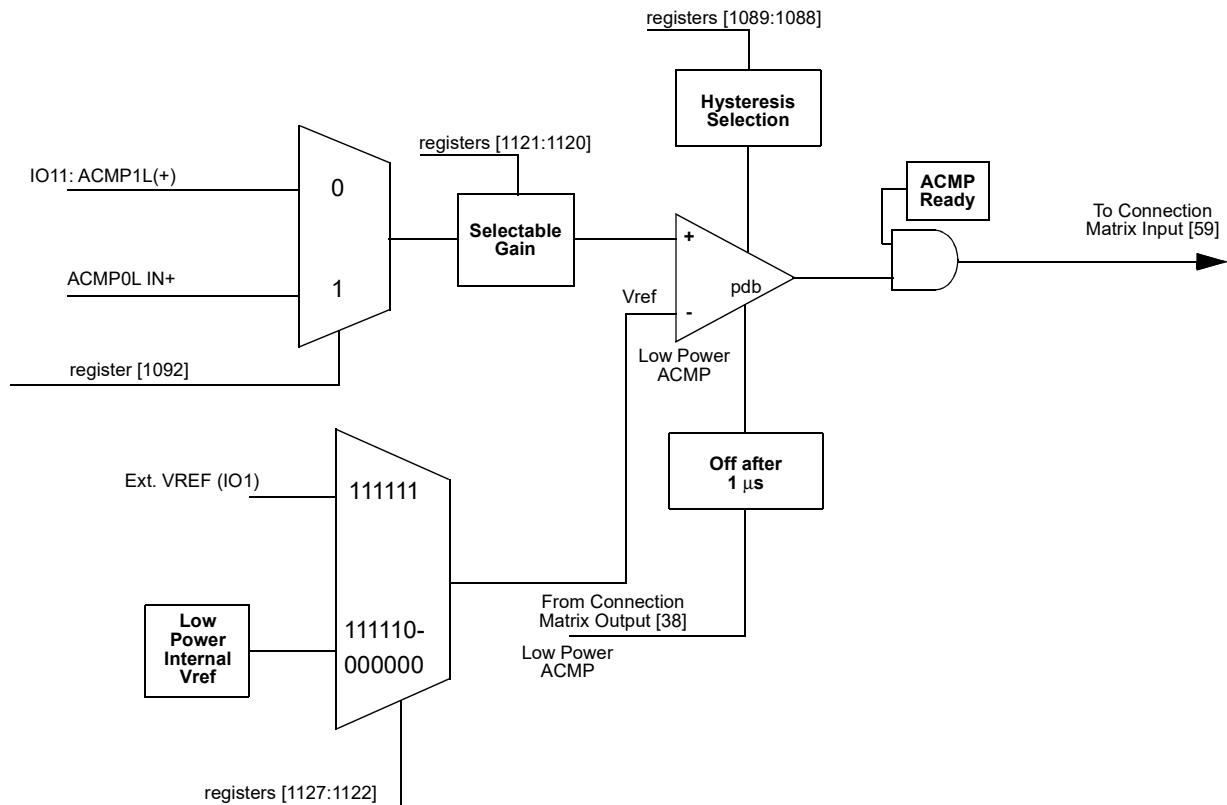


Figure 53: ACMP0L Block Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 9.3 ACMP TYPICAL PERFORMANCE

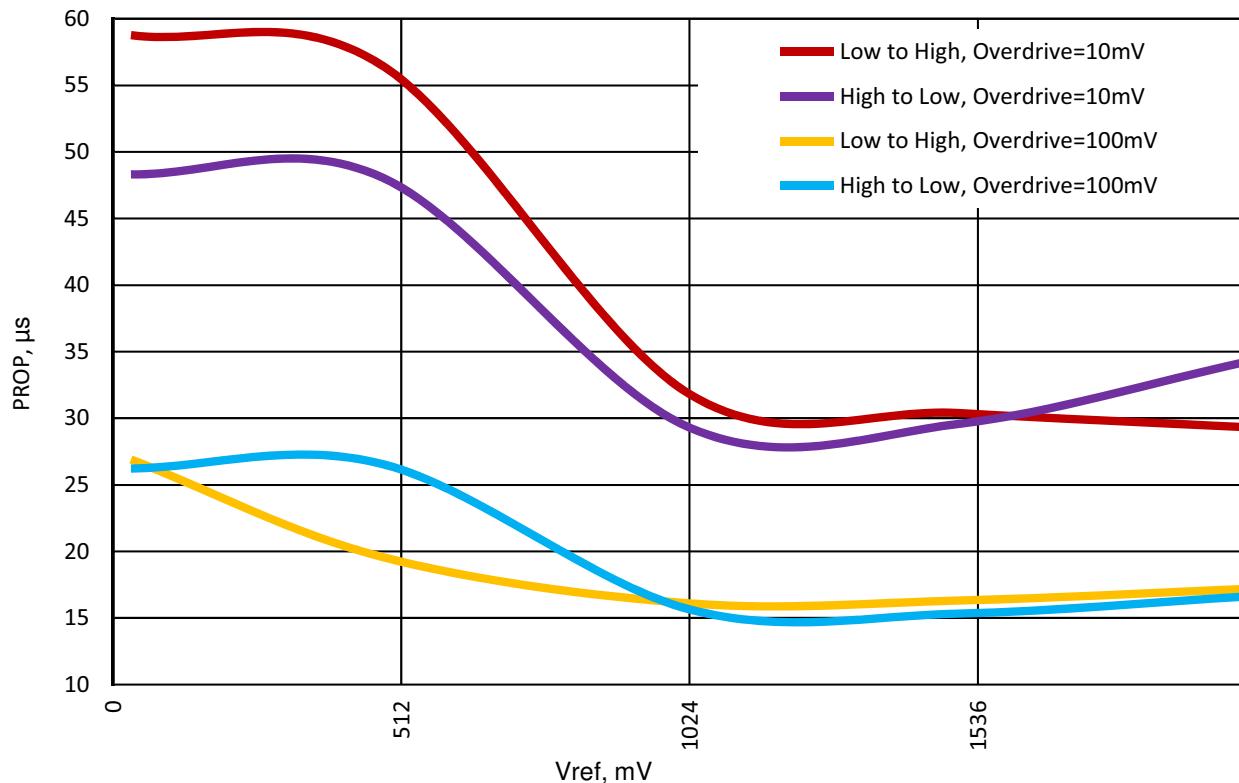


Figure 54: Typical Propagation Delay vs. Vref for ACMPxL at  $T = 25^{\circ}\text{C}$ , Gain = 1, Buffer - Disabled, Hysteresis = 0

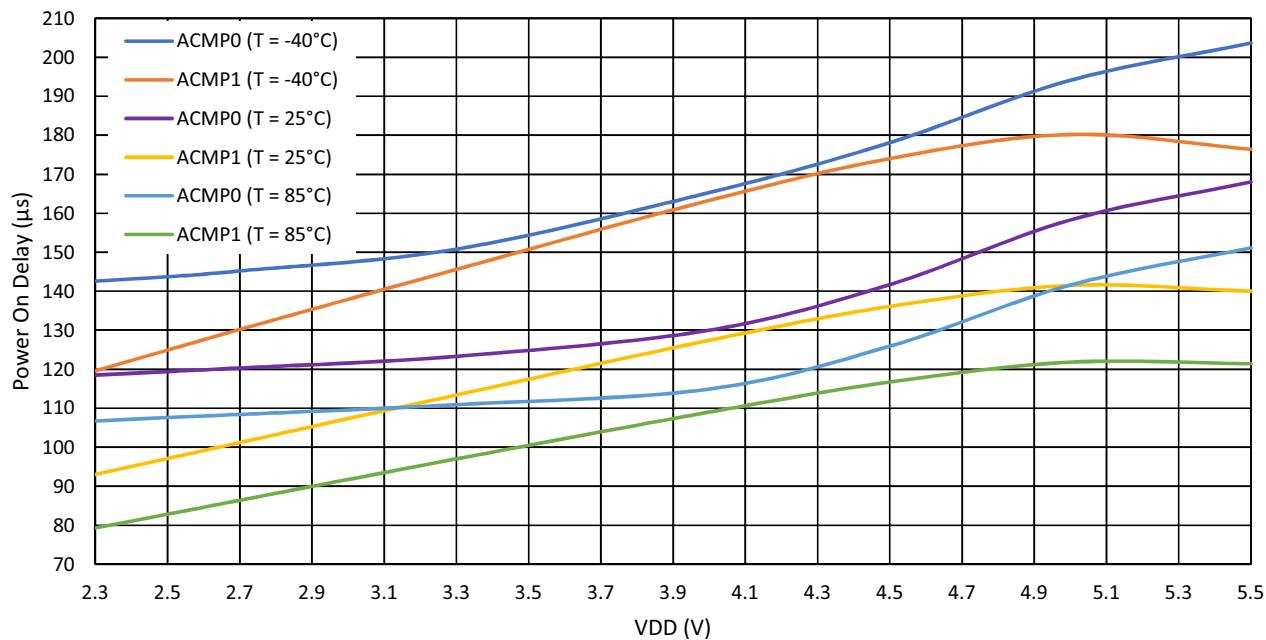


Figure 55: ACMPxL Power-On Delay vs. V<sub>DD</sub>

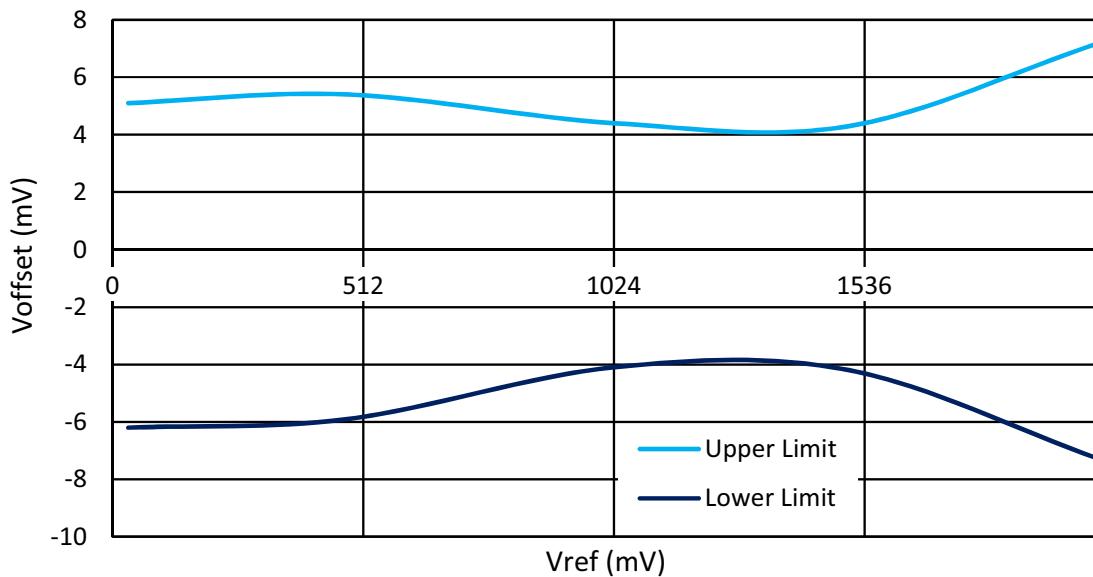


Figure 56: ACMPxL Input Offset Voltage vs. Vref at T = -40 °C to 85 °C

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 10 Programmable Delay/Edge Detector

The SLG46824 has a programmable time delay logic cell available that can generate a delay that is selectable from one of four timings (time 2) configured in the GreenPAK Designer. The programmable time delay cell can generate one of four different delay patterns, rising edge detection, falling edge detection, both edge detection, and both edge delay. These four patterns can be further modified with the addition of delayed edge detection, which adds an extra unit of delay as well as glitch rejection during the delay period. See [Figure 58](#) for further information.

**Note 1:** The input signal must be longer than the delay, otherwise it will be filtered out.

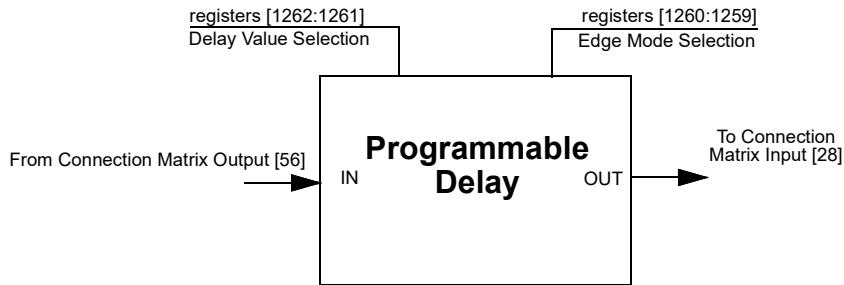


Figure 57: Programmable Delay

#### 10.1 PROGRAMMABLE DELAY TIMING DIAGRAM - EDGE DETECTOR OUTPUT

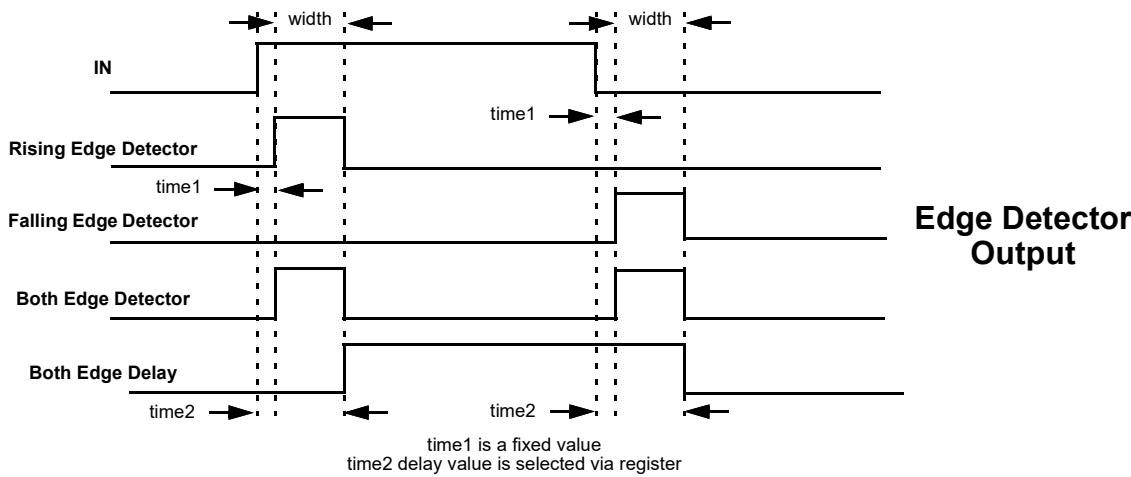


Figure 58: Edge Detector Output

Please refer to [Table 11](#).

## 11 Additional Logic Function. Deglitch Filter

The SLG46824 has one Deglitch Filter macrocell with inverter function that is connected directly to the Connection Matrix inputs and outputs. In addition, this macrocell can be configured as an Edge Detector, with the following settings:

- Rising Edge Detector
- Falling Edge Detector
- Both Edge Detector
- Both Edge Delay

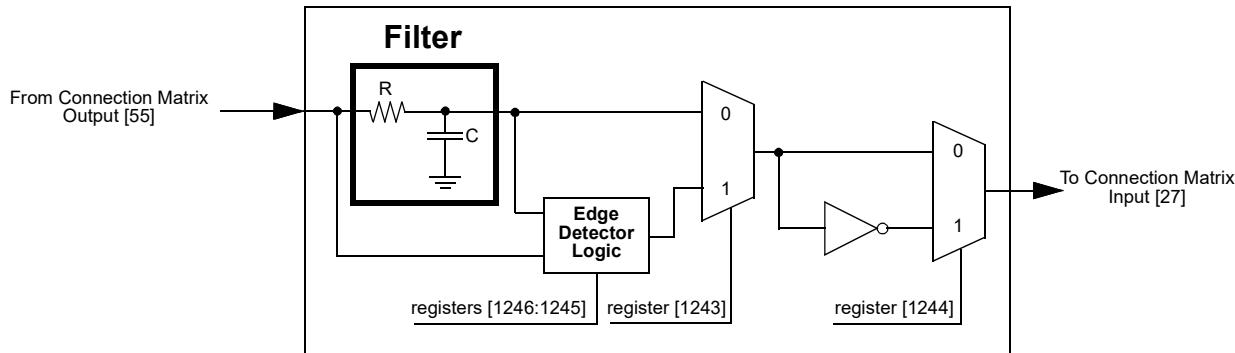


Figure 59: Deglitch Filter or Edge Detector

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 12 Voltage Reference

#### 12.1 VOLTAGE REFERENCE OVERVIEW

The SLG46824 has a Voltage Reference (Vref) Macrocell to provide references to the two analog comparators. This macrocell can supply a user selection of fixed voltage reference. The macrocell also has the option to output reference voltage on IO9. See [Table 43](#) for the available selections for each analog comparator. Also see [Figure 60](#), which shows the reference output structure.

#### 12.2 VREF SELECTION TABLE

**Table 43: Vref Selection Table**

SEL[5:0]	Vref	SEL[5:0]	Vref
0	0.032	32	1.056
1	0.064	33	1.088
2	0.096	34	1.12
3	0.128	35	1.152
4	0.16	36	1.184
5	0.192	37	1.216
6	0.224	38	1.248
7	0.256	39	1.28
8	0.288	40	1.312
9	0.32	41	1.344
10	0.352	42	1.376
11	0.384	43	1.408
12	0.416	44	1.44
13	0.448	45	1.472
14	0.48	46	1.504
15	0.512	47	1.536
16	0.544	48	1.568
17	0.576	49	1.6
18	0.608	50	1.632
19	0.64	51	1.664
20	0.672	52	1.696
21	0.704	53	1.728
22	0.736	54	1.76
23	0.768	55	1.792
24	0.8	56	1.824
25	0.832	57	1.856
26	0.864	58	1.888
27	0.896	59	1.92
28	0.928	60	1.952
29	0.96	61	1.984
30	0.992	62	2.016
31	1.024	63	External

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 12.3 VREF BLOCK DIAGRAM

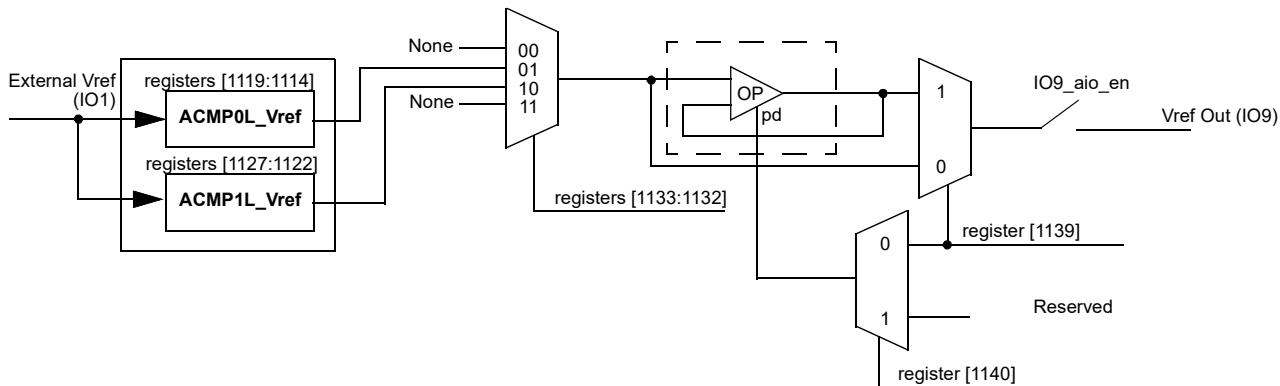


Figure 60: Voltage Reference Block Diagram

### 12.4 VREF LOAD REGULATION

**Note 1** It is not recommended to use Vref connected to external pin without buffer.

**Note 2** Vref buffer performance is not guaranteed at  $V_{DD} < 2.7$  V.

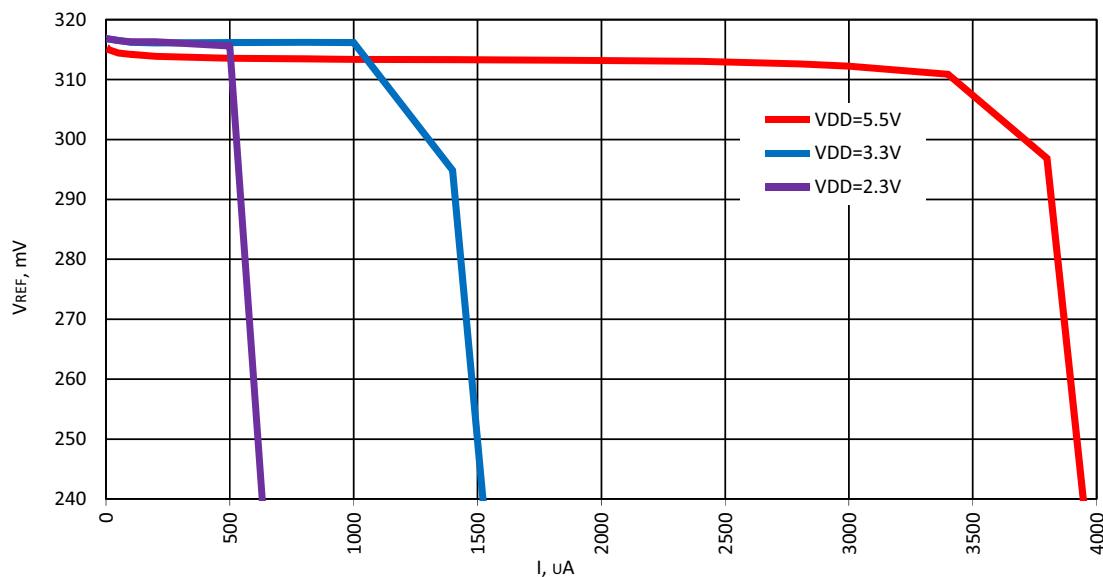
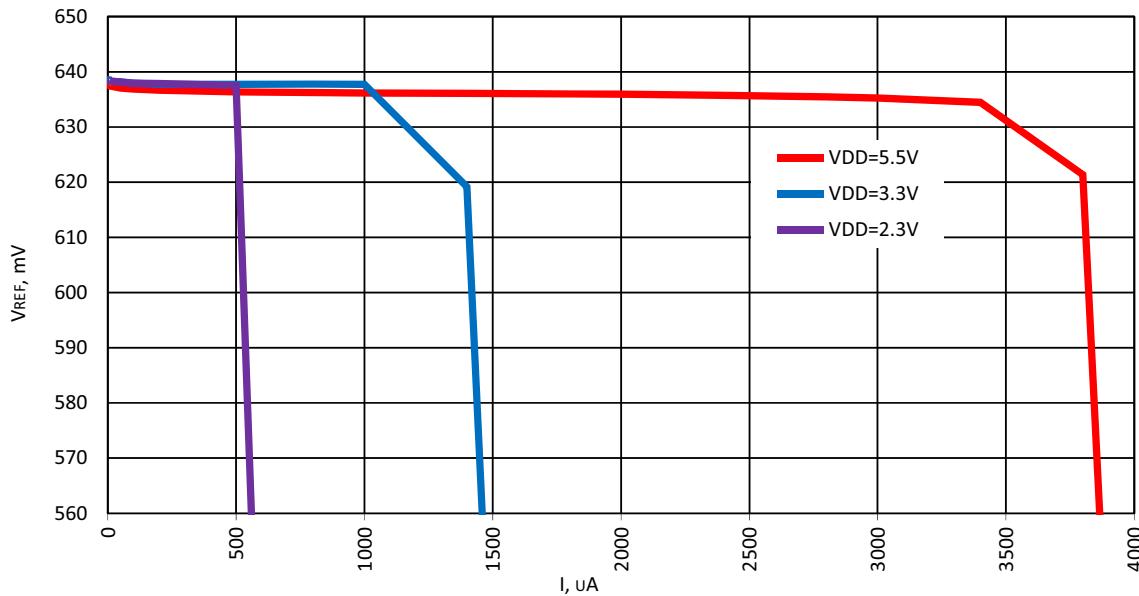
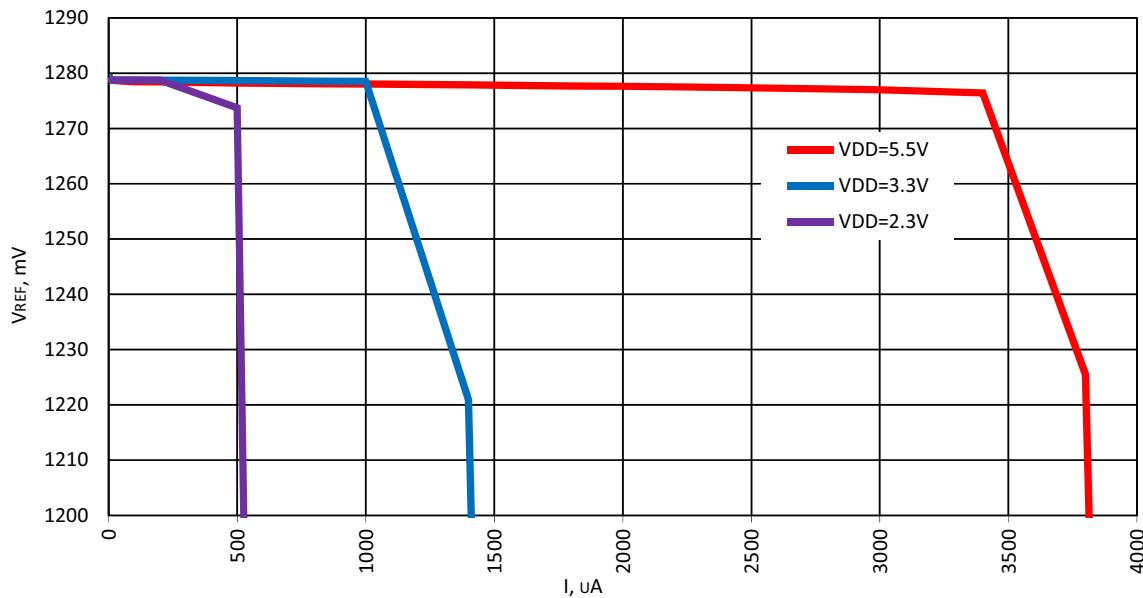
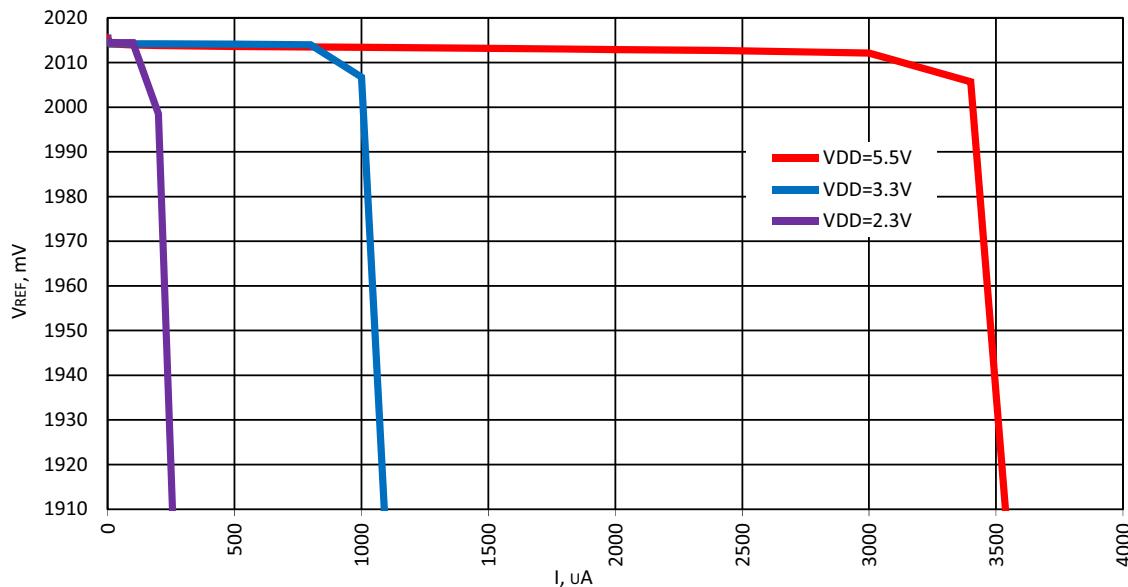


Figure 61: Typical Load Regulation,  $V_{REF} = 320$  mV,  $T = -40$  °C to +85 °C, Buffer - Enable

**GreenPAK Programmable Mixed-Signal Matrix with In System  
Programmability****Figure 62: Typical Load Regulation,  $V_{ref} = 640$  mV,  $T = -40$  °C to +85 °C, Buffer - Enable****Figure 63: Typical Load Regulation,  $V_{ref} = 1280$  mV,  $T = -40$  °C to +85 °C, Buffer - Enable**

**GreenPAK Programmable Mixed-Signal Matrix with In System  
Programmability****Figure 64: Typical Load Regulation,  $V_{ref} = 2016 \text{ mV}$ ,  $T = -40 \text{ }^{\circ}\text{C}$  to  $+85 \text{ }^{\circ}\text{C}$ , Buffer - Enable**

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 13 Clocking

#### 13.1 OSCILLATOR GENERAL DESCRIPTION

The SLG46824 has three internal oscillators to support a variety of applications:

- Oscillator0 (2.048 kHz)
- Oscillator1 (2.048 MHz)
- Oscillator2 (25 MHz)

There are two divider stages for each oscillator that gives the user flexibility for introducing clock signals to connection matrix, as well as various other Macrocells. The pre-divider (first stage) for Oscillator allows the selection of /1, /2, /4 or /8 to divide down frequency from the fundamental. The second stage divider has an input of frequency from the pre-divider, and outputs one of eight different frequencies divided by /1, /2, /3, /4, /8, /12, /24 or /64 on Connection Matrix Input lines [27], [28], and [29]. Please see [Figure 68](#) for more details on the SLG46824 clock scheme.

Oscillator2 (25 MHz) has an additional function of 100 ns delayed startup, which can be enabled/disabled by register [1052]. This function is recommended to use when analog blocks are used along with the Oscillator.

The Matrix Power-down/Force On function allows switching off or force on the oscillator using an external pin. The Matrix Power-down/Force On (Connection Matrix Output [72], [73], [74]) signal has the highest priority. The OSC operates according to the [Table 44](#).

**Table 44: Oscillator Operation Mode Configuration Settings**

POR	External Clock Selection	Signal From Connection Matrix	Register: Power-Down or Force On by Matrix Input	Register: Auto Power-On or Force On	OSC Enable Signal from CNT/DLY Macrocells	OSC Operation Mode
0	X	X	X	X	X	OFF
1	1	X	X	X	X	Internal OSC is OFF, logic is ON
1	0	1	0	X	X	OFF
1	0	1	1	X	X	ON
1	0	0	X	1	X	ON
1	0	0	X	0	CNT/DLY re-quires OSC	ON
1	0	0	X	0	CNT/DLY does not require OSC	OFF

**Note 1** The OSC will run only when any macrocell that uses OSC is powered on.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 13.2 OSCILLATOR0 (2.048 KHZ)

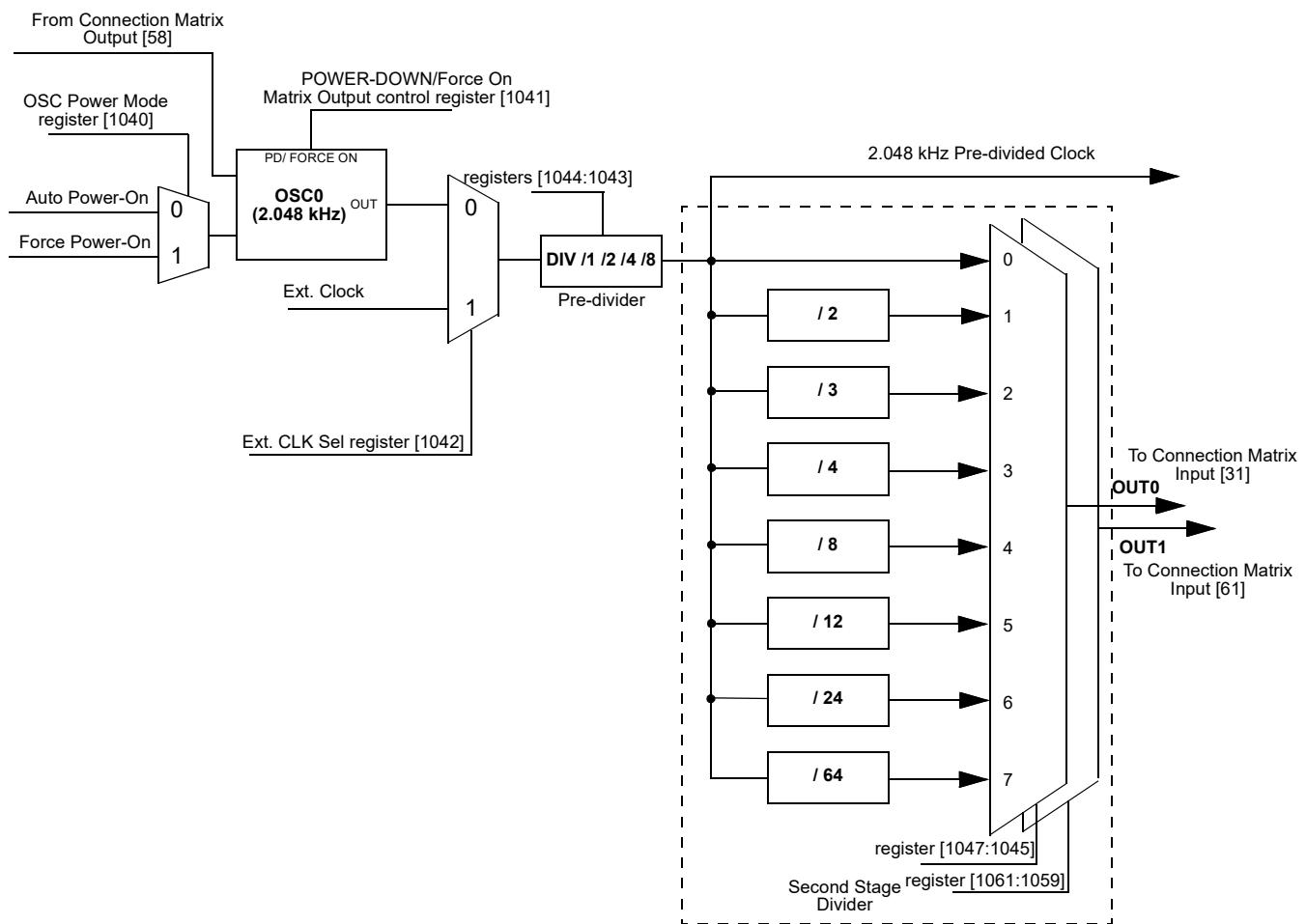


Figure 65: Oscillator0 Block Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 13.3 OSCILLATOR1 (2.048 MHZ)

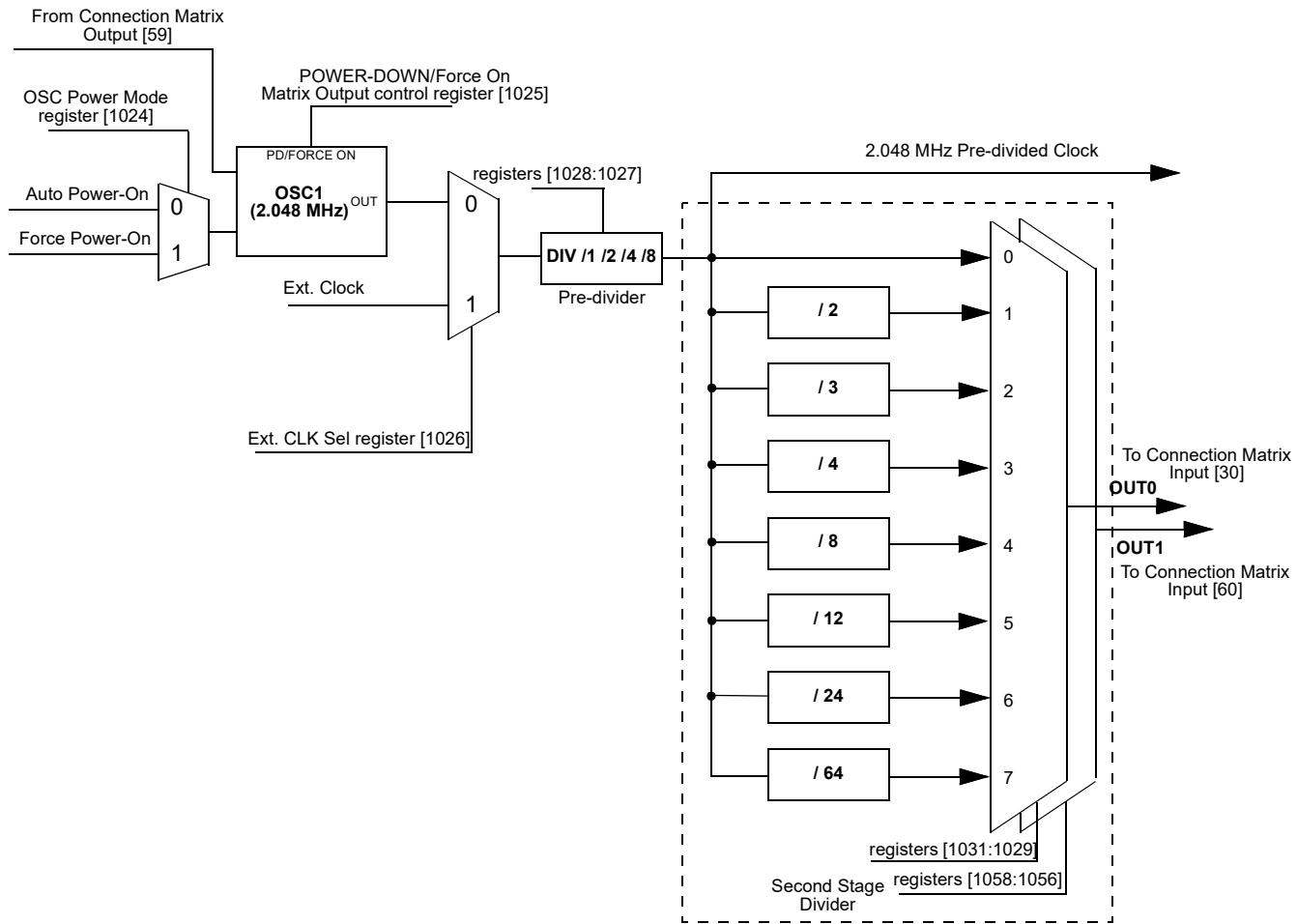
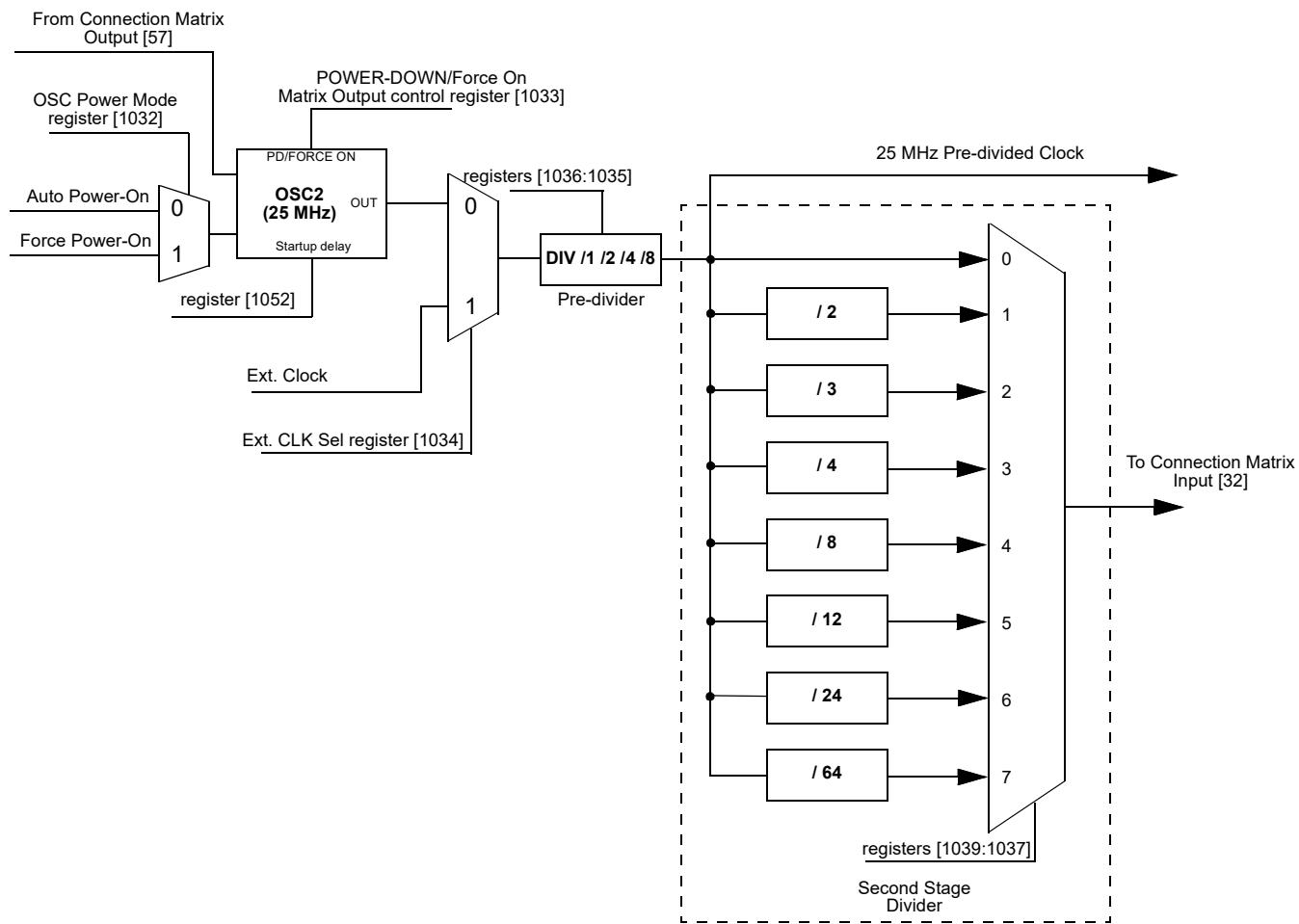


Figure 66: Oscillator1 Block Diagram

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 13.4 OSCILLATOR2 (25 MHZ)



**Figure 67: Oscillator2 Block Diagram**

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 13.5 CNT/DLY CLOCK SCHEME

Each CNT/DLY within Multi-Function macrocell has its own additional clock divider connected to oscillators pre-divider. Available dividers are:

- OSC0/1, OSC0/8, OSC0/64, OSC0/512, OSC0/4096, OSC0/32768, OSC0/262144
- OSC1/1, OSC1/8, OSC1/64, OSC1/512
- OSC2/1, OSC2/4

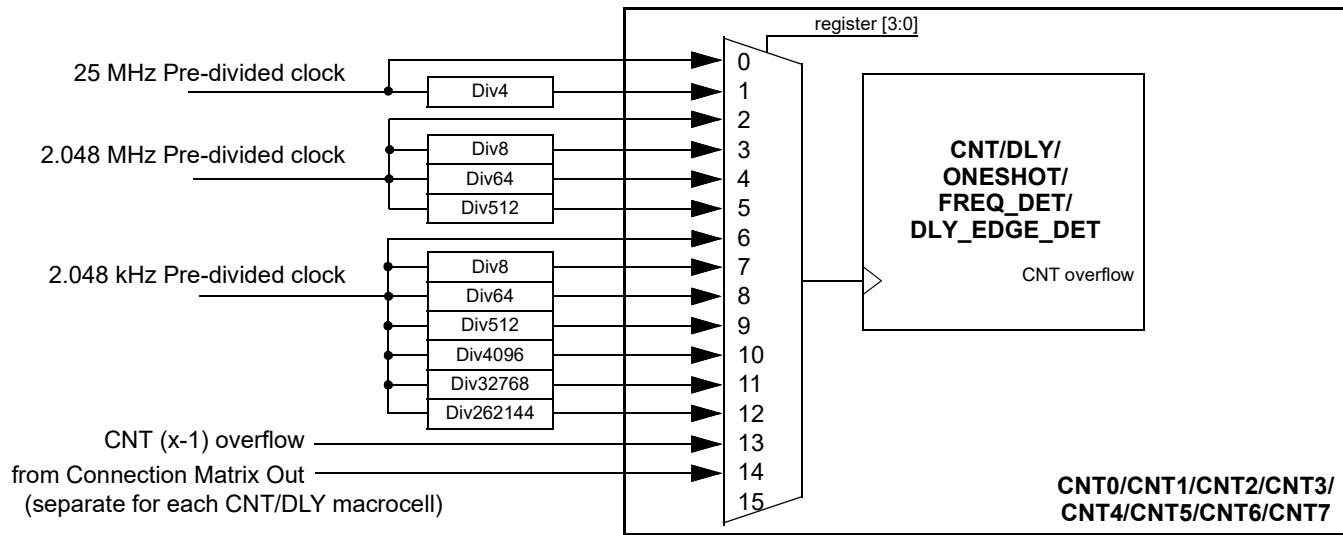


Figure 68: Clock Scheme

### 13.6 EXTERNAL CLOCKING

The SLG46824 supports several ways to use an external, higher accuracy clock as a reference source for internal operations.

#### 13.6.1 IO0 Source for Oscillator0 (2.048 kHz)

When register [1042] is set to 1, an external clocking signal on IO0 will be routed in place of the internal oscillator derived 2.048 kHz clock source. See [Figure 65](#). The high and low limits for frequency that can be selected are 0 MHz and 10 MHz.

#### 13.6.2 IO10 Source for Oscillator1 (2.048 MHz)

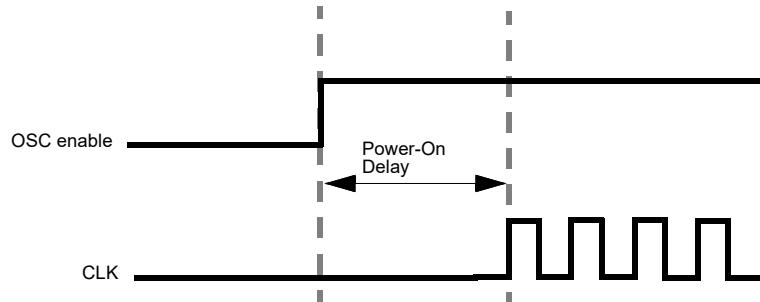
When register [1026] is set to 1, an external clocking signal on IO10 will be routed in place of the internal oscillator derived 2.048 MHz clock source. See [Figure 66](#). The high and low limits for frequency that can be selected are 0 MHz and 10 MHz.

#### 13.6.3 IO8 Source for Oscillator2 (25 MHz)

When register [1034] is set to 1, an external clocking signal on IO8 will be routed in place of the internal oscillator derived 25 MHz clock source. See [Figure 67](#). The external frequency range is 0 MHz to 20 MHz at  $V_{DD} = 2.3$  V, 0 MHz to 30 MHz at  $V_{DD} = 3.3$  V, 0 MHz to 50 MHz at  $V_{DD} = 5.0$  V. When an external clock is selected for OSC2, the oscillator's output signal will be inverted with respect to the IO8 input signal.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

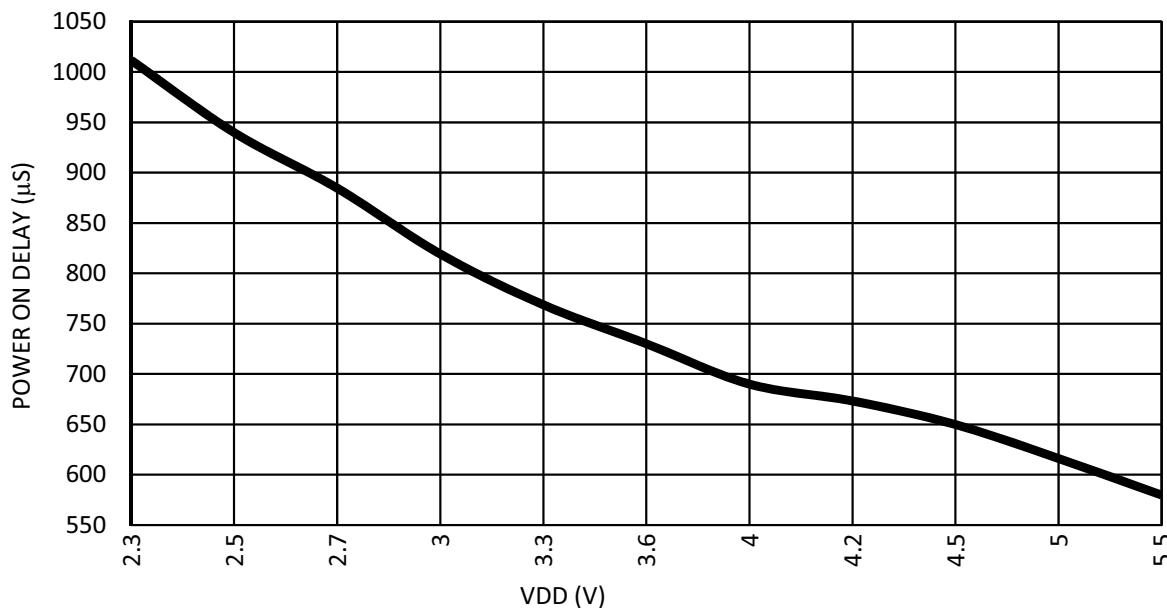
### 13.7 OSCILLATORS POWER-ON DELAY



**Figure 69: Oscillator Startup Diagram**

**Note 1** OSC power mode: "Auto Power-On".

**Note 2** "OSC enable" signal appears when any macrocell that uses OSC is powered on.



**Figure 70: Oscillator0 Maximum Power-On Delay vs.  $V_{DD}$  at  $T = 25^{\circ}\text{C}$ , OSC0 = 2.048 kHz**

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

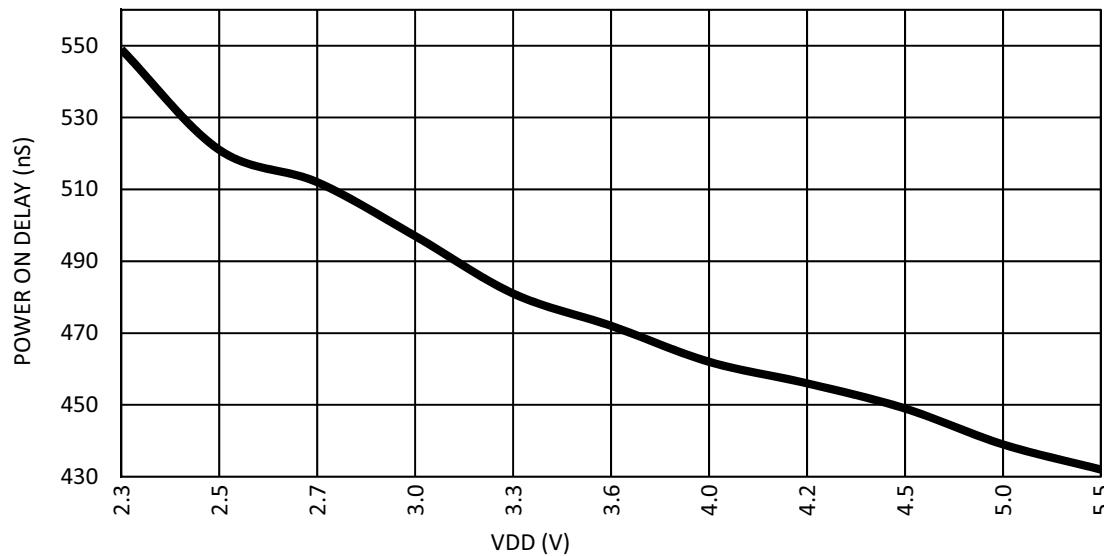


Figure 71: Oscillator1 Maximum Power-On Delay vs.  $V_{DD}$  at  $T = 25^\circ\text{C}$ ,  $\text{OSC1} = 2.048 \text{ MHz}$

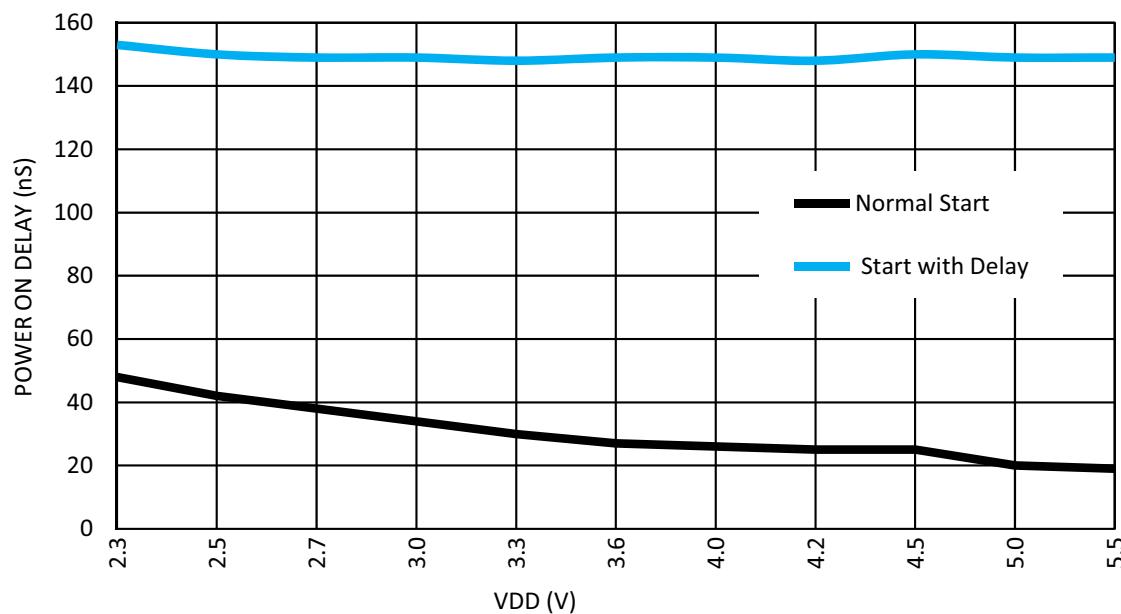


Figure 72: Oscillator2 Maximum Power-On Delay vs.  $V_{DD}$  at  $T = 25^\circ\text{C}$ ,  $\text{OSC2} = 25 \text{ MHz}$

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 13.8 OSCILLATORS ACCURACY

Note: OSC power setting: Force Power-On; Clock to matrix input - enable; Bandgap: turn on by register - enable.

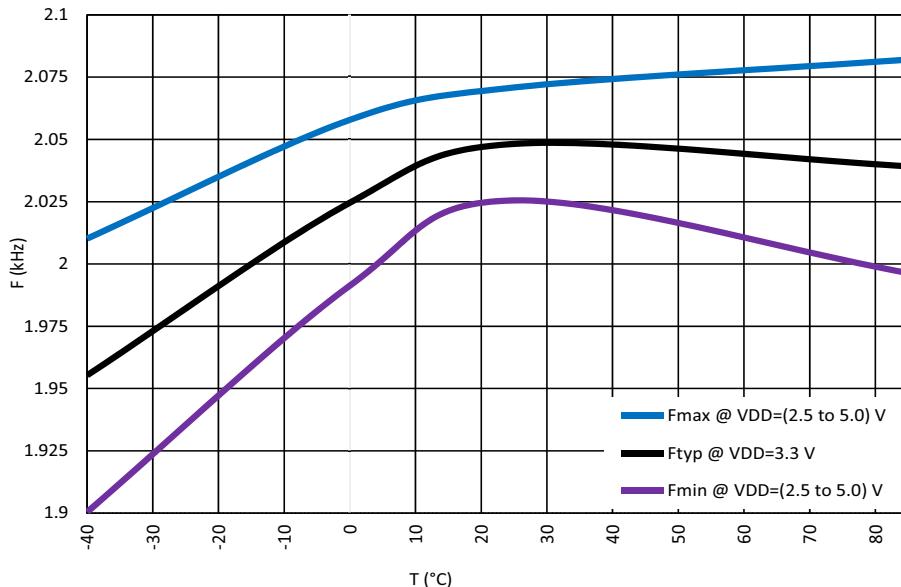


Figure 73: Oscillator0 Frequency vs. Temperature, OSC0 = 2.048 kHz

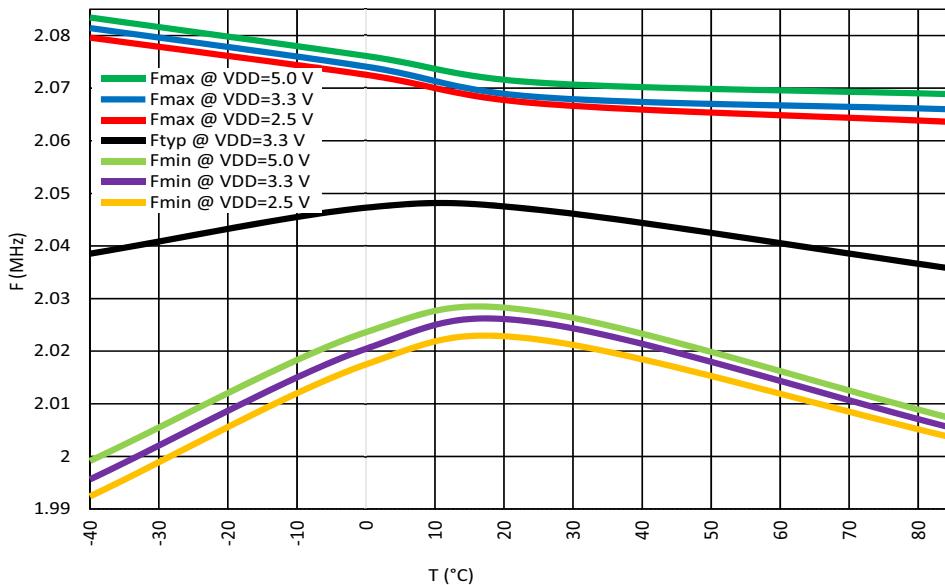
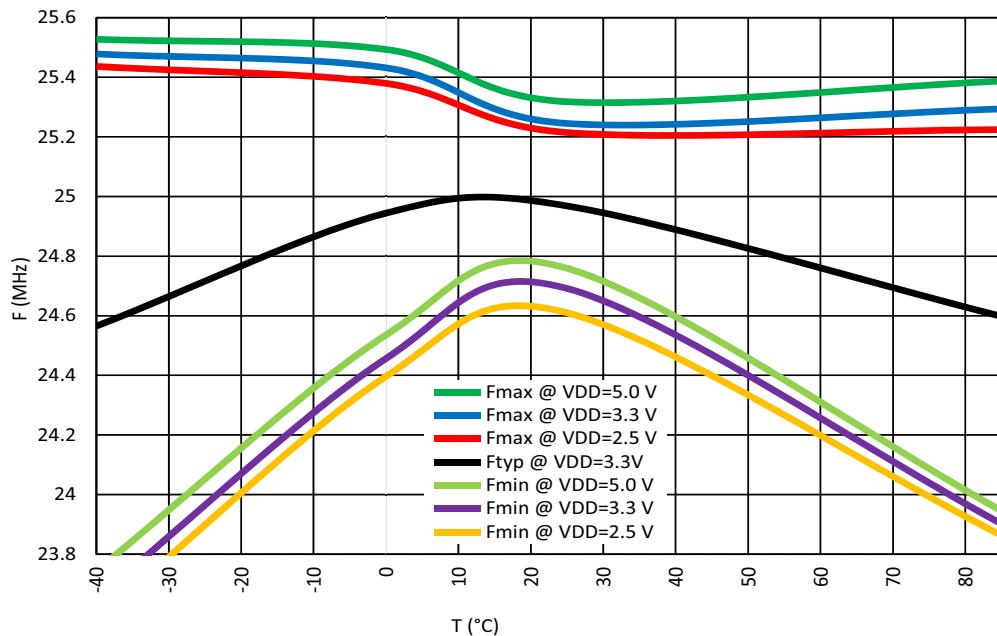
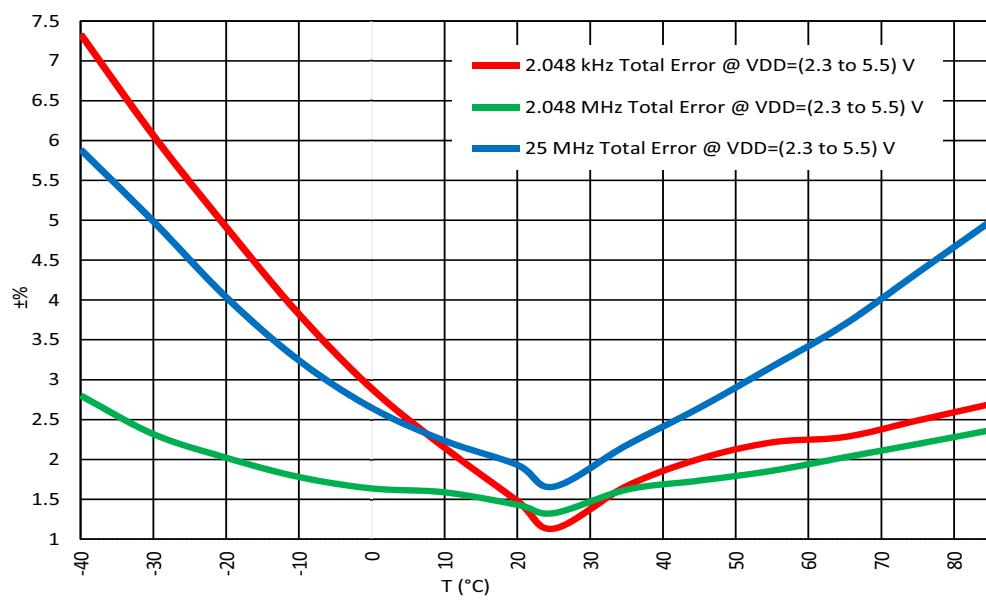


Figure 74: Oscillator1 Frequency vs. Temperature, OSC1 = 2.048 MHz

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability



**Figure 75: Oscillator2 Frequency vs. Temperature, OSC2 = 25 MHz**



**Figure 76: Oscillators Total Error vs. Temperature**

**Note:** For more information see Section 3.6.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 45: Oscillator Output Duty Cycle

Pre-divider	Second Stage Divider									
	OSC0 OSC1	OSC2	OSC0 OSC1 OSC2	OSC0 OSC1	OSC2	OSC0 OSC1 OSC2	OSC0 OSC1 OSC2	OSC0 OSC1 OSC2	OSC0 OSC1 OSC2	OSC0 OSC1 OSC2
	1	2	3	4	8	12	24	64		
1	50	60	50	33.3	66	50	50	50	50	50
2	50	50	50	33.3	66	50	50	50	50	50
4	50	50	50	33.3	66	50	50	50	50	50
8	50	50	50	33.3	66	50	50	50	50	50

## 14 Power-On Reset

The SLG46824 has a Power-On Reset (POR) macrocell to ensure correct device initialization and operation of all macrocells in the device. The purpose of the POR circuit is to have consistent behavior and predictable results when the  $V_{DD}$  power is first ramping to the device, and also while the  $V_{DD}$  is falling during power-down. To accomplish this goal, the POR drives a defined sequence of internal events that trigger changes to the states of different macrocells inside the device, and finally to the state of the IOs.

### 14.1 GENERAL OPERATION

The SLG46824 is guaranteed to be powered down and non-operational when the  $V_{DD}$  voltage (voltage on PIN1 for STQFN package; voltage on PIN20 for TSSOP package) is less than Power-Off Threshold (see in [Table 3.4](#)), but not less than -0.6 V. Another essential condition for the chip to be powered down is that no voltage higher (Note) than the  $V_{DD}$  voltage is applied to any other PIN. For example, if  $V_{DD}$  voltage is 0.3 V, applying a voltage higher than 0.3 V to any other PIN is incorrect, and can lead to incorrect or unexpected device behavior.

**Note:** There is a 0.6 V margin due to forward drop voltage of the ESD protection diodes.

To start the POR sequence in the SLG46824, the voltage applied on the  $V_{DD}$  should be higher than the Power-On threshold (Note). The full operational  $V_{DD}$  range for the SLG46824 is 2.3 V to 5.5 V. This means that the  $V_{DD}$  voltage must ramp up to the operational voltage value, but the POR sequence will start earlier, as soon as the  $V_{DD}$  voltage rises to the Power-On threshold. After the POR sequence has started, the SLG46824 will have a typical Startup Time (see in [Table 3.4](#)) to go through all the steps in the sequence, and will be ready and completely operational after the POR sequence is complete.

**Note:** The Power-On threshold is defined in [Table 3.4](#).

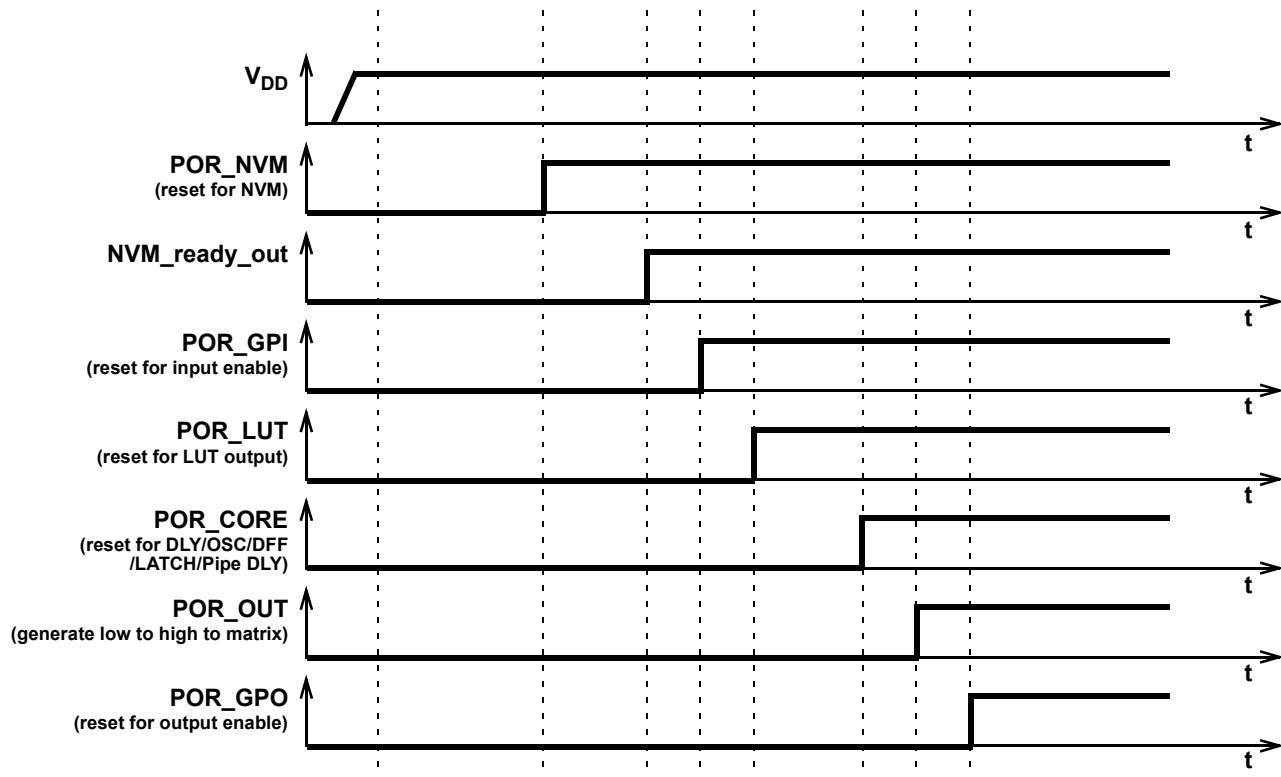
To power-down the chip, the  $V_{DD}$  voltage should be lower than the operational and to guarantee that chip is powered down, it should be less than Power-Off Threshold.

All PINs are in high impedance state when the chip is powered down and while the POR sequence is taking place. The last step in the POR sequence releases the IO structures from the high impedance state, at which time the device is operational. The pin configuration at this point in time is defined by the design programmed into the chip. Also, as it was mentioned before, the voltage on PINs can't be bigger than the  $V_{DD}$ , this rule also applies to the case when the chip is powered on.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 14.2 POR SEQUENCE

The POR system generates a sequence of signals that enable certain macrocells. The sequence is shown in [Figure 77](#).



**Figure 77: POR Sequence**

As can be seen from [Figure 77](#) after the  $V_{DD}$  has started ramping up and crossed the Power-On threshold, first, the on-chip NVM memory is reset. Next, the chip reads the data from NVM, and transfers this information to a CMOS LATCH that serves to configure each macrocell, and the Connection Matrix which routes signals between macrocells. The third stage causes the reset of the input pins, and then to enable them. After that, the LUTs are reset and become active. After LUTs, the Delay cells, OSCs, DFFs, LATCHES, and Pipe Delay are initialized. Only after all macrocells are initialized, internal POR signal (POR macrocell output) goes from LOW to HIGH (POR\_OUT in [Figure 77](#)). The last portion of the device to be initialized is the output pins, which transition from high impedance to active at this point.

The typical time that takes to complete the POR sequence varies by device type in the GreenPAK family. It also depends on many environmental factors, such as: slew rate,  $V_{DD}$  value, temperature, and even will vary from chip to chip (process influence).

### 14.3 MACROCELLS OUTPUT STATES DURING POR SEQUENCE

To have a full picture of SLG46824 operation during powering and POR sequence, refer to [Figure 78](#) which describes the macrocell output states during the POR sequence.

First, before the NVM has been reset, all macrocells have their output set to logic LOW (except the output pins which are in high impedance state). On the next step, some of the macrocells start initialization: input pins output state becomes LOW; LUTs also output LOW. After that input pins are enabled. Next, only LUTs are configured. Then, all other macrocells are initialized. After

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

macrocells are initialized, internal POR matrix signal switches from LOW to HIGH. The last are output pins that become active and determined by the input signals.

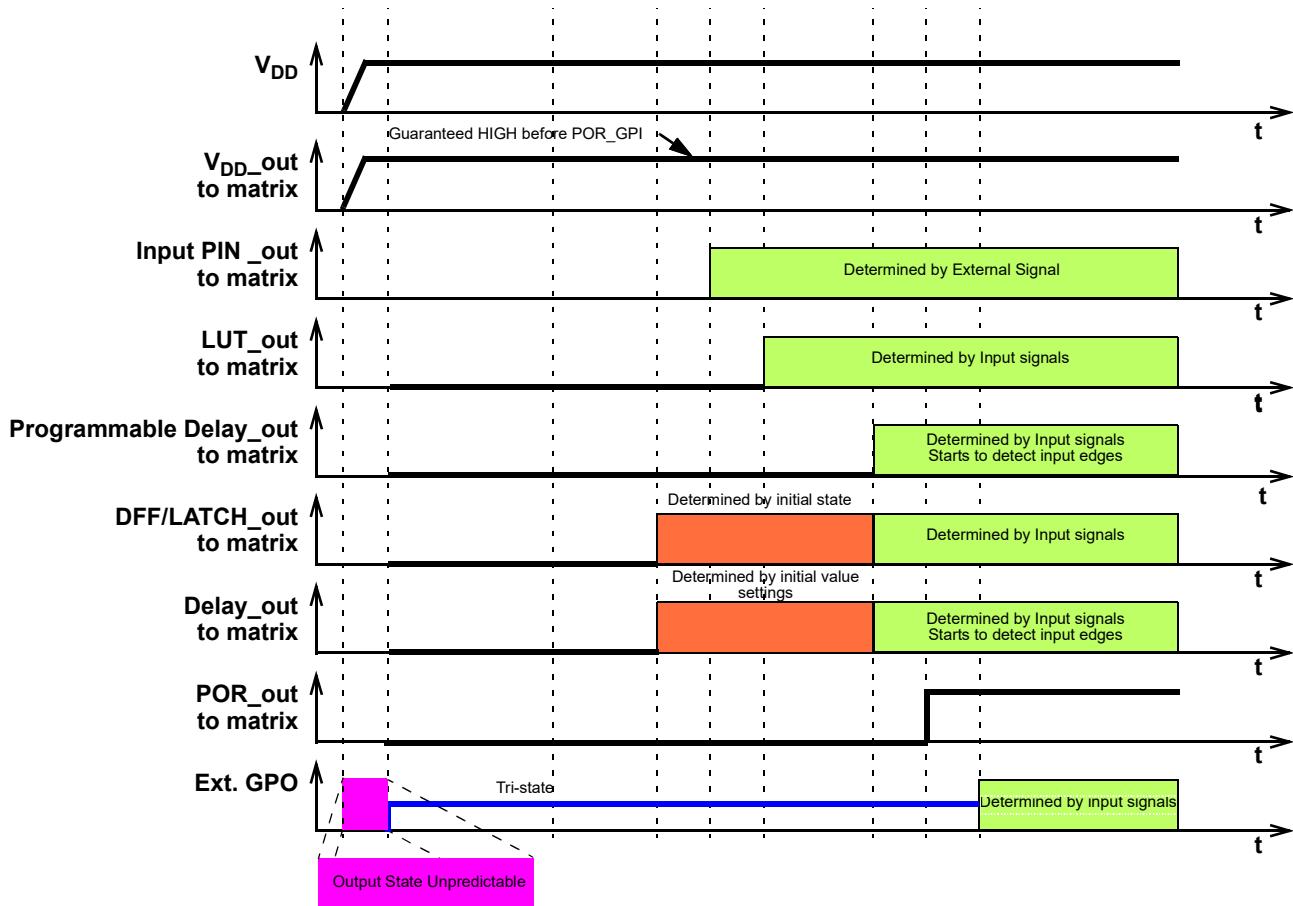


Figure 78: Internal Macrocell States during POR Sequence

### 14.3.1 Initialization

All internal macrocells by default have initial low level. Starting from indicated power-up time of 1.60 V to 2.07 V, macrocells in SLG46824 are powered on while forced to the reset state. All outputs are in Hi-Z and chip starts loading data from NVM. Then the reset signal is released for internal macrocells and they start to initialize according to the following sequence:

1. Input pins, Pull-up/down.
2. LUTs.
3. DFFs, Delays/Counters, Pipe Delay, OSCs, ACMPs.
4. POR output to matrix.
5. Output pin corresponds to the internal logic.

The Vref output pin driving signal can precede POR output signal going high by 3  $\mu$ s to 5  $\mu$ s. The POR signal going high indicates the mentioned power-up sequence is complete.

**Note:** The maximum voltage applied to any pin should not be higher than the  $V_{DD}$  level. There are ESD Diodes between pin  $\rightarrow V_{DD}$  and pin  $\rightarrow$  GND on each pin. Exceeding  $V_{DD}$  results in leakage current on the input pin, and  $V_{DD}$  will be pulled up, following the voltage on the input pin.

## 14.3.2 Power-Down

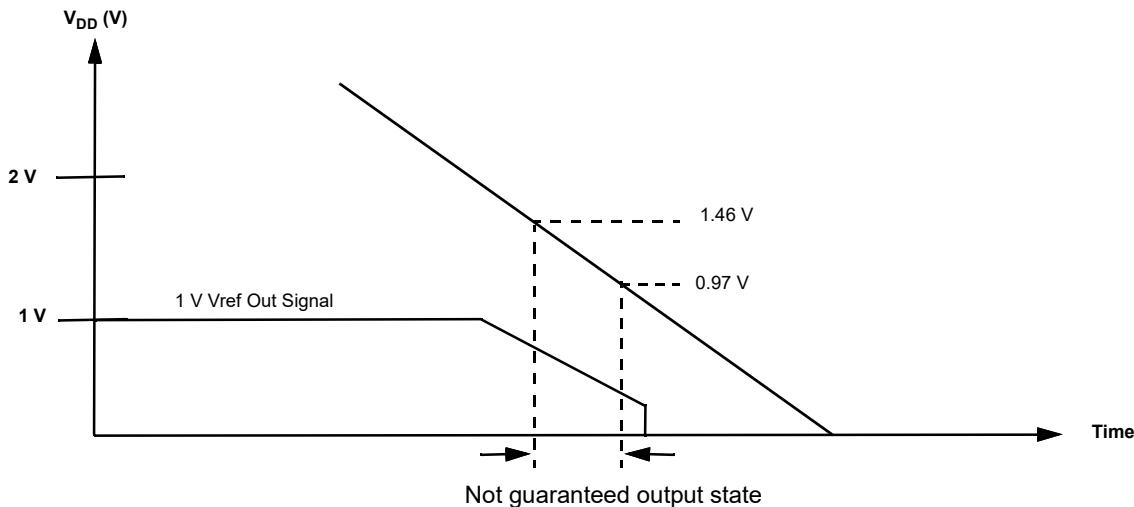


Figure 79: Power-Down

During power-down, macrocells in SLG46824 are powered off after  $V_{DD}$  falling down below Power-Off Threshold. Please note that during a slow rampdown, outputs can possibly switch state.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 15 I<sup>2</sup>C Serial Communications Macrocell

#### 15.1 I<sup>2</sup>C SERIAL COMMUNICATIONS MACROCELL OVERVIEW

In the standard use case for the GreenPAK devices, the configuration choices made by the user are stored as bit settings in the Non-Volatile Memory (NVM), and this information is transferred at startup time to volatile RAM registers that enable the configuration of the macrocells. Other RAM registers in the device are responsible for setting the connections in the Connection Matrix to route signals in the manner most appropriate for the user's application.

The I<sup>2</sup>C Serial Communications Macrocell in this device allows an I<sup>2</sup>C bus Master to read and write this information via a serial channel directly to the RAM registers, allowing the remote re-configuration of macrocells, and remote changes to signal chains within the device.

An I<sup>2</sup>C bus Master is also able read and write other register bits that are not associated with NVM memory. As an example, the input lines to the Connection Matrix can be read as digital register bits. These are the signal outputs of each of the macrocells in the device, giving an I<sup>2</sup>C bus Master the capability to remotely read the current value of any macrocell.

The user has the flexibility to control read access and write access via registers bits registers [1795:1792]. See Section 16 for more details on I<sup>2</sup>C read/write memory protection.

#### 15.2 I<sup>2</sup>C SERIAL COMMUNICATIONS DEVICE ADDRESSING

Each command to the I<sup>2</sup>C Serial Communications macrocell begins with a Control Byte. The bits inside this Control Byte are shown in Figure 80. After the Start bit, the first four bits are a control code. Each bit in a control code can be sourced independently from the register or by value defined externally by IO5, IO4, IO3, and IO2. The LSB of the control code is defined by the value of IO2, while the MSB is defined by the value of IO5. The address source (either register bit or PIN) for each bit in the control code is defined by registers [1623:1620]. This gives the user flexibility on the chip level addressing of this device and other devices on the same I<sup>2</sup>C bus. The default control code is 0001. The Block Address is the next three bits (A10, A9, A8), which will define the most significant bits in the addressing of the data to be read or written by the command. The last bit in the Control Byte is the R/W bit, which selects whether a read command or write command is requested, with a "1" selecting for a Read command, and a "0" selecting for a Write command. This Control Byte will be followed by an Acknowledge bit (ACK), which is sent by this device to indicate successful communication of the Control Byte data.

In the I<sup>2</sup>C-bus specification and user manual, there are two groups of eight addresses (0000 xxx and 1111 xxx) that are reserved for the special functions, such as a system General Call address. If the user of this device chooses to set the Control Code to either "1111" or "0000" in a system with other slave device, please consult the I<sup>2</sup>C-bus specification and user manual to understand the addressing and implementation of these special functions, to insure reliable operation.

In the read and write command address structure, there are a total of 11 bits of addressing, each pointing to a unique byte of information, resulting in a total address space of 16K bytes. The valid addresses are shown in the memory map in Figure 90.

With the exception of the Current Address Read command, all commands will have the Control Byte followed by the Word Address.

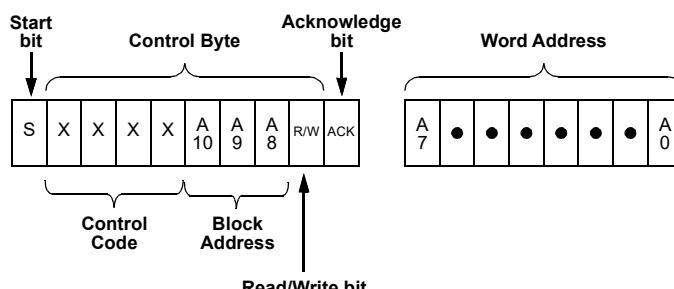


Figure 80: Basic Command Structure

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 15.3 I<sup>2</sup>C SERIAL GENERAL TIMING

General timing characteristics for the I<sup>2</sup>C Serial Communications macrocell are shown in Figure 81. Timing specifications can be found in the Section 3.4.

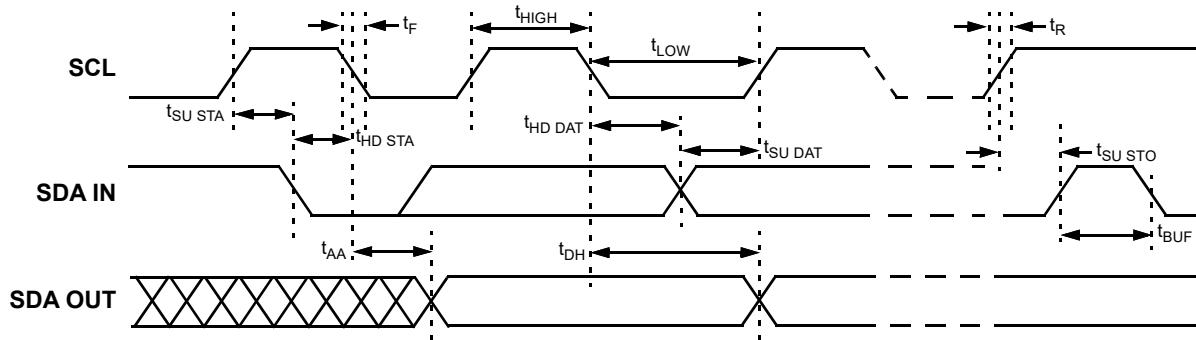


Figure 81: I<sup>2</sup>C General Timing Characteristics

### 15.4 I<sup>2</sup>C SERIAL COMMUNICATIONS COMMANDS

#### 15.4.1 Byte Write Command

Following the Start condition from the Master, the Control Code [4 bits], the Block Address [3 bits], and the R/W bit (set to "0") are placed onto the I<sup>2</sup>C bus by the Master. After the SLG46824 sends an Acknowledge bit (ACK), the next byte transmitted by the Master is the Word Address. The Block Address (A10, A9, A8), combined with the Word Address (A7 through A0), together set the internal address pointer in the SLG46824 where the data byte is to be written. After the SLG46824 sends another Acknowledge bit, the Master will transmit the data byte to be written into the addressed memory location. The SLG46824 again provides an Acknowledge bit and then the Master generates a Stop condition. The internal write cycle for the data will take place at the time that the SLG46824 generates the Acknowledge bit.

It is possible to latch all IOs during I<sup>2</sup>C write command to the register configuration data (block address A10A9A8 = 000), register [1602] = 1 - Enable. It means that IOs will remain their state until the write command is done.

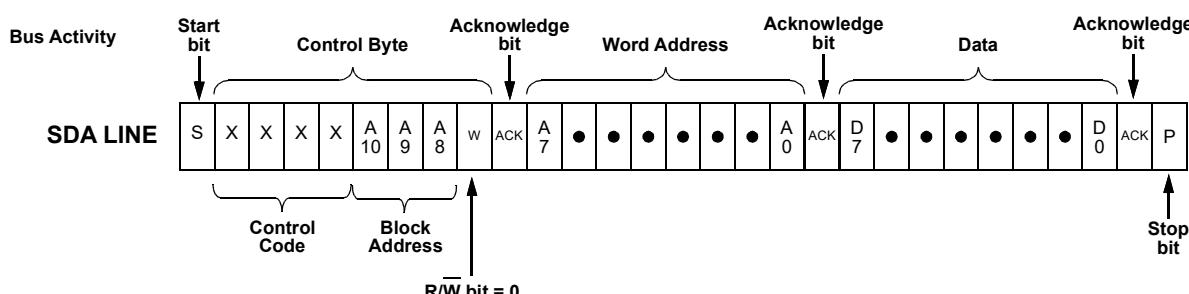


Figure 82: Byte Write Command, R/W = 0

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 15.4.2 Sequential Write Command

The write Control Byte, Word Address, and the first data byte are transmitted to the SLG46824 in the same way as in a Byte Write command. However, instead of generating a Stop condition, the Bus Master continues to transmit data bytes to the SLG46824. Each subsequent data byte will increment the internal address counter, and will be written into the next higher byte in the command addressing. As in the case of the Byte Write command, the internal write cycle will take place at the time that the SLG46824 generates the Acknowledge bit.

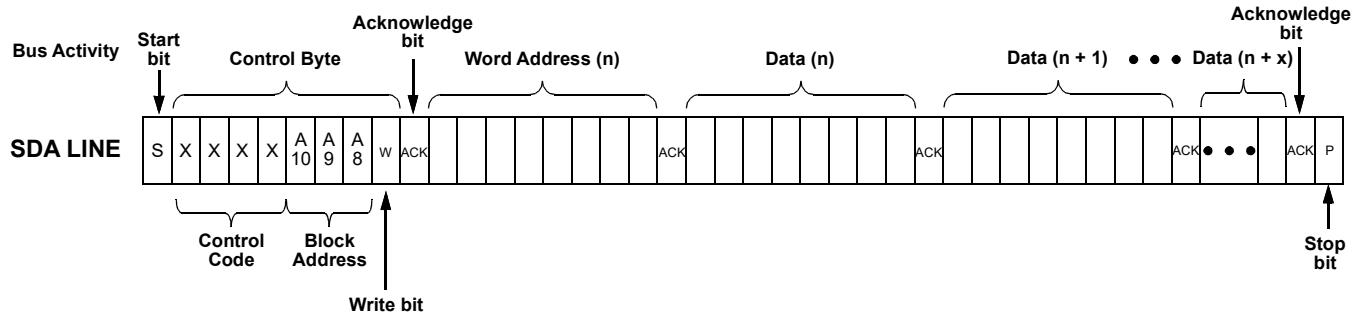


Figure 83: Sequential Write Command

### 15.4.3 Current Address Read Command

The Current Address Read Command reads from the current pointer address location. The address pointer is incremented at the first STOP bit following any write control byte. For example, if a Sequential Read command (which contains a write control byte) reads data up to address n, the address pointer would get incremented to n + 1 upon the STOP of that command. Subsequently, a Current Address Read that follows would start reading data at n + 1. The Current Address Read Command contains the Control Byte sent by the Master, with the R/W bit = "1". The SLG46824 will issue an Acknowledge bit, and then transmit eight data bits for the requested byte. The Master will not issue an Acknowledge bit, and follow immediately with a Stop condition.

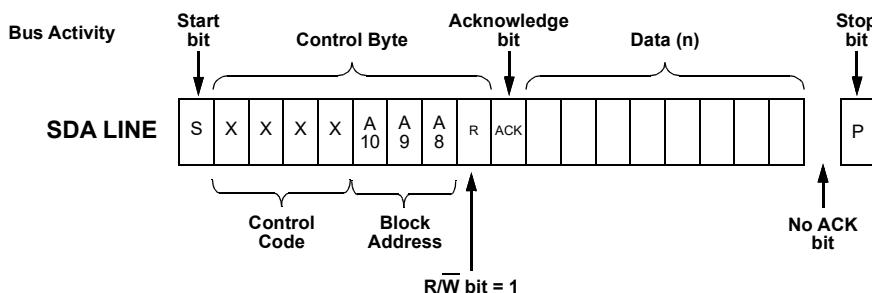


Figure 84: Current Address Read Command, R/W = 1

### 15.4.4 Random Read Command

The Random Read command starts with a Control Byte (with R/W bit set to "0", indicating a write command) and Word Address to set the internal byte address, followed by a Start bit, and then the Control Byte for the read (exactly the same as the Byte Write command). The Start bit in the middle of the command will halt the decoding of a Write command, but will set the internal address counter in preparation for the second half of the command. After the Start bit, the Bus Master issues a second control byte with the R/W bit set to "1", after which the SLG46824 issues an Acknowledge bit, followed by the requested eight data bytes.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

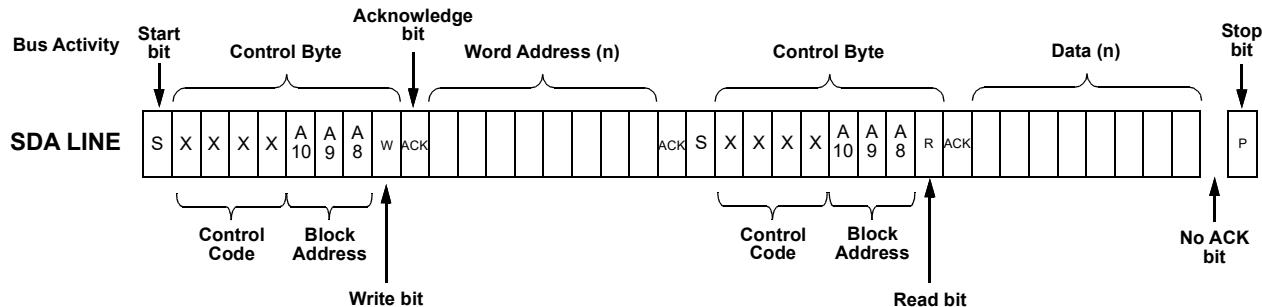


Figure 85: Random Read Command

### 15.4.5 Sequential Read Command

The Sequential Read command is initiated in the same way as a Random Read command, except that once the SLG46824 transmits the first data byte, the Bus Master issues an Acknowledge bit as opposed to a Stop condition in a random read. The Bus Master can continue reading sequential bytes of data, and will terminate the command with a Stop condition.

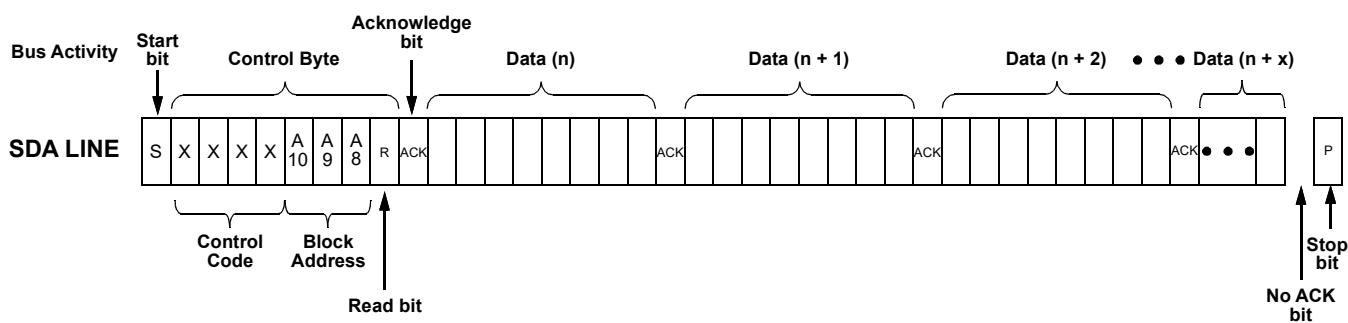


Figure 86: Sequential Read Command

### 15.4.6 I<sup>2</sup>C Serial Reset Command

If I<sup>2</sup>C serial communication is established with the device, it is possible to reset the device to initial power up conditions, including configuration of all macrocells, and all connections provided by the Connection Matrix. This is implemented by setting register [1601] I<sup>2</sup>C reset bit to “1”, which causes the device to re-enable the Power-On Reset (POR) sequence, including the reload of all register data from NVM. During the POR sequence, the outputs of the device will be in tri-state. After the reset has taken place, the contents of register [1601] will be set to “0” automatically. Figure 87 illustrates the sequence of events for this reset function.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

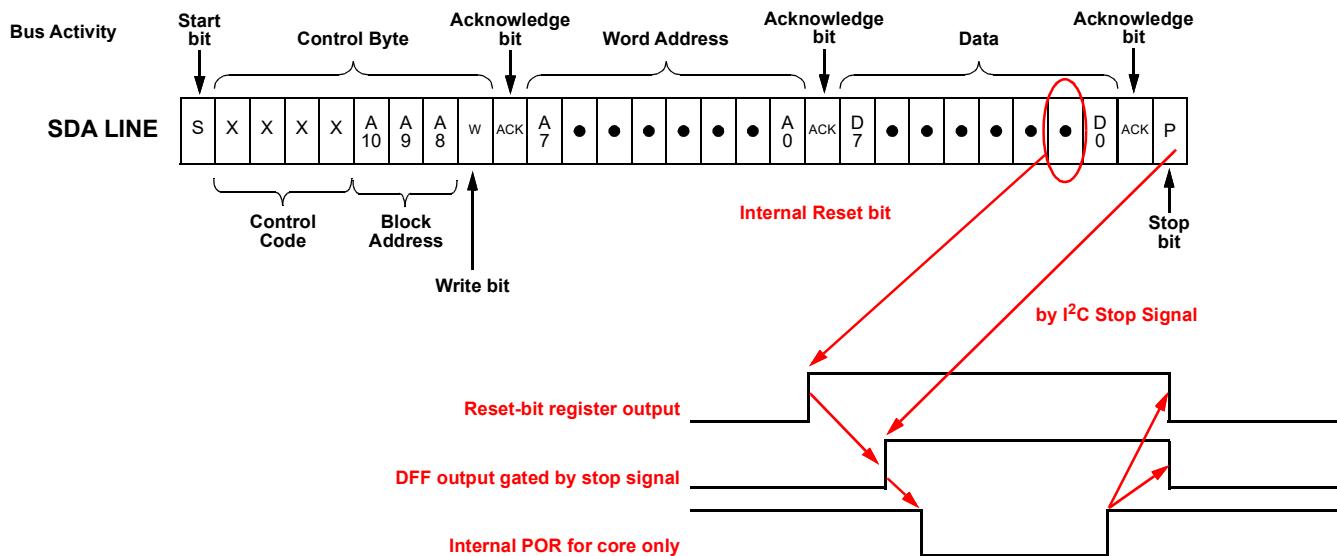


Figure 87: Reset Command Timing

### 15.5 CHIP CONFIGURATION DATA PROTECTION

The SLG46824 utilizes a scheme that allows a portion or the entire Register and NVM to be inhibited from being read or written/erased. There are two bytes that define the register and NVM access or change. The first byte RPR defines the 2k register read and write protection. The second byte NPR defines the 2k NVM data configuration read and write protection. If desired, the protection lock bit (PRL) can be set so that protection may no longer be modified, thereby making the current protection scheme permanent. The status of the RPR and NPR can be determined by following a Random Read sequence. Changing the state of the RPR and NPR is accomplished with a Byte Write sequence with the requirements outlined in this section.

The RPR register is located on H'E0 address, while NPR is located on H'E1 address.

The RPR format is shown in [Table 46](#), and the RPR bit functions are included in [Table 47](#).

**Table 46: RPR Format**

	b7	b6	b5	b4	b3	b2	b1	b0
RPR					RPRB3	RPRB2	RPRB1	RPRB0

**Table 47: RPR Bit Function Description**

Bit	Name		Type	Description
3:2	RPRB3	2k Register Write Selection Bits	R/W*	00: 2k register data is unprotected for write; 01: 2k register data is partly protected for write; Please refer to the <a href="#">Table 50</a> . 10: 2k register data is fully protected for write.
	RPRB2		R/W*	
1:0	RPRB1	2k Register Read Selection Bits	R/W*	00: 2k register data is unprotected for read; 01: 2k register data is partly protected for read; Please refer to the <a href="#">Table 50</a> . 10: 2k register data is fully protected for read.
	RPRB0		R/W*	

\* Becomes read only after PRL is high. The content is permanently locked for write and erase after PRL is high.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

The NPR format is shown in [Table 48](#), and the NPR bit functions are included in [Table 49](#).

**Table 48: NPR Format**

	b7	b6	b5	b4	b3	b2	b1	b0
NPR							NPRB1	NPRB0

**Table 49: NPR Bit Function Description**

Bit	Name		Type	Description				
1:0	NPRB1	2k NVM Configuration Selection Bits	R/W*	00: 2k NVM Configuration data is unprotected for read and write/erase; 01: 2k NVM Configuration data is fully protected for read; 10: 2k NVM Configuration data is fully protected for write/erase. 11: 2k NVM Configuration data is fully protected for read and write/erase.				
			R/W*					

\* Becomes read only after PRL is high. The content is permanently locked for write and erase after PRL is high.

The protection selection bits allow different levels of protection of the register and NVM Memory Array.

The Protect Lock Bit (PRL) is used to permanently lock (for write and erase) the current state of the RPR and NPR. A Logic 0 indicates that the protection byte can be modified, whereas a Logic 1 indicates the byte has been locked and can no longer be modified.

In this case it is impossible to erase the whole page E with protection bytes. The PRL is located at E4 address (register [1824]).

## 15.6 I<sup>2</sup>C SERIAL COMMAND REGISTER MAP

There are nine read/write protect modes for the design sequence from being corrupted or copied. See [Table 50](#) for details.

**Table 50: Read/Write Register Protection Options**

Configurations	Protection Modes Configuration									Test Mode	Register Address
	Unlock	Partly Lock Read	Partly Lock Write	Partly Lock Read/Write	Partly Lock Read & Lock Write	Lock Read & Partly Lock Write	Lock Read	Lock Write	Lock Read/Write (Note 3)		
RPR[1:0]	00	01	00	01	01	10	10	00	10		
RPR[3:2]	00	00	01	01	10	01	00	10	10		
I <sup>2</sup> C Byte Write Bit Masking (section 15.7.3)	R/W	R/W	R/W	R/W	R	W	W	R	-	-	C9
I <sup>2</sup> C Serial Reset Command (section 15.4.6)	R/W	R/W	R/W	R/W	R	W	W	R	-	-	C8b'1
Outputs Latching During I <sup>2</sup> C Write	R/W	R/W	R/W	R/W	R	W	W	R	-	-	C8b'2
Connection Matrix Virtual Inputs (section 6.3)	R/W	R/W	R/W	R/W	R	W	W	R	-	-	7A
Configuration Bits for All Macrocells (IOs, ACMPs, Combination Function Macrocells, etc.)	R/W	W	R	-	-	-	W	R	-	-	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 50: Read/Write Register Protection Options(Continued)

Configurations	Protection Modes Configuration									Test Mode	Register Address
	Unlock	Partly Lock Read	Partly Lock Write	Partly Lock Read/Write	Partly Lock Read & Lock Write	Lock Read & Partly Lock Write	Lock Read	Lock Write	Lock Read/Write (Note 3)		
RPR[1:0]	00	01	00	01	01	10	10	00	10		
RPR[3:2]	00	00	01	01	10	01	00	10	10		
Macrocells Inputs Configuration (Connection Matrix Outputs)	R/W	W	R	-	-	-	W	R	-	-	00~47
Protection Mode Selection	R/W	R/W	R	R	R	R	R/W	R	R	R	E4
Macrocells Output Values (Connection Matrix Inputs, section)	R	R	R	R	R	-	-	R	-	R	74~79;7B
Counter Current Value	R	R	R	R	R	-	-	R	-	R	7C~7F
Silicon Identification Service Bits	R	R	R	R	R	R	R	R	R	R	F9b'3~F9b'2
I <sup>2</sup> C Control Code	R/W	R/W	R	R	R	R	R/W	R	R	R	CAb'3~CAb'0
Page Erase byte	W**	W**	W**	W**	W**	W**	W**	W**	W**	W**	E3

R/W	Allow Read and Write Data
W	Allow Write Data Only
W**	Pages that can be erased are defined by NVM write protection
R	Allow Read Data Only
-	The Data is protected for Read and Write

**Note 1** R/W becomes read only if protection mode selection (lock bit) is set to 1.

**Note 2** R/W Readable/writable depend on the "Trim mode enable" bit. If "Trim mode enable" bit value = 1, then trim bits are enable.

**Note 3** Valid for designs where IO1 is configured as input or not used.

It is possible to read some data from macrocells, such as counter current value, connection matrix, and connection matrix virtual inputs. The I<sup>2</sup>C write will not have any impact on data in case data comes from macrocell output, except Connection Matrix Virtual Inputs. The silicon identification service bits allows identifying silicon family, its revision, and others.

See Section 17 for detailed information on all registers.

### 15.7 I<sup>2</sup>C ADDITIONAL OPTIONS

When Output latching during I<sup>2</sup>C write to the register configuration data (block address A10A9A8 = 000), register [1602] = 1 allows all PINs output value to be latched while register content is changing. It will protect the output change due to configuration process during I<sup>2</sup>C write in case multiple register bytes are changed. Inputs and internal macrocells retain their status during I<sup>2</sup>C write.

See Section 17 for detailed information on all registers.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 15.7.1 Reading Counter Data via I<sup>2</sup>C

The current count value in three counters in the device can be read via I<sup>2</sup>C. The counters that have this additional functionality are 16-bit CNT0, and 8-bit counters CNT2 and CNT4.

### 15.7.2 I<sup>2</sup>C Expander

In addition to the eight Connection Matrix Virtual Inputs, the SLG46824 chip has four pins which can be used as an I<sup>2</sup>C Expander. These four pins are IO0, IO5, IO6, and IO9.

Each of these pins can be used as an I<sup>2</sup>C Expander output or used as a normal pin. Also each of these four expander outputs have initial state settings which are specified in registers [1599:1592].

### 15.7.3 I<sup>2</sup>C Byte Write Bit Masking

The I<sup>2</sup>C macrocell inside SLG46824 supports masking of individual bits within a byte that is written to the RAM memory space. This function is supported across the entire RAM memory space. To implement this function, the user performs a Byte Write Command (see Section 15.4.1 for details) on the I<sup>2</sup>C Byte Write Mask Register (address 0C9H) with the desired bit mask pattern. This sets a bit mask pattern for the target memory location that will take effect on the next Byte Write Command to this register byte. Any bit in the mask that is set to “1” in the I<sup>2</sup>C Byte Write Mask Register will mask the effect of changing that particular bit in the target register, during the next Byte Write Command. The contents of the I<sup>2</sup>C Byte Write Mask Register are reset (set to 00h) after valid Byte Write Command. If the next command received by the device is not a Byte Write Command, the effect of the bit masking function will be aborted, and the I<sup>2</sup>C Byte Write Mask Register will be reset with no effect. [Figure 88](#) shows an example of this function.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

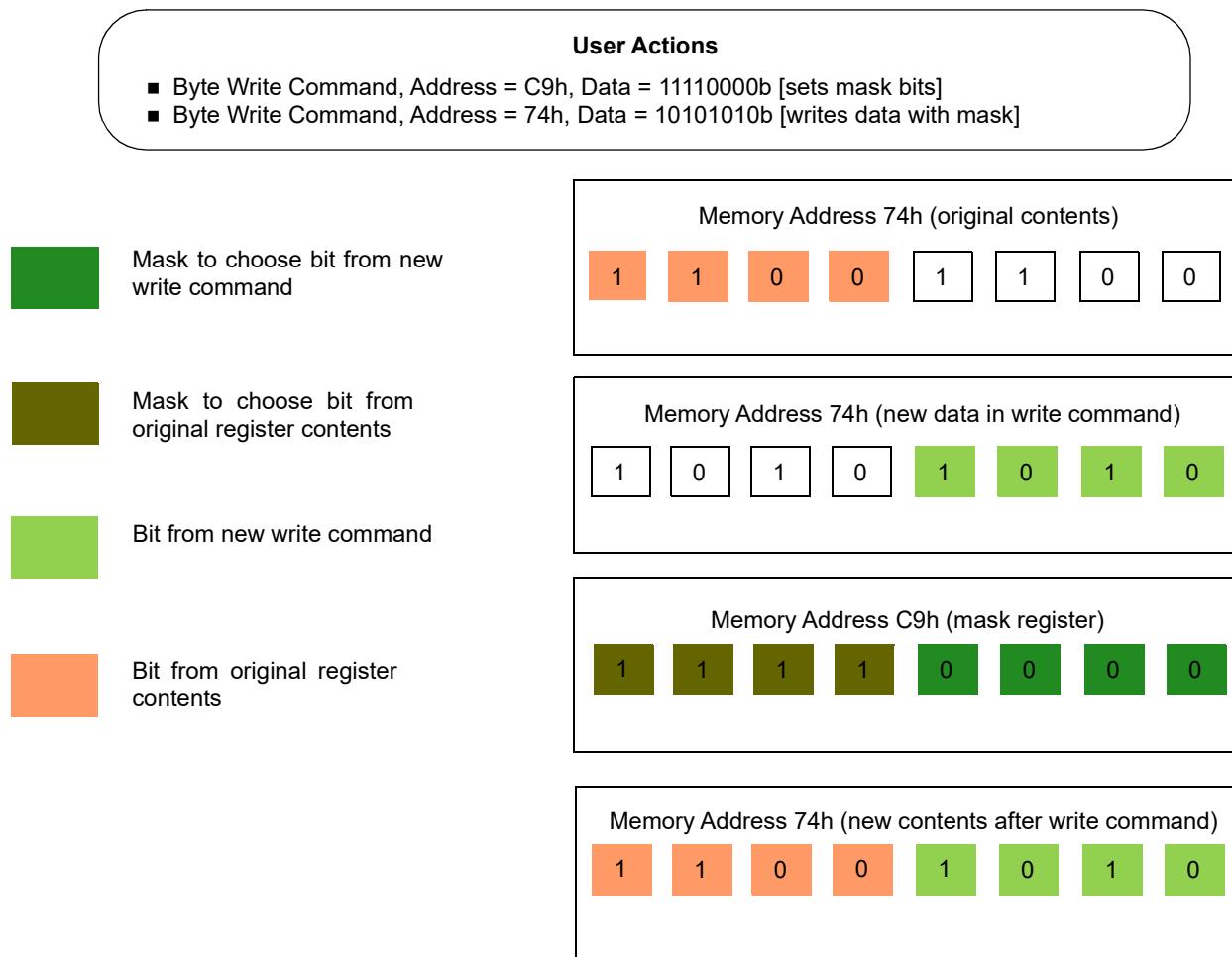


Figure 88: Example of I<sup>2</sup>C Byte Write Bit Masking

## 16 Non-Volatile Memory

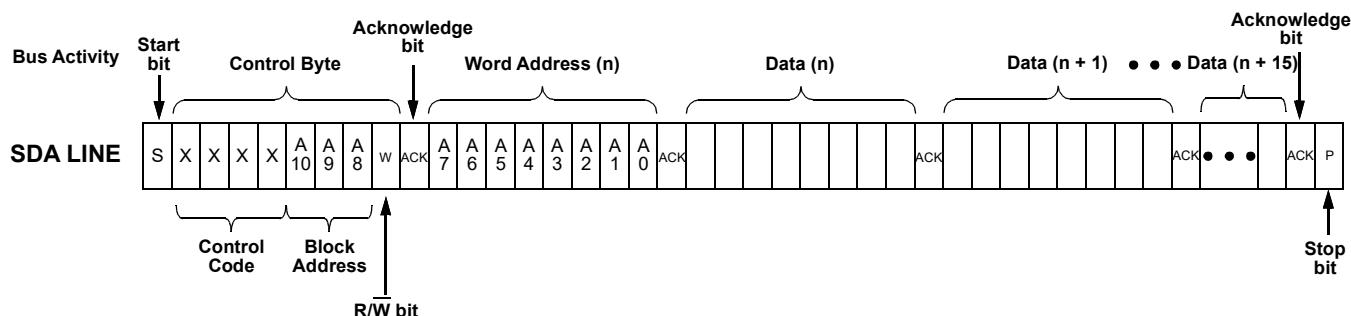
The SLG46824 provides 2,048 bits of Serial Electrically Erasable Memory internally organized as 16 pages of 16 bytes. The protection settings of the device can be made permanent if desired.

### 16.1 SERIAL NVM WRITE OPERATIONS

Write access to the NVM is possible by setting A3, A2, A1, A0 to “0000”, which allows serial write data for a single page only. Upon receipt of the proper Control Byte and Word Address bytes, the SLG46824 will send an ACK. The device will then be ready to receive page data, which is 16 sequential writes of 8-bit data words. The SLG46824 will respond with an ACK after each data word is received. The addressing device, such as a bus Master, must then terminate the write operation with a Stop condition after all page data is written. At that time the device will enter an internally self-timed write cycle, which will be completed within  $t_{WR}$ . While the data is being written into the NVM Memory Array, all inputs, outputs, internal logic, and I<sup>2</sup>C access to the Register data will be operational/valid. Please refer to [Figure 89](#) for the SLG46824 Memory Map.

**Note:** The 16 programmed bytes should be in the same page. Any I<sup>2</sup>C command that does not meet specific requirements will be ignored and NVM will remain unprogrammed.

Data “1” cannot be re-programmed as data “0” without erasure. Each byte can only be programmed one time without erasure.



**Figure 89: Page Write Command**

A10 will be ignored during communication to SLG46824.

A9 = 1 will enable access to the NVM.

A9 = 1 and A8 = 0 corresponds to the 2K bits chip configuration NVM data.

A9 = 1 and A8 = 1 are reserved

A3, A2, A1, and A0 should be 0000 for the page write operation.

In a single page, if the data written to any byte is 00H, the contents of the matching byte in NVM memory will not be altered.

I <sup>2</sup> C Block Address			Memory Space
Lowest I <sup>2</sup> C Address = 000h	A10 = 0	A9 = 0	A8 = X <b>2 Kbits Register Data Configuration</b>
	A10 = 0	A9 = 1	A8 = 0 <b>2 Kbits NVM Data Configuration</b>
	A10 = 0	A9 = 1	A8 = 1 <b>Reserved</b>
	A10 = 1	A9 = X	A8 = X <b>Not Used</b>
Highest I <sup>2</sup> C Address = 7FFh			

Figure 90: I<sup>2</sup>C Block Addressing

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 16.2 SERIAL NVM READ OPERATIONS

There are three read operations:

- Current Address Read
- Random Address Read
- Sequential Read

Please refer to the Section [15](#) for more details.

### 16.3 SERIAL NVM ERASE OPERATIONS

The erase scheme allows a portion or the 2K bits NVM chip configuration to be erased by modifying the contents of the Erase Register (ERSR). Changing the state of the ERSR is accomplished with a Byte Write sequence with the requirements outlined in this section.

The ERSR register is located on I<sup>2</sup>C Block Address = 000b, I<sup>2</sup>C Word Address = E3H.

The ERSR format is shown in [Table 51](#), and the ERSR bit functions are included in [Table 52](#).

**Table 51: Erase Register Bit format**

	b7	b6	b5	b4	b3	b2	b1	b0
Page Erase Register	ERSE	--	--	ERSEB4	ERSEB3	ERSEB2	ERSEB1	ERSEB0

**Table 52: Erase Register Bit Function Description**

Bit	Name		Type	Description
7	ERSE	Erase Enable	W	Setting b7 bit to "1" will start an internal erase cycle on the page defined by ERSEB4-0
6	--	--	--	--
5	--	--	--	--
4	ERSEB4	Page Selection for Erase	W	Define the page address, which will be erased. ERSB4 = 0 corresponds to the Upper 2K NVM used for chip configuration; ERSB4 = 1 reserved
3	ERSEB3		W	
2	ERSEB2		W	
1	ERSEB1		W	
0	ERSEB0		W	

Upon receipt of the proper Device Address and Erase Register Address, the SLG46824 will send an ACK. The device will then be ready to receive Erase Register data. The SLG46824 will respond with an ACK after Erase Register data word is received. The addressing device, such as a bus Master, must then terminate the write operation with a Stop condition. At that time the device will enter an internally self-timed erase cycle, which will be completed within t<sub>ER</sub> ms. While the data is being written into the Memory Array, all inputs, outputs, internal logic, and I<sup>2</sup>C access to the Register data will be operational/valid.

After the erase has taken place, the contents of ERSE bits will be set to "0" automatically. The internal erase cycle will be triggered at the time the Stop Bit in the I<sup>2</sup>C command is received.

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 17 Register Definitions

#### 17.1 REGISTER MAP

Table 53: Register Map

Byte	Address	Signal Function	Register Bit Definition
<b>Matrix Output</b>			
00	5:0	Matrix OUT0	IN0 of LUT2_0 or Clock Input of DFF0
00	11:6	Matrix OUT1	IN1 of LUT2_0 or Data Input of DFF0
01	17:12	Matrix OUT2	IN0 of LUT2_3 or Clock Input of PGen
02	23:18	Matrix OUT3	IN1 of LUT2_3 or nRST of PGen
03	29:24	Matrix OUT4	IN0 of LUT2_1 or Clock Input of DFF1
03	35:30	Matrix OUT5	IN1 of LUT2_1 or Data Input of DFF1
04	41:36	Matrix OUT6	IN0 of LUT2_2 or Clock Input of DFF2
05	47:42	Matrix OUT7	IN1 of LUT2_2 or Data Input of DFF2
06	53:48	Matrix OUT8	IN0 of LUT3_0 or Clock Input of DFF3
06	59:54	Matrix OUT9	IN1 of LUT3_0 or Data Input of DFF3
07	65:60	Matrix OUT10	IN2 of LUT3_0 or nRST(nSET) of DFF3
08	71:66	Matrix OUT11	IN0 of LUT3_1 or Clock Input of DFF4
09	77:72	Matrix OUT12	IN1 of LUT3_1 or Data Input of DFF4
09	83:78	Matrix OUT13	IN2 of LUT3_1 or nRST(nSET) of DFF4
0A	89:84	Matrix OUT14	IN0 of LUT3_2 or Clock Input of DFF5
0B	95:90	Matrix OUT15	IN1 of LUT3_2 or Data Input of DFF5
0C	101:96	Matrix OUT16	IN2 of LUT3_2 or nRST(nSET) of DFF5
0C	107:102	Matrix OUT17	IN0 of LUT3_3 or Clock Input of DFF6
0D	113:108	Matrix OUT18	IN1 of LUT3_3 or Data Input of DFF6
0E	119:114	Matrix OUT19	IN2 of LUT3_3 or nRST(nSET) of DFF6
0F	125:120	Matrix OUT20	IN0 of LUT3_4 or Clock Input of DFF7
0F	131:126	Matrix OUT21	IN1 of LUT3_4 or Data Input of DFF7
10	137:132	Matrix OUT22	IN2 of LUT3_4 or nRST(nSET) of DFF7
11	143:138	Matrix OUT23	IN0 of LUT3_5 or Clock Input of DFF8
12	149:144	Matrix OUT24	IN1 of LUT3_5 or Data Input of DFF8

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
12	155:150	Matrix OUT25	IN2 of LUT3_5 or nRST(nSET) of DFF8
13			
13	161:156	Matrix OUT26	IN0 of LUT3_6 or Input of Pipe Delay or UP Signal of RIPP CNT
14			
14	167:162	Matrix OUT27	IN1 of LUT3_6 or nRST of Pipe Delay or STB of RIPP CNT
15	173:168	Matrix OUT28	IN2 of LUT3_6 or Clock of Pipe Delay_RIPP_CNT
15			
16	179:174	Matrix OUT29	Reserved
16			
17	185:180	Matrix OUT30	MULTFUNC_16BIT_0: IN0 of LUT4_0 or Clock Input of DFF9; Delay0 Input (or Counter0 nRST/SET Input)
17	191:186	Matrix OUT31	MULTFUNC_16BIT_0: IN1 of LUT4_0 or nRST of DFF9; Delay0 Input (or Counter0 nRST Input) or Delay/Counter0 External Clock Source
18	197:192	Matrix OUT32	MULTFUNC_16BIT_0: IN2 of LUT4_0 or nSET of DFF9; Delay0 Input (or Counter0 nRST Input) or Delay/Counter0 External Clock Source or KEEP Input of FSM0
18			
19	203:198	Matrix OUT33	MULTFUNC_16BIT_0: IN3 of LUT4_0 or Data Input of DFF9; Delay0 Input (or Counter0 nRST Input) or UP Input of FSM0
19			
1A	209:204	Matrix OUT34	MULTFUNC_8BIT_1: IN0 of LUT3_7 or Clock Input of DFF10; Delay1 Input (or Counter1 nRST Input)
1A			
1A	215:210	Matrix OUT35	MULTFUNC_8BIT_1: IN1 of LUT3_7 or nRST (nSET) of DFF10; Delay1 Input (or Counter1 nRST Input) or Delay/Counter1 External Clock Source
1B	221:216	Matrix OUT36	MULTFUNC_8BIT_1: IN2 of LUT3_7 or Data Input of DFF10; Delay1 Input (or Counter1 nRST Input)
1B			
1C	227:222	Matrix OUT37	MULTFUNC_8BIT_2: IN0 of LUT3_8 or Clock Input of DFF11; Delay2 Input (or Counter2 nRST Input)
1C			
1D	233:228	Matrix OUT38	MULTFUNC_8BIT_2: IN1 of LUT3_8 or nRST (nSET) of DFF11; Delay2 Input (or Counter2 nRST Input) or Delay/Counter2 External Clock Source
1D			
1D	239:234	Matrix OUT39	MULTFUNC_8BIT_2: IN2 of LUT3_8 or Data Input of DFF11; Delay2 Input (or Counter2 nRST Input)
1E	245:240	Matrix OUT40	MULTFUNC_8BIT_3: IN0 of LUT3_9 or Clock Input of DFF12; Delay3 Input (or Counter3 nRST Input)
1E			
1F	251:246	Matrix OUT41	MULTFUNC_8BIT_3: IN1 of LUT3_9 or nRST (nSET) of DFF12; Delay3 Input (or Counter3 nRST Input) or Delay/Counter3 External Clock Source

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
1F	257:252	Matrix OUT42	MULTFUNC_8BIT_3: IN2 of LUT3_9 or Data Input of DFF12; Delay3 Input (or Counter3 nRST Input)
20	263:258	Matrix OUT43	MULTFUNC_8BIT_4: IN0 of LUT3_10 or Clock Input of DFF13; Delay4 Input (or Counter4 nRST Input)
21	269:264	Matrix OUT44	MULTFUNC_8BIT_4: IN1 of LUT3_10 or nRST (nSET) of DFF13; Delay4 Input (or Counter4 nRST Input) or Delay/Counter4 External Clock Source
21	275:270	Matrix OUT45	MULTFUNC_8BIT_4: IN2 of LUT3_10 or Data Input of DFF13; Delay4 Input (or Counter4 nRST Input)
22	281:276	Matrix OUT46	MULTFUNC_8BIT_5: IN0 of LUT3_11 or Clock Input of DFF14; Delay5 Input (or Counter5 nRST Input)
23	287:282	Matrix OUT47	MULTFUNC_8BIT_5: IN1 of LUT3_11 or nRST (nSET) of DFF14; Delay5 Input (or Counter5 nRST Input) or Delay/Counter5 External Clock Source
24	293:288	Matrix OUT48	MULTFUNC_8BIT_5: IN2 of LUT3_11 or Data Input of DFF14; Delay5 Input (or Counter5 nRST Input)
24	299:294	Matrix OUT49	MULTFUNC_8BIT_6: IN0 of LUT3_12 or Clock Input of DFF15; Delay6 Input (or Counter6 nRST Input)
25	305:300	Matrix OUT50	MULTFUNC_8BIT_6: IN1 of LUT3_12 or nRST (nSET) of DFF15; Delay6 Input (or Counter6 nRST Input) or Delay/Counter6 External Clock Source
26	311:306	Matrix OUT51	MULTFUNC_8BIT_6: IN2 of LUT3_12 or Data Input of DFF15; Delay6 Input (or Counter6 nRST Input)
27	317:312	Matrix OUT52	MULTFUNC_8BIT_7: IN0 of LUT3_13 or Clock Input of DFF16; Delay7 Input (or Counter7 nRST Input)
27	323:318	Matrix OUT53	MULTFUNC_8BIT_7: IN1 of LUT3_13 or nRST (nSET) of DFF16; Delay7 Input (or Counter7 nRST Input) or Delay/Counter7 External Clock Source
28	329:324	Matrix OUT54	MULTFUNC_8BIT_7: IN2 of LUT3_13 or Data Input of DFF16; Delay7 Input (or Counter7 nRST Input)
29	335:330	Matrix OUT55	Filter/Edge detect input
2A	341:336	Matrix OUT56	Programmable delay/edge detect input
2A	347:342	Matrix OUT57	OSC2 ENABLE from matrix
2B	353:348	Matrix OUT58	OSC0 ENABLE from matrix
2C	359:354	Matrix OUT59	OSC1 ENABLE from matrix

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
2D	365:360	Matrix OUT60	Vref PD from matrix
2D	371:366	Matrix OUT61	BG power-down from matrix
2E	377:372	Matrix OUT62	Reserved
2F	383:378	Matrix OUT63	Reserved
30	389:384	Matrix OUT64	PWR UP of ACMP0L from matrix
30	395:390	Matrix OUT65	PWR UP of ACMP1L from matrix
31	401:396	Matrix OUT66	Reserved
32	407:402	Matrix OUT67	IO0 Digital Output
33	413:408	Matrix OUT68	IO1 Digital Output
33	419:414	Matrix OUT69	IO1 Digital Output OE
34	425:420	Matrix OUT70	IO2 Digital Output
35	431:426	Matrix OUT71	IO3 Digital Output
36	437:432	Matrix OUT72	IO4 Digital Output
36	443:438	Matrix OUT73	IO4 Digital Output OE
37	449:444	Matrix OUT74	IO5 Digital Output
38	455:450	Matrix OUT75	IO5 Digital Output OE
39	461:456	Matrix OUT76	IO6 Digital Output
39	467:462	Matrix OUT77	IO7 Digital Output
3A	473:468	Matrix OUT78	IO8 Digital Output
3B	479:474	Matrix OUT79	IO8 Digital Output OE
3C	485:480	Matrix OUT80	IO9 Digital Output
3C	491:486	Matrix OUT81	IO9 Digital Output OE
3D	497:492	Matrix OUT82	IO10 Digital Output
3E	503:498	Matrix OUT83	IO10 Digital Output OE
3F	509:504	Matrix OUT84	IO11 Digital Output
3F	515:510	Matrix OUT85	IO11 Digital Output OE
40	521:516	Matrix OUT86	IO12 Digital Output
41	527:522	Matrix OUT87	IO12 Digital Output OE

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

<b>Address</b>		<b>Signal Function</b>	<b>Register Bit Definition</b>
<b>Byte</b>	<b>Register Bit</b>		
42	533:528	Matrix OUT88	IO13 Digital Output
42	539:534	Matrix OUT89	IO13 Digital Output OE
43	545:540	Matrix OUT90	IO14 Digital Output
44	551:546	Matrix OUT91	IO14 Digital Output OE
45	557:552	Matrix OUT92	Reserved
45	563:558	Matrix OUT93	Reserved
46	569:564	Matrix OUT94	Reserved
47	575:570	Matrix OUT95	Reserved
48	583:576	Reserved	
49	591:584		
4A	599:592	Reserved	
4B	607:600		
4C	615:608	Reserved	
4D	623:616		
4E	631:624	Reserved	
4F	639:632		
50	647:640	Reserved	
51	655:648		
52	663:656	Reserved	
53	671:664		
54	679:672	Reserved	
55	687:680		
56	695:688	Reserved	
57	703:696		
58	711:704		
59	719:712	Reserved	
5A	727:720		
5B	735:728	Reserved	
5C	743:736		
5D	751:744	Reserved	
5E	759:752		
5F	767:760	Reserved	
<b>IO Common</b>			
60	768	IO fast Pull-up/down enable	0: disable 1: enable
	769	I <sup>2</sup> C mode selection	0: I <sup>2</sup> C standard/fast mode 1: I <sup>2</sup> C fast mode+
	775:770	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
<b>IO0</b>			
61	777:776	IO0 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: reserved
	779:778	IO0 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	781:780	IO0 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	782	IO0 Pull-up/down selection	0: Pull-down 1: Pull-up
	783	IO0 output enable	0: disable 1: enable
<b>IO1</b>			
62	785:784	IO1 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog input
	787:786	IO1 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	789:788	IO1 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	790	IO1 Pull-up/down selection	0: Pull-down 1: Pull-up
	791	Reserved	
<b>Reserved</b>			
63	793:792	Reserved	
	795:794	Reserved	
	797:796	Reserved	
	798	Reserved	
	799	Reserved	
<b>IO2</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
64	801:800	IO2 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: reserved
	803:802	IO2 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	805:804	IO2 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	806	IO2 Pull-up/down selection	0: Pull-down 1: Pull-up
	807	IO2 output enable	0: disable 1: enable
<b>IO3</b>			
65	809:808	IO3 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: reserved
	811:810	IO3 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	813:812	IO3 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	814	IO3 Pull-up/down selection	0: Pull-down 1: Pull-up
	815	IO3 output enable	0: disable 1: enable
<b>IO4</b>			
66	817:816	IO4 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: reserved
	819:818	IO4 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	821:820	IO4 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	822	IO4 Pull-up/down selection	0: Pull-down 1: Pull-up
	823	Reserved	
<b>IO5</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
67	825:824	IO5 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: reserved
	827:826	IO5 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	829:828	IO5 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	830	IO5 Pull-up/down selection	0: Pull-down 1: Pull-up
	831	Reserved	
<b>SCL</b>			
68	832	Reserved	
	834:833	SCL input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: Reserved
	836:835	SCL Pull-up/down resistance selection	00: floating 01: Reserved 10: Reserved 11: Reserved
	837	Reserved	
	839:838	Reserved	
<b>SDA</b>			
69	840	Reserved	
	842:841	SDA input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: Reserved
	844:843	SDA Pull-up/down resistance selection	00: floating 01: Reserved 10: Reserved 11: Reserved
	845	Reserved	
	847:846	Reserved	
<b>IO6</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
6A	849:848	Reserved	
	851:850	IO6 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	853:852	IO6 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	854	IO6 Pull-up/down selection	0: Pull-down 1: Pull-up
	855	IO6 output enable	0: disable 1: enable
<b>IO7</b>			
6B	857:856	Reserved	
	859:858	IO7 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	861:860	IO7 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	862	IO7 Pull-up/down selection	0: Pull-down 1: Pull-up
	863	IO7 output enable	0: disable 1: enable
<b>IO8</b>			
6C	865:864	IO8 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: reserved
	867:866	IO8 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	869:868	IO8 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	870	IO8 Pull-up/down selection	0: Pull-down 1: Pull-up
	871	Reserved	
<b>Reserved</b>			
6D	873:872	Reserved	
	875:874	Reserved	
	877:876	Reserved	
	878	Reserved	
	879	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
<b>IO9</b>			
6E	881:880	IO9 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog output
	883:882	IO9 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	885:884	IO9 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	886	IO9 Pull-up/down selection	0: Pull-down 1: Pull-up
	887	Reserved	
<b>IO10</b>			
6F	889:888	IO10 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog output
	891:890	IO10 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	893:892	IO10 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	894	IO10 Pull-up/down selection	0: Pull-down 1: Pull-up
	895	Reserved	
<b>IO11</b>			
70	897:896	IO11 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog input
	899:898	IO11 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	901:900	IO11 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	902	IO11 Pull-up/down selection	0: Pull-down 1: Pull-up
	903	Reserved	
<b>IO12</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
71	905:904	IO12 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog input
	907:906	IO12 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	909:908	IO12 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	910	IO12 Pull-up/down selection	0: Pull-down 1: Pull-up
	911	Reserved	
<b>IO13</b>			
72	913:912	IO13 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog IO
	915:914	IO13 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	917:916	IO13 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	918	IO13 Pull-up/down selection	0: Pull-down 1: Pull-up
	919	Reserved	
<b>IO14</b>			
73	921:920	IO14 input mode configuration	00: digital in without Schmitt Trigger 01: digital in with Schmitt Trigger 10: low voltage digital in mode 11: analog input
	923:922	IO14 output mode configuration	00: Push-Pull 1x 01: Push-Pull 2x 10: 1x Open-Drain 11: 2x Open-Drain
	925:924	IO14 Pull-up/down resistance selection	00: floating 01: 10K 10: 100K 11: 1M
	926	IO14 Pull-up/down selection	0: Pull-down 1: Pull-up
	927	Reserved	
<b>Matrix Input</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
74	928	Matrix Input 0	Tie low
	929	Matrix Input 1	IO0 Digital Input
	930	Matrix Input 2	IO1 Digital Input
	931	Matrix Input 3	IO2 Digital Input
	932	Matrix Input 4	IO3 Digital Input
	933	Matrix Input 5	IO4 Digital Input
	934	Matrix Input 6	IO5 Digital Input
	935	Matrix Input 7	IO8 Digital Input
75	936	Matrix Input 8	IO9 Digital Input
	937	Matrix Input 9	IO10 Digital Input
	938	Matrix Input 10	IO11 Digital Input
	939	Matrix Input 11	IO12 Digital Input
	940	Matrix Input 12	IO13 Digital Input
	941	Matrix Input 13	IO14 Digital Input
	942	Matrix Input 14	LUT2_0_DFF0_OUT
	943	Matrix Input 15	LUT2_1_DFF1_OUT
76	944	Matrix Input 16	LUT2_2_DFF2_OUT
	945	Matrix Input 17	LUT2_3_PGEN_OUT
	946	Matrix Input 18	LUT3_0_DFF3_OUT
	947	Matrix Input 19	LUT3_1_DFF4_OUT
	948	Matrix Input 20	LUT3_2_DFF5_OUT
	949	Matrix Input 21	LUT3_3_DFF6_OUT
	950	Matrix Input 22	LUT3_4_DFF7_OUT
	951	Matrix Input 23	LUT3_5_DFF8_OUT
77	952	Matrix Input 24	LUT3_6_PIPEPLY_RIPP_CNT_OUT0
	953	Matrix Input 25	PIPEPLY_RIPP_CNT_OUT1
	954	Matrix Input 26	RIPP_CNT_OUT2
	955	Matrix Input 27	EDET_FILTER_OUT
	956	Matrix Input 28	PROG_DLY_EDET_OUT
	957	Matrix Input 29	MULTFUNC_8BIT_1: DLY_CNT_OUT
	958	Matrix Input 30	CKOSC1_MATRIX: OSC1 matrix input
	959	Matrix Input 31	CKOSC0_MATRIX: OSC0 matrix input
78	960	Matrix Input 32	CKOSC2_MATRIX: OSC2 matrix input
	961	Matrix Input 33	MULTFUNC_8BIT_2: DLY_CNT_OUT
	962	Matrix Input 34	MULTFUNC_8BIT_3: DLY_CNT_OUT
	963	Matrix Input 35	MULTFUNC_8BIT_4: DLY_CNT_OUT
	964	Matrix Input 36	MULTFUNC_8BIT_5: DLY_CNT_OUT
	965	Matrix Input 37	MULTFUNC_8BIT_6: DLY_CNT_OUT
	966	Matrix Input 38	MULTFUNC_8BIT_7: DLY_CNT_OUT
	967	Matrix Input 39	MULTFUNC_16BIT_0: LUT_DFF_OUT

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
79	968	Matrix Input 40	MULTFUNC_8BIT_1: LUT_DFF_OUT
	969	Matrix Input 41	MULTFUNC_8BIT_2: LUT_DFF_OUT
	970	Matrix Input 42	MULTFUNC_8BIT_3: LUT_DFF_OUT
	971	Matrix Input 43	MULTFUNC_8BIT_4: LUT_DFF_OUT
	972	Matrix Input 44	MULTFUNC_8BIT_5: LUT_DFF_OUT
	973	Matrix Input 45	MULTFUNC_8BIT_6: LUT_DFF_OUT
	974	Matrix Input 46	MULTFUNC_8BIT_7: LUT_DFF_OUT
	975	Matrix Input 47	MULTFUNC_16BIT_0: DLY_CNT_OUT
7A	976	Matrix Input 48	Virtual Input [7]: register [976]
	977	Matrix Input 49	Virtual Input [6]: register [977]
	978	Matrix Input 50	Virtual Input [5]: register [978]
	979	Matrix Input 51	Virtual Input [4]: register [979]
	980	Matrix Input 52	Virtual Input [3]: register [980]
	981	Matrix Input 53	Virtual Input [2]: register [981]
	982	Matrix Input 54	Virtual Input [1]: register [982]
	983	Matrix Input 55	Virtual Input [0]: register [983]
7B	984	Matrix Input 56	Reserved
	985	Matrix Input 57	Reserved
	986	Matrix Input 58	ACMP0L OUT
	987	Matrix Input 59	ACMP1L OUT
	988	Matrix Input 60	2nd CKOSC1_MATRIX
	989	Matrix Input 61	2nd CKOSC0_MATRIX
	990	Matrix Input 62	POR CORE
	991	Matrix Input 63	Tie high
7C	999:992	CNT0(16-bit) Counted Value	Q[7:0]
7D	1007:1000	CNT0(16-bit) Counted Value	Q[15:8]
7E	1015:1008	CNT2(8-bit) Counted Value	Q[7:0]
7F	1023:1016	CNT4(8-bit) Counted Value	Q[7:0]
<b>OSC/ACMP</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
80	1024	OSC1 turn on by register	when matrix output enable/pd control signal = 0: 0: auto on by delay cells 1: always on
	1025	matrix power-down or on select	0: matrix down 1: matrix on
	1026	external clock source enable	0: internal OSC1 1: external clock from IO10
	1028:1027	post divider ration control	00: div1 01: div2 10: div4 11: div8
	1031:1029	matrix divider ratio control	000: /1 001: /2 010: /4 011: /3 100: /8 101: /12 110: /24 111: /64
81	1032	OSC2 turn on by register	when matrix output enable/pd control signal = 0: 0: auto on by delay cells 1: always on
	1033	matrix power-down or on select	0: matrix down 1: matrix on
	1034	external clock source enable	0: internal OSC2 1: external clock from IO8
	1036:1035	post divider ration control	00: div1 01: div2 10: div4 11: div8
	1039:1037	matrix divider ratio control	000: /1 001: /2 010: /4 011: /3 100: /8 101: /12 110: /24 111: /64

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
82	1040	OSC0 turn on by register	when matrix output enable/pd control signal = 0: 0: auto on by delay cells 1: always on
	1041	matrix power-down or on select	0: matrix down 1: matrix on
	1042	external clock source enable	0: internal OSC0 1: external clock from IO0
	1044:1043	post divider ration control	00: div1 01: div2 10: div4 11: div8
	1047:1045	matrix divider ratio control	000: /1 001: /2 010: /4 011: /3 100: /8 101: /12 110: /24 111: /64
83	1048	Reserved	
	1049	OSC0 matrix out enable	0: disable 1: enable
	1050	OSC1 matrix out enable	0: disable 1: enable
	1051	OSC2 matrix out enable	0: disable 1: enable
	1052	OSC2 100 ns Startup Delay	0: enable 1: disable
	1053	OSC0 2nd matrix out enable	0: disable 1: enable
	1054	OSC1 2nd matrix out enable	0: disable 1: enable
	1055	Reserved	
84	1058:1056	OSC1 2nd matrix input: matrix divider ratio control	000: /1 001: /2 010: /4 011: /3 100: /8 101: /12 110: /24 111: /64
	1061:1059	OSC0 2nd matrix input: matrix divider ratio control	000: /1 001: /2 010: /4 011: /3 100: /8 101: /12 110: /24 111: /64
	1063:1062	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
85	1065:1064	Reserved	
	1066	Reserved	
	1067	Reserved	
	1068	Reserved	
	1069	Reserved	
	1070	Reserved	
	1071	Reserved	
86	1072	Reserved	
	1073	Reserved	
	1075:1074	Reserved	
	1076	Reserved	
	1077	Reserved	
	1078	Reserved	
	1079	Reserved	
87	1080	Reserved	
	1081	Reserved	
	1083:1082	ACMP0L hysteresis	00: 0 mV 01: 32 mV 10: 64 mV 11: 192 mV
	1084	Reserved	
	1085	Reserved	
	1086	Reserved	
	1087	Reserved	
88	1089:1088	ACMP1L hysteresis	00: 0 mV 01: 32 mV 10: 64 mV 11: 192 mV
	1090	Reserved	
	1091	Reserved	
	1092	ACMP1L positive input come from ACMP0L's input mux output enable	0: disable 1: enable
	1093	Reserved	
	1094	Reserved	
	1095	Reserved	
89	1097:1096	Reserved	
	1103:1098	Reserved	
8A	1105:1104	Reserved	
	1111:1106	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
8B	1113:1112	ACMP0L Gain divider	00: 1x 01: 0.5x 10: 0.33x 11: 0.25x
	1119:1114	ACMP0L Vref	ACMP Vref select: 000000: 32 mV ~ 111110: 2.016V/step = 32 mV; 111111: External Vref
8C	1121:1120	ACMP1L Gain divider	00: 1x 01: 0.5x 10: 0.33x 11: 0.25x
	1127:1122	ACMP1L Vref	ACMP Vref select: 000000: 32 mV ~ 111110: 2.016V/step = 32 mV; 111111: External Vref
8D	1128	Reserved	0: disable 1: enable
	1130:1129	Reserved	
	1131	Vref output OP	0: disable 1: enable
	1133:1132	Vref0 input selection	00: None 01: ACMP0L Vref 10: ACMP1L Vref 11: Reserved
	1134	Reserved	
	1135	Reserved	
8E	1136	Reserved	
	1137	Reserved	
	1138	Reserved	
	1139	Vref OUT PD	0: Vref OUT disable 1: Vref OUT enable
	1140	Reserved	0: enable/disable using Vref OUT PD register [1139] 1: Reserved
	1143:1141	Reserved	
8F	1145:1144	Reserved	
	1151:1146	Reserved	
<b>Digital Macrocell</b>			

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
90	1155:1152	LUT2_0/DFF0 setting	[3]: LUT2_0[3]/DFF0 or LATCH Select 0: DFF function 1: LATCH function [2]: LUT2_0[2]/DFF0 Output Sel 0: Q output 1: QB output [1]: LUT2_0[1]/DFF0 Initial Polarity Select 0: Low 1: High [0]: LUT2_0[0]
	1159:1156	LUT2_1/DFF1 setting	[3]: LUT2_1[3]/DFF1 or LATCH Select 0: DFF function 1: LATCH function [2]: LUT2_1[2]/DFF1 Output Select 0: Q output 1: QB output [1]: LUT2_1[1]/DFF1 Initial Polarity Select 0: Low 1: High [0]: LUT2_1[0]
91	1163:1160	LUT2_2/DFF2 setting	[3]: LUT2_2[3]/DFF2 or LATCH Select 0: DFF function 1: LATCH function [2]: LUT2_2[2]/DFF2 Output Select 0: Q output 1: QB output [1]: LUT2_2[1]/DFF2 Initial Polarity Select 0: Low 1: High [0]: LUT2_2[0]
	1167:1164	LUT2_3_VAL or PGEN_data	LUT2_3[3:0] or PGen 4bit counter data[3:0]
92	1175:1168	PGen data [7:0]	PGen data [7:0]
93	1183:1176	PGen data [15:8]	PGen data [15:8]
94	1191:1184	LUT3_0_DFF3 setting	[7]: LUT3_0[7]/DFF3 or LATCH Select 0: DFF function 1: LATCH function [6]: LUT3_0[6]/DFF3 Output Select 0: Q output 1: QB output [5]: LUT3_0[5]/DFF3 0: nRST from Matrix Output 1: nSET from Matrix Output [4]: LUT3_0[4]/DFF3 Initial Polarity Select 0: Low 1: High [3:0]: LUT3_0[3:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
95	1199:1192	LUT3_1_DFF4 setting	[7]: LUT3_1[7]/DFF4 or LATCH Select 0: DFF function 1: LATCH function [6]: LUT3_1[6]/DFF4 Output Select 0: Q output 1: QB output [5]: LUT3_1[5]/DFF4 0: nRST from Matrix Output 1: nSET from Matrix Output [4]: LUT3_1[4]/DFF4 Initial Polarity Select 0: Low 1: High [3:0]: LUT3_1[3:0]
96	1207:1200	LUT3_2_DFF5 setting	[7]: LUT3_2[7]/DFF5 or LATCH Select 0: DFF function 1: LATCH function [6]: LUT3_2[6]/DFF5 Output Select 0: Q output 1: QB output [5]: LUT3_2[5]/DFF5 0: nRST from Matrix Output 1: nSET from Matrix Output [4]: LUT3_2[4]/DFF5 Initial Polarity Select 0: Low 1: High [3:0]: LUT3_2[3:0]
97	1215:1208	LUT3_3_DFF6 setting	[7]: LUT3_3[7]/DFF6 or LATCH Select 0: DFF function 1: LATCH function [6]: LUT3_3[6]/DFF6 Output Select 0: Q output 1: QB output [5]: LUT3_3[5]/DFF6 0: nRST from Matrix Output 1: nSET from Matrix Output [4]: LUT3_3[4]/DFF6 Initial Polarity Select 0: Low 1: High [3:0]: LUT3_3[3:0]
98	1223:1216	LUT3_4_DFF7 setting	[7]: LUT3_4[7]/DFF7 or LATCH Select 0: DFF function 1: LATCH function [6]: LUT3_4[6]/DFF7 Output Select 0: Q output 1: QB output [5]: LUT3_4[5]/DFF7 0: nRST from Matrix Output 1: nSET from Matrix Output [4]: LUT3_4[4]/DFF7 Initial Polarity Select 0: Low 1: High [3:0]: LUT3_4[3:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
99	1231:1224	LUT3_5_DFF8 setting	[7]: LUT3_5[7]/DFF8 or LATCH Select 0: DFF function 1: LATCH function [6]: LUT3_5[6]/DFF8 Output Select 0: Q output 1: QB output [5]: LUT3_5[5]/DFF8 0: RSTB from Matrix Output 1: SETB from Matrix Output [4]: LUT3_5[4]/DFF8 Initial Polarity Select 0: Low 1: High [3:0]: LUT3_5[3:0]
9A	1232	LUT2_0 or DFF0 Select	0: LUT2_0 1: DFF0
	1233	LUT2_1 or DFF1 Select	0: LUT2_1 1: DFF1
	1234	LUT2_2 or DFF2 Select	0: LUT2_2 1: DFF2
	1235	LUT2_3 or PGen Select	0: LUT2_3 1: PGen
	1236	LUT3_0 or DFF3 Select	0: LUT3_0 1: DFF3
	1237	DFF3_SECONDQ_Sel	0: Q of first DFF 1: Q of second DFF
	1238	LUT3_1 or DFF4 Select	0: LUT3_1 1: DFF4
	1239	LUT3_2 or DFF5 Select	0: LUT3_2 1: DFF5
9B	1240	LUT3_3 or DFF6 Select	0: LUT3_3 1: DFF6
	1241	LUT3_4 or DFF7 Select	0: LUT3_4 1: DFF7
	1242	LUT3_5 or DFF8 Select	0: LUT3_5 1: DFF8
	1243	Filter or Edge Detector selection	0: filter 1: edge det
	1244	output Polarity Select	0: Filter/edge detect output 1: Filter/edge detect output inverted
	1246:1245	Select the edge mode	00: Rising Edge Det 01: Falling Edge Det 10: Both Edge Det 11: Both Edge DLY
	1247	Reserved	
9C	1255:1248	LUT value or Pipe Delay out SEL or nSET/END value	[7:4]:LUT3_6[7:4]/REG_S1[3:0]Pipe Delay out1 SEL [3:0]:LUT3_6[3:0]/REG_S0[3:0]Pipe Delay out0 SEL at RIPP CNT mode: bit[1250:1248] is the nSET value bit[1253:1251] is the END value bit[1254] functional mode:0: full cycle; 1: ranged cycle bit[1255] not used

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
9D	1256	Pipe Delay OUT1 Polarity Select	0: Non-inverted 1: Inverted
	1257	LUT3_6 or Pipe Delay Select	0: LUT3_6 1: Pipe Delay or RIPP CNT
	1258	PIPE_RIPP_CNT_S	0: Pipe delay mode selection 1: Ripple Counter mode selection
	1260:1259	Select the Edge Mode of Programmable Delay & Edge Detector	00: Rising Edge Detector 01: Falling Edge Detector 10: Both Edge Detector 11: Both Edge Delay
	1262:1261	Delay Value Select for Programmable Delay & Edge Detector	00: 125ns 01: 250ns 10: 375ns 11: 500ns
	1263	Reserved	
9E	1264	Reserved	
	1265	Reserved	
	1266	Reserved	
	1271:1267	Reserved	
9F	1276:1272	Reserved	
	1277	Reserved	
	1278	Reserved	
	1279	Reserved	
<b>Multifunction</b>			
A0	1286 1285 1282 1284 1283 1281 1280	Single 4-bit LUT	0000000: Matrix A - In3; Matrix B - In2; Matrix C - In1; Matrix D - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	0010000: Matrix A - D; Matrix B - nSET; Matrix C - nRST; Matrix D - CLK (DLY_IN - LOW)
		Single CNT/DLY	0000001: Matrix A - UP (CNT); Matrix B - KEEP (CNT); Matrix C - EXT_CLK (CNT); Matrix D - DLY_IN (CNT) (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	0000010: Matrix A - DLY_IN; Matrix B - In2; Matrix C - In1; Matrix D - In0 (DLY_OUT connected to In3)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
A0	1286 1285 1282 1284 1283 1281 1280	CNT/DLY → DFF	0000110: Matrix A - DLY_IN; Matrix B - nSET; Matrix C - nRST; Matrix D - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	0100010: Matrix A - DLY_IN; Matrix B - EXT_CLK (CNT); Matrix C - In1; Matrix D - In0 (DLY_OUT connected to In3; In2 - LOW)
		CNT/DLY → DFF	0100110: Matrix A - DLY_IN; Matrix B - EXT_CLK (CNT); Matrix C - nRST; Matrix D - CLK (DLY_OUT connected to D; nSET - HIGH)
		CNT/DLY → LUT	1000010: Matrix A - DLY_IN; Matrix B - In2; Matrix C - EXT_CLK (CNT); Matrix D - In0 (DLY_OUT connected to In3; In1 - LOW)
		CNT/DLY → DFF	1000110: Matrix A - DLY_IN; Matrix B - nSET; Matrix C - EXT_CLK (CNT); Matrix D - CLK (DLY_OUT connected to D; nRST - HIGH)
		CNT/DLY → LUT	0001010: Matrix A - In3; Matrix B - DLY_IN; Matrix C - In1; Matrix D - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	0001110: Matrix A - D; Matrix B - DLY_IN; Matrix C - nRST; Matrix D - CLK (DLY_OUT connected to nSET)
		CNT/DLY → LUT	1001010: Matrix A - In3; Matrix B - DLY_IN; Matrix C - EXT_CLK (CNT); Matrix D - In0 (DLY_OUT connected to In2; In1 - LOW)
		CNT/DLY → DFF	1001110: Matrix A - D; Matrix B - DLY_IN; Matrix C - EXT_CLK (CNT); Matrix D - CLK (DLY_OUT connected to nSET; nRST - HIGH)
		CNT/DLY → LUT	0010010: Matrix A - In3; Matrix B - In2; Matrix C - DLY_IN; Matrix D - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	0010110: Matrix A - D; Matrix B - nSET; Matrix C - DLY_IN; Matrix D - CLK (DLY_OUT connected to nRST)
		CNT/DLY → LUT	0110010: Matrix A - In3; Matrix B - EXT_CLK (CNT); Matrix C - DLY_IN; Matrix D - In0 (DLY_OUT connected to In1; In2 - LOW)
		CNT/DLY → DFF	0110110: Matrix A - D; Matrix B - EXT_CLK (CNT); Matrix C - DLY_IN; Matrix D - CLK (DLY_OUT connected to nRST; nSET - HIGH)
		CNT/DLY → LUT	0011010: Matrix A - In3; Matrix B - In2; Matrix C - In1; Matrix D - DLY_IN (DLY_OUT connected to In0)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
A0	1286 1285 1282 1284 1283 1281 1280	CNT/DLY → DFF	0011110: Matrix A - D; Matrix B - nSET; Matrix C - nRST; Matrix D - DLY_IN (DLY_OUT connected to CLK)
		CNT/DLY → LUT	0111010: Matrix A - In3; Matrix B - EXT_CLK (CNT); Matrix C - In1; Matrix D - DLY_IN (DLY_OUT connected to In0; In2 - LOW)
		CNT/DLY → DFF	0111110: Matrix A - D; Matrix B - EXT_CLK (CNT); Matrix C - nRST; Matrix D - DLY_IN (DLY_OUT connected to CLK; nSET - HIGH)
		CNT/DLY → LUT	1011010: Matrix A - In3; Matrix B - In2; Matrix C - EXT_CLK (CNT); Matrix D - DLY_IN (DLY_OUT connected to In0; In1 - LOW)
		CNT/DLY → DFF	1011110: Matrix A - D; Matrix B - nSET; Matrix C - EXT_CLK (CNT); Matrix D - DLY_IN (DLY_OUT connected to CLK; nRST - HIGH)
		LUT → CNT/DLY	0000011: Matrix A - In3; Matrix B - In2; Matrix C - In1; Matrix D - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	0000111: Matrix A - D; Matrix B - nSET; Matrix C - nRST; Matrix D - CLK (DFF_OUT connected to DLY_IN)
		LUT → CNT/DLY	0100011: Matrix A - In3; Matrix B - EXT_CLK (CNT); Matrix C - In1; Matrix D - In0 (LUT_OUT connected to DLY_IN; In2 - LOW)
		DFF → CNT/DLY	0100111: Matrix A - D; Matrix B - EXT_CLK (CNT); Matrix C - nRST; Matrix D - CLK (DFF_OUT connected to DLY_IN; nSET - HIGH)
		LUT → CNT/DLY	1000011: Matrix A - In3; Matrix B - In2; Matrix C - EXT_CLK (CNT); Matrix D - In0 (LUT_OUT connected to DLY_IN; In1 - LOW)
		DFF → CNT/DLY	1000111: Matrix A - D; Matrix B - nSET; Matrix C - EXT_CLK (CNT); Matrix D - CLK (DFF_OUT connected to DLY_IN; nRST - HIGH)
	1287	FSM0 SET/RST Selection	0: Reset to 0 1: Set to data
A1	1295:1288	LUT4_0_DFF9 setting [7:0]	[7:0]: LUT4_0[7:0]
A2	1303:1296	LUT4_0_DFF9 setting [15:8]	[15]: LUT4_0[15]/DFF or LATCH Select 0: DFF function; 1: LATCH function [14]: LUT4_0[14]/DFF Output Select 0: Q output; 1: QB output [13]: LUT4_0[13]/DFF Initial Polarity Select 0: Low; 1: High [12:8]: LUT4_0[12:8]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
A3	1305:1304	DLY/CNT0 Mode Selection	00: DLY 01: one shot 10: frequency det 11: CNT
	1307:1306	DLY/CNT0 edge Mode Selection	00: both edge 01: falling edge 10: rising edge 11: High Level Reset (only in CNT mode)
	1311:1308	DLY/CNT0 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
A4	1312	CNT0 output pol selection	0: Default Output 1: Inverted Output
	1314:1313	CNT0 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1315	Reserved	
	1316	Reserved	
	1317	Keep signal SYNC selection	0: bypass 1: after two DFF
	1318	UP signal SYNC selection	0: bypass 1: after two DFF
A5	1327:1320	REG_CNT0_Data[7:0]	Data[7:0]
	1335:1328	REG_CNT0_Data[15:8]	Data[15:8]
A7	1336	CNT0 CNT mode SYNC selection	0: bypass 1: after two DFF
	1339 1341 1340 1338 1337	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
A7	1339 1341 1340 1338 1337	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	00110: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	01110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	10010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	00111: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
A8	1343:1342	CNT1 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1351:1344	LUT3_7_DFF10 setting	[7]: LUT3_7[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3_7[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3_7[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3_7[4]/DFF Initial Polarity Select 0:Low; 1: High [3:0]: LUT3_7[3:0]
A9	1355:1352	DLY/CNT1 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1359:1356	CNT1 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT
AA	1367:1360	REG_CNT1_Data[7:0]	Data[7:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
AB	1368	CNT1 output pol selection	0: Default Output 1: Inverted Output
	1369	Reserved	
	1370	CNT1 CNT mode SYNC selection	0: bypass 1: after two DFF
	1371	CNT1 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1394, 1375:1372	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)
AB	1394, 1375:1372	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
AC	1383:1376	LUT3_8_DFF_11 setting	[7]: LUT3_8[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3_8[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3_8[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3_8[4]/DFF Initial Polarity Select 0: Low; 1: High [3:0]: LUT3_8[3:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
AD	1387:1384	DLY/CNT2 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1391:1388	CNT2 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT
AE	1393:1392	CNT2 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1395	CNT2 output pol selection	0: Default Output 1: Inverted Output
	1396	Reserved	
	1397	CNT2 CNT mode SYNC selection	0: bypass 1: after two DFF
	1398	CNT2 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1399	Reserved	
AF	1407:1400	REG_CNT2_Data[7:0]	Data[7:0]
B0	1408	Reserved	
	1411 1413 1412 1410 1409	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	00100: Matrix A-D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
B0	1411 1413 1412 1410 1409	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	00110: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	01110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	10010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	10110: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	00111: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
B1	1415:1414	CNT3 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1423:1416	LUT3_9_DFF12 setting	[7]: LUT3_9[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3_9[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3_9[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3_9[4]/DFF Initial Polarity Select 0:Low; 1: High [3:0]: LUT3_9[3:0]
B2	1427:1424	DLY/CNT3 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1431:1428	CNT3 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT
B3	1439:1432	REG_CNT3_Data[7:0]	Data[7:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
B4	1440	CNT3 output pol selection	0: Default Output 1: Inverted Output
	1441	Reserved	
	1442	CNT3 CNT mode SYNC selection	0: bypass 1: after two DFF
	1443	CNT3 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1466, 1447:1444	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)
B4	1466, 1447:1444	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
B5	1455:1448	LUT3_DFF setting	[7]: LUT3[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3[4]/DFF Initial Polarity Select 0: Low; 1: High [3:0]: LUT3[3:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
B6	1459:1456	DLY/CNT4 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1463:1460	CNT4 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT
B7	1465:1464	CNT4 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1467	CNT4 output pol selection	0: Default Output 1: Inverted Output
	1468	Reserved	
	1469	CNT4 CNT mode SYNC selection	0: bypass 1: after two DFF
	1470	CNT4 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1471	Reserved	
B8	1479:1472	REG_CNT4_Data[7:0]	Data[7:0]
B9	1480	Reserved	
	1483 1485 1484 1482 1481	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	00100: Matrix A-D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
B9	1483 1485 1484 1482 1481	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	00110: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	01110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	10010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	10110: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
	1487:1486	DFF → CNT/DLY	00111: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
	1487:1486	CNT5 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
BA	1495:1488	LUT3_11_DFF14 setting	[7]: LUT3_11[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3_11[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3_11[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3_11[4]/DFF Initial Polarity Select 0:Low; 1: High [3:0]: LUT3_11[3:0]
BB	1499:1496	DLY/CNT5 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1503:1500	CNT5 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT
BC	1511:1504	REG_CNT5_Data[7:0]	Data[7:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
BD	1512	CNT5 output pol selection	0: Default Output 1: Inverted Output
	1513	Reserved	
	1514	CNT5 CNT mode SYNC selection	0: bypass 1: after two DFF
	1515	CNT5 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1538, 1519:1516	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)
BD	1538, 1519:1516	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
BE	1527:1520	LUT3_12_DFF15 setting	[7]: LUT3_12[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3_12[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3_12[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3_12[4]/DFF Initial Polarity Select 0: Low; 1: High [3:0]: LUT3_12[3:0]

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
BF	1531:1528	DLY/CNT6 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1535:1532	CNT6 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT
C0	1537:1536	CNT6 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1539	CNT6 output pol selection	0: Default Output 1: Inverted Output
	1540	Reserved	
	1541	CNT6 CNT mode SYNC selection	0: bypass 1: after two DFF
	1542	CNT6 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1543	Reserved	
C1	1551:1544	REG_CNT6_Data[7:0]	Data[7:0]
C2	1556:1552	Single 3-bit LUT	00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW)
		Single DFF w RST and SET	10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW)

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
C2	1556:1552	Single CNT/DLY	00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF)
		CNT/DLY → LUT	00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2)
		CNT/DLY → DFF	10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D)
		CNT/DLY → LUT	00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1)
		CNT/DLY → DFF	10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST)
		CNT/DLY → LUT	01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0)
		CNT/DLY → DFF	11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK)
		LUT → CNT/DLY	00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN)
		DFF → CNT/DLY	10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN)
	1557	CNT7 output pol selection	0: Default Output 1: Inverted Output
C3	1558	Reserved	
	1559	CNT7 CNT mode SYNC selection	0: bypass 1: after two DFF
	1567:1560	LUT3_13_DFF16 setting	[7]: LUT3_13[7]/DFF or LATCH Select 0: DFF function; 1: LATCH function [6]: LUT3_13[6]/DFF Output Select 0: Q output; 1: QB output [5]: LUT3_13[5]/DFF 0: nRST from Matrix Output; 1: nSET from Matrix Output [4]: LUT3_13[4]/DFF Initial Polarity Select 0:Low; 1: High [3:0]: LUT3_13[3:0]
C4	1571:1568	DLY/CNT7 Clock Source Select	Clock source SEL [3:0] 0000: 25M(OSC2); 0001: 25M/4; 0010: 2M(OSC1); 0011: 2M/8; 0100: 2M/64; 0101: 2M/512; 0110: 2K(OSC0); 0111: 2K/8; 1000: 2K/64; 1001: 2K/512; 1010: 2K/4096; 1011: 2K/32768; 1100: 2K/262144; 1101: CNT_END; 1110: External; 1111: Not used
	1575:1572	CNT7 function and edge mode selection	0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset CNT; 1101: falling edge reset CNT; 1110: rising edge reset CNT; 1111: high level reset CNT

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
C5	1577:1576	CNT7 initial value selection	00: bypass the initial 01: initial 0 10: initial 1 11: initial 1
	1578	CNT7 DLY EDET FUNCTION Selection	0: normal 1: DLY function edge detection
	1583:1579	Reserved	
C6	1591:1584	REG_CNT7_Data[7:0]	Data[7:0]
C7	1592	IO0 I <sup>2</sup> C output expander data	
	1593	IO0 I <sup>2</sup> C output expander select	0: IO0 output come from matrix 1: IO0 output is register
	1594	IO5 I <sup>2</sup> C output expander data	
	1595	IO5 I <sup>2</sup> C output expander select	0: IO5 output come from matrix 1: IO5 output is register
	1596	IO6 I <sup>2</sup> C output expander data	
	1597	IO6 I <sup>2</sup> C output expander select	0: IO6 output come from matrix 1: IO6 output is register
	1598	IO9 I <sup>2</sup> C output expander data	
	1599	IO9 I <sup>2</sup> C output expander select	0: IO9 output come from matrix 1: IO9 output is register
C8	1600	Reserved	
	1601	I <sup>2</sup> C reset bit with reloading NVM into Data register (soft reset)	0: Keep existing condition 1: Reset execution
	1602	IO latching enable during I <sup>2</sup> C write interface	1: disable 0: enable
	1607:1603	Reserved	
C9	1615:1608	I <sup>2</sup> C write mask bits	0: overwrite 1: mask
CA	1619:1616	I <sup>2</sup> C slave address	
	1620	Slave address selection A4	0: from register 1: from IO2
	1621	Slave address selection A5	0: from register 1: from IO3
	1622	Slave address selection A6	0: from register 1: from IO4
	1623	Slave address selection A7	0: from register 1: from IO5
CB	1631:1624	8-bit Pattern ID Byte 0 (From NVM): ID[23:16]	
CC	1639:1632	Reserved	
<b>Reserved</b>			
CD	1643:1640	Reserved	
	1647:1644	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
CE	1648	Reserved	
	1652:1649	Reserved	
	1653	Reserved	
	1654	Reserved	
	1655	Reserved	
CF	1657:1656	Reserved	
	1658	Reserved	
	1659	Reserved	
	1660	Reserved	
	1661	Reserved	
	1662	Reserved	
	1663	Reserved	
D0	1671:1664	Reserved	
D1	1679:1672	Reserved	
D2	1687:1680	Reserved	
D3	1695:1688	Reserved	
D4	1703:1696	Reserved	
D5	1711:1704	Reserved	
D6	1719:1712	Reserved	
D7	1727:1720	Reserved	
D8	1735:1728	Reserved	
D9	1743:1736	Reserved	
DA	1751:1744	Reserved	
DB	1759:1752	Reserved	
DC	1767:1760	Reserved	
DD	1775:1768	Reserved	
DE	1783:1776	Reserved	
DF	1791:1784	Reserved	
E0 RPR	1793:1792	2k Register Read Selection Bits RPRB[1:0]	00: 2k register data is unprotected for read; 01: 2k register data is partly protected for read; 10: 2k register data is fully protected for read; 11: reserved
	1795:1794	2k Register Write Selection Bits RPRB[3:2]	00: 2k register data is unprotected for write; 01: 2k register data is partly protected for write; 10: 2k register data is fully protected for write; 11: reserved
	1796	Reserved	
	1797	Reserved	
	1798	Reserved	
	1799	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

**Table 53: Register Map (Continued)**

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
E1 NPR	1801:1800	2k NVM Configuration Selection Bits NPRB[1:0]	00: 2k NVM Configuration data is unprotected for read and write/erase; 01: 2k NVM Configuration data is fully protected for read; 10: 2k NVM Configuration data is fully protected for write/erase; 11: 2k NVM Configuration data is fully protected for read and write/erase.
	1802	Reserved	
	1803	Reserved	
	1804	Reserved	
	1805	Reserved	
	1806	Reserved	
	1807	Reserved	
E2 WPR	1809:1808	Reserved	
	1810	Write Protect Register Enable	0: No Software Write Protection enabled (default). 1: Write Protection is set by the state of the WPB[1:0] bits.
	1815:1811	Reserved	
E3	1820:1816	Page Selection for Erase ERSEB[4:0]	Define the page address which will be erased. ERSEB[4] = 0 corresponds to the upper 2k NVM used for chip configuration;
	1821	Reserved	
	1822	Reserved	
	1823	Erase Enable ERSE	0: erase disable 1: cause the NVM erase: full NVM (4k bits) erase for ERSCHIP = 1 (reg[1973]) if DIS_ERSCHIP = 0 (reg[1972]) or page erase for ERSCHIP = 0 (reg[1973]).
E4	1824	Protection Lock Bit (PRL)	0: RPR/WPR/NPR setting can be changed 1: RPR/WPR/NPR setting cannot be changed
	1831:1825	Reserved	
E5	1839:1832	Reserved	
E6	1847:1840	Reserved	
E7	1855:1848	Reserved	
E8	1863:1856	Reserved	
E9	1871:1864	Reserved	
EA	1879:1872	Reserved	
EB	1887:1880	Reserved	
EC	1895:1888	Reserved	
ED	1903:1896	Reserved	
EE	1911:1904	Reserved	
EF	1919:1912	Reserved	
F0	1926:1920	Reserved	
	1927	Reserved	
F1	1932:1928	Reserved	
	1934:1933		
	1935	Reserved	

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

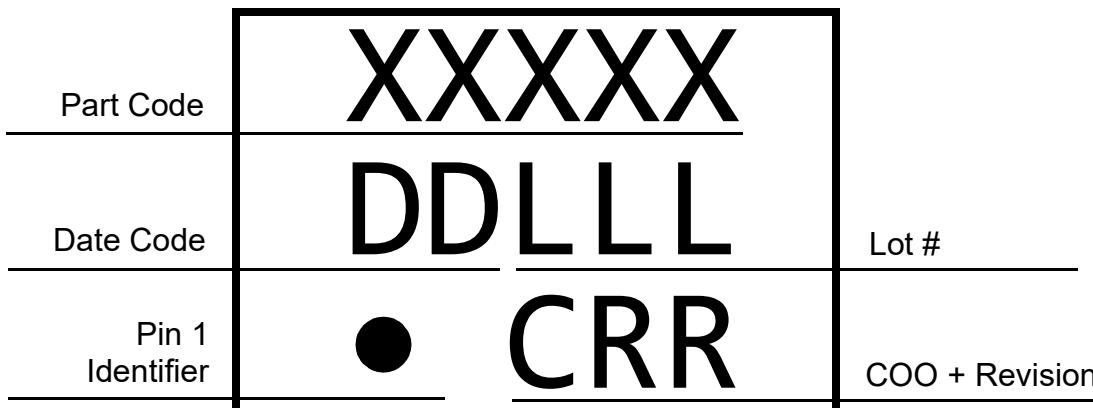
Table 53: Register Map (Continued)

Address		Signal Function	Register Bit Definition
Byte	Register Bit		
F2	1940:1936	Reserved	
	1943:1941		
F3	1949:1944	Reserved	
	1951:1950		
F4	1957:1952	Reserved	
	1959:1958		
F5	1965:1960	Reserved	
	1967:1966		
F6	1968	Reserved	
	1971:1969	Reserved	
	1972	Reserved	
	1973	Reserved	
	1974	Reserved	
	1975	Reserved	
F7	1983:1976	Reserved	
F8	1991:1984	Reserved	
F9	1992	Reserved	
	1993	Reserved	
	1995:1994	Reserved	
	1999:1996	Reserved	
FA	2000	Reserved	
	2001	Reserved	
	2002	Reserved	
	2006:2003		
	2007	Reserved	
FB	2015:2008	Reserved	
FC	2023:2016	Reserved	
FD	2031:2024	Reserved	
FE	2039:2032	Reserved	
FF	2047:2040	Reserved	

**GreenPAK Programmable Mixed-Signal Matrix with In System  
Programmability**

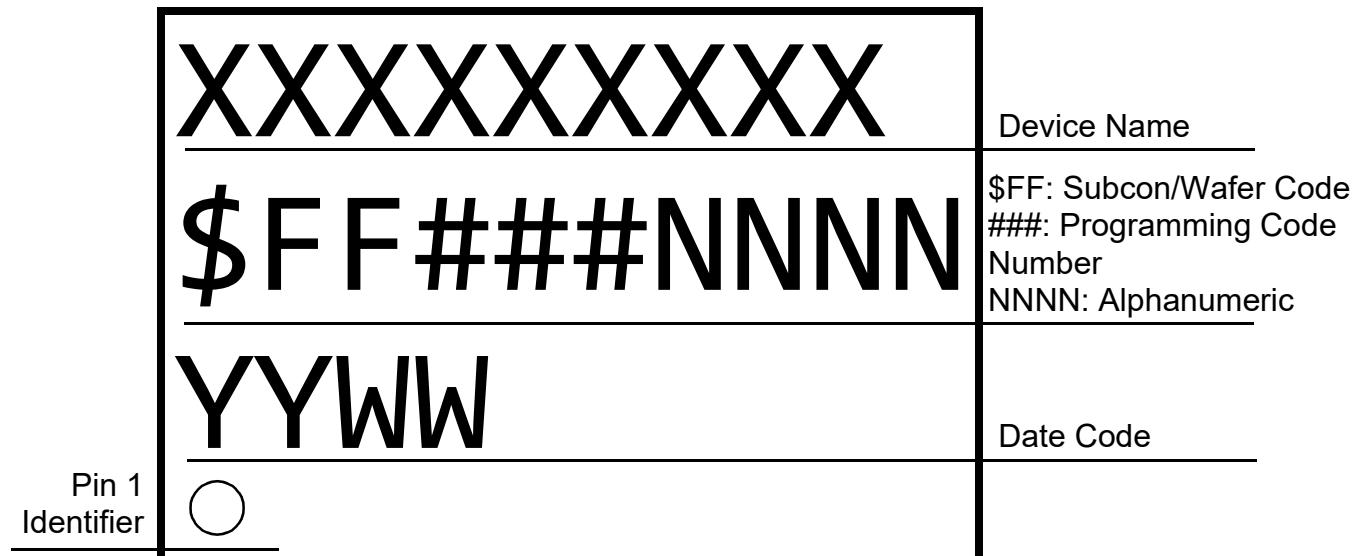
## 18 Package Top Marking System Definition

### 18.1 STQFN 20L 2 MM X 3 MM 0.4P FCD PACKAGE



- XXXXX - Part ID Field identifies the specific device configuration
- DD - Date Code Field: Coded date of manufacture
- LLL - Lot Code: Designates Lot #
- C - Assembly Site/COO: Specifies Assembly Site/Country of Origin
- RR - Revision Code: Device Revision

### 18.2 TSSOP-20



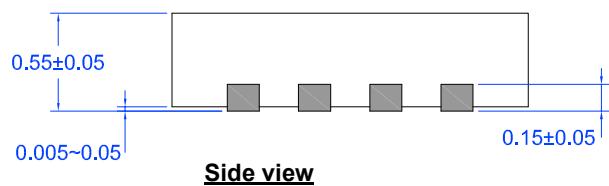
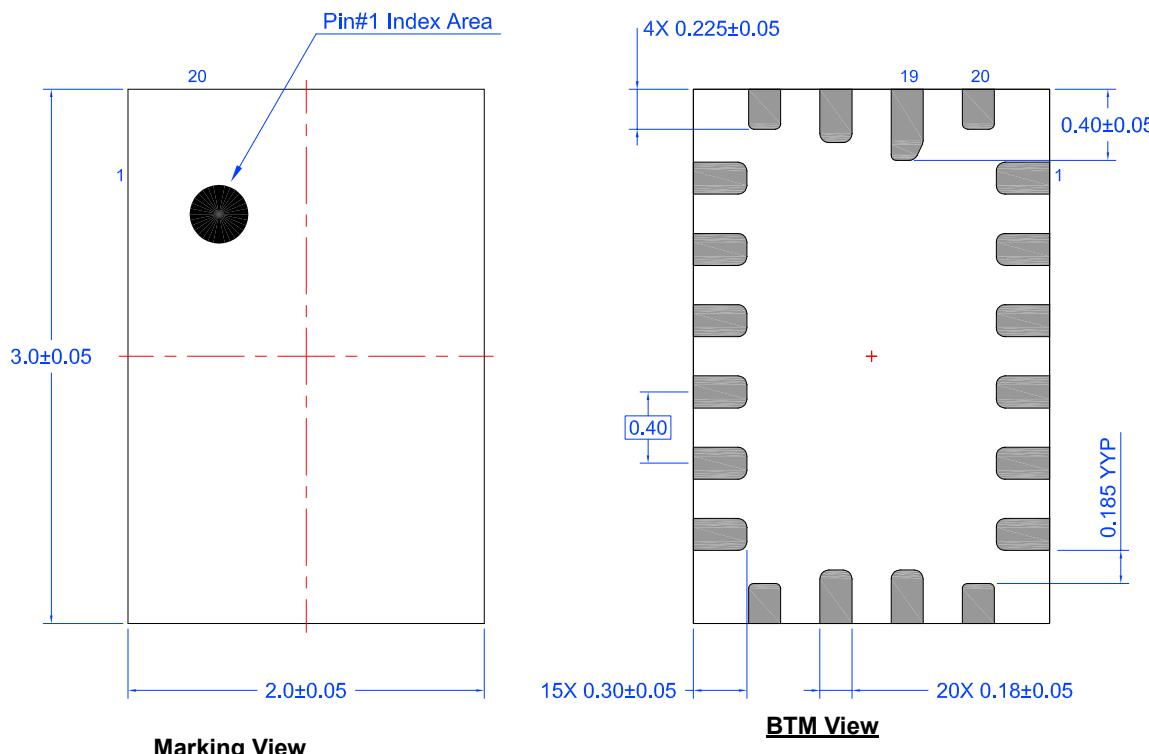
## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 19 Package Information

#### 19.1 PACKAGE OUTLINES FOR STQFN 20L 2 MM X 3 MM 0.4P FCD

JEDEC MO-220, Variation WECE

IC Net Weight: 0.008 g

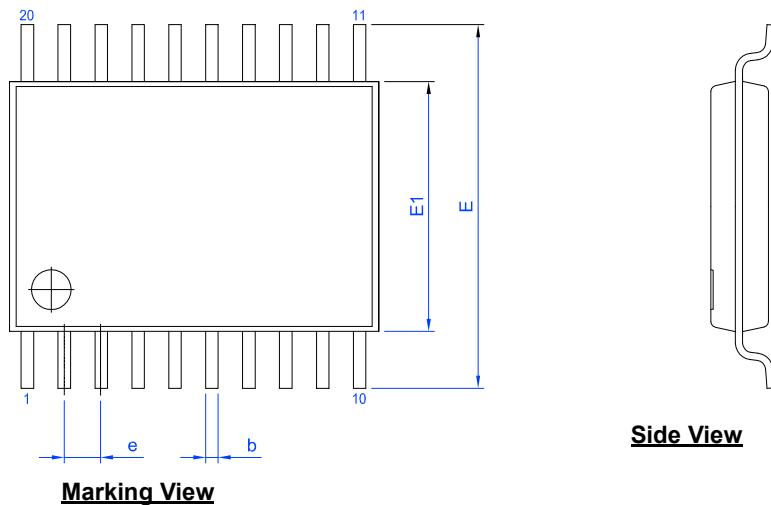


Unit: mm

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

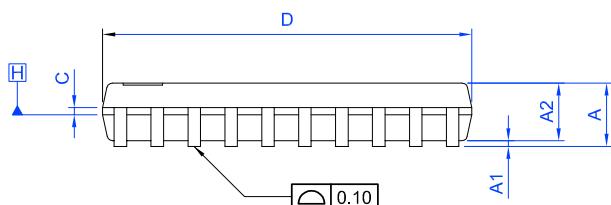
### 19.2 PACKAGE OUTLINES FOR TSSOP 20L 173 MIL GREEN

JEDEC MO-220, Variation WECE  
IC Net Weight: 0.083 g

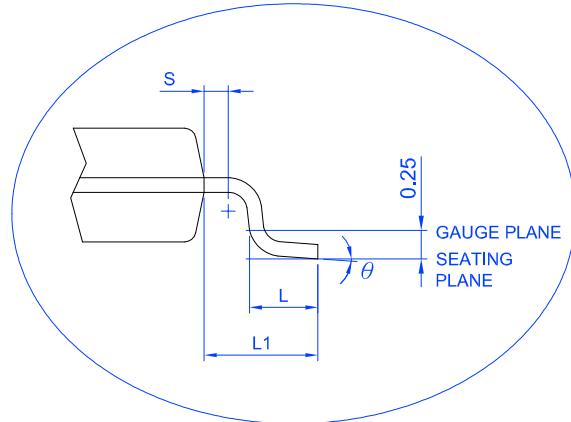


Side View

Marking View



Side view



NOTES:

1.JEDEC OUTLINE :

STANDARD : MO-153 AC REV.F  
THERMALLY ENHANCED : MO-153 ACT REV.F

2.DIMENSION 'D' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

3.DIMENSION 'E1' DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 PER SIDE.

4.DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 MM TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07 MM.

5.DIMENSIONS 'D' AND 'E1' TO BE DETERMINED AT DATUM PLANE H.

Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	-	-	1.20	D	6.40	6.50	6.60
A1	0.05	-	0.15	E1	4.30	4.40	4.50
A2	0.80	0.90	1.05	E		6.40 BSC	
b	0.19	-	0.30	L	0.50	0.60	0.75
C	0.09	-	0.20	L1		1.00 REF	
e		0.65 BSC		S	0.20	-	-
				Θ	0°	-	8°

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## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

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### 19.3 STQFN AND TSSOP HANDLING

Be sure to handle STQFN and TSSOP packages only in a clean, ESD-safe environment. Tweezers or vacuum pick-up tools are suitable for handling. Do not handle STQFN and TSSOP packages with fingers as this can contaminate the package pins and interface with solder reflow.

### 19.4 SOLDERING INFORMATION

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 3.30 mm<sup>3</sup> (nominal) for STQFN 20L Package and package volume of 25.74 mm<sup>3</sup> (nominal) for TSSOP-20 Package. More information can be found at [www.jedec.org](http://www.jedec.org).

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 20 Ordering Information

Part Number		Type
SLG46824V		20-pin STQFN
SLG46824VTR		20-pin STQFN - Tape and Reel (3k units)
SLG46824G		20-pin TSSOP
SLG46824GTR		20-pin TSSOP Tape and Reel (4k units)

**Note 1** Use SLG46824V or SLG46824G to order. Shipments are automatically in Tape and Reel.

**Note 2** "TR" suffix is no longer used. It is a legacy naming convention shown here only for informational purposes.

#### 20.1 TAPE AND REEL SPECIFICATIONS

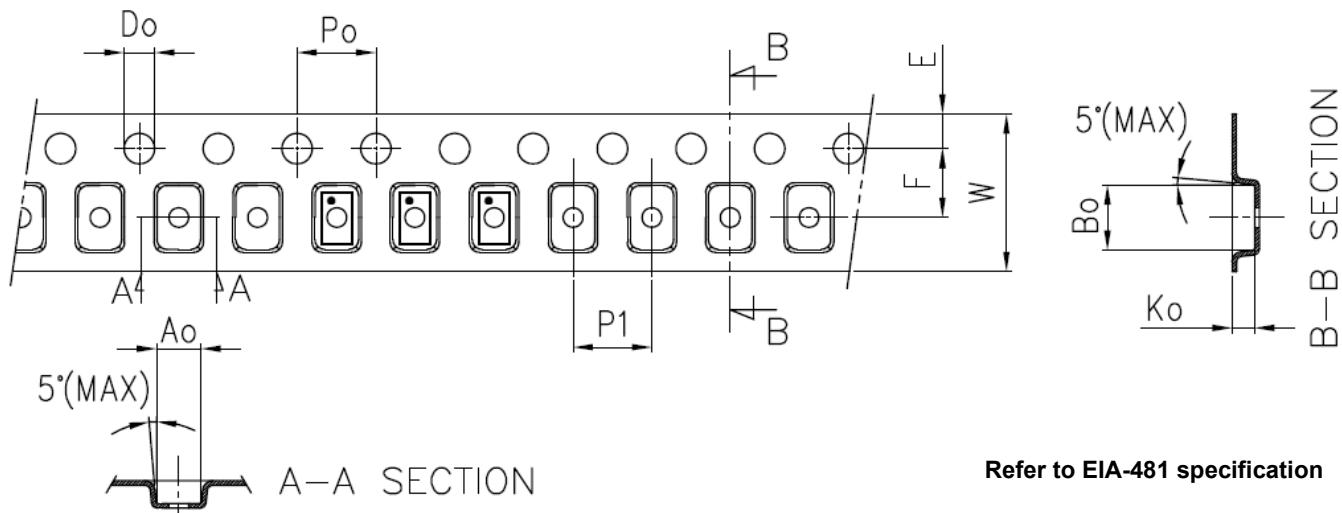
Package Type	# of Pins	Nominal Package Size (mm)	Max Units		Reel & Hub Size (mm)	Leader (min)		Trailer (min)		Tape Width (mm)	Part Pitch (mm)
			per Reel	per Box		Pockets	Length (mm)	Pockets	Length (mm)		
STQFN 20L 2 mm x 3 mm 0.4P FCD	20	2 x 3 x 0.55	3,000	3,000	178/60	100	400	100	400	8	4
TSSOP 20L 173 MIL Green Package	20	6.5 x 6.4	4,000	4,000	330/100	42	336	42	336	16	8

#### 20.2 CARRIER TAPE DRAWING AND DIMENSIONS

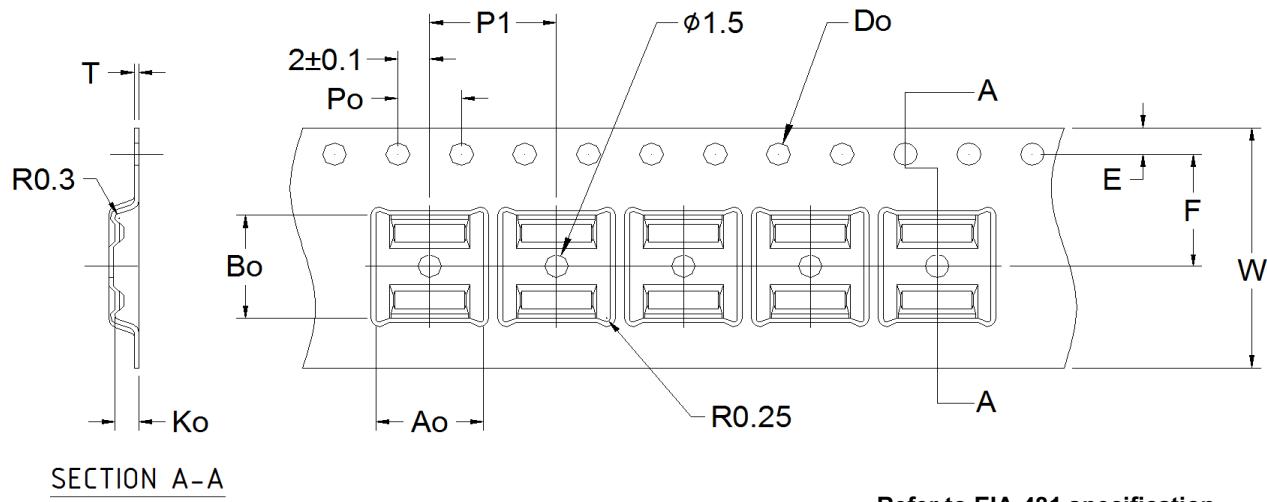
Package Type	Pocket BTM Length (mm)	Pocket BTM Width (mm)	Pocket Depth (mm)	Index Hole Pitch (mm)	Pocket Pitch (mm)	Index Hole Diameter (mm)	Index Hole to Tape Edge (mm)	Index Hole to Pocket Center (mm)	Tape Width (mm)
	A0	B0	K0	P0	P1	D0	E	F	W
STQFN 20L 2 mm x 3 mm 0.4P FCD	2.2	3.15	0.76	4	4	1.5	1.75	3.5	8
TSSOP 20L 173 MIL Green Package	6.8	6.9	1.6	4	8	1.5	1.75	7.5	16

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### 20.3 STQFN-20L



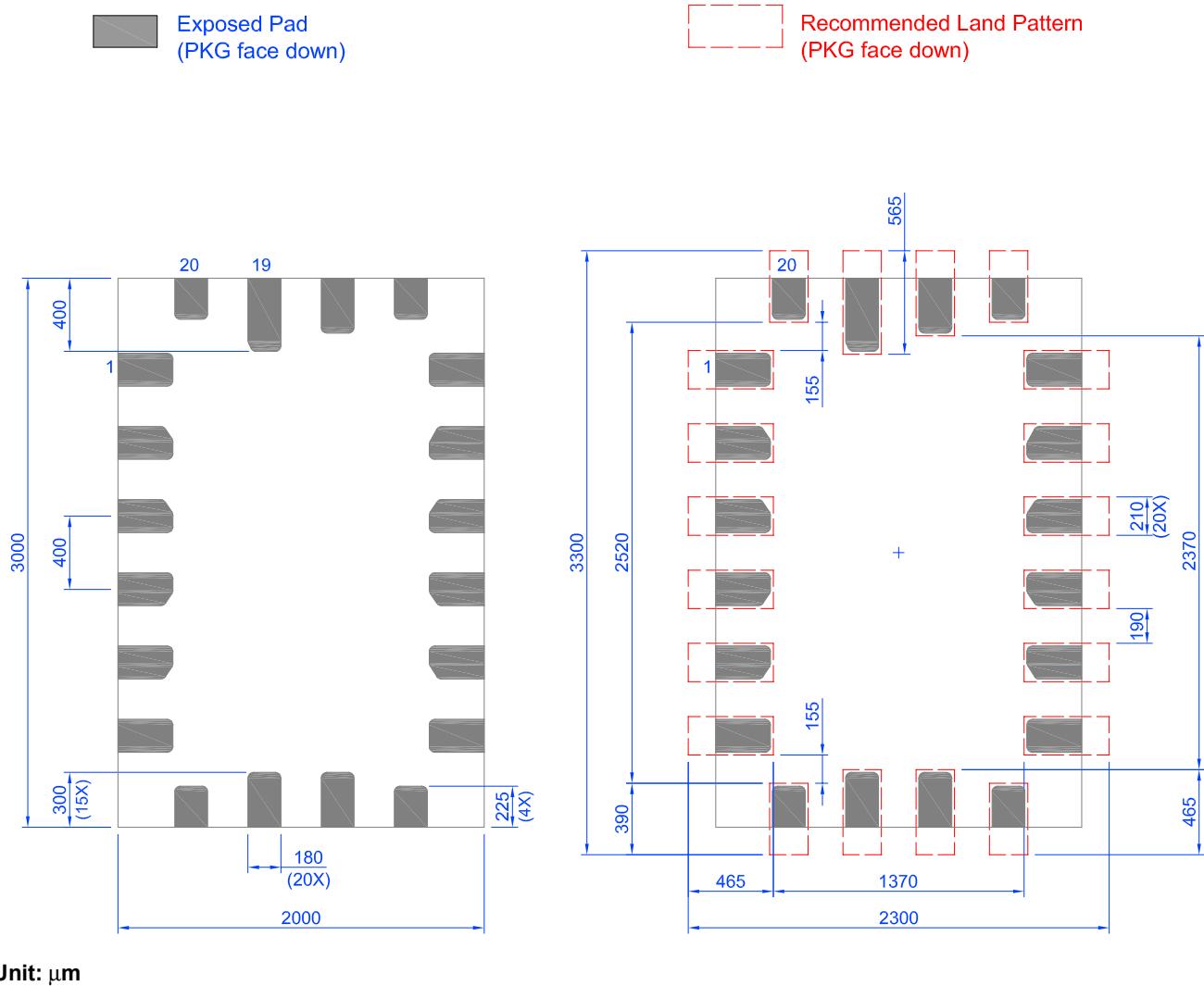
### 20.4 TSSOP-20L

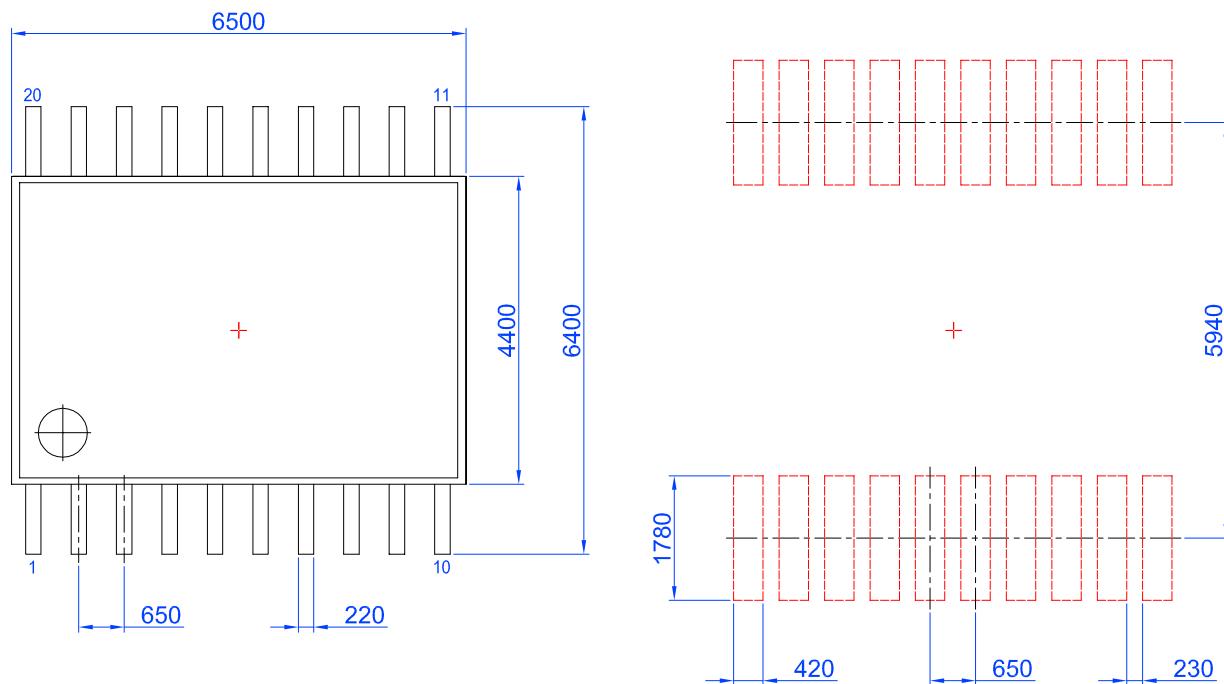


**Note:** Orientation in carrier: Pin1 is at upper left corner (Quadrant1).

## 21 Layout Guidelines

## 21.1 STQFN 20L 2 MM X 3 MM 0.4P FCD PACKAGE



**GreenPAK Programmable Mixed-Signal Matrix with In System  
Programmability****21.2 TSSOP-20****Unit: µm**

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### Glossary

#### A

ACK	Acknowledge bit
ACMP	Analog Comparator
ACMPH	Analog Comparator High Speed
ACMPL	Analog Comparator Low Power

#### B

BG	Bandgap
CLK	Clock

#### C

CMO	Connection matrix output
CNT	Counter

#### D

DFF	D Flip-Flop
DLY	Delay

#### E

EC	Electrical Characteristics
ERSE	Erase Enable
ERSR	Erase Register
ESD	Electrostatic discharge
EV	End Value

#### F

FSM	Finite State Machine
-----	----------------------

#### G

GPI	General Purpose Input
GPIO	General Purpose Input/Output
GPO	General Purpose Output

#### I

IN	Input
IO	Input/Output

#### L

LPF	Low Pass Filter
LSB	Least Significant Bit
LUT	Look Up Table

**GreenPAK Programmable Mixed-Signal Matrix with In System  
Programmability**

LV      Low Voltage

**M**

MSB      Most Significant Bit

MTP      Multiple-Time-Programmable

MUX      Multiplexer

**N**

NPR      Non-Volatile Memory Read/Write/Erase Protection

nRST      Reset

NVM      Non-Volatile Memory

**O**

OD      Open-Drain

OE      Output Enable

OSC      Oscillator

OUT      Output

**P**

PD      Power-down

PGen      Pattern Generator

POR      Power-On Reset

PP      Push-Pull

PRL      Protect Lock Bit

PWR      Power

P DLY      Programmable Delay

**R**

RPR      Register Read/Write Protection

RPRB      Register Read/Write Protection Bit

RPRL      Register Protection Read/Write/Erase Lock

REG      Register

R/W      Read/Write

**S**SCL      I<sup>2</sup>C Clock InputSDA      I<sup>2</sup>C Data Input/Output

SLA      Slave Address

SMT      With Schmitt Trigger

SV      nSET Value

**V**

Vref      Voltage Reference

**W**

WOSMT    Without Schmitt Trigger  
WPB       Write Protect Bit  
WPR       Write Protection Register  
WPRE      Write Protect Enable  
WS         Wake and Sleep Controller

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### Revision History

Revision	Date	Description
3.17	27-Feb-2023	Added notes to section Ordering Information
3.16	3-Feb-2023	Updated Package Marking for TSSOP package
3.15	9-Sep-2022	Added Note to section I <sup>2</sup> C Serial Command Register Map
3.14	9-Aug-2022	Fixed typos
3.13	7-Mar-2022	Updated Pull-up or Pull-down Resistance Parameter in EC table Renesas rebranding Added IC Net Weight in Package Information section Added information about SCL and SDA Pins' Schmitt Trigger Updated section IO8 Source for Oscillator2 (25 MHz) $t_{start}$ updated in table ACMP Specifications
3.12	24-Feb-2021	Updated table ACMP Specifications at T = -40 °C to +85 °C, V <sub>DD</sub> = 2.3 V to 5.5 V Unless Otherwise Noted
3.11	12-Feb-2021	Corrected 3-Bit LUT or DFF/LATCH with 8-Bit Counter/Delay Macrocells section Corrected POR Initialization and Power Down sections Corrected I <sup>2</sup> C Block Addressing Fixed typos Corrected table Oscillators Frequency Limits Added note in EC table Corrected GPIO Register OE IO Structure Diagrams Corrected I <sup>2</sup> C Mode Structure (for SCL and SDA) Corrected Recommended Operating Conditions Corrected Electrical Characteristics (I <sub>OH</sub> ) table
3.10	10-Mar-2020	Updated section CNT/DLY/FSM Timing Diagrams Corrected Functional Pin description Corrected registers[1623:1620] Corrected Register map's Bytes value Added note for CNTs Updated Typical Counter/Delay Offset Corrected EC of the I <sup>2</sup> C Pins Table Updated Pins Block Diagrams Fixed typos Corrected Edge Detection Mode Timing Diagram Section Delayed Edge Detection Mode added Figure I <sup>2</sup> C Block Addressing updated Corrected ACMPs hysteresis selection options
3.9	15-Jul-2019	Corrected Vref electrical specification Updated according to new template Corrected information in Analog Comparators section Updated according to Dialog's Writing Guideline Fixed typos Corrected Oscillators names Changed I <sup>2</sup> C Serial Communications Macrocell section structure
3.8	8-Apr-2019	Corrected 2-bit LUT3 or PGen figure Corrected Electrical Spec
3.7	22-Mar-2019	Added new subsection Electrostatic Discharge Ratings Fixed typos Removed information about SCL and SDA Pins' Schmitt Trigger Corrected Absolute Maximum Ratings Corrected Pinout figure

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

Revision	Date	Description
3.6	20-Feb-2019	Updated Absolute Maximum Ratings Added Maximum Average or DC Current (Through pin) parameter Corrected ACMPs Block Diagrams Added ACMPs' hysteresis information Added additional information about V <sub>DD2</sub> to IO Pins section Corrected Absolute Maximum Ratings Updated Typical delay table Fixed typos
3.5	5-Nov-2018	Added graphs to IO pins, ACMP and Oscillator sections Fixed typos
3.4	14-Sep-2018	Updated Oscillator Startup Diagram Fixed typos Updated Example of I <sup>2</sup> C Byte Write Bit Masking
3.3	8-Aug-2018	Fixed typos
3.2	7-Aug-2018	Fixed typos Updated Electrical Spec Updated figure I <sup>2</sup> C Block Addressing
3.1	24-May-2018	Updated Electrical Spec Fixed typos Updated register definitions: [1602], [2015:2008] Updated Electrical spec notes and conditions Updated STQFN and TSSOP Handling section
3.0	2-May-2018	Final version

## GreenPAK Programmable Mixed-Signal Matrix with In System Programmability

### Status Definitions

Revision	Datasheet Status	Product Status	Definition
1.<n>	Target	Development	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
2.<n>	Preliminary	Qualification	This datasheet contains the specifications and preliminary characterization data for products in pre-production. Specifications may be changed at any time without notice in order to improve the design.
3.<n>	Final	Production	This datasheet contains the final specifications for products in volume production. The specifications may be changed at any time in order to improve the design, manufacturing and supply. Major specification changes are communicated via Customer Product Notifications. Datasheet changes are communicated via <a href="http://www.renesas.com">www.renesas.com</a> .
4.<n>	Obsolete	Archived	This datasheet contains the specifications for discontinued products. The information is provided for reference only.

### RoHS Compliance

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